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PROPOSAL AND DEVELOPMENT OF A HIGHLY
MODULAR AND SCALABLE SELF-ADAPTIVE
HARDWARE ARCHITECTURE WITH PARALLEL
PROCESSING CAPABILITY.

THESIS SUBMITTED IN PARTIAL FULFILLMENT OF THE
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JAVIER E. SOTO VARGAS

DIRECTOR: JUAN MANUEL MORENO AROSTEGUI

This document is prepared to be printed double-sided.

*To my wife Carol,
for her immense love and unconditional support,
thanks for always being there for me.*

*To my two little dinosaurs: Gabriela and Daniel,
for the games that we will play,
and for the life that you will teach me to discover.*

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a mi sobrino Nicolás.
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*I consider myself the best friend of my friends,
and I think any of them love me as much
as I love the friend I love less.*

*Me considero el mejor amigo de mis amigos,
y creo que ninguno de ellos me quiere tanto
como yo quiero al amigo que quiero menos.*

Gabriel García Márquez (1927 – 2014)

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que propuse en esta tesis doctoral. Este trabajo es para todos ustedes.

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Abstract

*Education is what remains after one has forgotten
what one has learned in school.*

*La educación es lo que queda después de que uno ha
olvidado lo que se ha aprendido en la escuela.*

Albert Einstein (1879 – 1955)

This dissertation describes a novel unconventional self-adaptive hardware architecture with capacity for parallel processing. For scalability issues, this bioinspired architecture is based on a regular array of homogeneous cells. The proposed programmable architecture implements in a distributed way self-adaptive capabilities including self-placement and self-routing which, due to its intrinsic design, enable the development of systems with runtime reconfiguration, self-repair and/or fault tolerance capabilities. Additionally, this work defines the *configuration* and the *functional* units of the elementary cell, which implements the self-adaptive and parallel processing capabilities respectively.

The physical implementation of this architecture is composed of two-layers, interconnected cells in the first level and interconnected switch and pin matrices in the second level. Several chips can be interconnected for enlarging the cell array. Any application scheduled to the system has to be organized in components, where each component is composed by one or more interconnected cells. The interconnection of cells inside a component is made at cell level (first layer), while the physical interconnections of components are made in the second layer. Additionally, two layers are defined as conceptual organization for the implementation of general purpose applications: the SANE and the SANE assembly. The **SANE (Self-Adaptive Networked Entity)** is composed by a group of components. This is the basic self-adaptive computing system. It has the ability to monitor its local environment and its internal computation process. The **SANE ASSEMBLY (SANE-ASM)** is composed by a group of interconnected SANEs.

The processing capabilities of the cell are included in its **Functional Unit (FU)**, which can be described as a four-core configurable multicomputer. The FU includes twelve programmable configuration modes, i.e., each cell permits to select from one to four processors working in parallel, with different size of program and data memories. The cores are grouped or not depending of the configuration mode, allowing program memory sizes of 64, 128, 192 or 256 instructions. Similarly, the data memory can be combined in width and length, achieving combinations for data processing of 8, 16, 24 and 32 bits.

The self-adaptive capabilities of the cell are executed mainly by the **Cell Configuration Unit (CCU)**. The self-placement algorithm is responsible for finding out the most suitable position in the cell array to insert the new cell of a component. The self-routing algorithm is executed since the insertion of the second cell of a component, each time that the self-placement process ends. This algorithm allows interconnecting the ports of the FU of two cells through the cell ports. The self-placement and self-routing processes allow for performing complex functionality changes in real time, these processes endow the system with enhanced functionality, enabling the system

to change itself, this allows for the implementation of run-time self-configuration, without the need for any configuration manager. The absence of a centralized supervision system permits cells to perform some of the tasks in a distributed way.

The architecture proposed includes two mechanisms of fault tolerance. One of these is the Dynamic Fault Tolerance Scaling Technique, that has the ability to create and eliminate the redundant copies of the functional section of a specific application. This is possible due to the ability of run-time self-configuration included in the architecture. The other mechanism of fault tolerance is a dedicated or static Fault Tolerance System. It provides redundant processing capabilities that are working continuously. When a failure in the execution of a program is detected, the processors of the cell are stopped and the self-elimination and self-replication processes start for the cell (or cells) involved in the failure. This cell(s) will be self-discarded for future self-placement processes.

An FPGA-based prototype and a software tool have been built for demonstration purposes. The prototype includes all the self-adaptive capabilities described in this document. The prototype has been developed in two chips, each one is a Virtex4 Xilinx FPGA (XC4VLX60). The physical design includes the cell array together with a component-level routing system. Additionally a [Control Microprocessor \(CμP\)](#) and other peripherals provide support for the implementation of general purpose applications in the prototype.

With the purpose of having a complete development system, the software tool [SANE Project Developer \(SPD\)](#) has been implemented. The [SPD](#) is an Integrated Development Environment (IDE) that allows generating the memory initialization data for the control microprocessor inside the prototype. The [SPD](#) allows the creation and edition of various files that describe the configuration of a [SANE-ASM](#). The main (or top) file includes special [SANE-ASM](#) instructions (SASM files), which are equivalent to the assembler language for classic processors. The [SPD](#) allows the creation and edition of all related information of the [SANE-ASM](#). In addition, the [SPD](#) automatically builds the final hexadecimal file with the configuration of the [SANE-ASM](#) that will be downloaded in the FPGA-based prototype.

Resumen

*No man should escape our universities
without knowing how little he knows.*

*Ningún hombre debe escapar de nuestras
universidades sin saber lo poco que sabe.*

Julius Robert Oppenheimer (1904 – 1967)

Esta tesis doctoral describe una arquitectura de hardware auto-adaptable novedosa y no convencional con capacidad de procesamiento en paralelo. Por razones de escalabilidad, esta arquitectura bioinspirada está basada en una matriz regular de células homogéneas. La arquitectura propuesta es programable, e implementa de manera distribuida diversas capacidades auto-adaptables incluyendo el auto-emplazamiento y auto-enrutamiento, los cuales debido a su diseño intrínseco, permiten el desarrollo de sistemas reconfigurables en tiempo de ejecución, así como de sistemas auto-reparables y/o con capacidades de tolerancia a fallos. Adicionalmente este trabajo define las unidades de *configuración* y *funcional* de la célula, las cuales implementan las capacidades auto-adaptables y de procesamiento en paralelo respectivamente.

La implementación física de esta arquitectura esta compuesta de dos capas, que incluyen células interconectadas en el primer nivel y matrices de conmutación y pines en el segundo nivel. Las células ejecutan la funcionalidad básica del sistema. Diversos chips pueden ser interconectados para aumentar la matriz de células en el sistema. Cualquier aplicación que se quiera programar en el sistema debe estar organizada en componentes, donde cada componente está compuesto por una o más células interconectadas. La interconexión de células dentro de un componente es realizado en el mismo nivel de la matriz de células (primera capa), mientras que la interconexión de componentes es realizada en la segunda capa. Adicionalmente, se definen dos capas conceptuales que son usadas con propósitos organizativos en aplicaciones de propósito general, estas son: el SANE y el SANE-assembly. La *entidad auto-adaptable interconectada* o **SANE (Self-Adaptive Networked Entity)** está compuesta por un grupo de componentes. Este es el sistema de computación auto-adaptable básico, el cual tiene la habilidad de monitorizar su entorno local y su proceso de computación interno. El *Conjunto de SANES* o **SANE ASSEMBLY (SANE-ASM)** esta compuesto por un grupo de **SANES** interconectados.

Las capacidades de procesamiento de la célula están incluidas en su unidad funcional o **Functional Unit (FU)**. Esta puede ser definida como un multicomputador configurable con cuatro núcleos. La **FU** tiene doce modos de configuración programables, por lo que cada célula permite seleccionar entre uno y cuatro procesadores trabajando en paralelo con diversas capacidades en las memorias de programa y datos. Los núcleos son agrupados o no dependiendo del modo de configuración, permitiendo que la memoria de programa pueda implementar 64, 128, 192 o 256 instrucciones. De manera similar, la memoria de datos puede ser expandida a lo largo y/o ancho, permitiendo procesamiento de datos para 8, 16, 24 y 32 bits.

Las capacidades auto-adaptables de la célula son ejecutadas principalmente por la unidad de configuración de la célula o **Cell Configuration Unit (CCU)**. El algoritmo de auto-emplazamiento

es el encargado de encontrar la posición mas adecuada dentro de la matriz de células para insertar la nueva célula de un componente. El algoritmo de auto-enrutamiento es ejecutado a partir de la inserción de la segunda célula de un componente, cada vez que el algoritmo de auto-emplazamiento termina. Este algoritmo permite interconectar los puertos de las FU de dos células a través de los puertos de la célula. Los procesos de auto-emplazamiento y auto-enrutamiento permiten realizar en tiempo real cambios funcionales complejos; estos procesos dotan al sistema de una mayor funcionalidad, permitiendo que el sistema cambie por sí mismo, lo que permite la implementación de la auto-configuración en tiempo real, sin la necesidad de ningún gestor de configuración. La ausencia de un sistema de supervisión centralizado permite a las células realizar algunas de sus funciones de manera distribuida.

La arquitectura propuesta incluye dos mecanismos de tolerancia a fallos. Uno de estos es una técnica escalonada y dinámica de tolerancia a fallos, que tiene la habilidad de crear y eliminar copias redundantes de la unidad funcional (o de cómputo) de una aplicación específica. Esto es posible gracias a la capacidad de auto-configuración en tiempo real incluida en la arquitectura. El otro mecanismo de tolerancia a fallos es el Sistema de Tolerancia a Fallos dedicado o estático. Este provee capacidades de procesamiento redundante que están en funcionamiento continuamente. Cuando un fallo en la ejecución de un programa es detectado, los procesadores de la célula son detenidos y los procesos de auto-eliminación y auto-replicación se inician para la célula (o células) implicada en el fallo. Esta(s) célula(s) serán auto-descartadas para futuros procesos de auto-emplazamiento.

Se desarrolló un prototipo basado en FPGAs y una herramienta de software para comprobar la funcionalidad del sistema. El prototipo incluye todas las características de los sistemas auto-adaptable descritas en este documento. El prototipo ha sido desarrollado en dos chips, cada uno es una FPGA Virtex4 de Xilinx (XC4VLX60). El diseño físico incluye el arreglo de células junto a un sistema de enrutamiento a nivel de componentes. Adicionalmente incluye un microprocesador de control o C_μP (**Control Microprocessor**) y otros periféricos, que dan soporte a la implementación de aplicaciones de propósito general en el prototipo.

Con el propósito de tener un sistema de desarrollo completo, la herramienta de software SPD (**SANE Project Developer**) ha sido desarrollada. El SPD es un ambiente integrado de desarrollo (Integrated Development Environment o IDE) que permite generar y descargar la memoria de inicialización de datos para el C_μP dentro del prototipo. El SPD permite la creación y edición de archivos que describen la configuración de un SANE-ASM. El archivo principal incluye instrucciones especiales para el SANE-ASM (archivos SASM), el cual es equivalente al lenguaje de ensamblador de un procesador clásico. El SPD permite la creación y edición de toda la información relacionada con el SANE-ASM, así mismo construye de manera automática el archivo hexadecimal de configuración que será descargado a la FPGA del prototipo.

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Chapter 1

Introduction

Fall Down Seven Times, Get Up Eight.

Cae siete veces, levántate ocho.

Japanese Proverb – Proverbio Japonés

Abstract: This chapter is an introduction to adaptive and parallel processing systems. It includes mainly a theoretical framework, architecture overview and contributions, preliminary and related works.

Self-adaptation is defined as the ability of a system to react to its environment in order to optimize its performance. The AETHER project (Self-Adaptive Embedded Technologies for Pervasive Computing Architectures) [1] was a notable initiative in the study of novel self-adaptive computing technologies for future embedded and pervasive applications.

This work started as a contribution of the hardware platform for the AETHER project. After finalization of this project, I continue with the investigation introducing additional contributions to the initial platform developed.

One of the purposes of the AETHER project (including this work) is to show that self-adaptive computing architectures can be a powerful approach to simultaneously addressing the major problems raised by pervasive computing. In particular, it aims to tackle the issues related to parallel processing, self-adaptive capabilities and technological scalability, increased complexity and programmability of future embedded computing architectures by introducing self-adaptive technologies in computing resources.

1.1 Adaptive and Bioinspired Systems

An adaptive system consists of a set of interacting entities, which form an integrated whole that is able to respond to environmental changes or changes in the interacting parts. Adaptive systems are closely tied with the concept of bioinspired systems, that are systems built using configurable hardware and electronic instruments, that emulates the capabilities of the biological systems to process information and solve problems.

These features are relevant in research areas such as embedded systems and pervasive computing among others [2]. Some important features like self-organization and self-configuration are linked to higher computational requirements, where adaptive system architectures are formed as a promise in the evolution of classical computing systems. Self-adaptive computing architectures can be a powerful approach to simultaneously address the major problems raised by pervasive computing.

In coming years virtually every object will have a processing power, where the processing resources will require greater flexibility and scalability to meet the various needs of users. Adaptive computing systems offer the ability to adequate all or part of its architecture with applications that include changing needs or changing environments.

Adaptable architectures are closely linked to the concept of parallelism and reconfigurability, theoretically allowing greater efficiency for development of general purpose applications. According to [2] adaptive systems should have the following characteristics of bioinspired systems: self-configuration, adaptivity, self-distribution, self-organization, self-healing, automatic parallelization, accounting, self-protection and protection of others.

Self-healing is a special feature of an adaptive system, where hardware failures should be detected, handled and corrected by the system automatically. A fault tolerance system in an adaptive system together with other self-adaptive capabilities could provide this functionality.

1.2 Self-Adaptive capabilities in the proposed architecture

Self-configuration is a basic principle that permits a programmable or configurable system to modify autonomously its functionality at a given time [3]. This modification is usually driven by an optimization process that tries to match the behavior of the system with the constraints posed to the application it is intended to solve. The main characteristic to be present in the actual self-adaptive system is the capability of determining its configuration at a given time in an autonomous and distributed way by the system members (cells). This implies that the following properties should be supported at the hardware level by any architecture intended to be used as an efficient platform for self-adaptive principles: dynamic and distributed self-routing [4] [5] [6], dynamic and distributed self-placement, scalability and distributed control.

The self-placement and self-routing processes, due to its nature, enable the systems with runtime reconfiguration, self-repair and/or fault tolerance capabilities. This processes allow for performing complex functionality changes in real time, beyond the programmed context changes, currently common in the FPGA domain. The proposed self-placement and self-routing processes endow the system with enhanced functionality, making it possible for the system to change by itself, without the need for any configuration manager, as needed in current FPGAs. The absence of a centralized supervision system allows performing some of the tasks in a distributed way.

1.3 Architectures for parallel computing

Flynn's taxonomy [7] is probably the most common way to classify computer architectures with respect to their parallelism, based on the instruction and data flows. These streams are independent, so there are four possible combinations in parallel computing (see Table 1.1).

The model **SISD** (**Single Instruction Single Data**) based on the Von Neumann machine is the classic computing architecture; it uses a processor that is capable of performing actions sequentially, making different types of operations (arithmetic, logical, shifts, etc.) between data memory and processor registers. Although significant improvements have been implemented, like pipelining, prefetching, RISC architectures, code optimizers and others, it is expected to slow the pace of improvement, mainly due to physical implementation constraints. On the other hand, the need to solve new problems has increased, which demands high computational loads, so that the development of new parallel processing system acquires significant importance.

In a **SIMD** (**Single Instruction Multiple Data**) model a single program controls the processors using multiple data streams to perform operations that can be parallelized in a natural way. This type of architecture is useful in uniform applications, as in image processing, where it is necessary to apply the same function to many pixels simultaneously.

Name	Instructions Flow	Data Flow	Example, application
SISD	1	1	Classic computing architectures: Von Neumann, Harvard, PCs.
SIMD	1	Multiple	Vector processors, graphics cards.
MISD	Multiple	1	Uncommon, it is used in situations of redundant parallelism (Air Navigation)
MIMD	Multiple	Multiple	Multiprocessors, Multicomputer.

Table 1.1: Flynn’s taxonomy: classification of computer architectures with respect to its parallelism.

The model **MISD** (**M**ultiple **I**nstruction **S**ingle **D**ata), where many functional units perform different operations on the same data, is often used in situations of redundant parallelism, as in the case of air navigation, but due to its features it has been poorly implemented by industry.

Architecture **MIMD** (**M**ultiple **I**nstruction **M**ultiple **D**ata) is characterized by a set of processors executing different instruction sequences simultaneously on different data sets. This architecture can be classified in two, depending on the type of memory access, so you can have **MIMD** for shared memory (multiprocessor) and **MIMD** for distributed memory (multicomputer) [8]. The main advantage of the architecture **MIMD** over the **SIMD** architecture is that they have greater flexibility and applicability. However, the architecture **MIMD** is harder to configure and control [9]. The architecture **MIMD** due to its high degree of parallelism is emerging as the most suitable for the implementation of bioinspired systems.

1.4 Preliminary work

1.4.1 POEtic

The POEtic project [10] [5] tackled the development of a flexible computational substrate inspired by the evolutionary, developmental and learning phases in biological systems. The device is organized as a custom 32-bit RISC microprocessor and a custom FPGA. The internal architecture developed for the device is scalable, making it possible to construct a physical hardware platform whose size matches the requirements of the application to be implemented.

This project is based in essentially three biological models [11]: phylogenesis (P), the history of the evolution of the species, ontogenesis (O), the development of an individual as orchestrated by his genetic code, and epigenesis (E), the development of an individual through learning processes.

The POEtic architecture is divided in three parts, the environment subsystem, the organic subsystem and system interface. The environment subsystem of the POEtic tissue has been built around a custom 32-bit microprocessor with an efficient and flexible system bus and several custom peripherals. The organic subsystem is composed of two layers, a two-dimensional array of basic elements, called molecules, and a two-dimensional array of routing units. Each molecule is connected to its four neighbors in a regular structure. It is composed of a 16-bit LUT and a Flip Flop (DFF), which has the ability to access the routing layer which is used for communication between molecules. The second layer implements a dynamic routing algorithm that enables the creation of data paths between molecules at runtime. The dynamic routing system is designed to automatically connect the inputs and outputs of the molecules. The system interface allows

the communication between the environment and the organic subsystem of the tissue.

1.4.2 PERPLEXUS

The Perplexus project [12] [13] aims to develop a scalable hardware platform made of custom reconfigurable devices endowed with bioinspired capabilities that will enable the simulation of large-scale complex systems and the study of emergent complex behaviors in a virtually unbounded wireless network of computing modules.

The Perplexus project defines its platform as a network of ubidules (ubiquitous computing modules), which are equipped with wireless communication capabilities and important sensory elements. The project identifies three areas where the modeled structure can provide its functionality as a new and powerful simulation tool; these are: neuro-genetic computational modeling, study of culture diffusion and social robots.

1.5 State of the art

This section describes some projects that include similar features to the one presented here.

1.5.1 Confetti

Among the projects that have proposed architectures for advanced multiprocessor systems it is worth mentioning Confetti [14] [15], that is based on a scalable array of homogeneous processing nodes physically arranged as a networking computer mesh. This architecture is a dual-layered array of FPGAs, with a layer dedicated to processing (ECell) and the other to networking (ERouting). The basic computation element (ECell) is implemented in an FPGA. The networking level is implemented in a board specifically designed for this purpose. The principal difference with the proposed architecture is the scalability. The ECell has a higher processing capacity than the processing elements (cells) presented in this document. The main limitation of the Confetti architecture is the physical implementation of a very large number of processing elements. The architecture presented here can work with hundreds or millions of cells without architectural modifications. However, the boards used for the prototype don't permit the implementation of a large number of cells.

1.5.2 eDNA

The eDNA [16] presents the concept of a bioinspired reconfigurable hardware cell architecture that supports self-organization and self-healing. In order to validate the algorithms for self-organization and self-healing, the authors wrote a simulator to provide a fast method to examine the behavior of the proposed algorithms. All algorithms were based on the idea that they should run on processing elements (eCells) which used a NoC as communication medium. This approach provides an interesting starting point for future study and possible implementation of other self-adaptive capabilities to the system proposed in this work.

1.5.3 Self-routing reconfigurable fault-tolerant cell array

The work presented in [17] represents a self-routing reconfigurable fault-tolerant cell array. The reconfigurable and fault-tolerant cellular structure is based on a cell array. It comprises functional cells with spare cells having the same hardware structure. The functional cells can be configured with arithmetic or logical functions. The interconnection of functional cells can thus accomplish a complex task, as specified by the user. Compared with this work, our architecture only implements

redundancy when needed, due to its dynamic fault tolerance capability. This permits to have free resources that could be used for other processes inside the system.

1.5.4 CEDAR

The Configurable Embedded Distributed Architecture (CEDAR) [18] implements an adaptive routing strategy based on ACO (Ant Colony Optimization). Similar to our architecture, the CEDAR platform consists of an array of homogeneous Processing Elements (PE). Each PE can be configured as a computing or routing node. The main difference with the SANE architecture presented here is that each processing element (cell) provides processing and routing capabilities for the interconnection of neighbors and/or remote cells.

1.5.5 Amorphous

The amorphous computing [19] medium is a system of irregularly placed, asynchronous, locally interacting computing elements. The system can model this medium as a collection of computational particles sprinkled irregularly on a surface or mixed throughout a volume. The physical implementation of this system is quite difficult and therefore prevents from a future physical realization.

1.5.6 Cell Processors - Sony-Toshiba-IBM team

Other commercial implementations, like the Cell Processors [20] developed by Sony-Toshiba-IBM team, implement a SIMD architecture processor that consists of a 64-bit Power microprocessor coupled with multiple processors, a flexible IO interface, and a memory interface controller that supports multiple operating systems. Despite their capacity, SIMD architectures show limitations in general-purpose computing. Our self-adaptive system implements a MIMD architecture, whose processing capacity is configurable between 8, 16, 24 and 32 bits, and additionally each computing unit is able to execute small processing threads.

1.5.7 ADRES

The Architecture for Dynamically Reconfigurable Embedded System (ADRES) [21] [22] is an architecture that tightly couples a VLIW processor and a coarse-grained reconfigurable matrix.

The ADRES core consists of many basic components, e.g., Functional Units (FUs) and register files (RF). The whole ADRES core has two functional views: the VLIW processor and the reconfigurable matrix. The reconfigurable matrix is used to accelerate the dataflow-like kernels in a highly parallel way, whereas the VLIW executes the non-kernel code by exploiting instruction-level parallelism (ILP). These two functional views share some resources because their executions will never overlap with each other thanks to the processor/co-processor model.

For the VLIW part, several FUs are allocated and connected together through one multi-port register file, which is typical for a VLIW architecture. For the reconfigurable matrix, apart from the FUs and RF shared with the VLIW processor, there are a number of reconfigurable cells (RC) which basically comprise FUs and RFs too.

1.5.8 MorphoSys

MorphoSys [23] [24] [25] is a reconfigurable processing system targeted at data-parallel and computation-intensive applications. The MorphoSys architecture comprises five major components: the Reconfigurable Cell Array (RC Array), control processor (TinyRISC), Context Memory, Frame Buffer and a DMA Controller.

The reconfigurable component of MorphoSys is an array of reconfigurable cells (RCs) or processing elements. The RC Array has 64 cells in a two-dimensional matrix (8x8). The RC Array follows the [SIMD](#) model of computation. All RCs in the same row/column share same configuration data (context). However, each RC operates on different data.

The major component of MorphoSys is the Reconfigurable Cell (RC). Each RC incorporates an ALU-multiplier, a shift unit, input muxes and a register file. In addition, there is a context register that is used to store the current context and provide control/configuration signals to the RC components.

The control processor (TinyRISC) is a MIPS-like processor with a 4-stage scalar pipeline. It has a 32-bit ALU, register file and an on-chip data cache memory. This processor also coordinates system operation and controls its interface with the external world. The Context Memory stores multiple planes of configuration data (context) for RC Array, thus providing depth of programmability. The system incorporates a high-speed memory interface consisting of a streaming buffer (Frame Buffer) and a DMA controller. The Frame Buffer has two sets, which work in complementary fashion to enable overlap of data transfers with RC Array execution.

1.5.9 REMARC

Reconfigurable Multimedia Array Coprocessor (REMARC) [26] is a reconfigurable coprocessor that is tightly coupled to a main RISC processor and consists of a global control unit and 64 16-bit programmable logic blocks called nano-processors. REMARC is a [SIMD](#) architecture that is designed to accelerate multimedia applications, such as video compression, decompression, and image processing.

The base architecture of REMARC uses MIPS-II ISA. Coprocessor 0 is used for memory management, coprocessor 1 is used for floating point and REMARC operates as coprocessor 2. With REMARC, users can define and configure their own instructions specialized for their application.

REMARC consist of an 8x8 array of nano-processors and a global configuration unit. Each nano-processor has a 32-entry instruction RAM, a 16 bit ALU, a 16-entry data RAM, and 13 16-bit data registers. The global control unit controls the nano-processors and the transfer of data between the main processor and the nano-processors.

1.5.10 XPP (eXtreme Processing Platform)

The eXtreme Processing Platform (XPP) [27], [28] is a new runtime-reconfigurable data processing architecture. It is based on a hierarchical array of coarse grain, adaptive computing elements called processing array elements (PAEs), and a packet-oriented communication network.

An XPP device contains one or several processing array clusters (PACs), which includes rectangular blocks of PAEs. A typical XPP device contains four PACs. Each PAC is attached to a Configuration Manager (CM) responsible for writing configuration data into the configurable objects of the PAC. The XPP architecture is also designed for cascading multiple devices in a multichip setup. The PAE contains back registers, forward registers and an ALU object which performs the actual computations. PAE objects communicate via a packet-oriented network.

According to the authors, the strength of the XPP technology originates from the combination of array processing with unique, powerful run-time reconfiguration mechanisms. Parts of the array can be configured rapidly in parallel while neighboring computing elements are processing data. Reconfiguration is triggered externally or even by special event signals originating within the array, enabling self-reconfiguring designs. The architecture is designed to support different types of parallelism: pipelining, instruction level, data flow, and task level parallelism.

The high-level compiler for this architecture is called XPP-VC (XPP Vectorizing C Compiler). It uses new mapping techniques, combined with efficient vectorization. A temporal partitioning phase guarantees the compilation of programs with unlimited complexity, provided that only the supported C subset is used.

1.5.11 The SANE Virtual Processor (SVP)

The SANE Virtual Processor (SVP) [29][30] was defined as a concurrent programming model developed and used at the University of Amsterdam as a basis for designing and programming many-core chips. The model is defined by a small number of actions used to create and asynchronously manage the execution of concurrent SVP programs. These actions capture concurrency, implicit communication and resource management, and using these abstractions they aim to develop an understanding of self-adaptive computational systems in the AETHER collaborative European project [1].

The SVP model provides five actions in order to create and manage concurrency. These actions replace those normally used to construct sequential programs (loops and calls). Three of these actions are used to parallelize sequential programs (create, sync and break), and the other two are used for concurrency engineering (squeeze, kill), i.e., the self-adaptive aspects of the model. The create action defines a family of threads based on a single fragment of code. The result of the create action is the creation of an ordered set of thread contexts defined by parameters to the action. These parameters define the code used, the size of the context required and the number of threads to be created.

A thread creating a subordinate family can detect its termination using an SVP sync action. This identifies the family by name so that multiple concurrent families can be created and synchronized from within a single thread. The sync action provides a return code that specifies how a family was terminated and can provide a return value in the case of a break action.

The break action is provided to allow for the creation of dynamically bounded families of threads. In such circumstances, a semi-infinite range of index values is specified in the family's parameters and any thread in the family may terminate the creation of new contexts using the break action and return a scalar value (e.g. an index or pointer) back to the creating thread via the sync action. This construct is the SVP concurrent equivalent of a while loop in a sequential program.

Any thread that can identify a family and the place where it is executing and can provide the capability generated on its creation, may send a kill signal to that family and force its termination. The squeeze and kill signals are similar, but the squeeze maintains the family's state. This is a form of preemption of the unit of work that the family represents and it allows the family to be restarted by re-creating it using the state captured when it was squeezed.

1.5.12 HTHREADS

Hthreads [31] [32] is a unifying programming model for specifying application threads running within a hybrid CPU/FPGA system. This system provides unique capabilities within the reconfigurable computing community by enabling concurrent execution of threads specified through a set of pthreads compatible API library routines to be automatically compiled, synthesized, and seamlessly executed on a CPU/FPGA hybrid chip.

The thread interface used by hthreads is based around three major tasks: management, scheduling, and synchronization. For its implementation, they have developed three hardware based state machines that are executed in true parallel with the others and with the application itself. This provides coarse-grained parallelism which is needed for high performance.

Although this is a CPU/FPGA hybrid architecture that allows the definition of threads, in both software and hardware level in the same code. The hthreads model does not provide the advantages of the microthreads model [29], due to its compatibility with the architecture presented in this document.

1.6 Architecture Overview and Contributions

This hardware architecture developed within the framework of the AETHER project [1] differs from other architectures due mainly to the self-adaptive features implemented, that are executed autonomously and in a distributed way by the system members (cells). Basically, this is a novel unconventional MIMD hardware architecture [7] with self-adaptive capabilities including self-placement and self-routing which, due to its intrinsic design, enable the development of systems with runtime reconfiguration, self-repair and/or fault tolerance capabilities

One of the main features of this architecture is its high degree of parallelism. The major drawback is the configuration of complex applications, where many processors have to be programmed and synchronized in order to accomplish a specific task. A new high-level programming paradigm has to be implemented, with the purpose of obtaining the maximum performance of the architecture.

The architecture proposed includes two mechanisms of fault tolerance. One of these is the static Fault Tolerance System [33] [34]. It provides redundant processing capabilities that are working continuously. When a failure in the execution of a program is detected, the processors of the cell are stopped and the self-elimination and self-replication processes starts for the cell (or cells) involved in the failure. This cell(s) will be self-discarded for future self-placement processes.

The other mechanism of fault tolerance is the Dynamic Fault Tolerance Scaling Technique [35], which permits a given subsystem to modify autonomously its structure in order to achieve fault detection and fault recovery. It has the ability to create and eliminate the redundant copies of the functional section of a specific application.

In this document we present a detailed description of the hardware architecture and the self-adaptive algorithms. An FPGA-based prototype has been built for demonstration purposes. Also we present the main features of the software tool *SANE Project Developer*, an integrated development environment that allows the creation, configuration, compilation, programming and test of general purpose applications in the FPGA-based prototype. Although this parallel processing architecture is appropriate for applications requiring fault tolerance mechanisms, it is also suitable for the development of any general purpose application that requires a high degree of parallel processing.

1.6.1 Scalability

The system presented here is widely scalable, theoretically it allows to deploy as many cells as its addressing system allows. This represents a number of cells in the system close to 2^{32} .

In a system with a large number of cells, the cost of this scalability is represented in the propagation time of a combinational signal in the system (one logic gate per cell), this is reflected in the operation frequency of the system. This cost in the propagation time across the system is represented by the addition of the number of rows and columns of the cell array.

The main problem for the implementation of a large amount of cells is the granularity of the system and the test tools available. The granularity of the prototype and the hardware tools available only allow for testing the architecture with few cells, but in a near future, with the evolution of the technology in the manufacturing processes for integrated circuits, the test of a large cell array can be performed.

1.7 Document Organization

This document is organized as follows:

- ▶ Chapter 1 is the introduction, which includes some architecture generalities, preliminary and related works, and a theoretical framework of relevant aspects of the dissertation.
- ▶ Chapter 2 presents a detailed description of the system architecture from the hardware point of view.
- ▶ Chapter 3 describes the architecture of the Functional Unit, which provides the processing capabilities to the system. In addition, annexes A and B presents in detail the instruction set and the description of data memory registers respectively.
- ▶ Chapter 4 details all the self-adaptive processes implemented in the system. Appendix C presents the flow diagrams for self-adaptive algorithms implemented in system.
- ▶ Chapter 5 presents the high-level instructions that permit the implementation of applications in the system. Additionally, two example applications are shown, which include all functionalities implemented in the system. Appendix D shows the listings of these examples, and appendix E presents the software tool developed for implementing applications in the system.

1.8 Conclusions

This chapter describes the general concepts of adaptive and bioinspired systems, as well as the typical classification of computer architectures with respect to its parallelism. These are basic concepts for the architecture proposed in this dissertation. Additionally, preliminary works are presented, which shows the starting point for the evolution of this project. The state of the art presents other projects with similar contributions to the presented here, at both hardware and software levels. Some of these projects can be useful as reference for future evolution of this self-adaptive architecture.

Chapter 2

System Architecture

In theory, there is no difference between theory and practice. But in practice, there is.

*En teoría, no hay diferencia entre teoría y práctica.
Pero en la práctica, sí que la hay.*

Jan L.A. van de Snepscheut (1953 – 1994)

Abstract: This chapter presents a detailed description of all hardware components that compose the self-adaptive architecture presented in this dissertation. The system is presented in a top-down approach, starting for a general overview of the system and later specifying the subsystems or components involved in the architecture.

2.1 Conceptual organization

The proposed architecture consists of four conceptual layers (Figure 2.1). The bottom layer is composed of cells that implement the self-adaptive capabilities and provides the computing capacity of the system. The second one is the component layer, where each component is composed of interconnected cells. The third one is the [Self-Adaptive Networked Entity \(SANE\)](#) layer, which consists of a group of interconnected components, and the top layer, the [SANE ASSEMBLY \(SANE-ASM\)](#) is composed of a group of interconnected [SANEs](#).

The [SANE](#) is the basic self-adaptive computing system; it has the ability of monitoring its local environment and its internal computation process.

2.2 Overview for the configuration of an application

Any application scheduled to the [SANE](#) has to be organized in components, where each component is composed by one or more interconnected cells. The interconnection of cells inside of a component is made at cell level, while the physical interconnections of components are made in another layer, at the [Switch Matrix \(SM\)](#) level. The connections between components can be inside a chip or may span several chips. The interconnection of [SANEs](#) is just conceptual, because it takes place at the same layer of components.

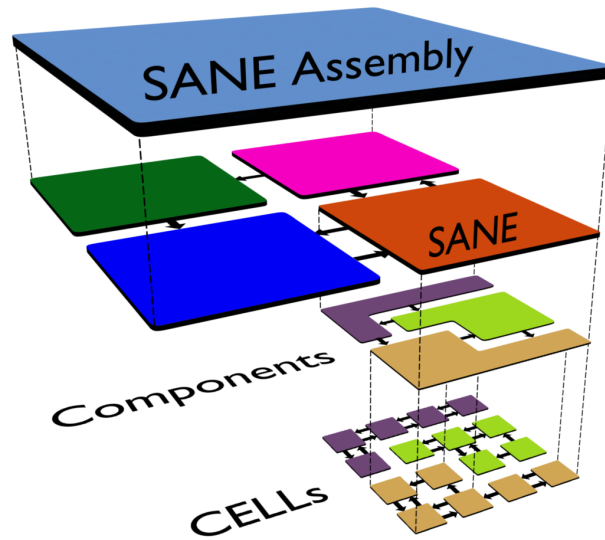


Figure 2.1: Conceptual layers of the self-adaptive hardware architecture.

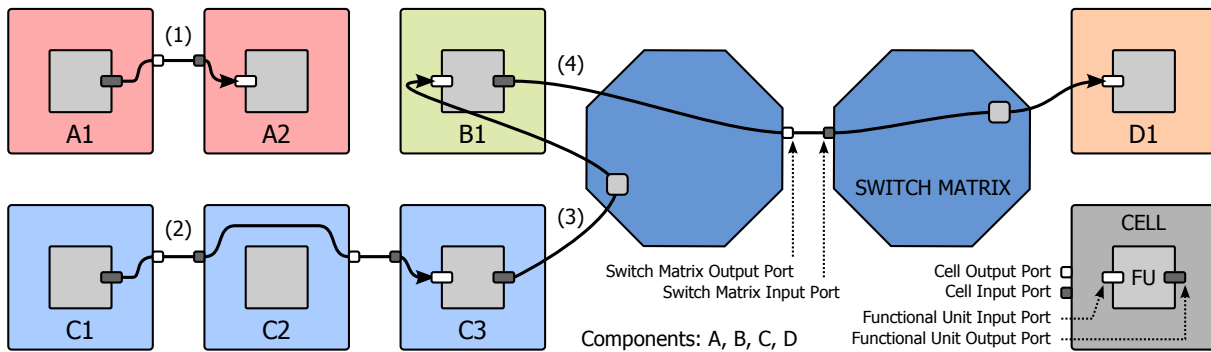


Figure 2.2: Possible connection between Functional Unit ports of two cells.

2.2.1 Connection of cells

Each cell includes a **Functional Unit (FU)**, which provides the processing capabilities to the cell. The purpose of a *connection* between two cells is interconnect the output port of the **FU** of a cell with the input port of the **FU** of another cell. The system provides the necessary hardware for the interconnections of **FU** ports of two cells as shown in Figure 2.2. This figure presents the following scenarios:

- (1) Connections between two neighbor cells of the same component.
- (2) Connections between two not neighbor cells of the same component.
- (3) Connections between two cells of different components that belong to the same **SM**.
- (4) Connections between two cells of different components in different **SMs**.

Note that connections of cells in the same component are made through cell ports, while connections of cells of different components are made through one or more **SMs**.

During the initial stages of the architectural development a software tool was developed, which allowed us to determine through exhaustive simulations the most appropriate number of cell ports, the number of **SM** ports and the number of cells per **SM** [3]. The following sections details all these features.

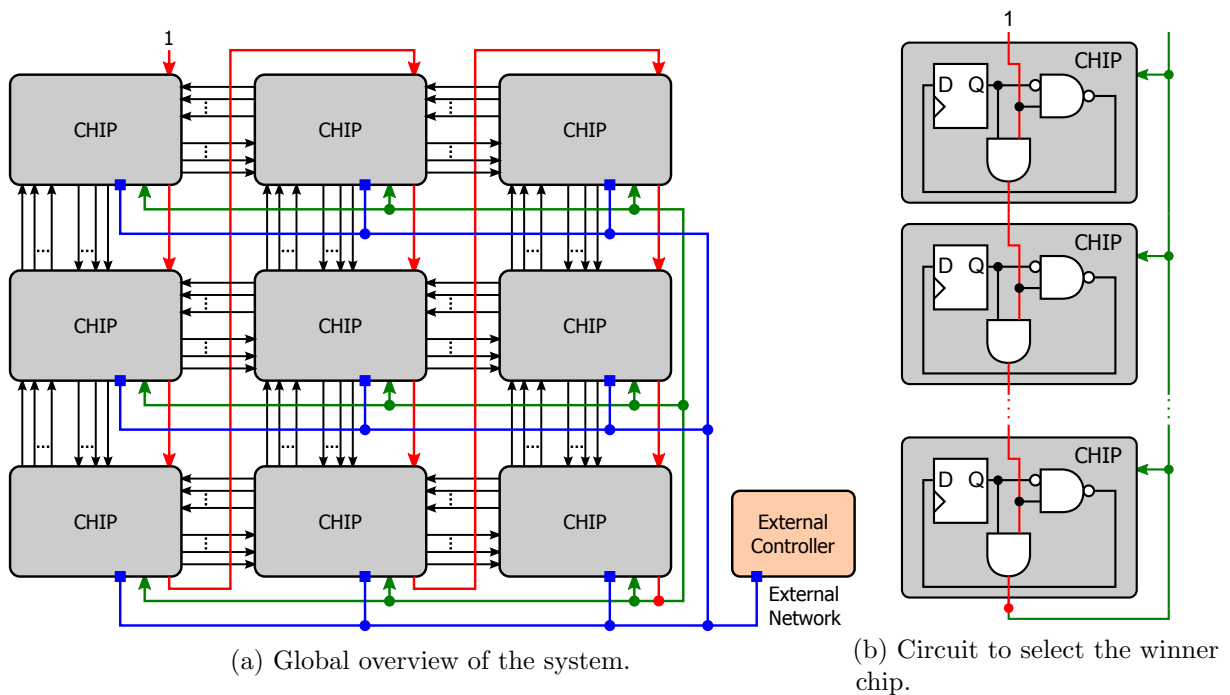


Figure 2.3: System architecture

2.3 Overview of System Architecture

The physical implementation of this architecture is composed of one or more interconnected chips, each of which includes a two-layers implementation with interconnected cells in the first level and interconnected Switch Matrices in the second level (components layer). These represents the first two layer of the conceptual organization. The [SANE](#) and [SANE-ASM](#) are just conceptual and are implemented in the same layer of components.

The system architecture is composed of interconnected chips and an [External Controller \(EC\)](#) as depicted in [Figure 2.3a](#). The ports that interconnect the chips and the [EC](#) can be divided in three groups: *data*, *network* and *chip_selection*. The *data* ports are composed of n buses of 9 bit each. The number of data buses that interconnect two chips depends of the internal capacity of the chip as will be explained later in this chapter. The *network* ports constitutes the [External Network \(ENET\)](#), which allows the information exchange between chips and [EC](#). The *chip_selection* ports allows to select the chip with higher priority between several candidates for the execution of a specific process. [Figure 2.3b](#) shows the implementation of the selection process for chips. The chips that participate in the selection process set to zero its flip flop. After a clock pulse the flip flop that remains in low level will be the winner and the chip starts the execution of the scheduled process. If there is not a winner, the feedback line remains in high level and the process ends.

The [EC](#) broadcasts frames through the [ENET](#) that contains the necessary information for the implementation of an application, or configuration data for a specific cell. All chips receive the information and performs one of two operations: retransmit the information inside the chip, or evaluate if they are candidates for the execution of a specific process e.g. for the implementation of a new component. The chip candidates take part of the selection process and the winner chip executes the process.

2.4 Chip Architecture

The chip architecture is depicted in Figure 2.4, which shows the representation of a chip that includes an array of clusters, Pin Interconnection Matrices (PIMs) and a Global Configuration Unit (GCU). Figure 2.5 shows a 3D representation of an extensive array of clusters. This two-layer implementation is composed by interconnected cells at the first level and interconnected switch and pin matrices in the second level.

Several chips can be interconnected by means of input and output ports of the PIM and the ENET, which is connected to the GCU. Inside the chip, the GCU is interconnected with the cell array and PIM by means of an Internal Network (INET). This is used for the information exchange between cells, PIM and GCU, and is used to support all internal processes in the chip.

The Internal and External networks give support to all self-adaptive processes in execution time, like self-placement, self-routing and real-time self-configuration processes among others.

2.5 Global Configuration Unit

The Global Configuration Unit (GCU) is in charge of controlling the self-adaptive processes inside the chip. The GCU is connected with the EC through the ENET and with the internal components of the chip through the INET. The GCU receives from the EC information related to self-adaptive processes or configuration data. Depending on the information, the GCU could translate it and make a broadcast inside the chip, or start a negotiation between chips, e.g. for defining the destination of a component. After negotiation, the winner chip by means of its GCU controls the self-adaptive processes inside the chip and sends a confirmation command to the EC when the process ends.

The participation of the GCU in the self-adaptive processes will be treated subsequently throughout this document.

2.6 Cluster

Figure 2.6 shows a cluster, that is composed by a 3x3 cell array and a Switch Matrix (SM). Inside a cluster, each cell is identified by means of a letter as shown (A, B, C, D, E, F, G, H and I).

The cells are interconnected with their four direct neighbors in directions *North*, *East*, *South*, and *West*. The SMs are interconnected with their eight direct SMs neighbors or PIMs in directions *North*, *NorthEast*, *East*, *SouthEast*, *South*, *SoutWest*, *West*, and *NorthWest* as shown in Figure 2.4.

2.7 Cell Architecture

The cell is the basic element of the proposed self-adaptive architecture. Therefore, the cell has to include the necessary hardware to carry out the basic principles of self-adaptation; dynamic and distributed self-routing [4] [5] [6], dynamic and distributed self-placement, scalability and distributed control.

The cell architecture and port distribution are depicted in Figure 2.7. The cell consists of the Functional Unit (FU), the Cell Configuration Unit (CCU) and multiplexers that allow the interconnection between FU ports of two cells.

The cell is interconnected with its four direct neighbors by means of local, remote and expansion ports. The cell has eight local input ports, eight local output ports, twelve remote input ports and twelve remote output ports equally distributed in the four sides of the cell, each

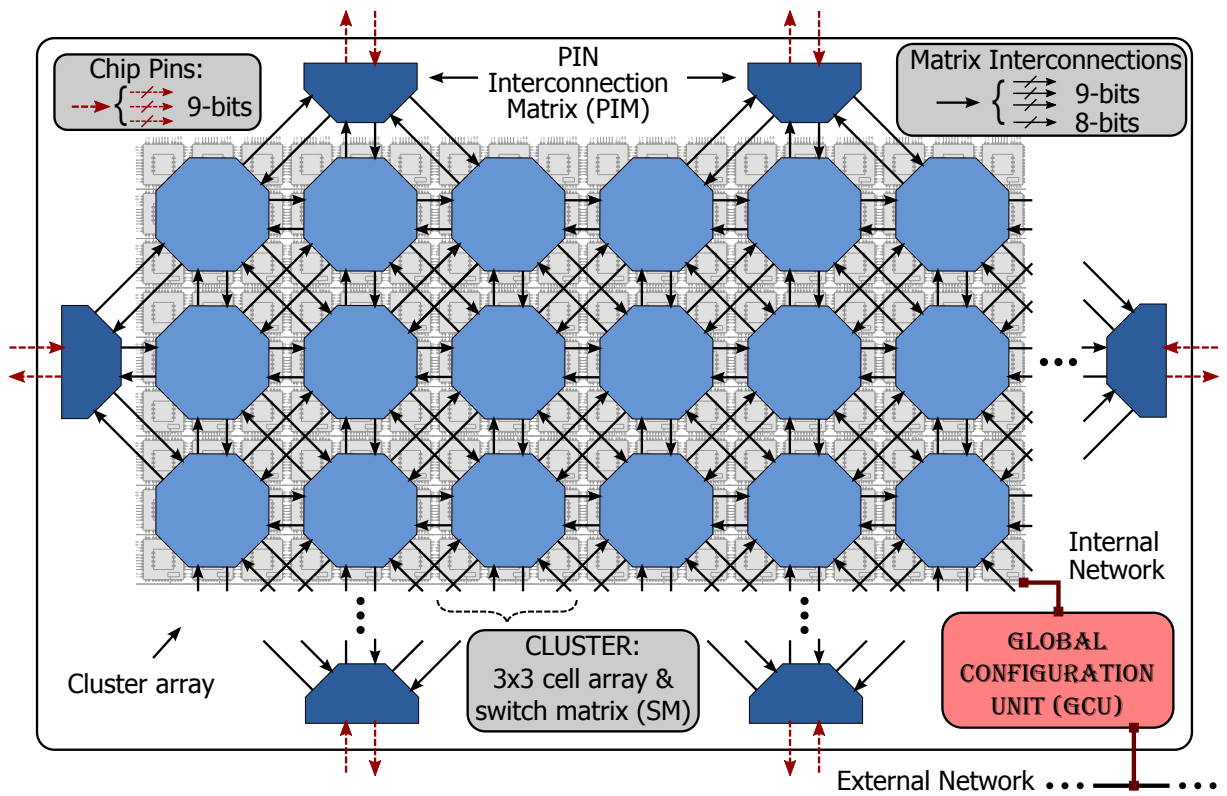


Figure 2.4: Organization of the proposed architecture inside a chip.

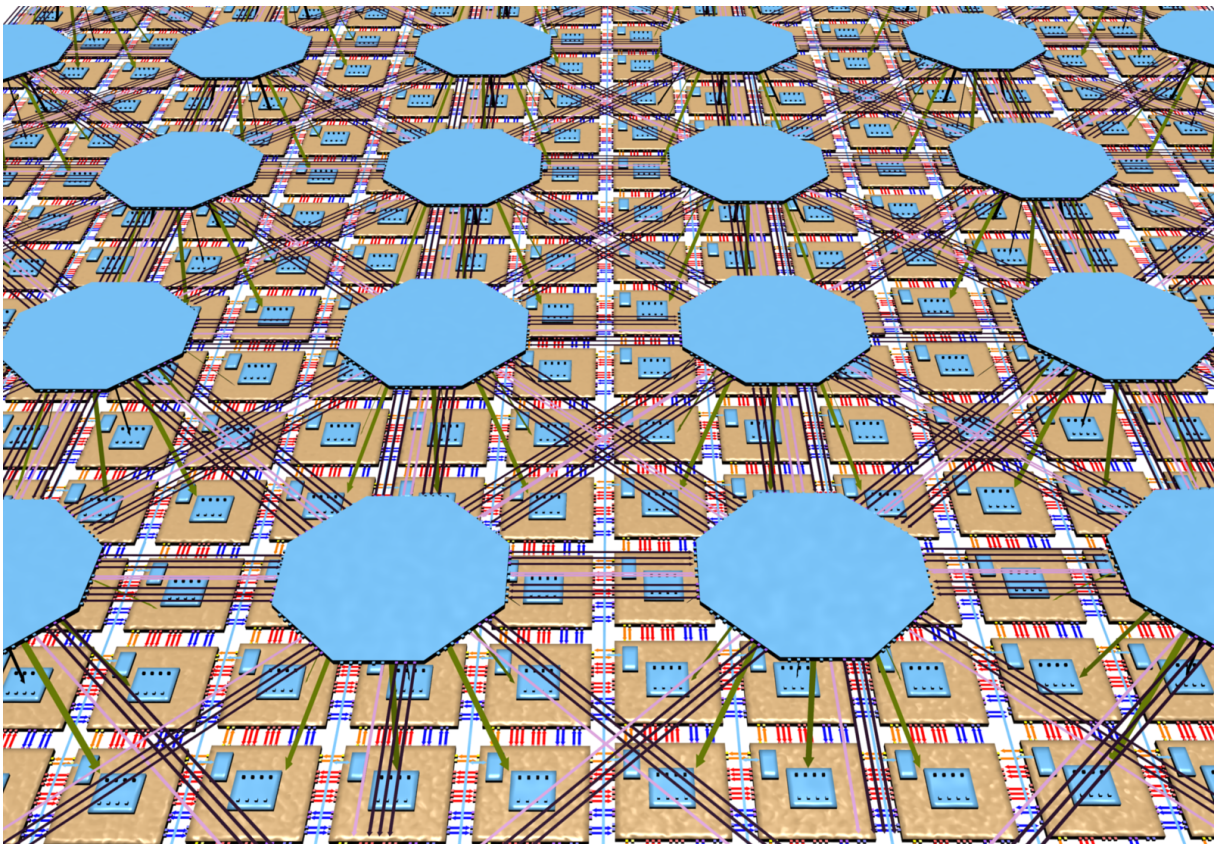


Figure 2.5: System architecture: 3D representation of an array of clusters.

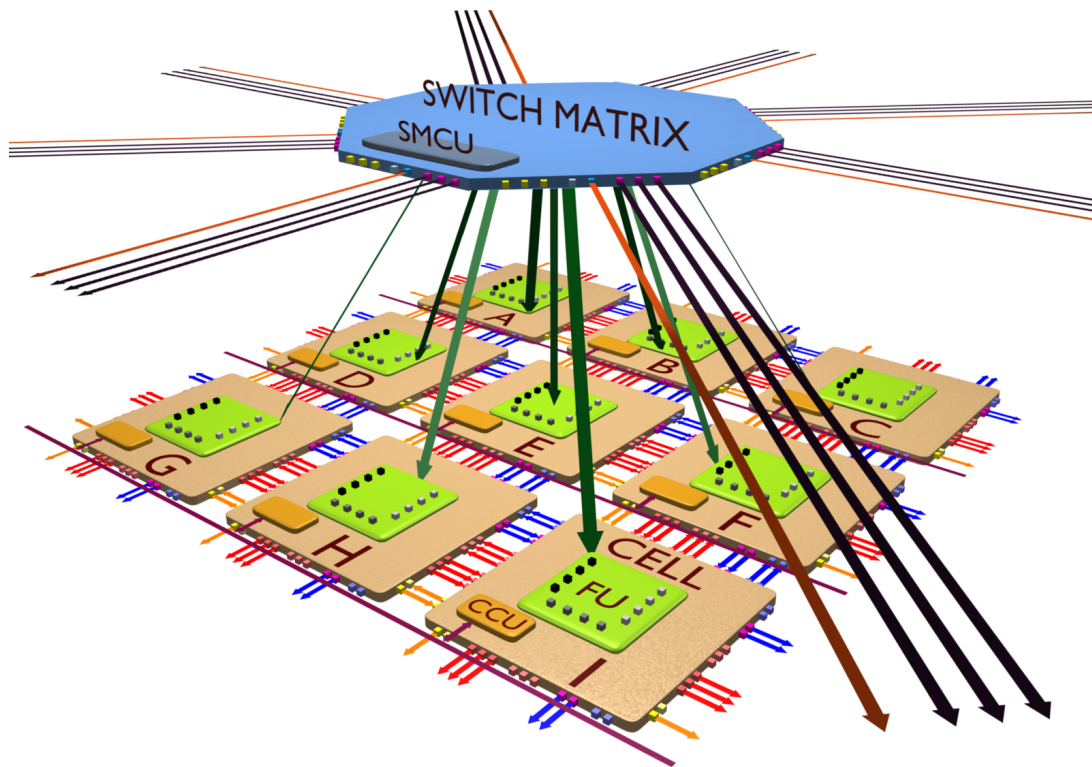


Figure 2.6: Cluster: 3x3 cell array and switch matrix.

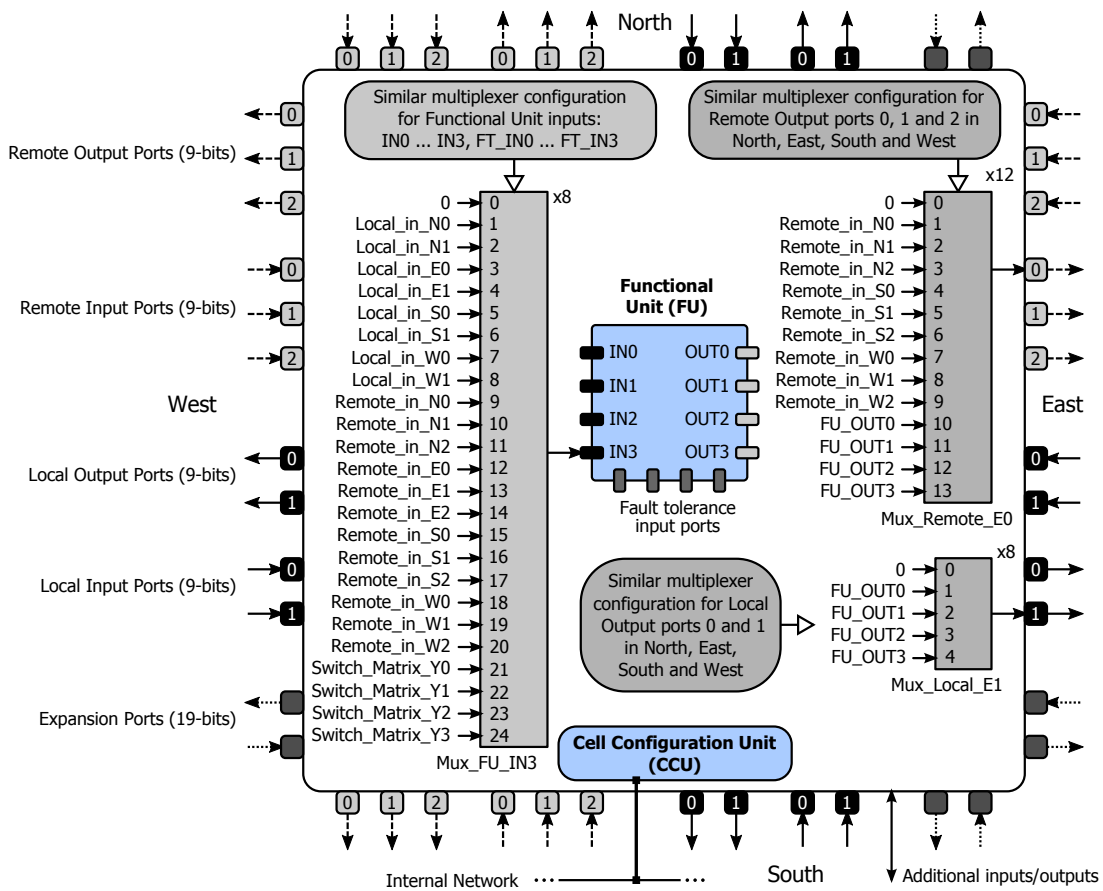


Figure 2.7: Cell architecture: internal hardware and ports.

one being a 9-bit wide bus, 8-bit for data and 1 bit for **Read Enable (RE)** flag. Additionally, the cell has four expansion input ports, four expansion output ports, a connection with the **INET** and additional input/output ports.

The cell includes additional ports interconnected with the **SM**: four 9-bits input ports, four 9-bit output ports (**FU** output ports), one expansion input port and one expansion output port.

The cell includes 28 multiplexers divided in three groups:

- ▶ 8 multiplexers connected to the local output ports. These multiplexers allow connecting the **FU** output ports with the local output port of the cell. These multiplexers are used exclusively to connect neighboring cells.
- ▶ 12 multiplexers connected to the remote output ports. These multiplexers allow connecting the remote output port with: (1) the **FU** output ports and (2) the remote input ports of the other sides of the cell, e.g., if the remote output port is in east, the multiplexer allows connecting the remote input ports from north, south and west. The remote port is used for connecting neighboring or remote cells.
- ▶ 8 multiplexers connected to the **FU** input ports. These multiplexers are used to connect local and remote cell input ports when the connection between two cells is in the same component (inputs 1 to 20). They additionally allow connecting **FU** ports of two different components using the inputs coming from the **SM** (inputs 21 to 24).

2.7.1 Functional Unit (FU)

The **FU** is in charge of executing the processes scheduled to the cell. The **FU** can be described as a four-core configurable multicomputer [8]. The **FU** has four 9-bit input ports and four 9-bit output ports. There are four additional input ports (*ft_input_ports*) used exclusively for the static **Fault Tolerance System (FTS)** [33].

The internal architecture of the **FU** is detailed in chapter 3 and annexes A and B. The **FTS** is described in section 3.7.

2.7.2 Cell Configuration Unit (CCU)

Using a distributed working principle, the **CCUs** of the cells in the array are responsible for the execution of the required algorithms for the implementation of the system self-adaptive capabilities, specifically the self-placement and self-routing algorithms. These algorithms are executed by the **CCU** using the **INET** and the expansion ports, and they are explained in detail in chapter 4.

2.8 Switch Matrix

The **Switch Matrix (SM)** allows connecting cells from two different components. Figure 2.8 shows the port distribution and the internal hardware that is included in the **SM**.

The **SM** is connected to its eight adjacent neighbors, each through three input ports and three output ports (9 bits each). It additionally includes one input and one output expansion port (8 bits each).

The **SM** is connected to the nine cells (cell_A...cell_I) belonging to the cluster, each one by means of four input ports and four output ports (9 bits each). The input ports correspond to the **FU** output ports of cells, and the output ports correspond to the output of internal multiplexers. In addition, the **SM** includes nine input and nine output expansion port (8 bits each) connected to each cell in the cluster.

The **Switch Matrix Configuration Unit (SMCU)** participates in the component self-routing process (section 4.8). In this process, the **FU** output port of a cell in a given component is connected to the **FU** input port of a cell in a different component. The process configures the multiplexers included in the **SM**.

The **SM** includes 60 multiplexers divided in two groups:

- ▶ 24 multiplexers connected to the **SM** output ports. These multiplexers are used as start point of a connection between two components or when a connection has to cross the **SM**. These multiplexers allow connecting the output port with: (1) the **FU** output port of any cell in the cluster (inputs 1 to 36), and (2) the input ports of other sides of the **SM** (inputs 37 to 57), e.g., if the output port is in east, the multiplexer allows connecting the input ports from north, northeast, southeast, south, southwest, west and northwest.
- ▶ 36 multiplexers connected to the **FU** input ports of cells. These multiplexers are used to direct the end point of a connection between two components to one of the nine cells belonging to the cluster. These multiplexers allow connecting the **FU** input port with: (1) the **FU** output port of other cells in the cluster (inputs 25 to 56), e.g., if the output port is in cell_A, the multiplexer allows connecting the output ports from cell_B...cell_I, and (2) the input ports of any side of the **SM** (inputs 1 to 24).

2.9 Pin Interconnection Matrix

The **Pin Interconnection Matrix (PIM)** is used exclusively for the port interconnection between cells of two components in different chips. Figure 2.9 shows the port distribution and the internal hardware that is included in the **PIM**.

The **PIM** is connected to its three adjacent clusters, each through three input ports and three output ports (9 bits each). It additionally includes one input and one output expansion port (8 bits each). The **PIM** is connected to the **INET**.

The **Pin Interconnection Matrix Configuration Unit (PIMCU)** configures the multiplexers in the component self-routing process, to allow for the interconnection of the **FU** port of a cell with a pin of the chip. Previously to this configuration, the **GCU** undertook a negotiation process with other chips, with the aim of assigning a pin of the chip to connect these components.

The **PIM** includes 12 multiplexers divided in two groups:

- ▶ 9 multiplexers connected to the **PIM** output ports. These multiplexers are used to connect a input pin with an output port. This is the start point of a connection between a input pin and the **FU** input port of the target cell.
- ▶ 3 multiplexers connected to the output pins of the **PIM**. These multiplexers are used to connect a input port with an output pin. These multiplexers are the last resource used to interconnect the **FU** output port of the source cell with the pin of the chip.

2.10 Expansion Signals

The expansion signals are included in the expansion ports of cells, **SMs** and **PIMs**. The expansion signals are used by self-placement and self-routing processes.

The signals can be divided in three categories as outlined below:

- ▶ **Cell to Cell:** The expansion port between cells includes four 19-bit input ports and four 19-bit output ports per cell, distributed in north, east, south and west. Each input and output

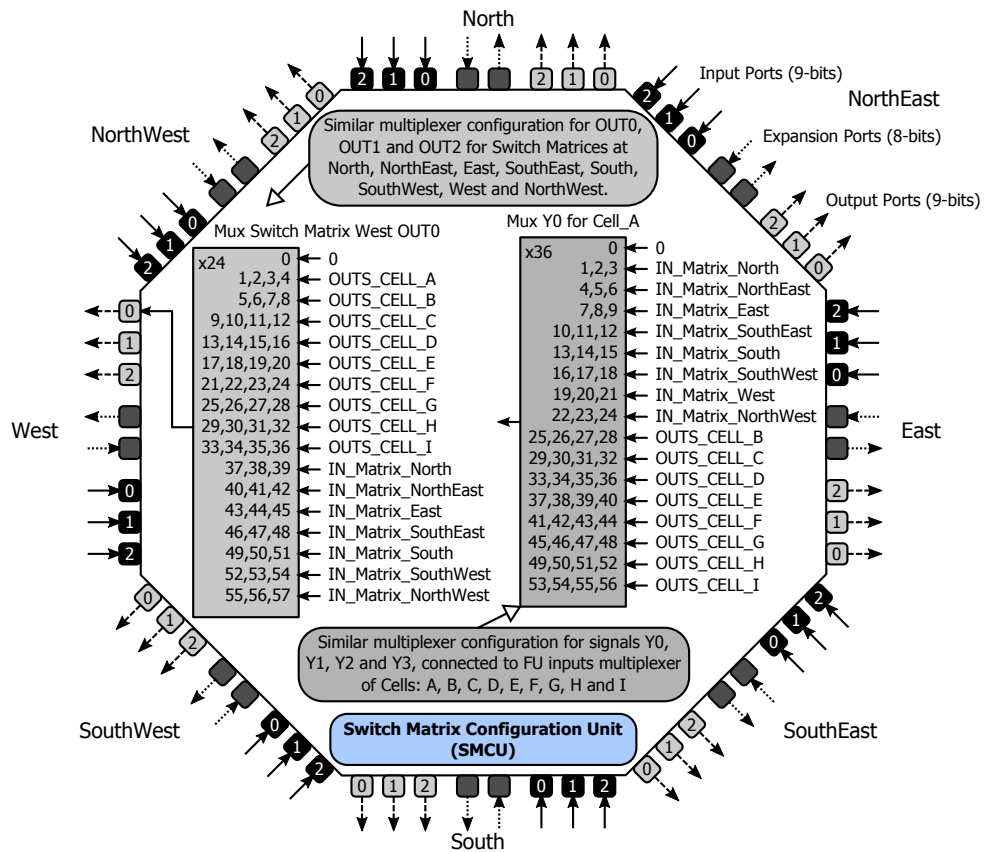


Figure 2.8: Architecture of Switch Matrix.

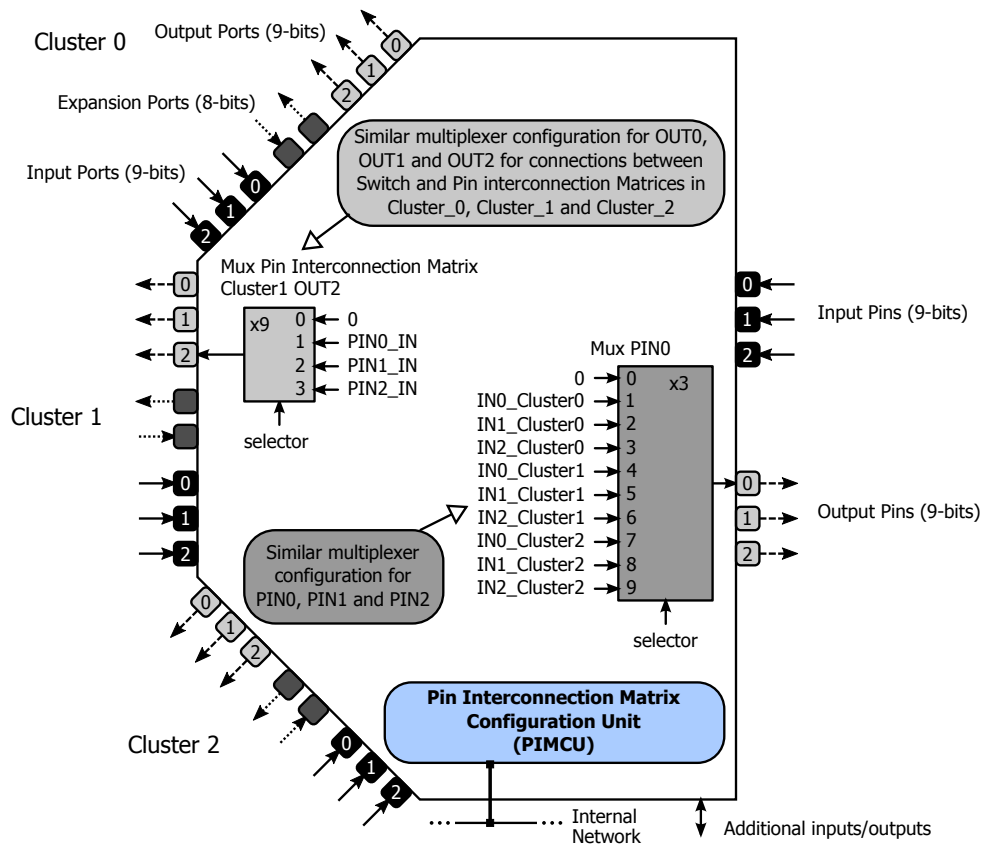


Figure 2.9: Architecture of Pin Interconnection Matrix.

port includes 11 signals. Figure 2.10 shows the expansion signals between two cells connected in east and west ports.

- ▶ **Cell to Switch Matrix:** Each SM includes nine 8-bit input ports and nine 8-bit output ports, for the connection of expansion signals between SM and the cells that belong to the cluster (cell_A...cell_I). Therefore, each cell includes additionally one 8-bit expansion input port and one 8-bit expansion output port. Figure 2.11 shows the expansion signals between cell A and SM inside the cluster.
- ▶ **Switch Matrix to Switch Matrix (or Pin Interconnection Matrix):** Each SM includes eight 8-bit expansion input ports and eight 8-bit expansion output ports, for the connection of expansion signals between SMs across clusters. Figure 2.12 shows the expansion signals between two SMs. The expansion ports between SM and PIMs are the same.

2.10.1 Global Signals for Self-routing Process

Figure 2.13 shows the additional global signals: *Routing_complete* and *Enable_routing*. These signals are the result of a logic OR function between all members of the system that could start or stop a routing process, i.e., CCUs and PIMCUs. When one of these CUs wants to start a routing process, it sets its *enable_routing_out* signal, enabling the routing capabilities for all members in the system. Similarly, when any CU wants to terminate the process, it sets the *routing_complete_out* signal. The self-routing process is detailed in section 4.6.

2.11 Internal and External Networks

The **Internal Network (INET)** and **External Network (ENET)** have been designed to provide the system with the necessary functionality to carry out the self-adaptive capabilities, specifically the self-placement and self-routing processes. Since several CUs of the system (CCUs, PIMCUs and GCU) should be able to send and simultaneously receive messages, the interface communication system is based on an adaptation of the I2C Bus Specification [36].

2.11.1 Communication Interface

The INET and ENET are based on two basic signals: serial clock line (SCL) and serial data line (SDA). These signals are the result of a logic AND (organized in rows and columns) between the output signals of all CUs of the system with networking capabilities. When the transmission (tx) process of a CU is in standby, the signals are at high logic level, thus, if all CU are in standby, the result on the SDA and SCL lines will be high. The Figure 2.14 shows the hardware implementation for the CUs involved in the INET.

When a CU needs to send a message, the transmission process starts, so that it has to set or clear the appropriate output signals. This way, the message will be visible in SDA and SCL and can be read simultaneously by all CUs of the system, including the transmitter. This characteristic is important in the execution of the self-adaptive algorithms implemented in the system. This implies that source cell(s) can get information of other cells without the need to transmit an answer from the target cell(s).

The transmission process could be started by one or more CUs in the chip (simultaneously), this depends on the algorithm that is being executed.

The ENET has a similar configuration to that of the INET. The ENET interconnects the GCUs with the EC.

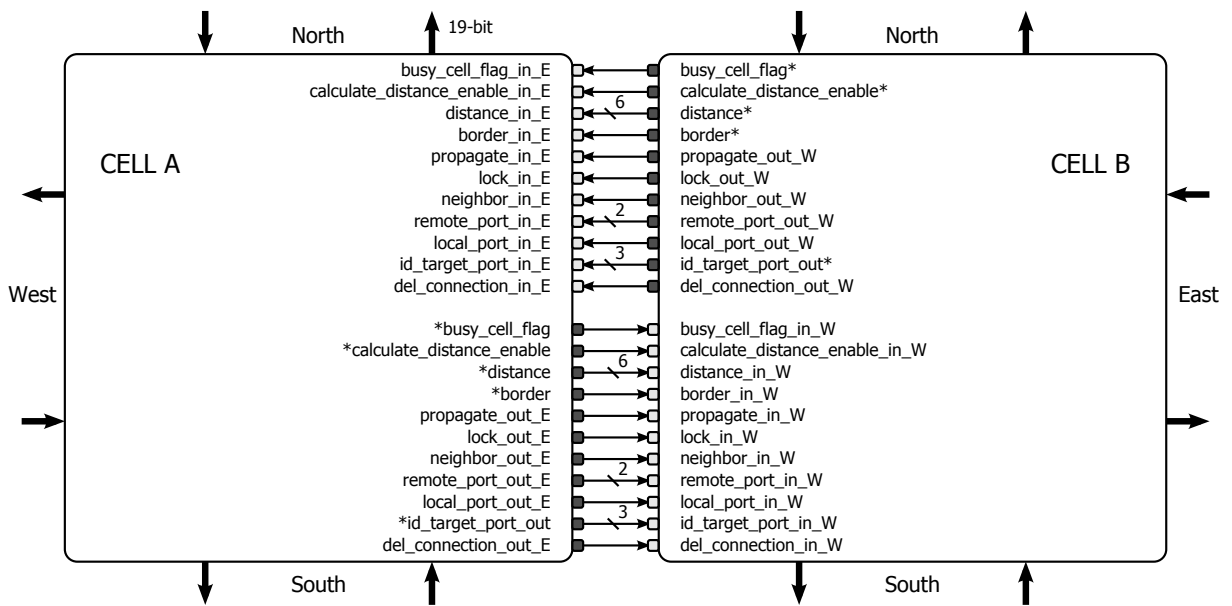


Figure 2.10: Expansion signals between cells¹.

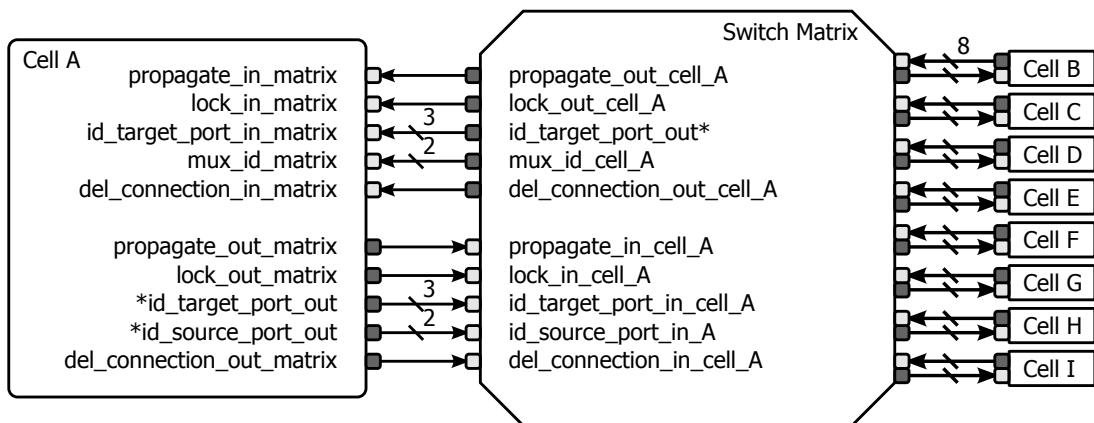


Figure 2.11: Expansion signals between cell and Switch Matrix¹.

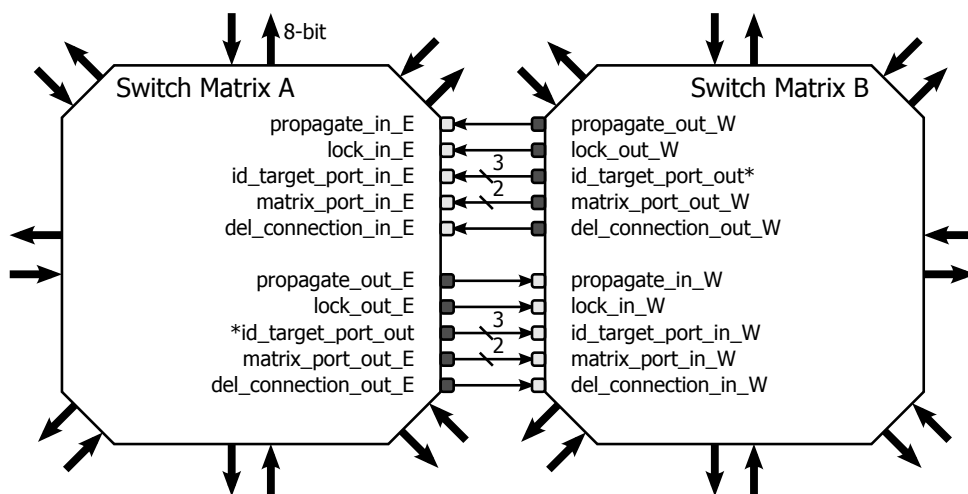


Figure 2.12: Expansion signals between Switch Matrices (including Pin Interconnection Matrix)¹.

¹Signals marked with * are common for all expansion ports.

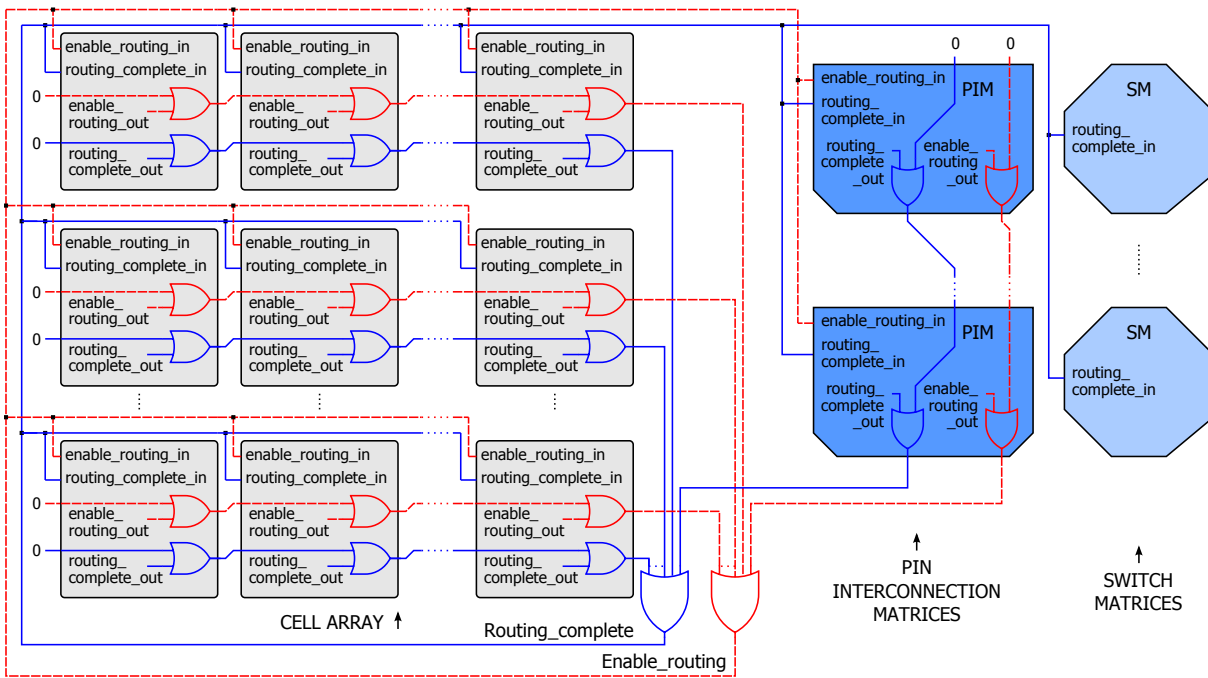


Figure 2.13: Routing signals implementation.

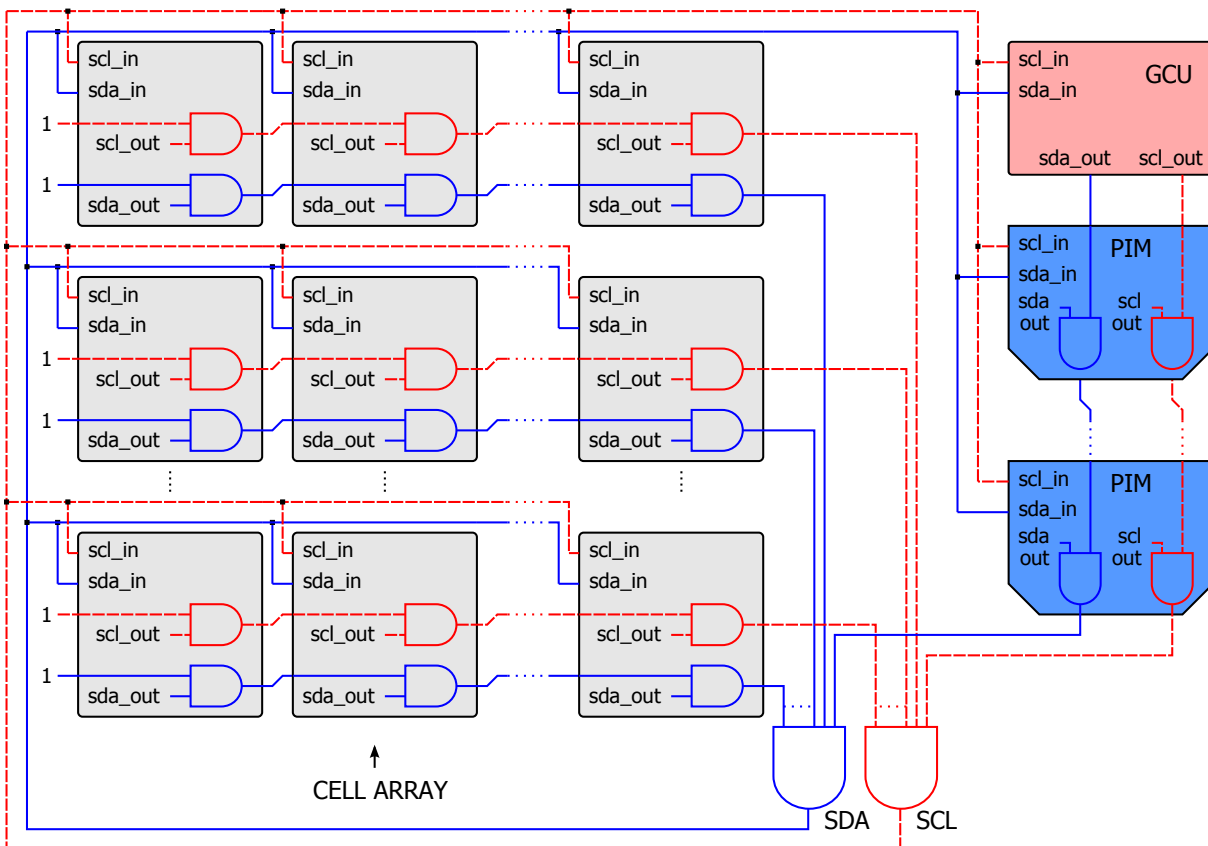


Figure 2.14: Internal Network implementation.

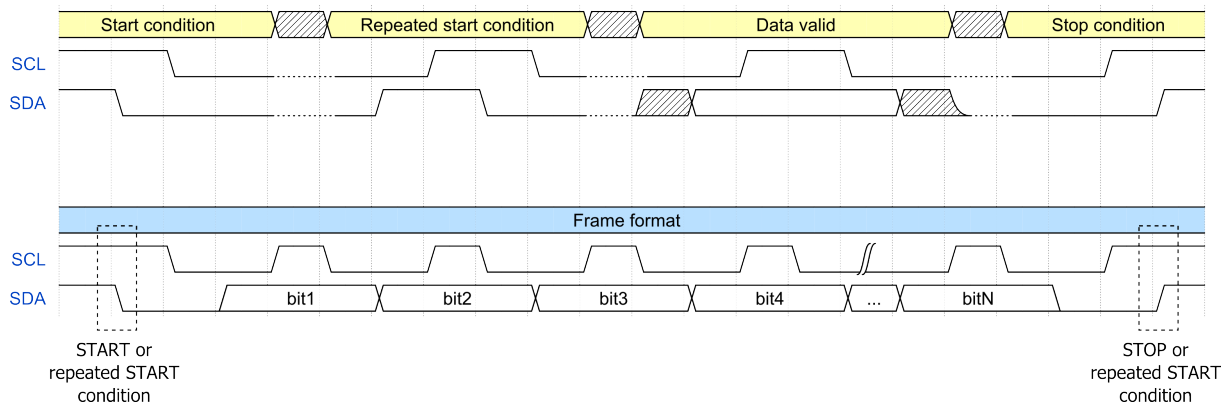


Figure 2.15: Considerations for Internal and External Networks.

2.11.2 Data Transmission

A transmission consists of three parts: generation of the start condition (or repeated start condition), data bits transmission and generation of the stop condition (or repeated start condition). Figure 2.15 shows necessary considerations for data transmission for *INET* and *ENET*, as follows:

- ▶ All transactions begin with a start condition and are terminated by a stop condition.
- ▶ Start condition: a high to low transition on the *SDA* line while *SCL* is high.
- ▶ Stop condition: a low to high transition on the *SDA* line while *SCL* is high.
- ▶ Data validity: The data on the *SDA* line must be stable during the high period of the clock. The high or low state of the data line can only change when the clock signal on the *SCL* line is low. One clock pulse (*SCL*) is generated for each data bit transferred.
- ▶ The bus stays busy if a repeated start condition is generated instead of a stop condition. In this respect, the start and repeated start conditions are functionally identical.

2.11.3 Comparison Process

The algorithms of self-placement and self-routing require the implementation of a data comparison process from one or more cells, to identify the cell with better characteristics for a particular function with respect to another cell within the array. The physical implementation of the *INET* described previously permits this functionality, thus many cells can simultaneously compare the data while the transmission/reception is being executed. This is possible due to the logic AND between all *sda_out* signals, so that the lowest value will be imposed in a comparison.

An example of a comparison process is shown in Figure 2.16a. Let us assume that four cells send the following values: $sda_out1=0x05$, $sda_out2=0x07$, $sda_out3=0x13$ and $sda_out4=0x4B$. These values will be compared bit to bit, starting with the most significant bit. The dominant value has to be the smallest one. As result of the logic AND, when one of the cells sends a high value but on the *SDA* line it appears a low value, this means that another cell has a better (lower) comparison value. This cell is self-discarded from the comparison and sets its *sda_out* to high value for the remaining bits. The cell that terminates the process without being discarded will be the winner (*sda_out1* in Figure 2.16a).

If there are two or more cells with the same value for comparison, the winner will be the leftmost uppermost cell in the array. This selection process takes place outside the *INET* with some additional bits, by means of the circuit shown in Figure 2.16b. The cells involved in the process put a low level in the flip flop, and after a clock pulse, only one of them must continue in low level. This one will be the "winner cell" of the comparison process.

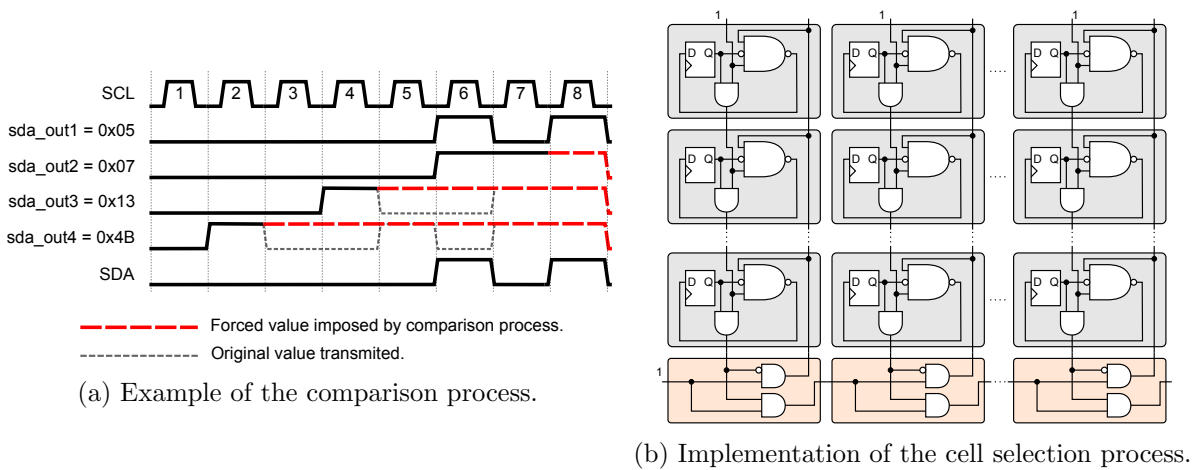


Figure 2.16: Comparison process.

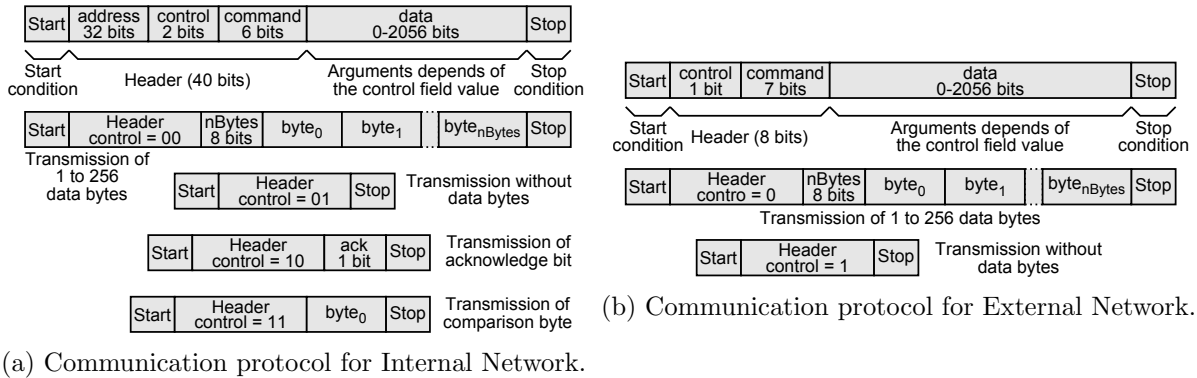


Figure 2.17: Comunnication protocols.

2.12 Communication Protocol for Internal Network

The communication protocol is formed by the grouping of bits that are transmitted and received. This exchange of information for **INET** takes place between several **CUs** inside a chip, specifically the **GCU**, the **PIMCUs** and the **CCUs**. Figure 2.17a shows a detailed description of this protocol.

All bits belonging to the protocol are delimited by the start and stop conditions previously exposed. The frame can be divided in two sections: the header and the arguments (or data bytes). The 40-bit header is always present in a frame. The arguments sent or received later are dependent on the *control bits* and the *command* value. The header fields are described below:

1. **address**: This 32-bit field is used to identify the cell to which the message is directed. This field includes the *id_cell* and *id_component*, each 16-bit long. The value 0xFFFFFFFF is reserved for broadcasting.
2. **control bits**: The 2-bit *control* field specifies the number of data bits after the *command*. Thus, there may be commands that require or not any additional information, as follows:

► **control=00** ⇔ **Data bytes**: When the *command* field requires additional information, the 8-bit *nBytes* field is used. It indicates the number *N* of bytes that will be sent. These bytes may include connection tables, command arguments or information for cells that will be for program memory and configuration registers.

$$1 \leq N \leq 256, \quad nBytes = N - 1$$

- ▶ **control=01** \Leftrightarrow **No data**: No additional data bytes are required.
 - ▶ **control=10** \Leftrightarrow **Acknowledge bit**: The 1-bit *ack* field is used as an acknowledgment mechanism, indicating that the *address* field sent by a source cell matches with the *address* of a target cell.
 - ▶ **control=11** \Leftrightarrow **Comparison byte**: The *byte₀* is the comparison value that is sent simultaneously by one or more cells. It is used when required to search the best cell location with respect to another to perform a given function (see section 2.11.3 for details).
3. **command**: The 6-bit *command* field specifies the action that will take place inside the element(s) to which the frame is addressed. The commands correspond to the execution of necessary algorithms for implementing the self-routing and self-placement processes. The data sent or received later are dependent on the control bits and the command value. The list of commands is showed in Table 2.1. The use of this commands and its functionality is explained in chapter 4.

Command (INET)	TX→RX	Description
insert_first_cell scan_first_cell end_first_cell	GCU→CCUs CCUs→CCUs CCU→GCU	Commands used for the placement of the first cell of a new component.
insert_other_cell scan_new_cell_connections request_scan_affinity_value scan_affinity_value set_target_cell_sr connect_others_to_new_cell_sr end_other_cell	GCU→CCUs CCUs→CCUs CCU→CCUs CCUs→CCUs CCU→CCUs CCU→CCUs CCU→GCU	Commands used for the placement of other cells in a component (from the second). Additionally performs the routing of the connections between cells of the same component already placed in the array.
error_routing	CCU, PIMCU→GCU	Error when there is no routing resources available for a connection.
start_components_connection set_target_cell_sr_component end_components_connection	GCU→CCUs CCU→CCU CCU→GCU, CCUs	Commands used for the connection of components.
configure_chip_connection set_target_cell_sr_chip search_pin_free_mb pin_free_mb set_target_port_mb start_cell_pin_connection cell_pin_connection_conf start_pin_cell_connection pin_cell_connection_conf configure_chip_connection_conf	CCU→GCU GCU→CCU GCU→PIMCUs PIMCU→GCU GCU→PIMCUs GCU→CCUs CCU→GCU GCU→PIMCUs PIMCU→GCU GCU→CCUs	Additional commands used for the connection of components in different chips. These commands must be executed after the placement and routing of all components.
write_configuration_registers write_program_memory[0,1,2,3] write_FU_memory_conf	GCU→CCU GCU→CCU CCU→GCU	Write the Configuration Registers and Program Memory of Functional Unit processors.
restart_processors disable_processors restart_and_disable_processors enable_processors	GCU→CCUs GCU→CCUs GCU→CCUs GCU→CCUs	Commands used for controlling the Functional Unit processors.

Continued on next page

Command (INET)	TX→RX	Description
wait restart_processors_wait enable_processors_wait	GCU→CCUs	Commands used for controlling the Functional Unit processors including "wait" or "standby" state.
start_subprocess[0,1,2,3] end_subprocess[0,1,2,3]	CCU→GCU GCU→CCUs	
delete_component_connections_ chip delete_component_connections_ conf delete_component_chip delete_component_conf	CCU, GCU→CCUs CCU→GCU GCU→CCUs CCUs→GCU	
deroute_connection_other_chip deroute_pin_cell_connection deroute_pin_cell_connection_conf deroute_connection_other_chip_ conf	PIMCU→GCU GCU→PIMCU PIMCU→GCU GCU→PIMCU	Commands used to deroute connections of component in other chips, which are used for deleting components.
replicate_cells delete_cell_connections_chip delete_cell_connections_conf eliminate_cell eliminate_cell_conf	CCU→GCU GCU, CCU→CCUs CCU→GCU GCU→CCU CCU→GCU	Commands used for self-elimination and self-replication processes.

Note: conf = confirmation

Table 2.1: Commands list for Internal Network.

2.13 Communication Protocol for External Network

The communication protocol for **ENET** permits to communicate the **GCU**s in different chips and the **EC**. Figure 2.17b shows a detailed description of this protocol.

All bits belonging to the protocol are delimited by the start and stop conditions previously exposed. The frame can be divided in two sections: the header and the arguments (or data bytes). The 8-bit header is always present in a frame. The arguments sent or received later are dependent on the *control bit* and the *command* value. The header fields are described below:

1. **control bit**: The 1-bit *control* field specifies the number of data bits after the *command*. Thus, there may be commands that require or not any additional information, as follows:
 - **control=0** ⇔ **Data bytes**: When the *command* field requires additional information, the 8-bit *nBytes* field is used. It indicates the number *N* of bytes that will be sent. These bytes may include connection tables, command arguments or information for chips that will be for program memory and configuration registers.
 $1 \leq N \leq 256, \quad nBytes = N - 1$
 - **control=1** ⇔ **No data**: No additional data bytes are required.
2. **command**: The 7-bit *command* field specifies the action that will take place inside the chip(s). The commands correspond to the execution of necessary algorithms for implementing the

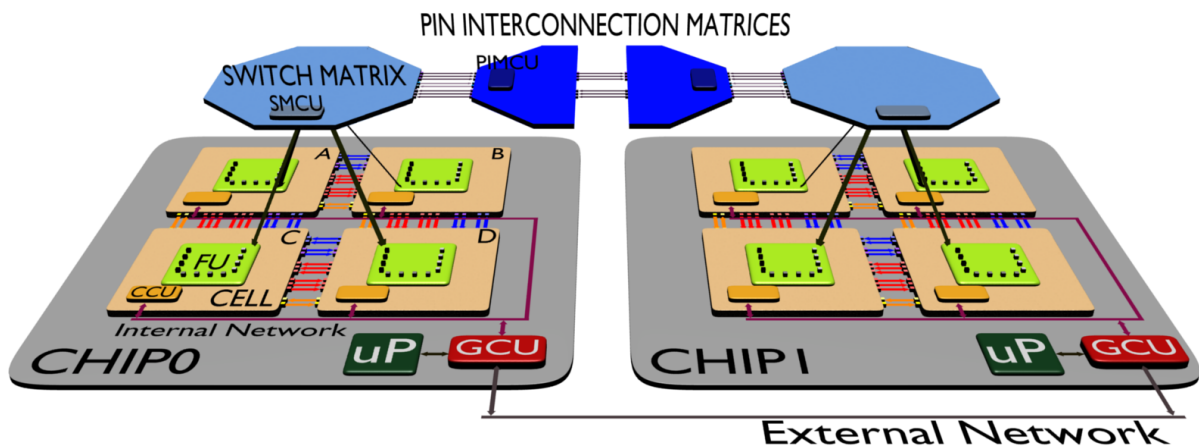


Figure 2.18: 3D representation of the prototype architecture.

self-routing and self-placement processes. The list of commands is showed in Table 2.3. The use of these commands and their functionality is explained in chapter 4.

2.14 Prototype architecture

For demonstration purposes, the original architecture previously described has been modified for the construction of a prototype, due mainly to the physical limitations in the FPGAs used for the system implementation. The prototype shown in Figure 2.18 has the following characteristics:

- ▶ The prototype has been developed in two chips, each one is a Virtex4 Xilinx FPGA (XC4VLX60), with an utilization rate close to 80% of their capacity.
- ▶ Each chip consists of a cluster that was reduced to a 2x2 cell array (this includes the SM), one PIM, one Control Microprocessor (C_μP) and the GCU.
- ▶ The Internal and External networks were implemented.
- ▶ The system supports up to 32 processors working in parallel.
- ▶ The system implements all self-adaptive capabilities described in this document.
- ▶ All system components are described in VHDL. The C_μP was implemented using the EDK design tool from Xilinx, which implements the MicroBlaze microprocessor; it is programmed in C language by means of the Xilinx Platform Studio (XPS) and Xilinx Software Development Kit.
- ▶ The programming and compilation of a entire project in system is manually performed using the SANE Project Developer (SPD) (See chapter 5 and appendix D).

Figure 2.19 shows the block diagram of a chip in the prototype. This design permits to have the same code description for both chips, the only difference is in the allocation of pins for each chip (files *.ucf).

The External Controller (EC) was replaced by the Control Microprocessor (C_μP) inside chips. It should be noted that C_μP is implemented in both chips but only one of them must assume the control for the system configuration (master chip). The C_μP of the master chip is responsible

Command (ENET)	TX→RX	Description
synchronize_chips	EC→GCU _s	Initial synchronization between chips
start_contest_winner_chip	EC→GCU _s	Contest for the execution of a process in a chip.
cell_number_new_component insert_first_cell end_first_cell insert_other_cell end_other_cell	EC→GCU _s EC→GCU GCU→EC EC→GCU GCU→EC	Insertion of a component in a chip.
error_routing	GCU→EC	There are no routing resources available for the connection of two cells in a component.
autoset_for_components_connection start_components_connection search_cell_other_chip routing_cell_target_chip end_routing_cell_target_chip end_components_connection error_components_connection	EC→GCU EC→GCU GCU→GCU _s GCU→GCU _s GCU→GCU _s GCU→EC GCU→EC	Commands used for connection of components.
set_address_program_memory write_configuration_registers write_program_memory[0,1,2,3] write_FU_memory_conf	EC→GCU _s EC→GCU _s EC→GCU _s GCU→EC	Write the Configuration Registers and Program Memory of Functional Unit processors.
restart_processors disable_processors restart_and_disable_processors enable_processors	EC→GCU _s EC→GCU _s EC→GCU _s EC→GCU _s	Commands used for controlling the Functional Unit processors.
wait restart_processors_wait enable_processors_wait	EC→GCU _s EC→GCU _s EC→GCU _s	Commands used for controlling the Functional Unit processors including "wait" or "standby" state.
start_subprocess[0,1,2,3] end_subprocess[0,1,2,3]	GCU→EC EC→GCU	Commands used for execution of subprocesses, i.e., run-time self-configuration.
autoset_for_delete_connections delete_component_connections_chip deroute_connection_other_chip deroute_connection_other_chip_conf delete_component_connections_conf delete_component_chip delete_component_conf	EC→GCU _s EC→GCU GCU→GCU _s GCU→GCU _s GCU→EC EC→GCU _s GCU→EC	Commands used to delete a component in the cell array.
replicate_cells delete_cell_connections_chip delete_cell_connections_conf eliminate_cell eliminate_cell_conf cell_reinsert	GCU→EC EC→GCU _s GCU→EC EC→GCU _s GCU→EC EC→GCU _s	Commands used for self-elimination and self-replication processes.

Note: conf = confirmation

Table 2.3: Commands list for External Network.

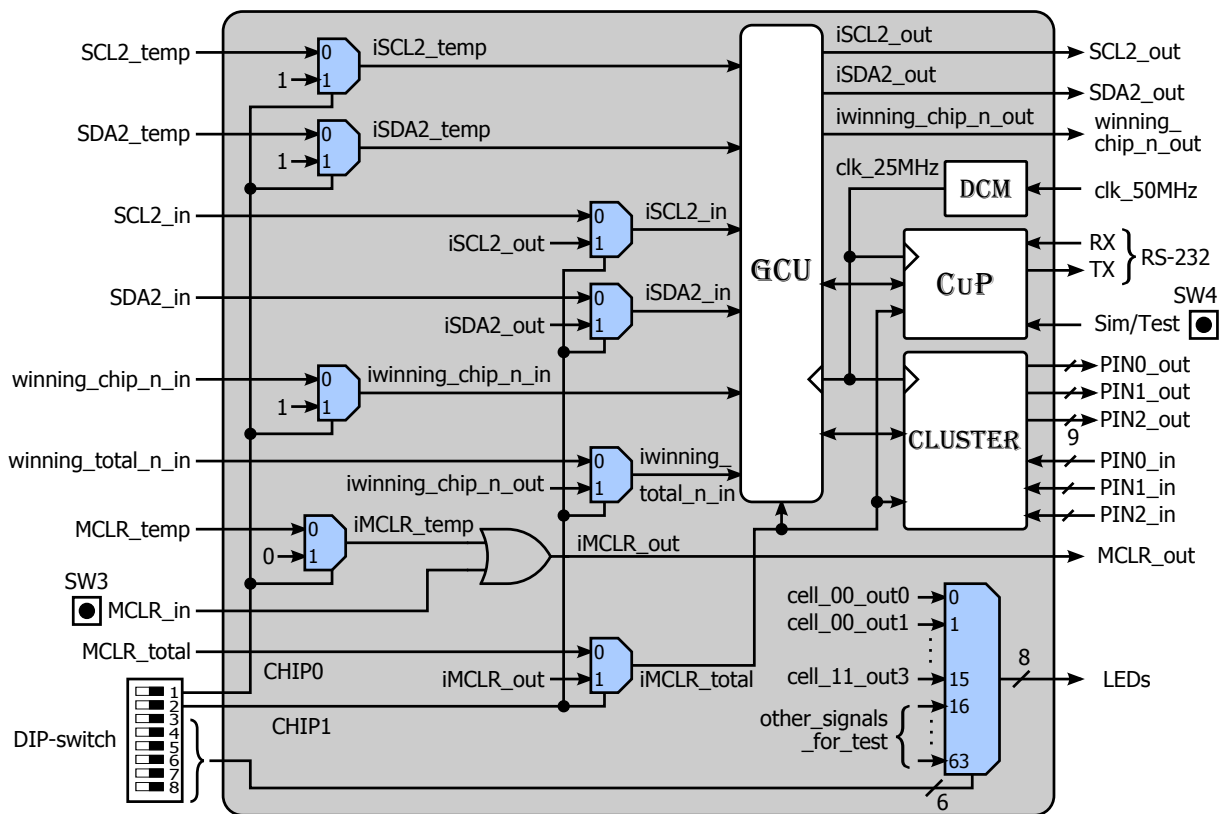
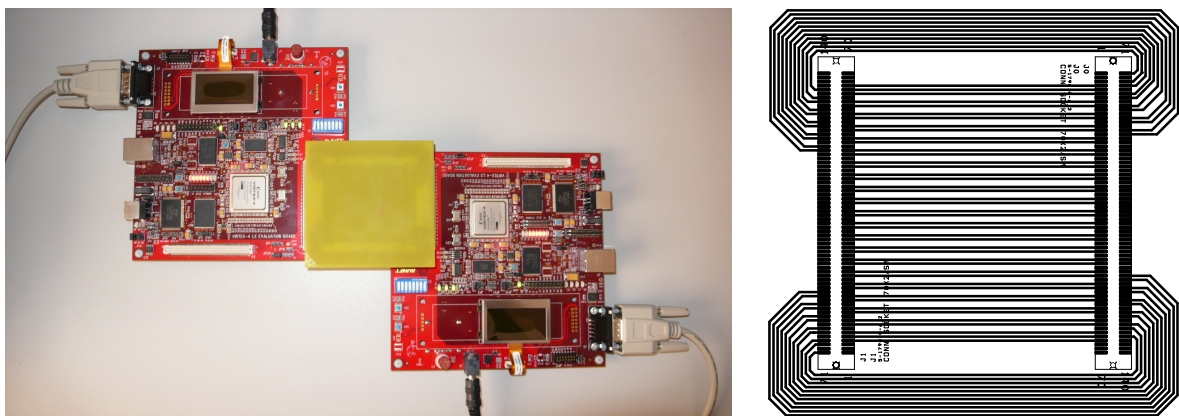


Figure 2.19: Block diagram of a chip in prototype.



(a) Prototype picture.

(b) Connector layout

Figure 2.20: Prototype implementation

for implementing the main program for the configuration and execution of system functionality, even during runtime. Because of this, the dip-switch in positions 1 and 2 allows the selection of the master and slave chip.

The **CuP** through the **GCU** in both chips is responsible for controlling the self-placement, self-routing and the execution of any other self-adaptive processes.

Figure 2.20 shows a picture of the physical implementation of the prototype and the layout of the connection board.

The output of cells can be visualized in the leds included in the cards. This output is useful for the test of applications in the system. The dip-switch in positions 3 to 8 allows to select the output of cells and other internal process for debugging purposes.

2.15 Conclusions

This chapter describes the hardware components involved in the self-adaptive architecture presented in this dissertation.

The chapter starts with the definition of the four conceptual layers defined for the architecture. Afterwards, some details for the configuration of an application are detailed, specifically the description of a connection between cells, which is critical in the definition of the architecture.

The system is presented in a top-down approach, starting for a general overview of the entire system, which includes several chips interconnected with an [External Controller \(EC\)](#). Afterwards, the two layer architecture of the chip is detailed. This is the physical implementation of the system, and includes a cluster array interconnected with a [Global Configuration Unit \(GCU\)](#) and Pin Interconnection Matrices ([PIMs](#)). The cluster is composed of a 3x3 cell array and a [Switch Matrix \(SM\)](#). The input and output ports and the internal hardware of each component is detailed in the corresponding section.

This chapter also describes in detail the communication protocols for [Internal Network \(INET\)](#) and [External Network \(ENET\)](#). These networks participate actively in the self-adaptive processes as discussed in the following chapters. The general description of the prototype implemented for testing the architecture is presented at the end of the chapter.

Chapter 3

Functional Unit Architecture

*Life would be tragic if it weren't funny.
La vida sería trágica sino fuera graciosa.*

Stephen Hawking (1942)

Abstract: This section shows the functional description of the cell Functional Unit. It includes description of cores, configuration modes, and details of principal parts of processors like Data and Program Memories. Appendices [A](#) and [B](#) provide complementary information over the functionality of processors, showing details about the Instruction Set and Data Memory Registers respectively.

3.1 General Description

The [Functional Unit \(FU\)](#) is in charge of executing the processes scheduled to the cell or, from other point of view, the [FU](#) provides the processing capabilities to the cell. The [FU](#) can be described as a four-core configurable multicomputer [8]. The [FU](#) has twelve configuration modes that allows implementing between one to four processors, which can be configured for data processing of 8, 16, 24 or 32 bits.

The architecture of the [FU](#) could be composed of logic gates, LUTs, ALUs or any configurable digital system, but due to the hardware necessary to carry out the self-adaptive principles, in order to balance overhead, it has been decided to include a configurable digital element with greater complexity. The need for a system with general purpose computation capabilities lead to the design of the [FU](#) as a set of configurable processors with Harvard architecture.

Figure 3.1 shows a block diagram of the cell, which includes the [FU](#) and the [Cell Configuration Unit \(CCU\)](#). Additionally, the cell includes multiplexers that allows the interconnections of [FU](#) ports between cells. The [CCU](#) and the multiplexers provide support for the self-adaptive capabilities of cells. The [FU](#) has the following main characteristics:

- ▶ Four 9-bit input ports.
- ▶ Four 9-bit output ports.
- ▶ Four cores: each core contains the digital elements necessary for the construction of a processor.
- ▶ [Output Multiplexing System \(OMS\)](#): the [OMS](#) permits the cores to write data to the output ports.

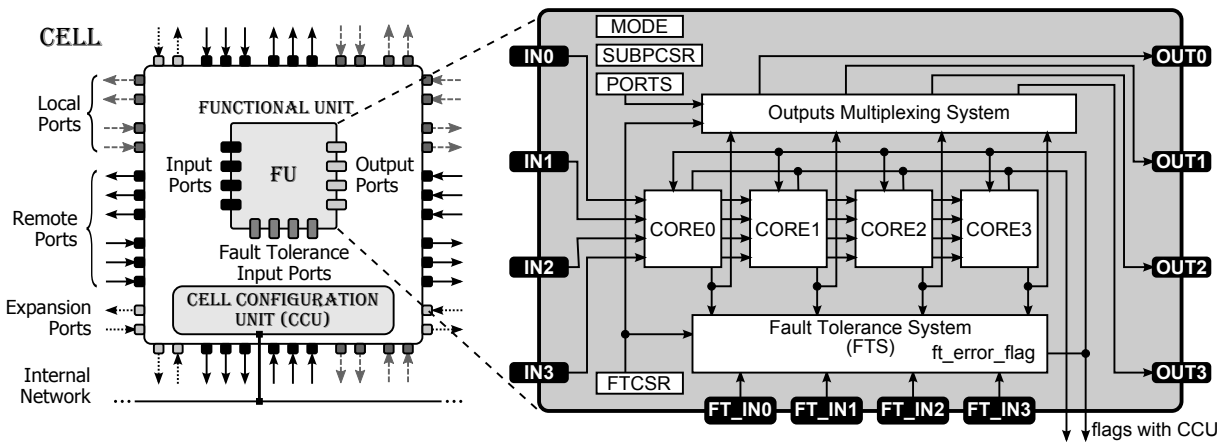


Figure 3.1: Functional Unit architecture.

- ▶ **Fault Tolerance System (FTS)**: the **FTS** enables the system to continue operating properly in the event of failure of some of its processors. If the **FTS** detects a hardware failure in a processor, the cell or cells involved in the failure could be self-replicated in another location inside the array. Therefore the cell will be self-discarded for future self-placement processes.
- ▶ Four 9-bit fault-tolerance input ports used exclusively for **FTS** when enabled.
- ▶ **PORTS** Register: configures the **OMS** allowing write operations over **FU** output ports.
- ▶ **FTCSR** Register: configures the **FTS** and the **OMS**.
- ▶ **MODE** Register: sets the configuration mode of cell, i.e., configures how the cores are grouped to build from one to four processors in **FU**.
- ▶ **SUBPCSR** Register: interface between **FU** and **CCU** for the execution of subprocesses, i.e., it allows the execution of runtime self-configuration capability of the system.

3.2 FU Ports

The **FU** input ports can be interconnected with the **FU** output ports of two cells through the local and remote cell ports or through the Switch Matrices. This connection is performed by the self-routing process (Chapter 4).

The 9-bit **FU** input and output ports are composed of an 1-bit Read Enable (**RE**) signal and 8-bit of data (including the Fault Tolerance input ports). When a data is written to the register related to the output port, it is generated a pulse in the ninth bit of the **FU** port. The **RE** pulse is one clock-cycle.

Figure 3.2 shows an example of **RE** pulse when different data bytes are written in an output register. The data (**ALU**) and the enable signal from a core permits to write the output register associated to the **FU** output, and additionally permits to generate the **RE** pulse. When two or more output port register are written simultaneously, i.e., for 16, 24 or 32-bit processors, the **RE** bit in each port of **FU** has the same behavior.

The **RE** pulse of an input port is used to detect when a data has been written in the port. For this purpose, the special instruction **BLMOV** is used.

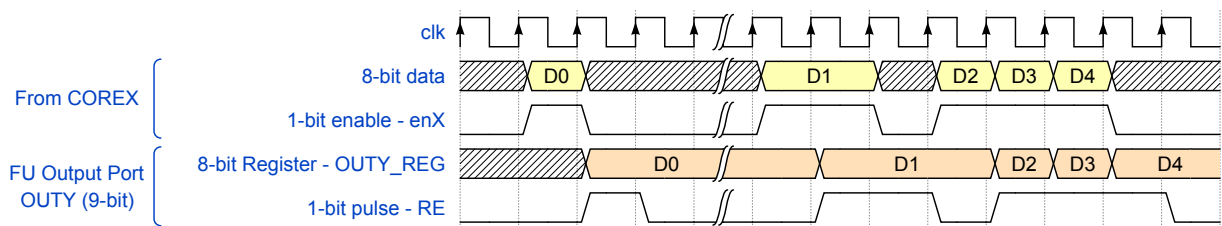


Figure 3.2: Read Enable pulse example.

3.3 Architecture of Processors

Throughout this document, the terms "cores" and "processors" are used frequently. The following sections clarify its difference from the point of view of the architecture presented.

3.3.1 Cores

The core can be described as a set of digital elements that could be used to build a processor (Figure 3.3). The FU has four cores, and each core includes the next principal components:

- ▶ General Purpose Registers (GPRs), 8 bytes, R0 to R7.
- ▶ 8-bit ALU.
- ▶ Code Condition Register (CCR).
- ▶ Program Counter.
- ▶ Control Memory.
- ▶ Program Memory (64 instructions capacity).

Most of this components have the same characteristics for all cores, except the ALU and the Program Counter. Each ALU includes specific hardware that supports the execution of instructions depending of the length of the processing data. The length of the Program Counter is different for each core: 8-bit for CORE0, 6-bit for CORE1 and CORE3, and 7-bit for CORE2, this is related to the size of the Program Memory that a core can handle in a specific configuration mode.

3.3.2 Processor

The processor is composed of the elements of one or more cores. Therefore, the FU can have between one to four processors. Figure 3.3 shows an example of the construction of three processors: the first is an 8-bit or 16-bit processor based on two cores, the second and third are 8-bit processors based in one core each. In this figure, the processor P0 shows the basic architecture of any processor in the FU. Note that there are bus lines denoted by 'N', which indicated that the data processing capability could be for 8, 16, 24 or 32 bits. The following are some consideration of processors in FU:

- ▶ The cores can be grouped in order to build a processor with more capacity. The program memories are added always in length, whilst the Data Memory can be added in length and/or width.
- ▶ The cores are grouped from left to right. The leftmost includes the most significant byte when the data processing is for 16, 24 or 32 bits.
- ▶ The Program Counter controls the sequence of the program. The processors includes conditional and unconditional instructions to modify this sequence.

Mode	Processors	CORE0		CORE1		CORE2		CORE3		
		CTR	ALU	CTR	ALU	CTR	ALU	CTR	ALU	
0	4	✓ P0 [8x8 - 64]	✓	✓ P1 [8x8 - 64]	✓	✓ P2 [8x8 - 64]	✓	✓ P3 [8x8 - 64]	✓	
1	3	✓	✓ P0 [16x8 - 128]	✗	✗	✓ P2 [8x8 - 64]	✓	✓ P3 [8x8 - 64]	✓	
2	2	✓	✓ P0 [16x8 - 128]	✗	✗	✓	✓ P2 [16x8 - 128]	✗	✗	
3	2	✓	✓	✗ P0 [24x8 - 192]				✓ P3 [8x8 - 64]	✓	
4	1	✓	✓	✗ P0 [32x8 - 256]						✗
5	3	✓	✓ P0 [8x16 - 128]	✗	✓	✓ P2 [8x8 - 64]	✓	✓ P3 [8x8 - 64]	✓	
6	2	✓	✓ P0 [8x16 - 128]	✗	✓	✓	✓ P2 [16x8 - 128]	✗	✗	
7	2	✓	✓ P0 [8x16 - 128]	✗	✓	✓	✓ P2 [8x16 - 128]	✗	✓	
8	2	✓	✓	✗ P0 [8x16 - 192]				✓ P3 [8x8 - 64]	✓	
9	1	✓	✓	✗ P0 [16x16 - 256]						✗
10	2	✓	✓	✗ P0 [8x24 - 192]		✓	✓	✓ P3 [8x8 - 64]	✓	
11	1	✓	✓	✗ P0 [8x32 - 256]						✓

- CTR denote the control of a processor, it includes the Program Counter, Control Memory and CCR. When CTR is active for COREX, the name of the processor is defined as PX.

- Nomenclature: P0 [16x8 - 64] = Processor 0 [Data memory includes 16 words of 8 bits each - Program memory with capacity for 64 instructions].

- Data processing: x8 = 8-bit, x16 = 16-bit, x24 = 24-bit, x32 = 32-bit.

Table 3.1: Configuration modes: active components for processors and memory distribution

- For an 8-bit processor, the ALU is active only for the core that assumes the control.
- For a 16-bit, 24-bit or 32-bit processors, the ALUs are concatenated in 2, 3 or 4 cores respectively.

Table 3.1 shows a relation of the configuration modes with the number and name of processors, as well as the active components of cores for each processor. This table also shows Data and Program Memory capacity for each configuration mode. The GPRs in Data Memory can be combined in width and length, achieving combinations for data processing of 8, 16, 24 and 32 bits. The mode 8 is the only one that does not use the GPRs of CORE2. The Program Memory can only be combined in length, making possible to have programs of 64, 128, 192 or 256 instructions.

For example, in the configuration mode 0, there are four active processors (P0 to P3), all of which have 64 instructions capacity of Program Memory and 8 bytes of GPRs in Data Memory. In mode 10, two processors are built (P0 and P3). The first (P0) has a Program Memory with capacity for 192 instructions and eight 24-bit words of GPRs in Data Memory; the second (P3), 64 instructions of Program Memory and 8 bytes of GPRs in Data Memory.

3.4 Data Memory

The Data Memory is 8, 16, 24 or 32 bit and it is composed of 1, 2, 3 or 4 blocks of General-Purpose Registers (**GPRs**) and 14 Configuration and Status Registers (**CSRs**).

Data memory access is performed through three buses, two for reading and one for writing. This way, a processor could read two registers, perform the desired operation and store the result in a third register, all in a single clock pulse.

3.4.1 General Purpose Registers (GPRs)

Each core includes eight 8-bit General Purpose Registers (**GPRs**), which are mapped in Data Memory according to the configuration mode selected. The grouping of these blocks is included in the Data Memory map shown later in this section.

3.4.2 Configuration and Status Registers (CSRs)

Appendix B includes a detailed description of the **CSRs**, which can be configured properly for any application designed for the system. All **CSRs** are 8-bit, below is presented a functional description of these registers.

Output Port Registers (OUT0 ... OUT3): The 8-bit OUTX register is connected directly to the 8 less significant bits of **FU** output port X. The ninth bit of **FU** corresponds to **RE** bit as explained in section 3.2. For a correct write operation of any OUTX register, it is necessary to be sure that register **PORTS** is configured properly.

Input Port Registers (IN0 ... IN3): The 8-bit INX represent the actual data in the 8 less significant bits of **FU** input port X, or from other point of view, the data in the output port register of a cell connected to this port. These are read-only registers. The **RE** pulse in an input port is used to detect when data has been written in the port. The special instruction **BLMOV** is used for this purpose.

Code Condition Register (CCR): The **CCR** is composed of three bits: **TA** (Thread Active), which indicates if the execution thread has finished or not. The **Z** and **C** elements correspond to the flags that indicate when an operation is zero and when the operation has generated a carry respectively. The instruction **END** is the only one able to stop the execution of the thread ($TA \leftarrow 0$).

Configuration Mode Register (MODE): The 8-bit **MODE** register is used for the configuration mode of the **FU**. Section 3.3.3 shows the twelve possible configuration modes for **FU**. This is a read only register, therefore a configuration mode can not be modified by a processor.

Famiy Register (FAMILY): The 8-bit **FAMILY** register was implemented to identify the family of the execution thread to which it belongs. The functionality of this register is reserved for future implementations, where a new programing paradigm [29] [30] [32] could be used to improve the functionality of the architecture.

Ports Configuration Register (PORTS): The 8-bit **PORTS** register configures the Output Multiplexing System in **FU**. This register configures the path between the ALU of a core and the OUTX register for a write operation over the **FU** output port.

Subprocesses Configuration and Status Register (SUBPCSR): The 8-bit **SUBPCSR** configures the execution of subprocesses. Any component in the system can start the execution of one to four subprocesses for dynamic reconfiguration in the system.

Fault-tolerance Configuration and Status Register (FTCSR): The 8-bit FTCSR configures the Fault-tolerance system that permits to detect a hardware failure in desired processors in the system (See section 3.7 for details).

3.4.3 Data Memory Map

Figure 3.4 shows the memory map for all possible processor in FU. Each memory map has a table that indicates the mode and the processor associated. For 8-bit processors, the GPRs of cores are joined lengthwise, which allows to increase the user GPRs in Data Memory.

For 16-bit processors in modes 5, 6, 7 and 8, the GPRs are joined widthwise, whereas for mode 9 the GPRs are joined lengthwise and widthwise as showed in figure. For 24-bit and 32-bit processors the GPRs are joined widthwise.

When there are more than one processor in the FU, it is important to note that all processors can read any INX register, but only one processor can write a specific OUTX register, this configuration must be performed in the PORTS register. Note that for 16, 24 and 32-bit processors, the ports IN0 and OUT0 represents the most significant byte for data processing.

3.5 Program Memory and Instructions Set

The FU includes four blocks of Program Memory (one on each core). Each block can store up to 64 instructions (64x25 bits). The Program Memory is joined depending on the configuration mode (see Table 3.1) increasing the instructions capacity for a processor.

Each 25-bit word in the Program Memory corresponds to one instruction. This word is divided in operation code (OPCODE) and the arguments. The OPCODE is 5-bit or 7-bit and the arguments could use the remaining bits depending on the instructions.

The instruction set is composed of 44 instructions, which includes arithmetic, logic, shift, branch, conditional branch and special instruction for the execution of microthreads [30].

Appendix A includes a detailed description of the instruction set for any processor in the FU.

3.6 Output Multiplexing System

Figure 3.5 shows a block diagram of Output Multiplexing System (OMS). The registers PORTS and FTCSR configure the core that is selected to perform a write operation over a specific OUT register. Note that any OUT register can be written by only one core.

When the FTS is disabled, the PORTS register allows for configuring the path between the data bus of a core and the OUT register, and also permits to configure the signal en_outX, that enables the write operation over the register. The enable signals (en_outX) are generated by the core that assumes the control of the processor. These signals are used for loading the output register and for the generation of the Read Enable (RE) pulse in the FU output ports.

When the FTS is enabled, the register FTCSR has control priority over PORTS register as shown in Table 3.2. See section 3.7 for details.

3.7 Fault Tolerance System (FTS)

The FTS enables the system to continue operating properly in the event of the failure of some of its processors. When a failure is detected by the FTS, the FU notifies the problem to the CCU, which starts the appropriate self-adaptive process for the replication of the damaged cells.

3.7. FAULT TOLERANCE SYSTEM (FTS)

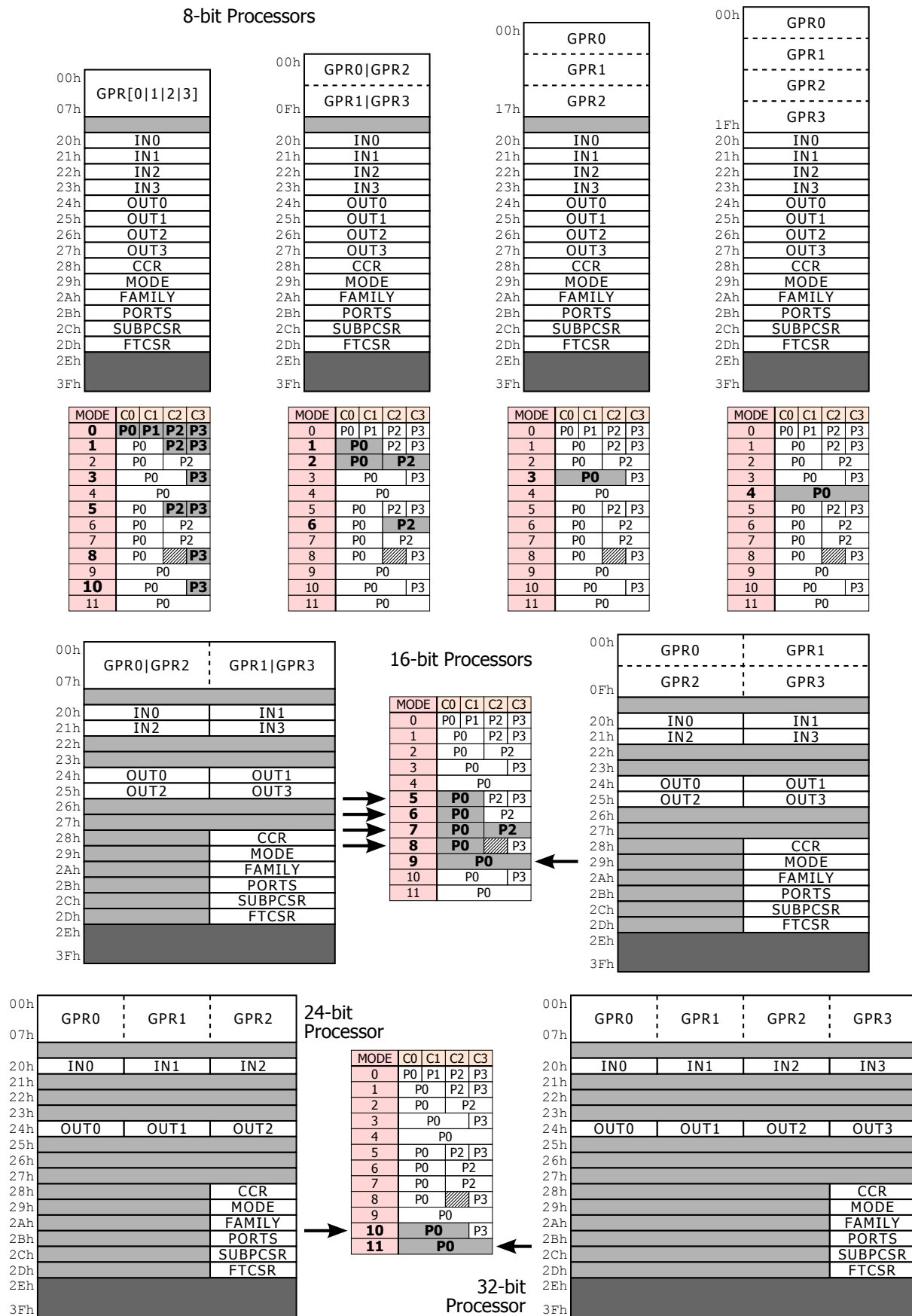


Figure 3.4: Data memory map for 8, 16, 24 and 32 bit processors.

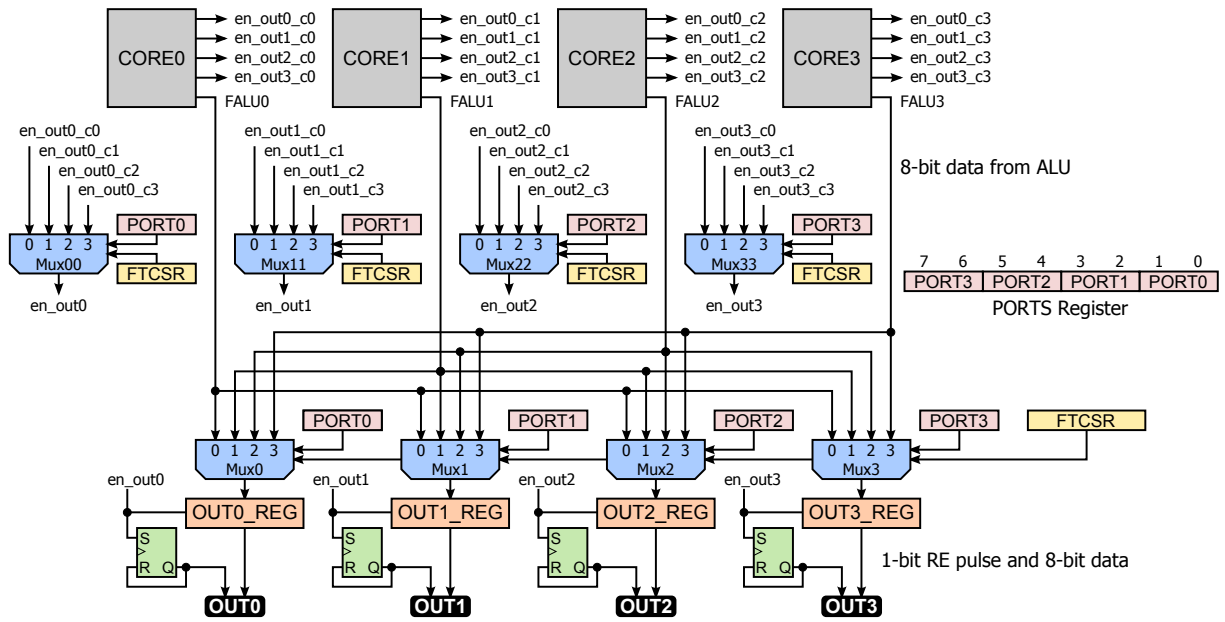


Figure 3.5: Block diagram of Output Multiplexing System.

<i>ft_controls</i>	en_out0	mux0	en_out1	mux1	en_out2	mux2	en_out3	mux3
1 - 1 - 5	1	FALU0	PORT1*		PORT2*		PORT3*	
1 - 1 - 6	1	FALU0	1	FALU1	PORT2*		PORT3*	
1 - 1 - 7	1	FALU0	1	FALU1	1	FALU2	PORT3*	
1 - 1 - 8	1	FALU0	1	FALU1	1	FALU2	1	FALU3
1 - 1 - others	PORT0*		PORT1*		PORT2*		PORT3*	
0 - X - X	PORT0*		PORT1*		PORT2*		PORT3*	

ft_controls ↔ *ft_enable* - *ft_redundant_cell* - *ft_mode*

* The value of en_outX y muxX depends of PORTX value.

Table 3.2: Output Multiplexing System operating table.

The **FTS** consists of a specific hardware that allows the comparison of two identical processors each time that a instruction is executed, that means each clock cycle. This involves the comparison of 2, 4, 6 or 8 cores, depending of the configuration mode of the **FTS** (*FT_mode*).

These processors that will be compared are defined as working and redundant. They must share the same inputs, but on the other hand, the working processor takes over writing the output ports, because two outputs can not be routed to the same location. There may be one or two cells participating in the **FTS**. These cells are called *primary* and *redundant*. The *primary cell* is mandatory and includes working processors. This cell may or may not include redundant processors. The *redundant cell* is optional and includes only redundant processors.

Figure 3.6 shows the block diagram of **FTS**, which is only active when **FTS** is enabled and it is the *primary cell* (signals *ft_enable* and not *ft_redundant_cell*). Table 3.3 shows the data bus comparisons available for **FTS**. Note that *FT_modes* 0 to 4 only perform comparisons with data bus from the same cell, whilst *FT_modes* 5 to 8 perform comparison between data buses of the cell with *FT_input* ports, which suppose a connection between the *redundant cell* and *primary cell*.

When the *redundant cell* is used, the **OMS** allows to write constantly the data bus of cores to the **FU** output ports as described in Figure3.5 and Table 3.2.

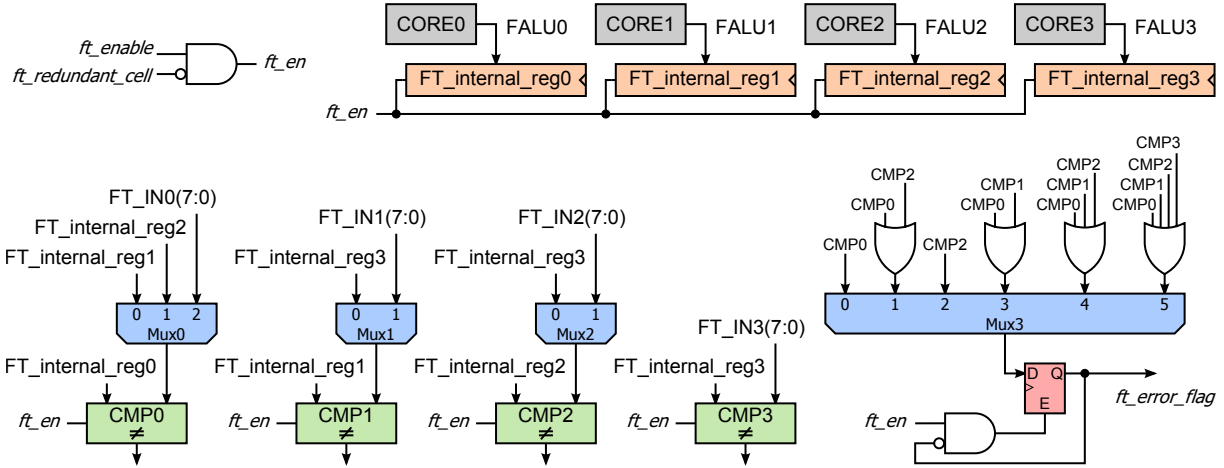


Figure 3.6: Fault Tolerance System.

FT_mode	Comparison	Mux0	Mux1	Mux2	Mux3
0	$F0 \Leftrightarrow F1$	0	X	X	0
1	$F0 \Leftrightarrow F1 \ \& \ F2 \Leftrightarrow F3$	0	X	0	1
2	$F2 \Leftrightarrow F3$	X	X	0	2
3	$F0 \Leftrightarrow F2$	1	X	X	0
4	$F0 \Leftrightarrow F2 \ \& \ F1 \Leftrightarrow F3$	1	0	X	3
5	$F0 \Leftrightarrow F0^*$	2	X	X	0
6	$F0 \Leftrightarrow F0^* \ \& \ F1 \Leftrightarrow F1^*$	2	1	X	3
7	$F0 \Leftrightarrow F0^* \ \& \ F1 \Leftrightarrow F1^* \ \& \ F2 \Leftrightarrow F2^*$	2	1	1	4
8	$F0 \Leftrightarrow F0^* \ \& \ F1 \Leftrightarrow F1^* \ \& \ F2 \Leftrightarrow F2^* \ \& \ F3 \Leftrightarrow F3^*$	2	1	1	5

FX denotes a data bus from ALU in COREX (FALUX). \Leftrightarrow denotes a comparison between cores. $\&$ denotes a logic AND. * denotes a data bus from the redundant cell (a connection between FUs of primary and redundant cell is assumed).

Table 3.3: Multiplexers configuration for Fault Tolerance System in primary cell.

3.7.1 Fault Tolerance Input Ports

When the redundant processor is included in the same cell where the working processor is located, the FT_input ports are not used, and the FTS only performs comparison between cores of the cell. In this case the *redundant cell* is not used (FT_modes 0 to 4).

Otherwise, when the redundant processor is located in the *redundant cell*, the FTS of the *primary cell* must perform a comparison between cores of different cells, in this case the OMS of the *redundant cell* must drive the output of the data flow of the core(s) to the output of the cell (RE is set to logic 1), which in turn should be connected to the FT_inputs of the FU of the *primary cell* that includes the working processor (FT_modes 5 to 8).

When the FTS is enabled in the *redundant cell*, the register FTCSR has priority over PORTS register to control the OMS as shown in Table 3.2. For example, in FT_mode 5 the data bus of CORE0 is routed directly to the OUT0_REG (mux0=FALU0 and en.out0=1 in Figure 3.5). In FT_mode 8 all cores are routed directly to the respective OUTX register.

The FU includes four FT_input ports. These ports must be interconnected by user with the output ports of the *redundant cell* when the FTS is enabled. The number of ports depends on the configuration mode of cell and the FT_mode.

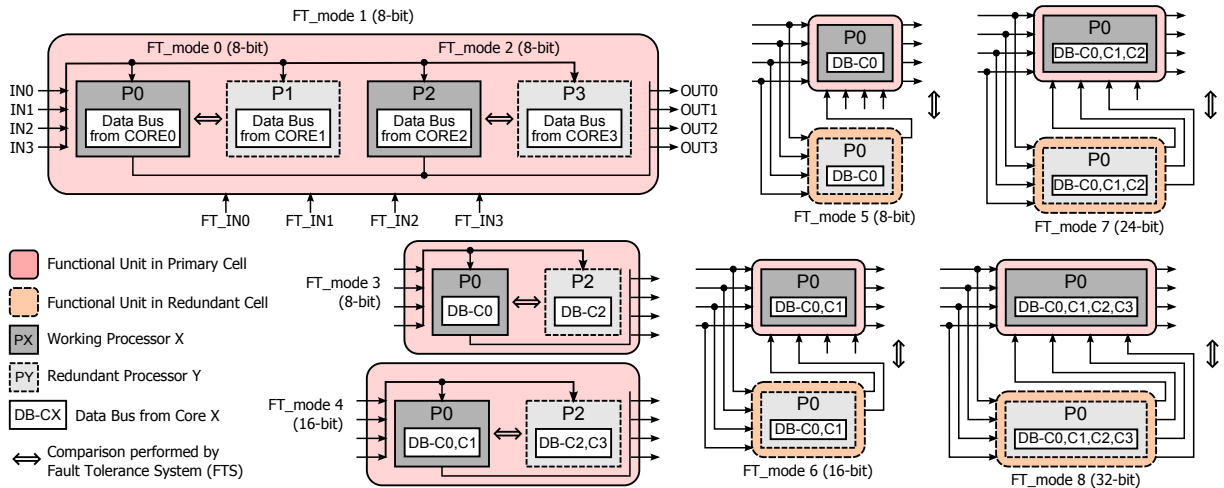


Figure 3.7: FT_modes for processors in Functional Unit.

3.7.2 Fault Tolerance Modes

The **FTS** could be implemented in any processors available in the system. Figure 3.7 shows the possible comparisons of processors with the same characteristics, whose result is the creation of a specific fault tolerance configuration mode (**FT_mode**).

Table 3.4 shows the 9 **FT_modes** available and the comparison performed. This table indicates the cores that are compared in each **FT_mode**, which could be combined with any of the 12 configuration modes available for the system, obtaining 108 possible combinations. It is responsibility of the developer to configure an appropriate combination between configuration mode of cells (always necessary) and **FT_mode** (if **FTS** is enabled). This table also shows the suggested cell configuration modes for each **FT_mode**.

As example lets suppose that it is necessary to implement the **FTS** to four 8-bit processors. For this purpose you need two cells (cell A and cell B) configured in mode 0, i.e., four 8-bit processors each. Therefore, the fault tolerance capability could be implemented with **FT_modes** 1 or 8. For option with **FT_mode** 1 you will have in cell A and B two primary processors and two redundant processors each. For option with **FT_mode** 8 you will have the four primary processors in cell A and the four redundant processors in cell B.

3.7.3 Configuration of FTS

When a specific application needs to implement a processor with fault tolerance capabilities, the developer has to set the configuration mode (**MODE** register) and the **FT_mode** by means of the Fault Tolerance Configuration and Status Register (**FTCSR**) (see section B.9 for details).

For configuration of **FTS** you should keep in mind the following considerations:

1. Enable the **FTS** for primary and redundant cell (if used). If it is not enabled, the other bits of **FTS** are not taken into account. You must set the bit *FT_enable*.
2. Select the **FT_mode** for primary and redundant cell (if used).
3. Indicate if the cell is the redundant cell. The bit *FT_redundant_cell* is used for this purpose. It must be set in the redundant cell for the **FT_modes** 5, 6, 7 and 8 only. If a cell is used as redundant, the comparators of **FTS** are disabled for that cell. The data bus of cores is driven to the output of redundant cell and **RE** is set to 1. The user must interconnect the output ports of redundant cell with the **FT_input** ports of primary cell.

FT_mode	Core Comparison	Suggested Configuration Mode	
		Primary Cell	Redundant Cell
0	$C0 \Leftrightarrow C1$	0	N/A
1	$C0 \Leftrightarrow C1 \ \& \ C2 \Leftrightarrow C3$	0	N/A
2	$C2 \Leftrightarrow C3$	0, 1, 5	N/A
3	$C0 \Leftrightarrow C2$	2	N/A
4	$C0-C1 \Leftrightarrow C2-C3$	7	N/A
5	$C0 \Leftrightarrow C0^*$	3, 4	3, 4
6	$C0-C1 \Leftrightarrow C0^*-C1^*$	5, 8, 9	5, 8, 9
7	$C0-C1-C2 \Leftrightarrow C0^*-C1^*-C2^*$	10	10
8	$C0-C1-C2-C3 \Leftrightarrow C0^*-C1^*-C2^*-C3^*$	0, 11	0, 11

\Leftrightarrow denotes a comparison between cores. $\&$ denotes a logic AND. $*$ denotes a core in the redundant cell (a connection between FUs of primary and redundant cell is assumed).

Table 3.4: Fault Tolerance Modes (FT_modes)

- The bit *FT_error_flag* in primary cell indicates when the FTS has found an error while performing a comparison between two processors, this bit stops the execution of the programs in the cores and alerts the CCU to start the self-elimination and self-replication processes of damaged cells.

3.8 Conclusions

This chapter describes the hardware architecture of **Functional Unit (FU)**. The FU ports are composed of four 9-bits input ports, four 9-bit output ports and four 9-bit fault tolerance input ports. The FU includes an **Output Multiplexing System (OMS)**, that is in charge of configuring the core that is enabled for write data in the FU output ports. The **Fault Tolerance System (FTS)** allows the detection of hardware failures, performing a comparison between two processors. If a failure is detected, the FU notifies to the CCU and damaged cells are self-replicated in system.

The FU includes four cores. Each core contains the digital elements that are used for construction of a processor: 8 bytes of General Purpose Registers (**GPRs**), 8-bit ALU, Code Condition Register (**CCR**), Program Counter, Control Memory and Program Memory (64 instructions capacity).

The processor is constituted by the elements of one or more cores. Therefore the FU can have between one to four processors working in parallel. There are twelve configuration modes, where the expansion of Data and Program Memory describes the specific configuration mode. The **GPRs** can be joined in length or width achieving data processing for 8, 16, 24 or 32 bits. This registers are mapped in Data Memory. The Program Memories can be joined or not depending on the configuration mode, which increases the instructions capacity for a processor allowing Program Memory sizes of 64, 128, 192 or 256 instructions. The instruction set of processors is composed of 44 instructions, which includes arithmetic, logic, shift, branch, conditional branch and special instruction for the execution of microthreads.

Chapter 4

Self-Adaptive Processes

*If you want to run, run a mile. If you want to
experience a different life, run a marathon.
Si quieres correr, corre una milla. Si quieres
experimentar una vida diferente, corre un maratón.*

Emil Zátopek (1922 – 2000)

Abstract: This chapter describes the self-adaptive capabilities included in the architecture, mainly the self-placement and self-routing, which due to its intrinsic design, enable the development of systems with runtime self-configuration, self-repair and/or fault tolerance capabilities. The self-adaptive capabilities are executed in an autonomous and distributed way by Configuration Units of Cells, Switch and Pin Interconnection Matrices.

4.1 Summary

The following is a summary of the self-adaptive processes that are supported by the architecture presented in this document, which will be explained in detail along this chapter. Note that most of the self-adaptive capabilities are based in self-placement and self-routing processes.

1. **Self-placement:** it is responsible for finding out the most suitable position in the cell array to insert the new cell of a component. This process is divided in two:
 - ▶ Self-placement for the first cell of a component.
 - ▶ Self-placement for other cells of a component.
2. **Self-routing:** it allows interconnecting the **FU** ports of two cells. The interconnection of cells can be at two levels:
 - ▶ Cell level, through local and remote cell ports.
 - ▶ Component level, through Switch and Pin Interconnection Matrices.

When a connection between cells must be eliminated, the **Self-derouting** process permits to disconnect the **FU** ports of two cells (at cell and component level), i.e., it releases the routing resources of a connection.

3. **Self-replication:** it permits to replicate the cell of a component to an empty cell in the array. For this purpose, the process includes the execution of the following processes for a specific cell in the order listed: self-derouting, self-placement and self-routing.

4. **Self-elimination:** it permits to eliminate and discard a specific cell(s) for future self-placement process when a hardware failure is detected. Its routing resources continue available and it can participate in future self-routing processes.
5. **Self-configuration:** it includes all previous self-adaptive process listed, and could be divided in two scenarios:
 - ▶ Self-repair: when the Static Fault Tolerance mechanism is enabled and a hardware failure is detected, the processes for self-replication and self-elimination of damaged cell(s) are executed.
 - ▶ Dynamic reconfiguration: when the execution of subprocesses is enabled for a component. It has the ability of create and eliminate components, among others. Therefore, the self-placement and self-routing processes could be executed.

4.2 Previous Considerations

For the understanding of the proposed algorithms, it is important to note that the **Control Microprocessor (C_μP)** includes the high-level instructions in system, which will be executed sequentially for the configuration of a **SANE-ASM**. These high-level instructions will be defined as **SANE Assembler (SASM)** instructions.

This is the starting point for the configuration of an application in the system. The **SASM** instructions will be detailed in chapter 5. In advance, for the understanding of the following sections some **SASM** instructions are introduced:

- ▶ `create_component`.
- ▶ `connect_component`.
- ▶ `delete_component`.
- ▶ `start_subprocess_X`.
- ▶ `end_subprocess_X`.
- ▶ `ft_configuration` (Fault Tolerance configuration).

The name of each **SASM** instruction gives an idea of its functionality. The execution of this instructions may require a negotiation process to establish the chip that has to execute a specific process. Once the chip is defined, the **C_μP** sends the information to the **Global Configuration Unit (GCU)** of the selected chip to execute the desired action. Thereby, the **GCU** is the start point for the execution of self-placement and self-routing algorithms inside a chip. When the processes end, the **GCU** receives a confirmation command and notifies to the **C_μP** the end of the process. Thereafter, the **C_μP** may continue with the execution of other **SASM** instructions. The communication between Configuration Units (**CUs**), **GCU** and **C_μP** is made through the **Internal Network (INET)** and the **External Network (ENET)**. The labels “`_inet`” and “`_enet`” will be added to the commands related with these networks along this chapter.

It is important to note, that the algorithms presented in this chapter are being executed by several **CUs** at the same time in distributed way. Therefore, each **CU** includes its proper set of variables, e.g., the result of the execution of the algorithms is independent for each cell. The flow diagrams for self-adaptive algorithms in cells and Switch Matrices (**SMs**) are summarized in Appendix C and will be introduced along this chapter.

4.3 Initial State, Cell Address and Connection Tables

In the initial state, all cells are free, i.e., they do not belong to any component. The cells belonging to any component have to be placed and connected for data processing and information exchange.

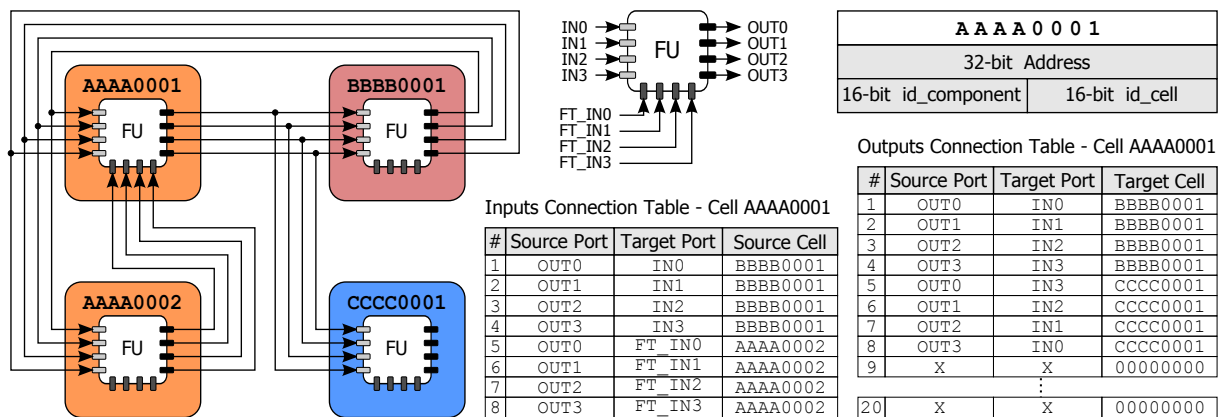


Figure 4.1: Address and Connection Tables example for cell AAAA0001.

This is a sequential process where each cell has to be placed and routed in the system. For this purpose, the cells execute in a distributed way the self-placement and self-routing algorithms.

All cells have a 32-bit unique identifier called *address*. This field is divided into two 16-bit words, called *id_component* and *id_cell*. The *id_component* is the component unique identifier, where the value FFFFh is reserved for broadcasting and the value 0000h to indicate that the cell is free and does not belong to any component (initial value). Therefore, it is possible to instantiate up to 65534 different components. The *id_cell* is the cell unique identifier in a component, so there may be up to 65536 cells in a component and a maximum close to 2^{32} cells in the system.

All cells has two connection tables as detailed below:

- ▶ The **Input Connection Table** store the connections of the eight inputs of **FU** (including the fault tolerance input ports). This table includes the fields source port, target port and source cell, which corresponds to a connection between the **FU** output port of another cell with the **FU** input of the cell.
- ▶ The **Output Connection Table** can store up to 20 connections, which is limited for the number of port of the cell, i.e., 8 local ports plus 12 remote ports. When the cell includes connections with other components, the number of connections within the same components is proportionally reduced. This table includes the fields source port, target port and target cell, which corresponds to a connection between the **FU** output port of the cell with the **FU** input port of another cell.

Figure 4.1 shows an example of the *address* and connection tables for the cell AAAA0001 in a SANE with three components.

4.4 Creation of Components in a Chip

The `create_component` and `connect_component` are basic instructions that permit the system to create and interconnect new components in the cell array. These SASM instructions require the execution of two basic self-adaptive processes: self-placement and self-routing. These algorithms are executed in an autonomous and distributed way by system members (cells, SMs and PIMs). The Cell Configuration Unit (CCU) includes the algorithms for all self-adaptive processes at cell level. It includes an interface with the INET that implements the respective communication protocol (see sections 2.11 and 2.12 for details). The Switch Matrix Configuration Unit (SMCU) and Pin Interconnection Matrix Configuration Unit (PIMCU) include the algorithms for self-routing at component level.

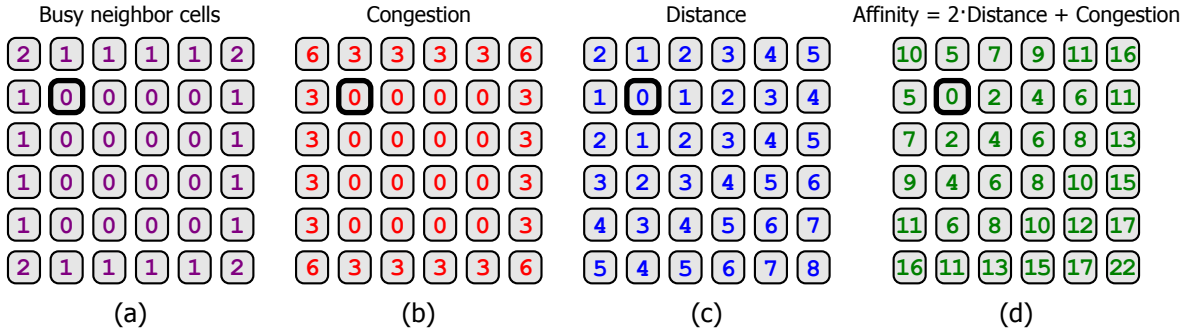


Figure 4.2: Example of *busy_neighbor_cells*, *congestion*, *distance* and *affinity*.

In addition to the communication functionality, the transmission (tx) and mainly the reception (rx) processes participate actively in the self-routing and self-placement algorithms. It is important to note that tx and rx processes can be executed simultaneously by one or more cells in the array, even the rx process can modify the data of the tx process if it is necessary, e.g., for the comparison byte and the acknowledgment bit. The flow diagram for tx and rx processes is shown in Section C.1.

4.5 Self-Placement Process

The self-placement algorithm is responsible for finding out the most suitable position in the cell array to insert the new cell of a component. For the placement of components in the array it is advisable but not essential to have the cells organized by number of connections with other cells. Therefore, the cell with more connections is first placed in a convenient place, where there is a large number of free neighboring cells. The following variables are defined for self-placement process:

- ▶ **Busy_neighbor_cells:** This value indicates the number of busy cells around a cell. The cells in the border of the array includes busy (or not implemented) cells by default.
- ▶ **Congestion:** The routing *congestion* figure (4.1) is defined as the number of remote output ports that are busy (or not available) in a cell. The cells in the border of the array include busy (or not implemented) remote ports by default.

$$congestion = remote_ports_used \quad (4.1)$$

- ▶ **Distance:** The *distance* between two cells is the sum of the absolute differences of their coordinates (Manhattan distance).
- ▶ **Affinity:** The figure cost *affinity* indicates the location appropriateness for the placement of the new cell of a component with respect to another cell of the same component. The *affinity* is defined in (4.2).

$$affinity = 2 \cdot distance + congestion \quad (4.2)$$

Figure 4.2 shows an example of these variables. It assumes the initial configuration, i.e., there are no routing resources used. These variables are modified dynamically, each time that a cell is placed or a connection is routed. Note that *distance* and *affinity* values are relative to a specific cell (highlighted).

4.5.1 Self-Placement of the First Cell of a Component

For the placement of the first cell of a component, a particular procedure is used, different from other cells. In this case, a good candidate position is defined as one where a free cell has low routing congestion and the largest number of free neighboring cells. The procedure includes the next steps:

1. The GCU broadcasts by means of the INET a message with the new cell identifier (*address*) and its input and output connection tables.
 - *tx_command=insert_first_cell_inet.*
 - *tx_address=0xFFFFFFFF.*
 - *tx_data = new cell address (4 bytes) + connection tables.*
2. Free cells send simultaneously through INET, using a comparison process, the addition result of the number of *busy_neighbor_cells* and *congestion* value ((a) + (b) in Figure 4.2).
3. The winner cell will be the leftmost uppermost cell with the lowest value. This cell stores the *address* and the connection tables. Additionally, it sends a message to the GCU indicating the end of the "self-placement of the first cell of a component" process, e.g., the highlighted cell in Figure 4.2 shows the location of the first cell of a component, when the array is empty.

Section C.2.1 presents a flow diagram of the algorithm implemented by cells for the insertion process of the first cell of a component.

4.5.2 Self-Placement of Other Cells of a Component

After inserting the component first cell, the remaining cells of the component are placed as close as possible to the cell with the largest number of connections with the new cell. For this purpose, the *affinity* is used. The procedure is as follows:

1. The GCU broadcasts to the cell array a message with the new cell identifier (*address*) and its connection tables.
 - *tx_command=insert_other_cell_inet.*
 - *tx_address=0xFFFFFFFF.*
 - *tx_data = new cell address (4 bytes) + connection tables.*
2. The cells belonging to that component send a message by means of the INET indicating the one's complement of the number of connections they share with the new cell, starting a comparison process. The winner cell will be the one which has the largest number of connections.
3. This cell starts a process, in which the *distance* with free cells is calculated. Then, it requests to the free cells to start a comparison process of their *affinity*.
4. The winner cell will be the leftmost uppermost cell with the lowest *affinity* value. This cell stores the *address* and connection tables, e.g., the cell below the highlighted cell in Figure 4.2 (d) corresponds to the second cell placed in the cell array.

Section C.2.2 presents the flow diagram of the algorithm that performs the self-placement of the other cells of the component (from the second). Figure 4.3 shows an example with three components in an array of two clusters (6x3 cells array). This figure shows the execution sequence of self-placement and self-routing processes for component AAAA. The final location of component BBBB and CCCC is also shown.

4.5. SELF-PLACEMENT PROCESS

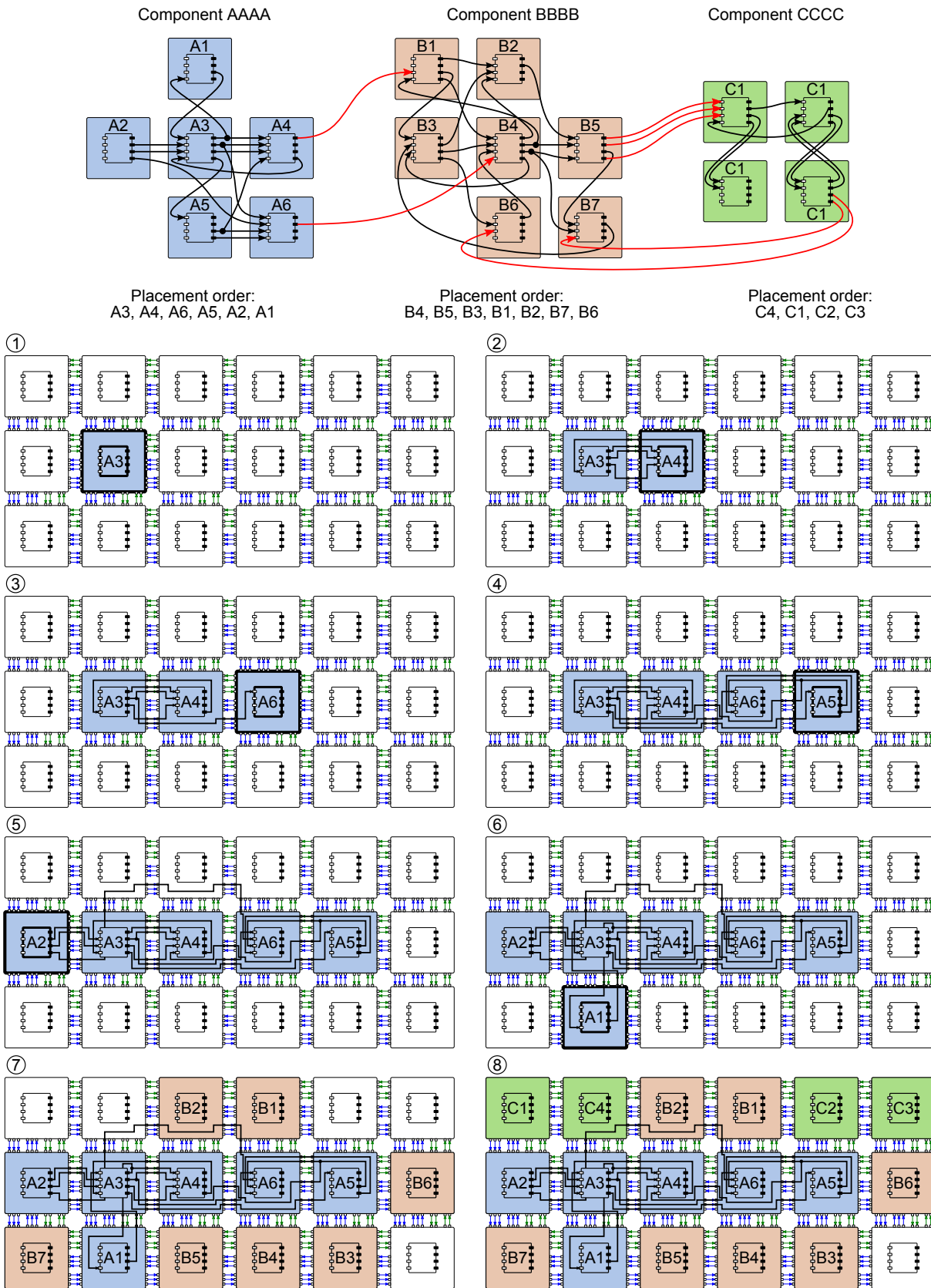


Figure 4.3: Example of the self-placement algorithm implementation for three components in an array of two clusters (6x3 cell array). The resources used by self-routing algorithm are shown only for component AAAA.

4.6 Self-Routing Process

The Self-routing allows interconnecting the **FU** ports of two cells. It can be at cell level, through the local and remote cell ports, or at component level, through the Switch Matrices (**SMs**) and Pin Interconnection Matrices (**PIMs**).

When a cell or a component must be deleted from the array, the self-routing process must be executed for disconnecting the **FU** port of cells previously connected. This process will be defined as Self-derouting. This process can be at cell level or a component level.

Section [C.3](#) and [C.4](#) presents the flow diagrams of the Self-Routing processes implemented in **CCUs** and **SMCUs** respectively. The following section describes these processes.

4.7 Self-Routing at Cell Level

The self-routing algorithm at cell level is executed since the insertion of the second cell of a component, each time that the self-placement process ends. The algorithm allows interconnecting the ports of the functional unit of two cells, in the same component, through the local and remote cell ports. The local input-output ports are used exclusively to interconnect the **FU** ports of two neighbor cells (north, east, south or west). The remote ports are used when the cells to be connected are not adjacent or when the local ports are already occupied.

This process is divided in two parts. The first consists in locating the source and the target cell inside the cell array for a specific connection. For this procedure, the **INET** is used. The second is an expansion process between the source and target cells. This process is executed each time that the source and target cells are configured for a new connection. The cell multiplexers are dynamically configured to interconnect the desired ports. In this process, some bits of the expansion ports are used (see section [2.10](#) for details).

4.7.1 Configuration of source and target cells for cell connections

The first cell that starts the self-routing process is the newly inserted cell, which activates its *source_cell_flag*.

1. The *source_cell* goes through its output connections table, and sends messages to cells of the same component.
2. If the *address* of a busy cell that receives this message matches with the *address* of the message, this cell activates its *target_cell_flag* and sets the acknowledge signal to the *source_cell*. Then, the *source_cell* starts the “Expansion Process at Cell Level” to configure the path.
3. If the *source_cell* does not receive the acknowledge signal, it will continue with its remaining connections.
4. When the *source_cell* (new inserted cell) ends with its output connections table, it broadcasts a message including its address, asking for cells in the component able to route their output connections with this cell. Then, it resets its *source_cell_flag* and activates its *target_cell_flag*.

Hitherto, the new inserted cell tried to route all its output connections, which depends of the cells already placed. The output connections that has not been routed, will be made later, when cells that are inserted later complete the whole process. The algorithm continues with the routing of the input ports of the new inserted cell.

5. The cells of the component that have at least one output connection to be routed to the *target_cell* start an elimination process, where the winner is the leftmost uppermost cell.

Signal name	Description
<i>neighbor_out_X</i> <i>neighbor_in_X</i>	Used in the Search Phase. These signals are used to find the <i>target_cell</i> in neighboring cells.
<i>propagate_out_X</i> <i>propagate_in_X</i>	Used in the Search Phase. These signals are used to find the <i>target_cell</i> in the cell array.
<i>lock_out_X</i> <i>lock_in_X</i>	Used in the Configuration Phase. These signals are used in the reverse process of the Search Phase, to configure the multiplexers in the cells included in the path.
<i>local_port_out_X</i> <i>local_port_in_X</i> <i>remote_port_out_X</i> <i>remote_port_in_X</i>	Used in both phases, the Search and Configuration. These signals are used to indicate the local or remote port that will be used in case to configure the path.
<i>id_target_port_out</i> <i>id_target_port_in_X</i>	Used in the Search Phase. These signals are used to indicate the connection target port of the <i>target_cell</i> .

Table 4.1: Description of expansion port signals used by the Expansion Process at Cell Level.

6. The winner cell activates its *source_cell_flag*. This new *source_cell* looks up its output connections table and starts the “Expansion Process at Cell Level” to configure all connection paths between source and target cells.
7. When the *source_cell* ends routing all possible connections with the *target_cell*, it broadcasts a message asking for other cells in the component able to make their output connections with the *target_cell*.
8. Steps 5., 6. and 7. are repeated until all connections are completed with the *target_cell*. When the process ends, the last *source_cell* sends a message to the GCU indicating the end of self-routing and self-placement process for the inserted cell.

Section C.3.1 shows the algorithm used for the selection of source and target cells. When this cells are selected, the “Expansion Process at Cell Level” can be executed. The total time of the self-placement and self-routing processes of the new inserted cell depends on some factors, like the placement order and the component interconnections that includes the number of connections between cells (inputs and outputs).

4.7.2 Expansion Process at Cell Level

Once the source and target cells of a component are ready, the expansion process starts, configuring the cell multiplexers to interconnect the FU ports between those cells. The signals that participate in this process are explained in Table 4.1.

When a cell has to be connected to another one, the system first checks if the cells are neighbors. In that case, and if a free local port exists between them, they get connected by means of the local ports, otherwise the connection is tried with a remote connection resource.

The path configuration is divided in two phases. The first one is the **Search Phase at Cell Level**. This starts from the *source_cell* and looks for the *target_cell* in the array. During the process some information is stored, in a distributed way, in every cell that has been visited. The phase ends when the *target_cell* has been found. If the first phase exhausted any possibility to find the *target_cell* without reaching it, then no path exists between the *source_cell* and the

target_cell, and there is no reason to continue with the second phase. Then, the *source_cell* sends an error message to the GCU and the self-routing process ends.

The second phase recovers the information generated by the first one for the path configuration. This is called the **Configuration Phase at Cell Level**, it starts from the *target_cell* to the *source_cell* using the propagation information stored during the first phase of the algorithm.

Sections C.3.2, C.3.3 and C.3.4 presents the flow diagrams related with the expansion process at cell level.

Search Phase at Cell Level

The Search Phase is started by the *source_cell*. This is an expansion process that propagates signals in the sides of the cell that have available routing resources, like local and/or remote free ports. The propagation process includes the configuration of signals for each side (north, east, south and west) of the cell as follows:

a Configuration of propagation signals:

- ▶ This condition is valid only for the *source_cell*: If the side of the cell has any free local port, then that side sets the *neighbor_out* signal and configures the *local_port_id_out* signal in the expansion port.
- ▶ For propagation of any cell (including the *source_cell*): If the side of the cell has any free remote port, then that side sets the *propagate_out* signal and configures the *remote_port_id_out* signal in the expansion port.

b The cell assigns to the signal *id_target_port_out* the value:

- ▶ For *source_cell*, the identification number of the Functional Unit target port for the connection with the *target_cell*. This number is read from the output connections table of the *source_cell*.
- ▶ For other cells, the signal *id_target_port_in* read from the port that receives the propagation signal.

c After the configuration of the signals previously mentioned, the cell goes to the state *lock_cell*, where it waits for the activation of any *lock_in* signal.

The propagation previously explained is executed by each cell that reads the *propagate_in* signal. When a cell receives more than one *propagate_in* signal simultaneously it follows a priority order (NORTH, EAST, SOUTH and WEST) and it serves only the highest priority signal received. The cell receiving the *propagate_in* signal stores the side from which the expanding cell accessed it by means of the *origin* register. The propagation process explores the entire cell array until finding the *target_cell*, if possible.

It is important to mention that busy cells also participate in the expansion process since the remote connections can also cross busy cells. Nevertheless, this process is completely transparent to the internal cell operation since it is executed using dedicated resources, at the placement and routing layer.

Configuration Phase at Cell Level

The Configuration Phase starts when the Search Phase finds the *target_cell*. This occurs when any propagation signal in any side of the *target_cell* is activated, then the *target_cell* proceeds in priority order as follows:

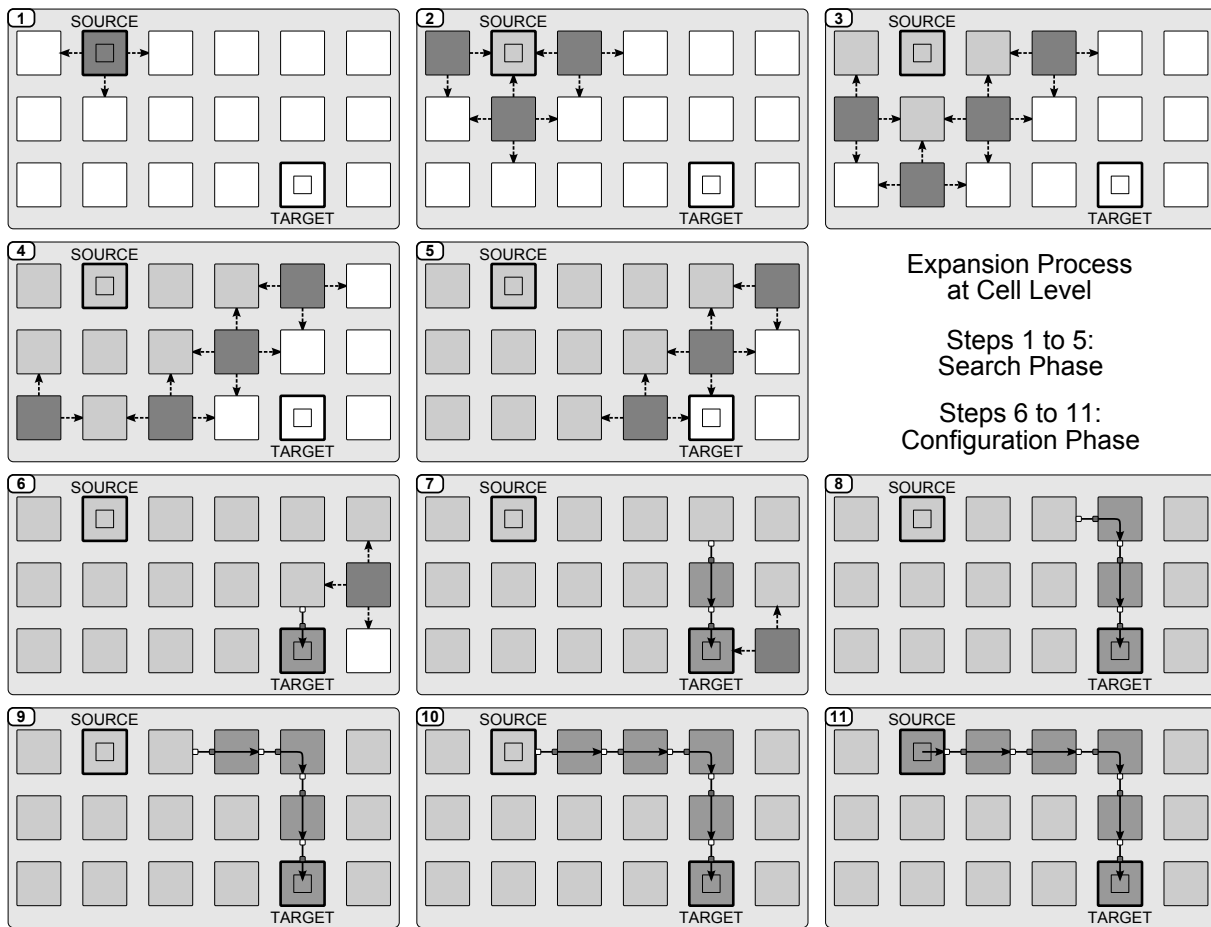


Figure 4.4: Example of Expansion Process at Cell Level.

1. If the *target_cell* detects in any of its sides the activation of a *neighbor_in* signal, it will know that the *source_cell* is its neighbor and also its position (If not, go to step 2.). At that moment, the local connection is established. The connection is configured taking into account the signals *id_target_port_in* and *local_port_id_in*. Then the cell activates the signal *lock_out* and *neighbor_out* in the side where the *neighbor_in* signal was received, and it goes to *idle* state.
2. If the target cell detects in any of its sides the activation of a *propagate_in* signal, it will know its position. At that moment, the remote connection is established. The connection is configured taking into account the signals *id_target_port_in* and *remote_port_id_in*. Then the cell activates the signal *lock_out* in the side where the *propagate_in* signal was received, and goes to *idle* state.

The Configuration Phase that was started by the *target_cell* goes backward over the path previously configured in the Search Phase until it arrives to the *source_cell*. This process configures the multiplexers of the corresponding cells to fix the path. The cells that participate in this process are in the state *lock_cell* and perform the following actions when the signal *lock_in* in the corresponding side is activated:

1. If it is the *source_cell*: the cell configures the local or remote port taking into account the source port of the Functional Unit included in the connection table and the signal *local_port_id* or *remote_port_id* previously configured. The local port is used if the signal *neighbor_in* is active. The cell activates the signal *routing_complete* (shared by all the cells) in order to reset

all the signals related to the expansion process, and the Expansion Process for a connection ends.

2. If it is not the source cell: the cell configures the remote port of the side where the *lock_in* signal was read taking into account the *origin* register and the *remote_port_id* previously configured. The cell goes to *idle* state and the signal *lock_out* is activated in the side that indicates the register *origin*.
3. The next cell that receives the signal *lock_in* starts the process again from step 1.

Figure 4.4 shows an example of the Search and Configuration Phases of the Expansion Process at Cell Level. This example assumes that routing resources of all cells are available. Step 1 to 5 represents the Search Phase, that starts from the *source_cell* propagating signals until it finds the *target_cell*, then the Configuration Phase starts (steps 6 to 11). Note that the propagation of signals continue in steps 6 and 7, since the Expansion Process is finalized by *source_cell* in step 11. Note that the distance between *source_cell* and *target_cell* is 5, the connection is established through six routing resources (or multiplexers), five in remote port of cells and one in FU input of *target_cell*, this resources are represented with the head of the arrows in step 11.

Figure 4.3 shows a sequence that illustrate the execution of self-placement and self-routing algorithms for the component AAAA (steps 1 to 6). Note that a connection can cross a free cell (step 5). Equation (4.3) represents the execution time of the expansion process implemented for the prototype. This time is proportional to the *distance* between cells and the clock period, T .

$$T_{EP} = (4 \cdot distance + 2)T \quad (4.3)$$

4.8 Self-Routing at Component Level

When the creation of all components in system is completed, the self-routing process at component level can be executed by means of the SASM instruction `connect_component`. This algorithm implements the interconnection of cells belonging to different components through SMs (and PIMs if chip-to-chip connection is necessary).

The process is divided into two parts, the first configures the source and target cells of a connection between different components, and the second is the “Expansion Process at Component Level” that is performed through the SMs, where the Switch Matrix Configuration Unit (SMCU) and eventually Pin Interconnection Matrix Configuration Unit (PIMCU) are responsible of the configuration of the multiplexers to connect the desired ports. The interconnection of components can be done in the same cluster or in different clusters. In the latter case the SM will be interconnected with one of its eight neighbors and so on, until reaching the target cell of the connection.

The self-routing process at component level is similar to the self-routing process at cell level previously described. The process is started and completed by the cells with the difference that the expansion process is performed in the Switching Matrices, using a similar algorithm that is used by cells in the expansion process. The main difference is that matrices have eight neighbors, while cells have only four. This allows interconnecting distant cells using less routing resources (multiplexers) in comparison with routing hardware resources for cells.

If in the search process of the target cell the acknowledge signal is not received, it may be because the target cell is in another chip. In this case, the pins through which the connection between source and target will be made are configured by the GCUs of the corresponding chips, initiating self-routing processes at the component level in the chips through which the connection goes through. This process will involve the PIMCU—in addition to the SMCUs—configuring the multiplexers required to perform the desired connection.

4.8.1 Configuration of Source and Target Cells for Components Connections

The procedure is as follows:

1. The **GCU** of a chip starts the execution of the algorithm sending to the cell array the command *start_components_connection_inet*.
2. All cells with at least one pending connection with a cell of other component participate in the elimination process, where the leftmost uppermost is the winner cell. If there is a winner cell, it activates its *source_cell_flag* (goto step 3). If there is not a winner the **GCU** receives the command *end_components_connection_inet* and the process ends.
3. The *source_cell* looks up its output connections table. If there is a non-routed connection with a cell belonging to other component, the *source_cell* sends a message to find the target cell by means of command *set_target_cell_sr_component_inet* (goto step 4). If there is no more connections to route goto step 2.
4. If the target cell of a connection is in the same chip, this cell activates its *target_cell_flag* and sets the acknowledge signal to the *source_cell*. Then, the *source_cell* starts the “Expansion Process at Component Level” to configure the path with the *target_cell*, the process continues in step 3. If the *source_cell* does not receive the acknowledge signal, it is possible that the *target_cell* is located in another chip. Then, the following additional steps must be executed:
 - a. The chip that contains the *source_cell* is marked as *source_chip*. The *source_cell* sends to the **GCU** the command *configure_chip_connection_inet* for the configuration of a connection between chips.
 - b. The **GCU** broadcasts to chips the command *search_cell_other_chip_enet* with the *address* of the target cell and the **FU** target port of the connection.
 - c. The chips broadcast internally the information. The chip that contains the target cell is marked as *target_chip*. The *target_cell* activates its *target_cell_flag*. The *target_chip* selects a free pin of its **PIM** and sends the information to the *source_chip*.
 - d. The *source_chip* starts the “Expansion Process at Component Level” between the *source_cell* and the *target_pin* of the **PIM**. When the process ends, the *source_cell* sends to the **GCU** the confirmation command *cell_pin_connection_confirmation_inet*. The **GCU** sends to the *target_chip* the command *routing_cell_target_chip_enet* requesting the routing process.
 - e. The **GCU** of the *target_chip* broadcasts internally the command *start_pin_cell_connection_inet*. The *target_chip* performs an “Expansion Process at Component Level” between the *source_pin* of the **PIM** and the *target_cell*. When the process ends, the **PIM** sends to the **GCU** the confirmation command *pin_cell_connection_confirmation_inet*.
 - f. The **GCU** of the *target_chip* broadcasts the confirmation message *end_routing_cell_target_chip_enet*, later the **GCU**s broadcast internally the command *configure_chip_connection_confirmation_inet*.
 - g. The connection between *source_cell* and *target_cell* at component level using **PIMs** has been performed, the *source_cell* continues the process from step 3.

4.8.2 Expansion Process at Component Level

The expansion process at component level can be executed for three scenarios:

- Between *source_cell* and *target_cell* when the components belong to the same chip.

Signal name	Description
<i>propagate_out_matrix</i> (<i>cell</i>) <i>propagate_in_matrix</i> (<i>cell</i>) <i>propagate_out_cell_X</i> (<i>SM</i>) <i>propagate_in_cell_X</i> (<i>SM</i>) <i>propagate_out_X</i> (<i>SM</i> , <i>PIM</i>) <i>propagate_in_X</i> (<i>SM</i> , <i>PIM</i>)	Used in the Search Phase. These signals are used to find the <i>target_cell</i> or <i>target_pin</i> in the chip.
<i>lock_out_matrix</i> (<i>cell</i>) <i>lock_in_matrix</i> (<i>cell</i>) <i>lock_out_cell_X</i> (<i>SM</i>) <i>lock_in_cell_X</i> (<i>SM</i>) <i>lock_out_X</i> (<i>SM</i> , <i>PIM</i>) <i>lock_in_X</i> (<i>SM</i> , <i>PIM</i>)	Used in the Configuration Phase. These signals are used in the reverse process of the Search Phase, to configure the multiplexers in the matrices included in the path.
<i>id_source_port_out</i> (<i>cell</i>) <i>id_source_port_in_X</i> (<i>SM</i>)	Used in the Search Phase. These signals are used to indicate the FU source port of a connection.
<i>mux_id_matrix</i> (<i>cell</i>) <i>mux_id_cell_X</i> (<i>SM</i>)	Used when the Search Phase finds the <i>target</i> . These signals are used to indicate the multiplexer used by SM for configures a connection.
<i>matrix_port_out</i> (<i>SM</i> , <i>PIM</i>) <i>matrix_port_in</i> (<i>SM</i> , <i>PIM</i>)	Used in both phases, the Search and Configuration. These signals are used to indicate the matrix port that will be used for the path configuration.
<i>id_target_port_out</i> (<i>cell</i> , <i>SM</i> , <i>PIM</i>) <i>id_target_port_in_matrix</i> (<i>cell</i>) <i>id_target_port_in_X</i> (<i>SM</i> , <i>PIM</i>)	Used in the search phase of the target cell. These signals are used to indicate the FU target port of the <i>target_cell</i> or the <i>target_pin</i> of the PIM .

Table 4.2: Description of expansion port signals used by the Expansion Process at component level.

- Between *source_cell* and *target_pin* when the components belongs to different chips (partial configuration of a connection).
- Between *source_pin* and *target_cell* when the components belongs to different chips (partial configuration of a connection).

For the description of the process, the term *source* may refer to *source_cell* or *source_pin*, whilst the term *target* may refer to *target_cell* or *target_pin*. Once the *source* and *target* are ready, the expansion process starts, configuring the multiplexers of **SMs** (and **PIMs**) for a connection. The signals that participate in this process are explained in Table 4.2.

The path configuration is divided in two phases. The first one is the **Search Phase at Component Level**. This starts from the *source* and looks for the *target* in the chip. During the process some information is stored, in a distributed way, in every **SM** or **PIM** that has been visited. The phase ends when the *target* has been found. If the first phase exhausted any possibility to find the *target* without reaching it, then no path exists between the *source* and the *target*, and there is no reason to continue with the second phase. Then, the *source* sends an error message to the **GCU** and the self-routing process ends.

The second phase recovers the information generated by the first one for the path configuration. This is called the **Configuration Phase at Component Level**, it starts from the *target* to the *source* using the propagation information stored during the first phase of the algorithm.

Sections C.3.2, C.4, C.4.1 and C.4.2 present the flow diagrams related with the expansion process at component level. Note that the *source* (CCU for presented flow diagrams) is the start and end point of the process.

Search Phase at Component Level

This is an expansion process that propagates signals in cells and the sides of the SMs or PIMs that have available routing resources. The Search Phase is started by the *source* as follows:

- a. If the *source* is a cell: the cell sets its *propagation_out_matrix* signal. The cell reads the FU source port from output connections table and assigns the value to the signal *id_source_port_out*. If the *target_cell* is in the chip, the cell reads the FU target port from output connections table and assigns the value to the signal *id_target_port_out*. If the *target_cell* is in another chip, the cell reads the *target_pin* from a previous configured value and assigns it to the signal *id_target_port_out*
- b. If the *source* is a PIM: whether the side of the PIM has any free output port, then that side sets the *propagate_out* signal. The PIM configures the *id_target_port_out* that contains the FU target port from the data read in a previous configuration.
- c. After the configuration of the signals previously mentioned, the cell or PIM goes to the state *lock_component*, where it waits for the activation of any *lock_in* signal.

The SM receiving the *propagate_in_cell_X* signal stores the side from which the expanding cell accessed it by means of the *origin_cell* register. Thereafter, the propagation process continues configuring the propagation signals for SMs in each side (north, northeast, east, southeast, south, southwest, west and northwest) as follows:

- d. If the side of the SM has any free port, then that side sets the *propagate_out* signal.
- e. The SM assigns to the signal *id_target_port_out* the value read from the cell, SM or PIM, depending of the port that receives the propagation signal.
- f. After the configuration of the signals previously mentioned, the SM goes to the state *lock_components*, where it waits for the activation of any *lock_in* signal.

The propagation previously explained (from d.) is executed by each SM that reads the *propagate_in* signal. When a SM receives more than one *propagate_in* signal simultaneously it follows a priority order (NORTH, NORTHEAST, EAST, SOUTHEAST, SOUTH, SOUTHWEST, WEST and NORTHWEST) and it serves only the highest priority signal received. The SM receiving the *propagate_in* signal stores the side from which the expanding SM accessed it by means of the *origin_matrix* register. The propagation process explores the entire chip until finding the *target*, if possible.

Configuration Phase at Component Level

The Configuration Phase starts when the Search Phase finds the *target*. This occurs when any propagation signal in any side of the *target* is activated, then the *target* proceeds as follows:

- If the *target* is a cell: when the *target_cell* detects the activation of the signal *propagate_in_matrix*, the connection with the SM is established. The connection is configured taking into account the signals *mux_id_matrix* and *id_target_port_in_matrix*. Then the cell activates the signal *lock_out_matrix*, and it goes to *idle* state.

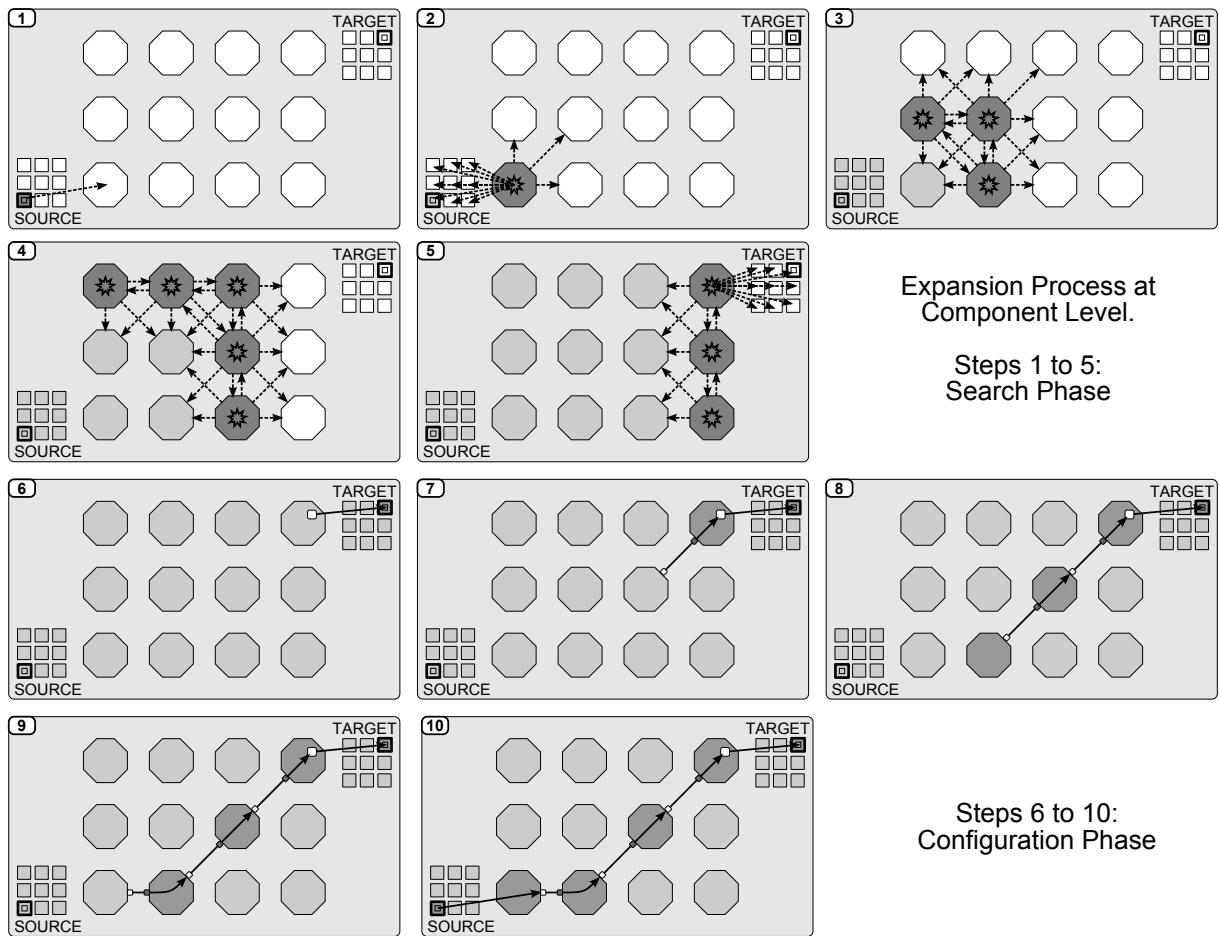


Figure 4.5: Example of Expansion Process at component level.

- If the *target* is a **PIM**: when the **PIM** detects the activation of the signal *propagate_in_X*, the connection with the **SM** is established. The connection is configured taking into account the signals *matrix_port_in_X* and *id_target_port_in_X*. Then the **PIM** activates the signal *lock_out_X*, and it goes to *idle* state.

The Configuration Phase that was started by the *target* goes backward over the path previously configured in the Search Phase until it arrives to the *source*. This process configures the multiplexers of the corresponding **SMs** to fix the path. The **SMs** that participate in this process are in the state *lock_component* and perform the following actions when the signal *lock_in* in the corresponding side is activated:

- If the *source_cell* is not in the cluster: the **SM** configures the port of the side where the *lock_in* signal was read taking into account the *origin_matrix* register and the *matrix_port* previously configured. The **SM** goes to *idle* state and the signal *lock_out* is activated in the side that indicates the register *origin_matrix*.

The next **SM** that receives the signal *lock_in* repeats the previous process again until the *source* is found, then the process continues as follows:

- If the *source* is a cell: when the *source_cell* is in the cluster, the **SM** configures the multiplexer related with the cell X (Mux Y from cell X) taking into account the *origin_cell* register and the

signals *id_source_port_in_X* and *matrix_port_in_X* previously configured. The **SM** activates the signal *lock_out_cell_X* and it goes to the *idle state*. Thereafter, the cell that receives the signal *lock_in_matrix* activates the signal *routing_complete* (shared by all **CUs**), and the “Expansion Process at Component Level” ends.

- If the *source* is a **PIM** (it includes the *source_pin*): the **PIM** configures the port taking into account the signals *id_source_port_in_X* and *matrix_port_in_X* previously configured. Thereafter, the **PIM** activates the signal *routing_complete* (shared by all **CUs**), and the “Expansion Process at Component Level” ends.

Figure 4.5 shows an example of the Search and Configuration Phases of the Expansion Process at Component Level. This example assumes that routing resources of all **SMS** are available. Step 1 to 5 represents the Search Phase, that starts from the *source_cell* propagating signals until finds the *target_cell*, then the Configuration phase starts (steps 6 to 10). Note that the distance between *source_cell* and *target_cell* is 19, however the connection is established through five routing resources (or multiplexers), four in **SMS** and one in *target_cell*, this resources are represented with the head of the arrows in step 10.

4.9 Self-Elimination and Self-Replication

The Static Fault Tolerance mechanism included in the system may require the execution of processes for elimination and replication of cells. This mechanism is a combination between the **Fault Tolerance System (FTS)** and the **SASM** instruction `ft_configuration`, which is used for configuring the cell or cells involved in the process. Note that previous to the elimination of a cell, all its connections must be derouted as detailed in section 4.11.

When a hardware failure is detected by the **FTS**, the damaged cell(s) request to the **C_μP** to execute the processes for self-eliminate and self-replicate the cell (or cells) involved in the failure. The **SASM** instruction `ft_configuration` executes the process as detailed in section 5.3.8. The cell data registers and its processing capacity is lost (probably corrupted). However, the routing resources and some adaptive capabilities of the cell (included in the **CCU**) are still working. This is due to routing resources of cell are independent of processing capabilities of cell, where the failure was detected. This means that the cell continues participating in the self-placement (as busy cell) and self-routing processes. This allows the interconnection of two distant cells in a component using the routing resources of a cell with damage in its **FU**.

4.9.1 Elimination of a Cell inside a Chip

The elimination of a cell is executed when the **GCU** sends the command *eliminate_cell_inet*. Then, the cell whose *address* matches with the *address* of frame executes the following actions:

1. Deletes the input and output connection tables.
2. Disables **FU** processors.
3. Deletes **FU** Program Memories.
4. Sets the cell as busy. Therefore, the cell will not participate in future self-placement process.
5. Sets the *address* as 0xFFFF0001. This is a special reserved address used for identification of cells that have been eliminated by the Static Fault Tolerance mechanism.

Subsequently, the cell sends the confirmation command *eliminate_cell_confirmation_inet* and the process ends.

4.10 Self-Configuration by means of Subprocesses

Any SANE application can be assumed to be a self-adaptive processing system with the MIMD architecture advantages, like multiple parallel processing [7]. The runtime self-configuration capability of the system is present when a SANE application requests the execution of at least one subprocess.

Any component in the system has the ability to start up to four subprocesses in execution time. The SASM instructions `start_subprocess_X` and `end_subprocess_X` are used for this purpose. Each subprocess may includes others SASM instructions like `create_component`, `connect_component` and `delete_component` among others, i.e., a subprocess could create, interconnect or delete components between others.

The creation and interconnection of components are capabilities that has been described in previous sections. The delete component capability will be detailed in the following section. Note that before deleting a component, all its connections must be derouted as detailed in section 4.11.

4.10.1 Delete a Component inside a Chip

The runtime Self-configuration mechanism included in the system may require to start a process for deleting components. The deletion of a component is executed when the GCU sends the command `delete_component_chip_inet`. Then, the cells whose `id_component` matches with the `id_component` included in the command execute the following actions:

1. Deletes the input and output connection tables.
2. Disables FU processors.
3. Deletes FU Program Memories.
4. Sets the cell as free. Therefore, the cell can participate in future self-placement process.
5. Sets the `address` as 0x00000000. This is a special reserved address used for identification of free cells.

Subsequently, the cells send the confirmation command `delete_component_confirmation_inet` and the process ends. Note that when a component is deleted, the cells that belonged to the component can participate in future self-placement and self-routing processes. The routing resources of cells that will be deleted in this process are not altered, i.e, if a connection between two cells crosses a cell that will be deleted, the connection remains configured after cell deletion.

4.11 Self-Derouting Process

The Self-derouting process permits to release all routing resources used to interconnect cells. This process can be executed for a single cell or a entire component. For cells, the process is executed taking into account the `address` of a specific cell (`cell_X`). For components, the process requires the identification of a component (`component_X`).

The self-derouting algorithm for a single cell is executed by the Static Fault Tolerance mechanism, before starting the processes for eliminating and replicating cells. The cell that will be eliminated is the `cell_X`. The algorithm permits to release all routing resources used to interconnect the `cell_X`, i.e., it permits to disconnect the `cell_X`.

The self-derouting algorithm for a entire component is executed when a component will be deleted, this is normally used by the runtime self-configuration mechanism by means of subprocesses in the high-level configuration file. The component that will be deleted is the `component_X`. The algorithm permits to release all routing resources used to interconnect the `component_X`, i.e., it allows to disconnect the `component_X`.

This process is divided in two parts. The first consists in locating the cells that have at least one connection with the *cell_X* or with the *component_X*. For this procedure, the **INET** is used. The second is the Release Process between the interconnected cells, i.e., the *source* and *target* of a connection. This process is executed for each connection with the *cell_X* or the *component_X*.

Unlike the expansion processes at cell or component level, the Release Process has only one phase, that goes from the *target* to the *source* of a connection. When a connection between components uses **PIMs**, the *source* of a connection can be a *source_cell* or a *source_pin*, whilst the *target* can be a *target_cell* or a *target_pin*. The Release Process is the same for *target_cell* or *target_pin*.

Sections **C.3.2**, **C.3.5** and **C.4.3** present the flow diagrams related with the release processes at cell and component level. Note that the **CCU** in the *target_cell* and **CCU** in the *source_cell* (for presented flow diagrams) are the start and end point of the process respectively.

4.11.1 Cell Selection for Derouting Process of a Single Cell

The process is described below:

1. The **GCU** starts the self-derouting process sending the command *delete_cell_connections_chip_inet* with the *address* of *cell_X* as argument.
2. The cells look up their input connections table. The *cell_X* and the cells that have at least one input connection with the *cell_X* participate in an elimination process, where the leftmost uppermost cell will be the winner, which will be the *target* for the Release Process. If there is not a winner cell, there are no more connections with *cell_X*, the process ends and the **GCU** receives the command *delete_cell_connections_confirmation_inet*.
3. The winner cell (*target*) starts the “Release Process” for disconnecting all its input connections with the *cell_X*. If the winner is the *cell_X*, this starts the “Release Process” for disconnecting all its inputs connections with other cells.
4. When the winner cell ends looking up its inputs connections table, this sends the command *delete_cell_connections_chip_inet* with the *address* of *cell_X* as argument and the process is repeated again from step 2.

4.11.2 Cell Selection for Derouting Process of a Entire Component

The process is described below:

1. The **GCU** starts the self-derouting process sending the command *delete_components_connections_chip_inet* with the identifier of *component_X* as argument (*id_component*).
2. The cells look up their input connections table. The cells that belongs to the *component_X*, and the cells that have at least one input connection with the *component_X* participates in an elimination process, where the leftmost uppermost cell will be the winner, which will be the *target* for the “Release Process”. If there is not a winner cell, there are no more connections with *component_X*, the process ends and the **GCU** receives the command *delete_components_connections_confirmation_inet*.
3. The winner cell (*target*) starts the “Release Process” for disconnecting all its input connections with the *component_X*. If the winner cell belongs to the *component_X*, this starts the “Release Process” for disconnecting all its inputs.

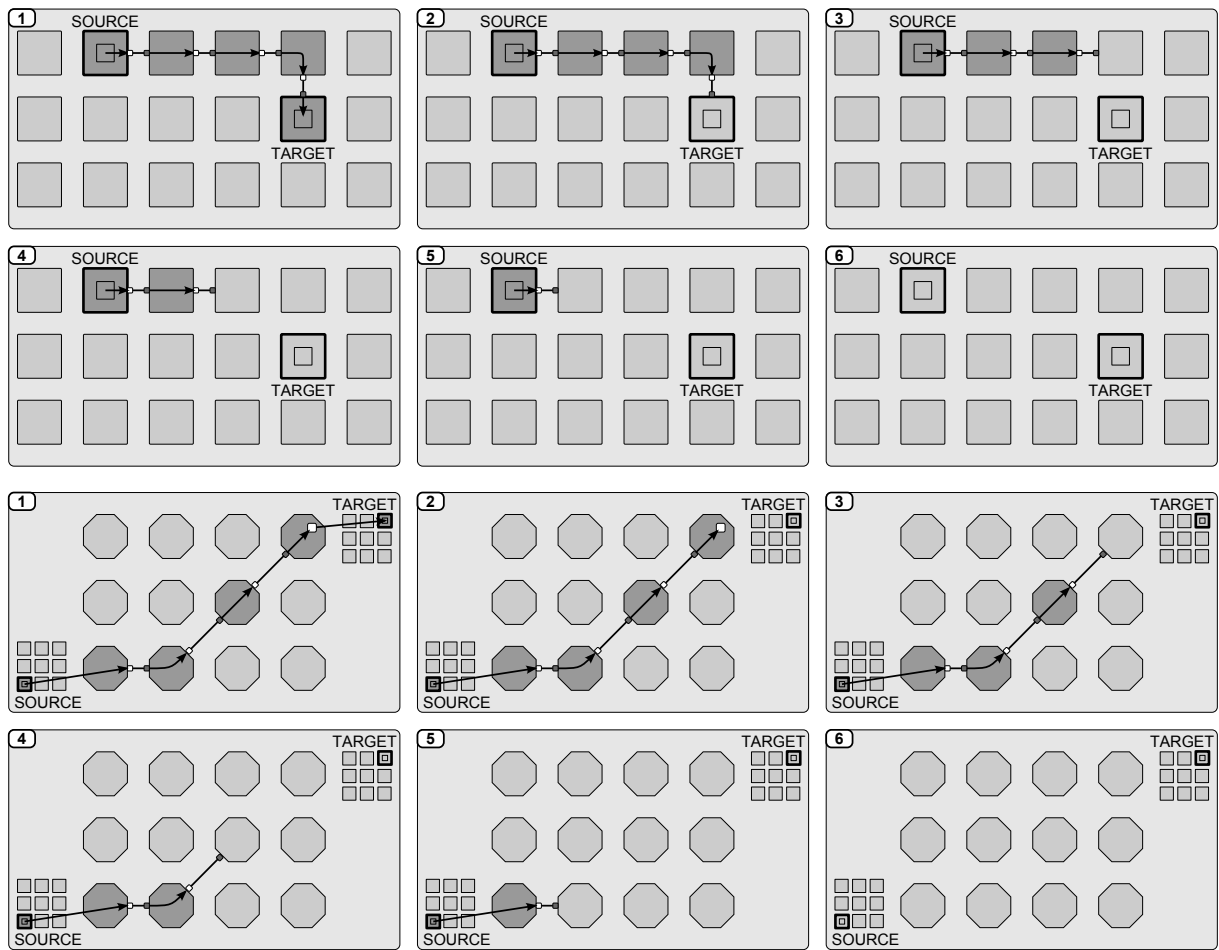


Figure 4.6: Example of Release Process at Cell and Component Level.

4. When the winner cell ends looking its input connections table, this sends the command `delete_component_connections_chip_inet` with the identifier of `component_X` as argument (`id_component`) and the process is repeated again from step 2.

4.11.3 Release Process

This process releases the routing resources used for a interconnection between cells, or between a cell and a PIM. In this process, the multiplexers of cells, SMs and PIMs are dynamically released to disconnect the desired ports. If the connection is at cell level, the multiplexers of FU inputs, local and remote cell ports are released. If the connection is at component level, the multiplexers of FU inputs, SMs and PIMs are released. Figure 4.6 shows an example of the Release Process at cell and component level.

For this process some bits of the expansion ports are used (see section 2.10 for details). The signals that participate in this process are explained in Table 4.3.

The Release Process has only one phase, that goes from the *target* to the *source* of a connection. When a connection between components use PIMs, the *source* of a connection could be a *source_cell* or a *source_pin*, whilst the *target* could be a *target_cell* or a *target_pin*. The Release Process is the same for *target_cell* or *target_pin*, so the following procedures assume the *source* and *target* as cells. Once the FU input port of the *target_cell* is selected, the release process starts, configuring the multiplexers to their initial state.

Signal name	Description
<i>del_connection_out_X</i> (cell, SM) <i>del_connection_out_cell_X</i> <i>del_connection_out_matrix</i> <i>del_connection_out_cell</i>	Used to indicate the port that must be released. The signal used is propagated only in one side of the cell or SM.
<i>neighbor_out_X</i> <i>neighbor_in_X</i>	Used to indicate that the connection is with a local port.
<i>local_port_out_X</i> <i>local_port_in_X</i> <i>remote_port_out_X</i> <i>remote_port_in_X</i>	Used to indicate the local or remote cell port that was used to configure the path.
<i>matrix_port_out_X</i> <i>matrix_port_in_X</i>	Used to indicate the SM port that was used to configure the path.
<i>id_source_port_out</i> <i>id_source_port_in_X</i>	Used to indicate to SM the FU input port that was used to configure the path.

Table 4.3: Description of expansion port signals used by the Release Process.

The Release Process starts from the FU input port of the *target_cell* and go backwards to the origin of a connection, i.e., the FU output port of the *source_cell*. This process reads the multiplexers configuration and propagate the signal *del_connection_out_X* in the direction where the connection was previously established by Expansion Process. The process is described below:

- 1 The *target_cell* reads the configuration of the FU input port multiplexer selected for the Release Process and performs one of the following actions:
 - ▶ If the FU input port is connected to a local port, the *target_cell* propagates the signal *del_connection_out_X* in the side where the connection was established. It also propagates the signals *neighbor_out_X* and *local_port_out_X* that permits to the neighboring cell to identify the local port used for a connection.
 - ▶ If the FU input port is connected to a remote port, the *target_cell* propagates the signal *del_connection_out_X* in the side where the connection was established. It also propagates the signal *remote_port_out_X* that permits to the neighboring cell to identify the remote port used for a connection.
 - ▶ If the FU input port is connected to SM, the *target_cell* propagates the signal *del_connection_out_matrix*. It also propagates the signal *id_source_port_out* that permits to the matrix to identify the multiplexer used for a connection.
- 2 The *target_cell* releases the FU input port multiplexer, and goes to *idle* state.
- 3 The process continues at cell level or component level as follows:
 - a. At cell level: when a cell receives the signal *del_connection_in_X* proceeds as follows:
 - i. If the signal *neighbor_in_X* is received: it confirms that this cell is the origin of a connection, the local port multiplexer is released and the process ends.
 - ii. If the remote port is connected to a FU output port of the cell: it confirms that this cell is the origin of a connection, the remote port multiplexer is released and the process ends.

- iii. If the remote port is connected to another remote port: the cell propagates the signal *del_connection_out_X* in the side where the connection was established. It also propagates the signal *remote_port_out_X* that permits to the neighboring cell to identify the remote port used for a connection. The process continues from a.
- b. At component level: when a SM receives the signal *del_connection_in_cell_X*:
 - i. If the SM multiplexer is connected to a cell: it confirms that this cell is the origin of a connection. The SM propagates the signal *del_connection_out_cell_X*, the SM multiplexer is released and the process is finalized by the cell.
 - ii. If the SM multiplexer is connected to a SM port. The SM propagates the signal *del_connection_out_X* in the side where the connection was established. It also propagates the signal *matrix_port_out_X* that permits to the neighboring SM to identify the port used for a connection. The process continues from b.

When the process is completed, the *source* activates the signal *routing_complete* (shared by all CUs), and the “Release Process” ends. It is important to mention that busy cells also participate in the Release Process since the connections can also cross busy cells. Nevertheless, this process is completely transparent to the internal cell operation since it is executed using dedicated resources, at the routing layer.

4.12 Conclusions

This chapter describes the self-adaptive processes implemented in the system. The algorithms presented are the base for the implementation of the high-level instructions in system. These algorithms are implemented in the Configuration Units of Cells, Switch and Pin interconnection Matrices.

The self-placement algorithm is responsible for finding out the most suitable position to insert the new cell of a component. For the placement of the first cell of a component, a particular procedure is used, different from other cells. In this case, a good candidate position is defined as one where a free cell has low routing congestion and the largest number of free neighboring cells. After the insertion of the component first cell, the next cells to be inserted are placed as close as possible to the cell with the largest number of connections with the new cell.

The self-routing algorithm allows interconnecting the Functional Unit ports of two cells. This process can be executed at cell or component level. The self-routing process at cell level is executed since the insertion of the second cell of a component, each time that the self-placement process ends. The algorithm allows interconnecting the ports of the functional unit of two cells, in the same component, through the local and remote cell ports. After the insertion of all components, the self-routing process at component level can be executed. This algorithm implements the interconnection of two cells belonging to different components through Switch and Pin Interconnection Matrices.

The self-derouting process permits to release all routing resources used for interconnect cells or component. This process can be executed for a single cell or a entire component. For this purpose, the Release Process is implemented. This process releases the routing resources (multiplexers) used for a interconnection between cells.

The elimination of a single cell and the deletion of a entire component are processes used by the runtime self-configuration capabilities included in the system: (1) the Static Fault Tolerance mechanism is able to execute the self-replication and self-elimination of cells, and, (2) the dynamic reconfiguration by means of subprocess can execute the creation, connection and deletion of components, among others.

Chapter 5

Development and Implementation of Self-adaptive Applications with Parallel Processing Capabilities.

*Being honest may not get you a lot of friends but
it'll always get you the right ones.*

*Ser honesto puede que no te dé muchos amigos, pero
te dará los amigos adecuados.*

John Lennon (1940 – 1980)

Abstract: This chapter presents the main features for the creation of the [SANE Assembler \(SASM\)](#) configuration file, which is used for configuring any [SANE-ASM](#) application that could be implemented by a user. Consequently, a detailed description of format and syntax of [SASM](#) instructions is presented. Additionally, two application examples with “Dynamic” and “Static” Fault Tolerance capabilities are presented. This chapter is complemented with the appendixes [D](#) and [E](#), which respectively present the generalities of the software tool implemented for configuring applications, and the listings of the application examples described in this chapter.

5.1 SANE ASSEMBLY Development System

One of the main inconveniences in the design phase of the architecture was the creation of applications that permit to test the system. This process consisted in the creation of a [SANE ASSEMBLY \(SANE-ASM\)](#), that includes a specific number of interconnected components, and interconnected cells inside each component. This functionality involved, for each cell in the application, the creation of inputs and outputs connection tables, the configuration of special registers, and the generation of hexadecimal instructions code for each processor (between 1 and 4 per cell) from programs written in the native assembler language created for the [Functional Unit \(FU\)](#) ([Appendix A](#)). Any modification in the application implies a lot of time rewriting the data for its configuration. Similar to any commercial general purpose device a software tool is fundamental for improving the capacity of a designer when developing applications.

The [SANE Project Developer \(SPD\)](#) is an Integrated Development Environment (IDE) that allows generating the memory initialization data for the [Control Microprocessor \(CμP\)](#) inside the prototype. The [SPD](#) allows the creation and edition of files that describe the configuration

of a **SANE-ASM**. This file includes high-level instructions that are defined as **SANE Assembler (SASM)** instructions. The file that includes these instructions is called the **SASM** file.

The **SPD** allows the insertion and edition of all related information of the **SANE-ASM**, this involves the configuration of the following parameters: *i*) the identification number of cells and components; *ii*) the configuration registers; *iii*) the input and output connection tables; *iv*) text descriptions of cells and components; *v*) text aliases for cells; and *vi*) creation and edition of **Assembler (ASM)** and **SASM** files. For writing the Program Memories of the processors, **ASM** files will be created, this permits to execute the functionality of a processor in the cell.

The **SPD** supports building of the hexadecimal files (**SHEX** and **SXM**) with the configuration of the **SANE-ASM** that will be implemented in the FPGA. This process includes the compilation of the files involved in the process according to the **SASM** file. The **SPD** generates a list of errors, warnings and infos for all files involved in the building process and guides the user to make the appropriate corrections if required. The **SPD** also supports the compilation of individual **ASM** files.

Appendix **D** shows a general description of the **SANE Project Developer (SPD)**.

5.2 Overview for the Configuration of an Application

Any application scheduled to the **SANE-ASM** has to be organized in components, where each component is composed by one or more interconnected cells. The interconnection of cells inside of a component is made at cell level, while the physical interconnections of components are made in another layer, at the **Switch Matrix (SM)** level. The connections between components can be inside a chip or may span several chips. The interconnection of **SANEs** is just conceptual, because it takes place at the same layer of components.

Once the application has been defined and the components are ready for implementation, the main configuration file has to be created. This includes a sequence of high-level instructions and their corresponding data arguments relative to the application. The high-level instructions are called the **SANE Assembler (SASM)** instructions and are included in the **SASM** file (***.SASM** file).

The **Control Microprocessor (CμP)**¹ is responsible for implementing the main configuration file that includes the **SASM** instructions for the configuration and execution of system functionality, even during runtime. This program is stored in a section of memory dedicated to this purpose. The **CμP** is able to execute the instructions shown in Table 5.1. Note that each instruction has assigned a unique identifier or Instruction Code (IC). Additionally, these instructions may or may not include other words in memory concerning to the execution of the instruction (arguments), as detailed in following sections.

The **CμP** executes sequentially the main program starting with the first word stored in memory, which is interpreted as a instruction. Afterwards, each word read is interpreted according to the instruction format, i.e, a word in memory could be interpreted as a **SASM** instruction or an argument related with an instruction. The instructions format is detailed in Section 5.3. The **CμP** includes a *pointer* that permits to read sequentially each word in memory. The **CμP** also includes a *stack* that stores temporally the value of the *pointer* when some special instructions call for it.

The algorithms for the execution of **SASM** instructions may require that **CμP** sends through the **External Network (ENET)** frames to Global Configuration Units (**GCU**s), which are responsible for controlling the self-adaptive processes inside the chips. A specific protocol is used for this purpose. Then, the chips start a negotiation process to establish the chip that has to start the

¹The **CμP** replaces the **External Controller (EC)** in prototype.

Instructions	IC	Context
create_component connect_components delete_component	0x00 0x01 0x02	Create, interconnect or delete components in order to built dynamically a SANE that best fits the applications goals.
write_fu_memory_cr write_fu_memory_pm0 write_fu_memory_pm1 write_fu_memory_pm2 write_fu_memory_pm3	0x03 0x04 0x05 0x06 0x07	Write configuration registers and memories of processors in the Functional Unit (FU) of the Cell, in order to configure the configuration registers and the application of their processors.
restart_processors disable_processors restart_and_disable_processors enable_processors	0x08 0x09 0x0A 0x0B	Manipulation of program counters of the FU processors in order to restart, disable and enable the processors of the cells.
wait restart_processors_wait enable_processors_wait	0x0C 0x0D 0x0E	Manipulation of program counters of FU processors, and to set the system in <i>wait</i> mode for SANE requirements like execution of subprocesses or the Static Fault Tolerance mechanism.
end	0x0F	End of SANE-ASM configuration
start_subprocess_0 end_subprocess_0 start_subprocess_1 end_subprocess_1 start_subprocess_2 end_subprocess_2 start_subprocess_3 end_subprocess_3	0x10 0x11 0x12 0x13 0x14 0x15 0x16 0x17	Denotes the start and end of a subprocess.
ft_configuration	0x18	Configuration of original and redundant cells for static fault tolerance.

IC = Instruction Code

Note = The arguments of the instructions are not shown in this table.

Table 5.1: List of SASM or high-level instructions for initial and run-time configuration.

process to execute the command. This depends of a priority order assigned to the chips, and the utilization rate inside every chip. The selection process uses the circuit presented in Figure 2.3b.

Remember that **ENET** allows to interconnect the **C_μP** with the chips by means of its **GCU**. Similarly, the **Internal Network (INET)** connects the Configuration Units (**CUs**) inside the chips, it includes the **GCU**, the Cell Configuration Units (**CCUs**) and the Pin Interconnection Matrix Configuration Units (**PIMCUs**). These networks give support to all self-adaptive process in the system. The sections 2.12 and 2.13 show details about the protocols implemented for **INET** and **ENET** respectively.

For the execution of the self-adaptive capabilities, the **C_μP**, the **GCU**s and the **CU**s inside the chips implement low-level commands relative to the specific algorithm needed for the execution of these instructions. These commands are included in frames that go through the **ENET** and the **INET**. The description of **SASM** instructions in following sections include the terms “*enet*” and “*inet*”, which are used to discriminate the network by which the command (or process requested) is included.

5.3 Description of SASM Instructions

The SASM instructions that C_μP is able to execute are shown in Table 5.1. Note that all instructions in this table have an equivalent instruction for the implementation of the main configuration file in the SPD. However, the SPD includes an additional instruction called `write_FU_memory`, which automatically includes the instructions of the table that are related with writing the FU memory (`write_FU_memory_XXX`) for a specific cell.

The following sections present a detailed description of the SASM instructions included in system. Each section presents one or more instructions depending on the context. Note that each section presents a table that shows the instruction syntax related with the SPD and the instruction format that must be included in the corresponding memory section in C_μP. The **Built Project** option in SPD compiles the main configuration file included in the SASM file (`*.sasm`), as well as all ASM files (`*.asm`) that includes the task scheduled for processors in cells. The result is the creation of two files. The first is the SHEX file (`*.shex`), which includes the instructions format shown in following sections. The other is the SXM file (`*.sxm`), which is a representation of the hexadecimal value that will be downloaded to the C_μP in prototype using the **Write Memory** option in the SPD.

5.3.1 Creation of Components

The SASM instruction `create_component` is used for the creation of new components in the system. Table 5.2 shows its syntax and instruction format. Note that each word of the input/output connection table is 37-bit width, therefore it is implemented in two memory positions in C_μP. The eight words of the input connection table will be included in memory, whilst the number of outputs could be between 0 and 20.

SPD Syntax and arguments	<code>create_component</code>	<code>id_component</code>
Instruction format in C _μ P memory	<code>create_component_IC,</code> <code>id_component,</code> <code>comp_cells_number,</code> <code>num_outputs_cell_1,</code> <code>address_cell_1</code> <code>0x00,</code> <code>0x00000000,</code> <code>...</code> <code>0x00,</code> <code>0x00000000,</code> <code>...</code> <code>...</code> <code>num_outputs_cell_2,</code> <code>address_cell_2,</code> <code>...</code> <code>...</code>	<code>//Start the creation of a component</code> <code>//16-bit component identifier</code> <code>//Zero-based num cells in component</code> <code>//Number of outputs cell_1 (0 to 20)</code> <code>//32-bit address, first cell in component</code> <code>//bits(36:32) connection table for IN0</code> <code>//bits(31:0) connection table for IN0</code> <code>...</code> <code>//similar for IN1...IN3, FT_IN0...FT_IN3</code> <code>//bits(36:32) Output connection table #1</code> <code>//bits(31:0) Output connection table #1</code> <code>...</code> <code>//similar for other outputs depending on</code> <code>//num_outputs value (0 to 20 outputs)</code> <code>//Number of outputs cell_2 (0 to 20)</code> <code>//32-bit address of second cell</code> <code>...</code> <code>//input/output connection tables, cell_2</code> <code>...</code> <code>//similar for other cells in component</code>

Table 5.2: Syntax and format for `create_component` instruction.

When the C_μP executes the `create_component` instruction, it follows the next steps:

1. The C_μP sends a message to the GCUs (chips) with a command and the value relative to the number of cells in the component (`cell_number_new_component_enet + comp_cells_number`).

2. Each **GCU** calculates if the component fits into the chip. The **GCU** knows the number of busy cells in the chip and the number of cells of the new component. If the chip has the capacity to insert the new component, it participates in the selection process.
3. The **CμP** starts the selection process using the command *start_contest_winner_chip_enet*. This determines which chip should make the placement of the new component. If there is not a winner chip, the **CμP** shows an error message and the process ends (system full).
4. The **CμP** sends to chips commands that start a specific process for the insertion of a new cell. Thereafter, the **CμP** waits for a confirmation command and continues with the next cell, as follows:
 - a. First cell: The **CμP** sends the command and arguments: *insert_first_cell_enet + address + connection_tables*. The **GCU** of the winner chip translates the command *insert_first_cell_enet* to the *insert_first_cell_inet* and broadcasts the message inside the chip. The algorithm “**Self-placement of the first cell of a component**” is executed (Section 4.5.1). When the process ends the **GCU** receives the command *end_first_cell_inet*, which is translated and sent to the **CμP** as *end_first_cell_enet*. The **CμP** continues with the next cell.
 - b. Other cells: The **CμP** sends the command and arguments: *insert_other_cell_enet + address + connection_tables*. The **GCU** of the winner chip translates the command *insert_other_cell_enet* to *insert_other_cell_inet* and broadcasts the message inside the chip. The algorithms “**Self-placement of other cells of a component**” and “**Self-routing at cell level**” are executed (Sections 4.5.2 and 4.7). When the process ends the **GCU** receives the command *end_other_cell_inet*, which is translated and sent to the **CμP** as *end_other_cell_enet*. The **CμP** continues with the next cell.
5. When the self-placement and self-routing processes for all cells of a component have finalized, the **CμP** continues with the next **SASM** instruction.

Each time that a cell is inserted, the **GCU** of the chip sets to high two flags: *components_connection_enable* and *delete_components_or_cells_enable*. These flags are used for instructions **connect_component**, **delete_component** and **ft_configuration** to indicate that a chip is able to connect components, delete components and eliminate cells respectively.

5.3.2 Connection of Components

After creation of all components in a **SANE-ASM**, the **SASM** instruction **connect_component** must be executed. This instruction permits to interconnect all components, i.e., performs the interconnection of cells at component level through Switch Matrices (**SMs**). This command does not include arguments. Table 5.3 shows their syntax and instruction format.

SPD Syntax and arguments	<code>connect_component</code>
Instruction format in CμP memory	<code>connect_component_IC, //Interconnecting cells at component level</code>

Table 5.3: Syntax and format for **connect_component** instruction

Each time that a cell has been inserted inside a chip using the instruction **create_component**, the **GCU** sets to high the flag *components_connection_enable*. This flag indicates to the chip that

it is able to execute the algorithm related with the components connection: “**Self-Routing at Component Level**” (Section 4.8)

For the understanding of the following steps, let us assume that in at least two chips in system have been inserted new components, i.e, these chips have the flag *components_connection_enable* activated.

1. The **C_μP** sends a message to the **GCU**s (chips) with the command *autoset_for_components_connection_enet*. Each **GCU** that has active the flag *components_connection_enable* is enabled to participate in the selection process.
2. The **C_μP** starts the selection process using the command *start_contest_winner_chip_enet*. This determines which chip will start the algorithm. If there is not a winner chip the process ends, therefore the **C_μP** executes the next **SASM** instruction.
3. The **C_μP** sends to chips the command *start_components_connection_enet*. The winner chip translates and broadcasts the command inside the chip: *start_components_connection_inet*. The winner chip executes the “**Self-Routing at Component Level**” algorithm (Section 4.8). It goes through the output connection tables of cells inside the chip and performs all possible interconnections at component level.
4. When there are no more possible connections at component level for the winner chip, the flag *components_connection_enable* is cleared. This chip will not participate in future selection process. The **GCU** receives the command *end_components_connection_inet*, which is translated and sent to **C_μP** using the command *end_components_connection_enet*. The **C_μP** repeats the process from step 1. until all connections at component level will be performed. Note that loop is broken in step 2.

5.3.3 Delete Components

The **SASM** instruction `delete_component` is implemented when the deletion of a component is required. This is useful for runtime self-configuration, where the dynamic creation and deletion of components could be required by subprocesses. Table 5.4 presents their syntax and instruction format. This instruction requires the component identifier as argument (*id_component*).

SPD Syntax and arguments	<code>delete_component</code>	<code>id_component</code>
Instruction format in C_μP memory	<code>connect_component_IC,</code> <code>id_component,</code>	<code>//Start process to delete a component</code> <code>//16-bit component identifier</code>

Table 5.4: Syntax and format for `delete_component` instruction

Each time that a cell has been inserted inside a chip using the instruction `create_component`, the **GCU** sets to high the flag *delete_component_or_cell_enable*. This flag indicates to the chip that it is able to execute the algorithms related with the component deletion: “**Self-DeRouting Process**” and “**Delete a Component inside a Chip**” (Sections 4.11 and 4.10.1).

For the understanding of the following steps, lets assume that in at least two chips in system has been inserted new components, i.e, these chips has the flag *delete_component_or_cell_enable* activated. When the **C_μP** executes this instruction, it follows the next steps.

1. The **C_μP** sends a message to the **GCU**s (chips) with the command *autoset_for_delete_connections_enet*. Each **GCU** that has active the flag *delete_component_or_cell_enable* is enabled to participate in the selection process.

2. The C_μP starts the selection process using the command *start_contest_winner_chip_enet*. This determines the chip that will execute the algorithm to disconnect the component. If there is a winner chip, goto next step. If there is not a winner chip goto step 5.
3. The C_μP sends to chips the command *delete_component_connections_chip_enet*. The winner chip translates and broadcasts the command inside the chip: *delete_component_connections_chip_inet*. The winner chip executes the “**Self-Derouting Process**” (Section 4.11). It goes through the input connection tables of cells inside the chip and releases all routing resources related with the interconnection of a specific component.
4. When all connections of a component have been released for the winner chip the flag *delete_component_or_cell_enable* is cleared. In this case, The chip will not participate in future selection process. The GCU receives the command *delete_components_connection_confirmation_inet*, which is translated and sent to C_μP using the command *delete_component_connections_confirmation_enet*. The C_μP repeats the process from step 1. until all connections of a component are released. Note that loop is broken in step 2.
5. The C_μP sends a frame with the information of the component to delete: *delete_component_chip_enet + id_component*. The GCUs broadcast the frame internally, the chip that includes the component executes the algorithm “**Delete a Component inside a Chip**” (Section 4.10.1). The chips that have at least one component activate the flag *delete_component_or_cell_enable* for future deletion processes. The appropriate confirmation command is sent to the GCU, which translates and transmits the command to the C_μP and the process ends. Therefore, the C_μP will be able to execute the next SASM instruction.

5.3.4 Write Functional Unit Program Memories and Configuration Registers

The **Functional Unit (FU)** of each cell includes four cores (CORE0 to CORE3), which can be configured to build between one to four processors as detailed in section 3.3. Each core includes a Program Memory that is identified with the same numeric order of the core (PM0, PM1, PM2 and PM3). Therefore, the SASM instructions *write_FU_memory_PM0*, *write_FU_memory_PM1*, *write_FU_memory_PM2* and *write_FU_memory_PM3* are used for writing the Program Memory of the correspondent core. Note that depending on the cell configuration mode, the PMX may or may not correspond with the processor PX. For example in mode 0, there are four processors (P0 to P3) with 64 instructions capacity each; it corresponds with the PM of each core (PM0 to PM3). In mode 4, there is only one processor (P0) with 256 instructions capacity, which requires the concatenation of the PMs of all cores.

The FU includes some configuration registers (CRs), which could be written similarly to Program Memories since they are mapped in memory. These registers are: MODE, FAMILY, PORTS and FTCSR. The SASM instruction *write_FU_memory_CR* is used for this purpose. Table 5.5 shows the syntax and instructions format of these instructions, which requires the *address* of cell as argument.

It is important to note, that SPD includes an additional instruction called *write_FU_memory*, which automatically includes the instructions of the table that are related with writing the FU memory (*write_FU_memory_XXX*) for a specific cell. The SPD performs this action by reading the MODE register and the ASM files associated with the processors of cells. This instruction permits to reduce the length of the SASM file when multiple *write_FU_memory_XXX* instructions must be used.

The execution of these instructions is similar, so it will be explained jointly. However, note that each instruction is executed independently. The C_μP executes these instructions as follows:

SPD Syntax and arguments	<pre> write_FU_memory_CR address write_FU_memory_PM0 address write_FU_memory_PM1 address write_FU_memory_PM2 address write_FU_memory_PM3 address write_FU_memory address¹ </pre>
Instruction format in C _μ P memory	<pre> write_FU_memory_CR_IC, //Write Configuration Registers address, //32-bit address of cell 0x04, //number of registers to write 0x00, //data for MODE register 0x00, //data for FAMILY register 0x00, //data for PORTS register 0x00, //data for FTCSR register </pre>
	<pre> write_FU_memory_PMX_IC, //Write Program Memory [0,1,2,3] address, //32-bit address of cell asm_instructions_number, //Y number of asm instructions (1-64) 0x00000000, //asm instruction 1 0x00000000, //asm instruction 2 ... // 0x00000000, //asm instruction Y </pre>

¹ Instruction of the SPD that automatically includes other *write_FU_memory_XXX* instructions for a specific cell; it depends on the configuration mode and the length of the assembler code(s) for the processor(s) in the cell.

Table 5.5: Syntax and format for instruction related to writing Function Unit Program Memories and Configuration Register

1. The C_μP sends a message to the GCUs (chips) with the *address* of the cell to which the data is directed: *set_address_program_memory_enet + address*.
2. The C_μP sends a message to the GCUs (chips) with the data as follows:
 - ▶ To write PM0: *write_program_memory0_enet + data for PM0*.
 - ▶ To write PM1: *write_program_memory1_enet + data for PM1*.
 - ▶ To write PM2: *write_program_memory2_enet + data for PM2*.
 - ▶ To write PM3: *write_program_memory3_enet + data for PM3*.
 - ▶ To write CRs: *write_configuration_registers_enet + data for CRs*.
3. The GCU of each chip translates the command from ENET to INET and broadcasts the information internally as follows:
 - ▶ To write PM0: *write_program_memory0_inet + address + data for PM0*.
 - ▶ To write PM1: *write_program_memory1_inet + address + data for PM1*.
 - ▶ To write PM2: *write_program_memory2_inet + address + data for PM2*.
 - ▶ To write PM3: *write_program_memory3_inet + address + data for PM3*.
 - ▶ To write CRs: *write_configuration_registers_inet + address + data for CRs*.
4. The cell whose *address* matches with the *address* of the frame performs the write operation of the data frame to FU program memory or Configuration Registers. This cell sends the appropriate confirmation command to the GCU, which translates and transmits the command to the C_μP and the process ends. The C_μP starts the execution of the next SASM instruction.

SPD Syntax and arguments	<code>restart_processors</code> <code>disable_processors</code> <code>restart_and_disable_processors</code> <code>enable_processors</code>
Instruction format in C _μ P memory	<code>restart_processors_IC,</code> //Restart all processors
	<code>disable_processors_IC,</code> //Disable all processors
	<code>restart_and_disable_processors_IC,</code> //Restart & disable all proc...
	<code>enable_processors_IC,</code> //Enable all processors

Table 5.6: Syntax and format for instructions related to management of processors in the SASM file.

5.3.5 Restart, Enable and Disable Processors

The initial state of all processors in system is disabled. The processors of a specific cell are enabled automatically when any instruction that write the FU memory is executed (`write_FU_memory_XXX`). The SASM instructions presented in Table 5.6 permit to restart, disable or enable all processors in system.

The instruction `restart_processors` could be used to restart the processors after the configuration of a SANE-ASM. Therefore, all processors restart the execution of their scheduled process at the same time. The threads start their execution from origin 0x0.

The instruction `disable_processors` is used to disable the execution of processors in system. This could be implemented before the execution of other SASM instructions to ensure that processors do not executes an undesirable action, e.g., if a processor executes a subprocess before the configuration of the entire SANE-ASM, or, if the user wants to disable processors whilst the execution of a subprocess.

The instruction `restart_and_disable_processors` is similar to `disable_processors`. Additionally, this instruction permits to restart the processors in system at the same time that they are disabled. The threads start their execution from origin 0x0 when they are enabled again.

The instruction `enable_processors` is used to enable the execution of threads in the FU processors. The threads start their execution from origin 0x0 or any other, depending on previous instruction used (`restart_and_disable_processors` or `disable_processors`).

The execution of these instructions is similar, therefore it will be explained jointly. However, note that each instruction is executed independently as presented bellow:

- The C_μP sends a frame to the GCUs with the corresponding command:
 - ▶ To restart the processors: `restart_processors_enet`
 - ▶ To disable the processors: `disable_processors_enet`
 - ▶ To restart and disable the processors: `restart_and_disable_processors_enet`
 - ▶ To enable the processors: `enable_processors_enet`
- The GCU of each chip translates the command from ENET to INET and broadcasts the information internally as follows:
 - ▶ To restart the processors: `restart_processors_inet`
 - ▶ To disable the processors: `disable_processors_inet`
 - ▶ To restart and disable the processors: `restart_and_disable_processors_inet`
 - ▶ To enable the processors: `enable_processors_inet`
- The cells perform the appropriate operation for the FU processors. These instructions do not send any confirmation command, therefore the C_μP may continue with the next instruction.

5.3.6 System in “Wait” State for Runtime Self-configuration

Remember that runtime Self-configuration is possible when the Static Fault Tolerance mechanism or when the execution of subprocesses are included in the SASM file. Therefore, when the system requires the execution of one of these features, the C_μP must be in a special state, where it waits for an event coming from any cell in the system, which requests the execution of special SASM instructions: `ft_configuration`, `start_subprocess_X` and `end_subprocess_X`. This special state is called “*wait*” state, and it is included in the instructions presented in Table 5.7. Note that some of the instructions presented include additional functionalities like the option to restart or enable the processor in system, which were described in the previous section.

SPD Syntax and arguments	<code>wait</code> <code>restart_processors_wait</code> <code>enable_processors_wait</code>
Instruction format in C _μ P memory	<code>wait_IC, //CMP goto wait state: CMP->wait</code>
	<code>restart_processors_wait_IC, //CMP->wait, processors are restarted</code>
	<code>enable_processors_wait_IC, //CMP->wait, processors are enabled</code>

Table 5.7: Syntax and format for instruction regarding configuration of system in “*wait*” state.

The execution of these instructions is similar, therefore it will be explained jointly. However, note that each instruction is executed independently as follows:

1. The C_μP stores the position where the pointer is located ($stack \leftarrow pointer$). Afterwards, the C_μP sends a frame to the GCUs with the corresponding command:
 - ▶ Only for *wait* state: *wait_enet*.
 - ▶ For *wait* state and restart processors: *restart_processors_wait_enet*.
 - ▶ For *wait* state and enable processors: *enable_processors_wait_enet*.
2. The C_μP goes to *wait* state. The C_μP waits for an event (or request) coming from any cell in system (this request implies the runtime self-configuration, which could be for the execution of a subprocess using the instructions `start_subprocess_X` and `end_subprocess_X`, or for the execution of a process to replicate and eliminate cells using the instruction `ft_configuration`).
3. The GCU of each chip translates the command form `ENET` to `INET` and broadcasts the information internally as follows:
 - ▶ Only for *wait* state: *wait_inet*.
 - ▶ For *wait* state and restart processors: *restart_processors_wait_inet*.
 - ▶ For *wait* state and enable processors: *enable_processors_wait_inet*.
4. The cells in the system sets to high the bit *System Wait State*, which belongs to the register SUBPCSR (this register is closely tied with the execution of subprocesses). Each cell performs the corresponding action as follows:
 - ▶ Only for *wait* state: the cells goes to *standby* state.
 - ▶ For *wait* state and restart processors: the cells restart their processors and goes to *standby* state.
 - ▶ For *wait* state and enable processors: the cells enable their processors and goes to *standby* state.
5. The processors continue (or restart) the execution of their scheduled task.

Afterwards, any cell in the state *standby* (current) could make a request for starting any of the following process: (i) Start a dynamic reconfiguration of the system by means of subprocesses. (Section 5.3.7) (ii) Start the self-elimination and self-replication of cell(s) when a failure is detected by the Fault Tolerance System (FTS). (Section 5.3.8).

5.3.7 Runtime Self-configuration by means of Subprocesses

Table 5.5 shows the syntax and instructions format for execution of subprocesses. The instructions `start_subprocess_X` and `end_subprocess_X` permit to group other **SASM** instructions within them, which will be executed when any cell in system requests it. This cell must be properly configured for this purpose. Note that `start_subprocess_X` instruction requires the component identifier as argument. It is not permitted to include a subprocess between other subprocess, neither to include the configuration of a static Fault Tolerance mechanism (`ft_configuration` instruction) inside a subprocess.

SPD Syntax and arguments	<code>start_subprocess_X</code> ¹ ... <code>end_subprocess_X</code> ²	<code>id_component</code>
Instruction format in C _μ P memory	<code>start_subprocess_X_IC,</code> <code>id_component,</code> ... <code>end_subprocess_X_IC,</code>	//Start subprocess X //16-bit <code>id_component</code> for subprocess X //SASM instructions //end of subprocess X

¹ `start_subprocess_0`, `start_subprocess_1`, `start_subprocess_2` or `start_subprocess_3`.

² `end_subprocess_0`, `end_subprocess_1`, `end_subprocess_2` or `end_subprocess_3`.

Table 5.8: Syntax and format for instruction related with execution of subprocesses.

In the initial configuration or when the system is not in *wait* state, the instructions related with a subprocess are ignored, this condition includes the instructions inside the subprocess.

The runtime self-configuration mechanism by means of subprocesses is closely tied with the execution of the following instructions: *i*) `wait`; *ii*) `restart_processors_wait`; and *iii*) `enable_processors_wait`. After the execution of any of these instructions, the C_μP is in *wait* state, which means that it is waiting for a message from a cell to start a subprocess. Remember that C_μP saves the location of the current instruction ($stack \leftarrow pointer$), which corresponds with any instructions that includes the label (`wait`).

Some bits of the register SUBPCSR must be configured appropriately for the execution of subprocesses. Therefore, the CCU of a cell whose processor sets the bit *EXECUTE_SUBPROCESS* (*EXSP*) starts the procedure detailed bellow for the execution of a subprocess.

The following procedure is detailed for a subprocess X, where X could be any of the four instructions available for subprocesses (0, 1, 2 or 3). The process starts when the bit *EXSP* is set to high for any processor. The FU notifies to the CCU the activation of this bit, an the CCU requests to the C_μP the execution of a subprocess as follows:

1. The CCU sends a frame with the corresponding information: command `start_subprocessX_inet + id_component`.
2. The GCU translates and broadcasts the information through **ENET** by means of the command `start_subprocessX_enet`.

3. The C_μP searches in the code the instruction related with the subprocess requested (`start_subprocess_X`). Note that the argument of the instruction must match with the data received, which is the identifier of the component (`id_component`).
4. The C_μP executes sequentially the SASM instructions inside subprocess X.
5. The subprocess ends when the C_μP executes the instruction `end_subprocess_X`. The C_μP sends a frame with the confirmation of the end of the subprocess X by means of the command `end_subprocessX_enet` and the `id_component` as argument, which is forwarded inside the chips by the GCU using the command `end_subprocessX_inet`. The CCUs whose `id_component` matches with the data in frame notifies it to the FU, which sets to high the bit `ENDS SUBPROCESS X` that indicated the end of the execution of the subprocess X.
6. The C_μP recovers the value of the pointer (`pointer ← stack`). The C_μP executes the instruction denoted by pointer that contains a SASM instruction with the label `wait` and the process continues normally.

Note that cell processors may continue their scheduled task normally whilst subprocess X is executed. It is responsibility of the user to include the appropriate validation in the ASM program of cells, or disable and enable the processors in the subprocess X using the appropriate SASM instructions.

5.3.8 Static Fault Tolerance Configuration

The Static Fault Tolerance mechanism is a combination between the Fault Tolerance System (FTS) included in the Functional Unit (FU) of cells and the SASM instruction `ft_configuration`, which is used for indicating to C_μP the cells involved in the process. Table 5.9 shows the syntax and instruction format of this instruction, which configures the primary and redundant cells for the self-elimination and self-replication of damaged cells when a hardware failure is detected. If the redundant cell is not implemented, the parameter must be set to 0x00.

SPD Syntax and arguments	<code>ft_configuration</code>	<code>addressPrimaryCell, addressRedundantCell</code>
Instruction format in C _μ P memory	<code>ft_configuration_IC,</code> <code>addressPrimaryCell,</code> <code>addressRedundantCell,</code> <code>...</code> <code>...</code>	<code>//Static Fault Tolerance IC</code> <code>//32-bit address of primary cell</code> <code>//32-bit address of redundant cell if</code> <code>//implemented, 0x00000000 if redundant</code> <code>//cell is not implemented</code>

Table 5.9: Syntax and format for instruction related to Static Fault Tolerance mechanism

In the initial configuration or when the system is not in `wait` state, the instruction `ft_configuration` is ignored, the C_μP continues with the execution of other SASM instructions. The primary and redundant cells (configured as arguments) involved in the Static Fault Tolerance mechanism must be properly configured by means of register FTCSR.

The `ft_configuration` instruction is closely tied with the execution of the following instructions: *i*) `wait`; *ii*) `restart_processors_wait`; and *iii*) `enable_processors_wait`. After the execution of any of these instructions, the C_μP is in `wait` state, which means that it is waiting for a message from a cell to start the elimination and replication of damaged cells. Remember that C_μP saves the location of the current instruction (`stack ← pointer`), which corresponds with any instructions that includes the label (`wait`).

The CCU of a cell where the hardware failure is detected starts the process detailed below:

1. The processors of primary cell are disabled, i.e., no more instructions will be executed. The **CCU** of the primary cell starts the process for replication of cells. This **CCU** sends to **GCU** the command *replicate_cells_inet* with the *address* of the primary cell as argument. This is forwarded to **CμP** with the command *replicate_cells_enet*.
2. The **CμP** searches in memory the instruction (**ft_configuration**) whose first argument matches with the *address* included in the message (primary cell).
3. The **CμP** start a process for eliminating the primary and redundant cells. The *elimination* term implies that cells will not participate in future self-placement processes. The procedure is as follows:
 - a. The **CμP** sends a message to the **GCU**s (chips) with the command *autoset_for_delete_connections_enet*. Each **GCU** that has active the flag *delete_component_or_cell_enable* is enabled to participate in the selection process.
 - b. The **CμP** starts the selection process using the command *start_contest_winner_chip_enet*. This determines the chip that will execute the algorithm to disconnect the primary cell. If there is a winner chip, goto step c. for disconnecting the primary cell. If there is not a winner chip goto step e. for eliminating the primary cell.
 - c. The **CμP** sends to chips the command *delete_cell_connections_chip_enet* with the *address* of the primary cell. The winner chip translates and broadcasts the command inside the chip: *delete_cell_connections_chip_inet*. The winner chip executes the “**Self-derouting Process**” (Section 4.11). It goes through the input connection tables of primary cell inside the chip and releases all routing resources related with the interconnection of this cell.
 - d. When all connections with the primary cell have been released for the winner chip the flag *delete_component_or_cell_enable* is cleared. In this case, the chip will not participate in future selection process. The **GCU** receives the command *delete_cell_connections_confirmation_inet*, which is translated and sent to **CμP** using the command *delete_cell_connections_confirmation_enet*. The **CμP** repeats the process from step a. until all connections with the primary cell are released. Note that loop is broken in step b.
 - e. The **CμP** sends a frame with the information of the primary cell: *eliminate_cell_chip_enet* + *address*. The **GCU**s broadcast the frame internally, the cell whose *address* matches executes the algorithm “**Elimination of a Cell inside a Chip**” (Section 4.9.1), which configures the damaged cell as *busy cell* and its *address* will be fixed to 0xFFFF0001 to avoid future use.
 - f. The chips that have at least one component activate the flag *delete_component_or_cell_enable* for future elimination processes. The appropriate confirmation command is sent to the **GCU**, which translates and transmits the command to the **CμP** and the process of elimination of the primary cell ends.
 - g. If the *address* of the redundant cell is different to 0x00, the process of elimination must be executed again from step a. This time for the *Redundant Cell*. When elimination of primary and redundant cells is finalized, the process continues with the insertion of primary and redundant cells in different location.
4. The **CμP** starts the process for inserting the primary and redundant cells (replication process).
 - a. The **CμP** sets the *pointer* to zero and starts searching the cells in the configuration memory. That means finding the instruction **create_component** that includes the primary or redundant cells.

- b. When the configuration data of the primary or redundant cell is found, one of the following processes is executed, which depends on the features of the component that includes the cell:
 - ▶ **Self-placement of First Cell of a Component** (Section 4.5.1).
 - ▶ **Self-placement of Others Cell of a Component** (Section 4.5.2).
 - c. The previous step is repeated for the remaining cell (primary or redundant). Afterwards, the process continues with the configuration of program memories of these cells.
5. The **C_μP** starts the process for writing the Configuration Registers or Program Memories of primary and redundant cells (replication process).
- a. The **C_μP** sets the *pointer* to zero and starts searching all instructions related with writing the **FU** memory (`write_FU_memory_XXX`).
 - b. The instruction `write_FU_memory_XXX` is executed if the *address* of the primary or redundant cells matches with the *address* configured for the instruction.
 - c. The process ends when the instruction `end` is found.
6. The **GCU** asks to the system to start the process “**Self-routing at Component Level**” to route the missing connections in the system (Section 4.8).
7. The **C_μP** recovers the value of the pointer ($pointer \leftarrow stack$). The **C_μP** executes the instruction denoted by pointer that contains a **SASM** instruction with the label `wait` and the process continues normally.

When elimination and replication processes ends, the processors in the system are enabled again and continue working (start working for replicated cells). It is user responsibility to restart the software application scheduled to the **SANE**, or to recover a known starting point.

5.4 Development of Applications

Remember that any **SANE** application can be assumed to be a self-adaptive processing system with the **MIMD** architecture advantages, like multiple parallel processing. The runtime self-configuration capability of the system is present when a **SANE** application requests the execution of at least one subprocess. For this case, Listing 5.1 shows an example of the syntax of the high-level configuration file (or **SASM** file)². Despite this example does not represent the solution of a problem and only shows the structure of an application with subprocesses, the following features could be abstracted from the code:

- ▶ The **SPD** permits to simplify the instructions for writing the configuration registers and program memories of **FU**. Note that lines 8 to 12 could be simplified using the instruction `write_FU_memory`, which is used along this listing.
- ▶ The subprocesses are ignored (or skipped) the first time the code is executed, i.e., the initial configuration starts from the line 49.
- ▶ From line 49 to line 56, the basic configuration of the system is performed. It includes a instruction to restart and disable the processors, creation of components, writing of configuration registers and program memories for processors, and the connection of components.

²The special characters semicolon (;) or double-slash (//) are used to include comments in the code.

- ▶ The execution of threads starts when the instruction of line 57 permits to enable the processors. In this moment, the C_μP remains in *wait* state. The cell(s) that includes the appropriate functionality can request to the C_μP to start the execution of a subprocess. For this example, the cells AAAA0001 and BBBB0001 could start subprocesses for the component to which the cell belongs, i.e., the components AAAA and BBBB respectively. Note that a component can request the execution up to four subprocesses, which are identified with the *id_component*.
- ▶ Note that any cell in component AAAA may execute a dynamic reconfiguration as follows: the subprocess_0 and subprocess_2 permits to create and delete dynamically the component DDDD. Similarly, subprocess_1 and subprocess_3 permits to create and delete components EEEE, FFFF and AABB.
- ▶ Any cell in component BBBB may execute the subprocess_0 in line 42 to restart the processors in system.
- ▶ The instruction `end` denotes the last instruction of the SASM file.

Listing 5.2 presents the structure of a SANE-ASM that includes other case for dynamic reconfiguration, the Static Fault Tolerance mechanism. This mechanism permits to self-repair the system when a hardware failure is detected in the Fault Tolerance System (FTS) configured for the working or the redundant processor, which are located in primary and redundant cells (`cell_A_primary` and `cell_A_redundant`) . This listing includes the following features:

- ▶ The SPD lets users make definition of variables with the reserved word `equ`. Lines 4 to 11 show the syntax of these definitions.
- ▶ From line 20 to line 30, the basic configuration of the system is performed. It includes instructions to disable the processors, creation of components, writing of configuration registers, writing of program memories for processors, connection of components and enable processors.
- ▶ The cells denoted as `cell_A_primary` and `cell_A_redundant` must enable and configure appropriately the FTS.
- ▶ The execution of threads starts when the instruction of line 31 permits to restart the processors. In this moment, the C_μP remains in *wait* state. If a hardware failure occurs in the *Working_Processor* or *Redundant_Processor*, the primary cell starts the processes for self-elimination and self-replication of damaged cells. This process is executed by the C_μP, which starts the execution of the elimination and replication of primary and redundant cells. For this example, the cells AAAA0001 and AAAA0002 (`cell_A_primary` and `cell_A_redundant`) are configured for this processes with the instruction *ft_configuration*.

When an application does not include the instructions that include the self-configuration capabilities previously explained, the system executes a general purpose application with capacity for parallel processing. The dynamic reconfiguration is enabled when the SASM file ends with a instruction that includes the option to put the system in *wait* state, i.e., when the program ends with any of the following instructions: `wait`, `restart_processors_wait` or `enable_processors_wait`.

Many applications were implemented and tested in the prototype using the SPD. However not all can be presented because of space. The following sections presents two application examples that include Dynamic and Static Fault Tolerance capabilities.

Listing 5.1: Example of a SANE-ASM with Subprocesses for dynamic reconfiguration.

```

1 ;*****
2 ;* Subprocesses are ignored in the initial configuration
3 ;*****
4 ;* Subprocesses for component 0xAAAA
5 ;*****
6 start_subprocess_0      0xAAAA    //Subprocess 0 for component 0xAAAA
7   create_component      0xDDDD
8   write_FU_memory_CR    0xDDDD0001; These instructions
9   write_FU_memory_PM0   0xDDDD0001; are equivalent
10  write_FU_memory_PM1   0xDDDD0001; to the instruction
11  write_FU_memory_PM2   0xDDDD0001; 'write_FU_memory 0xDDDD0001'
12  write_FU_memory_PM3   0xDDDD0001; for the SANE Project Developer
13  connect_component
14 end_subprocess_0
15 ;*****
16 start_subprocess_1     0xAAAA    //Subprocess 1 for component 0xAAAA
17   create_component      0xEEEE
18   create_component      0xFFFF
19   create_component      0xAABB
20   write_FU_memory       0xEEEE0000
21   write_FU_memory       0xEEEE0001
22   write_FU_memory       0xEEEE0002
23   write_FU_memory       0xFFFF0000
24   write_FU_memory       0xFFFF0001
25   write_FU_memory       0xAABB0000
26   write_FU_memory       0xAABB0001
27   connect_component
28 end_subprocess_1
29 ;*****
30 start_subprocess_2     0xAAAA    //Subprocess 2 for component 0xAAAA
31   delete_component      0xDDDD
32 end_subprocess_2
33 ;*****
34 start_subprocess_3     0xAAAA    //Subprocess 3 for component 0xAAAA
35   delete_component      0xEEEE
36   delete_component      0xFFFF
37   delete_component      0xAABB
38 end_subprocess_3
39 ;*****
40 ;* Subprocesses for component 0xB BBB
41 ;*****
42 start_subprocess_0     0xB BBB    //Subprocess 0 for component 0xB BBB
43   restart_processors
44 end_subprocess_2
45
46 ;*****
47 ;* Start of SANE-ASM configuration
48 ;*****
49 restart_and_disable_processors
50 create_component       0xAAAA
51 write_FU_memory        0xAAAA0001
52 create_component       0xB BBB
53 write_FU_memory        0xB BBB0001
54 create_component       0xCCCC
55 write_FU_memory        0xCCCC0001
56 connect_component
57 enable_processors_wait ;CMP waits a request from a Cell
58                       ;for the execution of a subprocess
59 end                   ;End of SASM configuration file

```


Listing 5.2: Example of a SANE-ASM with Subprocesses for dynamic reconfiguration.

```

1 ;*****
2 ;* Definitions
3 ;*****
4 component_A      equ  0xAAAA      //Component with four cells
5 cell_A_primary   equ  0xAAAA0001
6 cell_A_redundant equ  0xAAAA0002
7 cell_A_function3 equ  0xAAAA0003
8 cell_A_function4 equ  0xAAAA0004
9 component_B      equ  0xB BBB     //Component with two cells
10 cell_B_function1 equ  0xB BBB0000
11 cell_B_function2 equ  0xB BBB0001
12 ;*****
13 ;* Fault Tolerance configuration is ignored in the initial configuration
14 ;* If the redundant cell is not implemented, the argument 2 must be 0x0
15 ;*****
16 ft_configuration cell_A_primary, cell_A_redundant
17 ;*****
18 ;* Start of SANE-ASM configuration
19 ;*****
20 disable_processors
21 create_component      component_A
22 write_FU_memory       cell_A_primary
23 write_FU_memory       cell_A_redundant
24 write_FU_memory       cell_A_function3
25 write_FU_memory       cell_A_function4
26 create_component      component_B
27 write_FU_memory       cell_B_function1
28 write_FU_memory       cell_B_function2
29 connect_component
30 enable_processors
31 restart_processors_wait ;CMP waits a request from a Cell for the
32                        ;elimination and replication of primary
33                        ;and redundat cells
34 end                    ;End of SASM configuration file

```

5.5 Application Example: Dynamic Fault-Tolerance Scaling

As previously described, any component in the system has the ability to start up to four subprocesses in execution time. Each subprocess is a group of any number of [SASM](#) instructions, e.g., a subprocess could create, eliminate or interconnect components between others. The Dynamic Fault-Tolerance Scaling technique uses this functionality for its purpose.

Lets us say that a component in a specific [SANE](#) is used for monitoring another component that is used for computing purposes (*Monitor* and *Compute* sections respectively). The *Monitor* could use two subprocesses to create exact copies of the *Compute* and the remaining two subprocesses to eliminate it. This way the *Monitor* section has the ability to create and eliminate redundant copies of the *Compute* section when a specific condition in execution time is achieved. This principle is used for the demonstration application explained in this section.

5.5.1 Dynamic Fault-Tolerance Structure

The [SANE](#) developed for any Dynamic Fault-Tolerance application can be divided in four parts, the *Compute*, *Monitor*, *Control* and *Interface* sections.

The *Compute* section executes the functionality scheduled to the [SANE](#). This section is

composed of a variable number of cells that implement any general-purpose application.

The *Monitor* section is composed of a variable number of cells, which has the task of monitoring the real-time functionality of the *Compute* section, thus it has the ability to stop the operation of a **SANE** if a fault condition is detected. This section requests the execution of four subprocesses (SP) as follows:

- ▶ SP0: Creation of first copy of *Compute* section.
- ▶ SP1: Creation of second copy of *Compute* section.
- ▶ SP2: Kill the first copy of of *Compute* section.
- ▶ SP3: Kill the second copy of of *Compute* section.

Therefore, the *Monitor* section has the ability to request the creation/killing of exact copies of the *Compute* section (maximum two), depending of the requirements of the **SANE**. When there is only the original *Compute* section, it is not possible to detect a fault. When there are two *Compute* sections implemented, the *Monitor* section has the ability to stop the functionality of the **SANE** if the comparison between the original and the copy is different. When there are two copies of the *Compute* section implemented, the monitoring system decides the continuity of the **SANE**, it depends if at least two of them have the same results, otherwise the *Monitor* section ends the **SANE** functionality.

The *Control* and *Interface* sections are included by default in the architecture. The *Control* section executes the subprocesses. This functionality is included in all cells, but it is only enabled in one cell of the *Monitor* section, which will be responsible to start the subprocesses for creating or killing the copies of the *Compute* section. The *Interface* section corresponds to the resources available for the interconnection of cells and components. This is configured for the self-placement and self-routing algorithms.

The first and second copy of the *Compute* section are not configured (placed and routed) in the initial configuration, instead it exclusively depends on the runtime application characteristics. This additional hardware is dynamically created and eliminated by the *Monitor* section of a **SANE**. Even if the self-placement and self-routing processes of the new hardware are not completed, the processors of the other active **SANEs** (or active cells) in the system continue working in parallel without any interruption. This is possible because the self-placement and self-routing processes are executed in a parallel and distributed way by the configuration units of cells, while the processors of the cells are executing their scheduled processing work.

5.5.2 Description of the application

This demonstration application is a **SANE**-based subsystem. It can be described as a dynamic fault-tolerance scaling technique implemented on the self-adaptive architecture described in this document. The application should be able to improve autonomously its fault tolerance features based on its current workload.

As previously mentioned, the organization of a **SANE** includes four sections: *Compute*, *Monitor*, *Control* and *Interface*. For this demonstrator application the *Compute* section is implemented by a single-cell component, it is a 16-bit pseudo-random number generator, which has been chosen just to illustrate the principles proposed in the architecture.

The *Monitor* section is implemented in a two-cell component. Each cell implements the subsections called *Monitor_1* and *Monitor_2*. The *Monitor_1* determines on-line the power consumption average produced by the *Compute* section. The power consumption has been divided in high, medium and low consumption thresholds; it is calculated with the average of transitions of the random sequence generated.

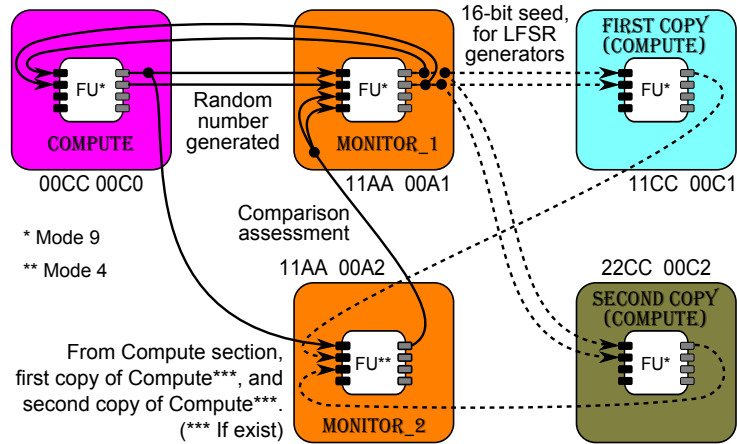


Figure 5.1: Component interconnection for the dynamic fault tolerance application.

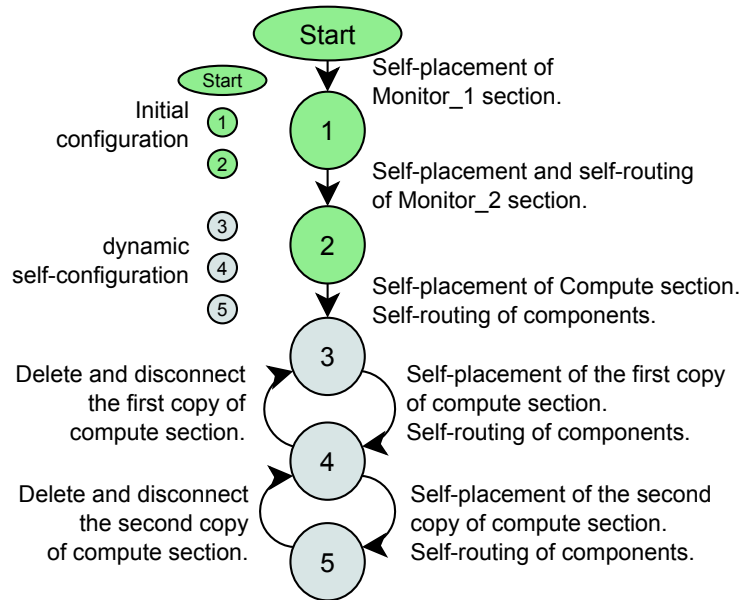


Figure 5.2: Sequence of activities. The processes executed by the system are represented by the text over the arrows. All cells are free in the "start" state.

The average for high consumption has to be larger than 11 changes. In this case, the *Monitor_1* section maintains only the original *Compute* section. In medium consumption regime, the thresholds are between 6 and 10 changes, the *Monitor_1* section maintains the first copy of the *Compute* section while the power consumption average is within this thresholds. In low consumption regime, the threshold is between 1 and 5 changes. Therefore, while the average is in low consumption the second copy of the *Compute* section is present in the system.

The *Monitor_2* compares the outputs provided by the original *Compute* section and its copies (if they exist), and sends the result of these comparisons to *Monitor_1*, which depending of the result of this comparisons takes the decision to stop or not the system.

The *Control* is implicit in the system, it is constituted by the *CCU* of the *Monitor_1* section. The *Interface* section includes the routing resources available for interconnections of cells, which includes the ports of cells, Switch and Pin Interconnection Matrices.

The first and the second copy of the *Compute* section are implemented in components

Address: (id_component + id_cell)	Cell Configuration Mode	Description
00CC 00C0	4	Compute section. Generator of a 16-bit pseudo-random number sequence
11AA 00A1	9	Monitor_1 section. Calculates the average consumption of the Compute section
11AA 00A2	9	Monitor_2 section. Comparisons of all compute sections.
11CC 00C1	9	First copy of Compute section.
22CC 00C2	9	Second copy of Compute section.

Table 5.10: Description of components for the example application: Dynamic Fault Tolerance Scaling.

composed of a single cell. The application for this *Compute* copies is exactly the same, the pseudo-random number generation. The components developed for this application and their interconnections are shown in Figure 5.1 and Table 5.10. The cells in mode 9 have one 16-bit processor with capacity for 256 instructions in program memory and 16x16 data memory. The cell in mode 4 has one 8-bit processor with 32-bytes data memory and 256 instructions capacity.

Figure 5.2 shows the processes executed in the *SANE*, where it is important to note the dynamic creation and kill processes of copies depending on the changing power consumption of the *Compute* section. Steps “start”, 1 and 2 constitute the initial configuration of basic hardware required for the execution of the application, the *Monitor* and original *Compute* section.

Steps 3 to 5 are executed alternately and controlled by the *Monitor_1* section, which creates and kills copies of the *Compute* section depending on its average power consumption.

In the appendix E, Table E.1 presents a relation of the files created and generated by *SPD* regarding this application. Listings presented in section E.1 show these files.

5.6 Application Example: Static Fault-Tolerance

Lets suppose a 8-bit sequence of data that has to be generated by a processor with a capacity for 250 instructions, which has to include a *Fault Tolerance System* (*FTS*) to protect the reliability of the sequence. The sequence has to be generated at a low speed, much lower than the clock available, so it is necessary to implement a delay in the sequence. This could be implemented in the processor of another cell with a capacity for 50 instructions.

The problem can be solved in many ways, the figure 5.3 shows a specific solution. This *SANE* includes three components (*AAAA*, *BBBB* and *CCCC*). The cell identified as *AAAA0001* includes the primary processor, which generates the sequence, and the cell *BBBB0002* includes the redundant processor that generates the same sequence. These cells are configured in configuration mode 4 and in *FT_mode* 5, that allows the *FTS* of the primary cell making the comparison of 2 cores (Core 0 in primary and redundant cells). The cell *CCCC0003* contains a processor that performs the delay. This will be in mode 0, and its *FTS* will be disabled (only one processor is used, the other three could be used for future implementations).

When the primary and redundant cells generate one data of the sequence, the *OUT0* port of the primary cell is written, producing the *Read Enable* (*RE*) flag. This is conducted to the cell *CCCC0003*, which waits this *RE* pulse from cell *AAAA0001* to start the generation of a delay

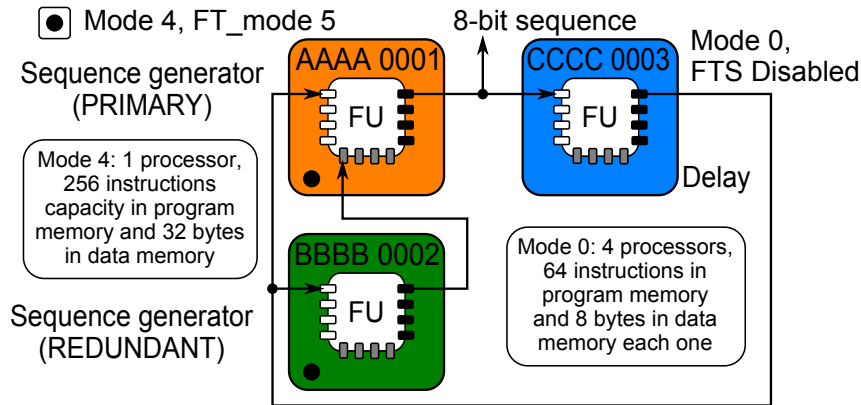


Figure 5.3: Components configuration for Static Fault Tolerance application example.

(this RE is received by means of the special instruction called BLMOV "Blocked Move", which reads the port, saves the data in a memory location and follows with the next instruction when a RE pulse is produced). The data read is not important for the cell that produces the delay (CCCC0003). This cell executes the delay algorithm, and then writes any data in its OUT0 port, which produces a RE pulse that has to be conducted to the inputs of the primary and redundant cells. When these cells receive the RE pulse they generate the next data of the special sequence, and so on. While the delay is performed, the primary and redundant processors could calculate the next data of the sequence in a parallel way.

If the primary or redundant processor have a hardware failure, the cells AAAA0001 and BBBB0002 are self-eliminated, the address FFFF0001 will be fixed in both cells, and they will not be used in subsequent self-placement operations. Its routing resources continue available. Next, the cells AAAA0001 and BBBB0002 start the self-replication process, it involves the self-placement and self-routing of these cells in another location inside the cell array. Once this process ends, the sequence starts the generation again.

In the appendix E, Table E.2 presents a relation of the files created and generated by SPD regarding this application. Listings presented in section E.2 show these files.

5.7 Conclusions

The high-level configuration file for the description of a SANE ASSEMBLY (SANE-ASM) has been defined as the SANE Assembler (SASM) file. This file is composed of a sequence of SASM instructions that describes the configuration of the SANE-ASM. The syntax and instruction format for all SASM instructions has been presented. There are 25 instructions that permits the execution of the following process:

- ▶ Create, delete and interconnect components.
- ▶ Write the Functional Unit (FU) memory of cells, including the Configuration registers.
- ▶ Restart, disable or enable the processors in system.
- ▶ Configuration of system in *wait* state, which permits the execution of runtime self-configuration processes in system.
- ▶ Execution of one to four subprocess, which provides the system with dynamic reconfiguration capabilities.
- ▶ Configuration of Static Fault Tolerance mechanism, which provides the system with self-healing capability.
- ▶ Instruction to denote the end of the SASM configuration file.

Two application examples have been presented. The first is the Dynamic Fault Scaling Technique, which permits to check the dynamic reconfiguration of the system by means of subprocesses. This application is able to improve autonomously its fault tolerance features based on its current workload. Therefore, depending on a specific condition in the functional section of an application, the system dynamically either creates or kills one or two copies of its functional section. The fault tolerance subsystem compares the redundant copies of the functional section, if they exist, so as to decide the continuity of the system depending on eventual failures in the comparison.

The other mechanism of fault tolerance is a dedicated or Static Fault Tolerance mechanism. It provides redundant processing capabilities that are working continuously. In the application example, when a failure in the execution of a binary sequence in the Primary or Redundant processors is detected, the processors in Primary cell are stopped and the self-elimination and self-replication processes start for the cells involved in the failure. These cells will be self-discarded for future self-placement processes.

Chapter 6

Publications and Results

*When you have the running spirit,
you look forward to life.*

*Cuando se tiene espíritu de atleta,
se tiene ilusión por la vida.*

Max Popper (1893 – 1976)

Abstract: This chapter presents the publications performed during the elaboration of this thesis. Additionally, this chapter shows a summary of the files generated for the application, which are divided in three sections: hardware, firmware and software. The synthesis implementation results of the hardware architecture are presented at the final of the chapter.

6.1 Publications

The following is the list of publications organized from latest to oldest.

6.1.1 Neurocomputing Journal

Title:	A self-adaptive hardware architecture with fault tolerance capabilities.
Authors:	Javier Soto, Juan Manuel Moreno, Joan Cabestany.
Journal:	Neurocomputing, Volume 121, 9 December 2013, Pages 25-31. Advances in Artificial Neural Networks and Machine Learning.
Abstract:	This paper describes a Fault Tolerance System (FTS) implemented in a new self-adaptive hardware architecture. This architecture is based on an array of cells that implements in a distributed way self-adaptive capabilities. The cell includes a configurable multiprocessor, so it can have between one and four processors working in parallel, with a programmable configuration mode that allows selecting the size of program and data memories. The self-elimination and self-replication capabilities of cell(s) are performed when the FTS detects a failure in any of the processors that include it, so that this cell(s) will be self-discarded for future implementations. Other adaptive capabilities of the system are self-routing, self-placement and runtime self-configuration. Additionally, it is described as an example application and a software tool that has been implemented to facilitate the development of applications to test the system.
DOI:	http://dx.doi.org/10.1016/j.neucom.2012.10.038
ISSN:	0925-2312

6.1.2 Advances in Computational Intelligence - IWANN 2011

Title	Description of a Fault Tolerance System Implemented in a Hardware Architecture with Self-adaptive Capabilities
Authors	Javier Soto, Juan Manuel Moreno, Joan Cabestany.
Book Title	Advances in Computational Intelligence
Book Subtitle	11th International Work-Conference on Artificial Neural Networks conference, IWANN 2011, Torremolinos-Málaga, Spain, June 8-10, 2011, Proceedings, Part II.
Other	Publisher: Springer Berlin Heidelberg, 2011. Series Volume: 6692, pp 557-564.
Abstract:	This paper describes a Fault Tolerance System (FTS) implemented in a new self-adaptive hardware architecture. This architecture is based on an array of cells that implements in a distributed way self-adaptive capabilities. The cell includes a configurable multiprocessor, so it can have between one and four processors working in parallel, with a programmable configuration mode that allows selecting the size of program and data memories. The self-elimination and self-replication capabilities of cell(s) are performed when the FTS detects a failure in any of the processors that include it, so that this cell(s) will be self-discarded for future implementations. Other self-adaptive capabilities of the system are self-routing, self-placement and runtime self-configuration.
DOI	http://dx.doi.org/10.1007/978-3-642-21498-1_70
Print ISBN	978-3-642-21497-4
Online ISBN	978-3-642-21498-1

6.1.3 International Conference - Reconfig'09

Title	Implementation of a Dynamic Fault-Tolerance Scaling Technique on a Self-adaptive Hardware Architecture
Authors	Javier Soto, Juan Manuel Moreno, Jordi Madrenas, Joan Cabestany.
Publication	International Conference on Reconfigurable Computing and FPGAs, 2009. ReConFig '09, Cancun, Quintana Roo, Mexico, December 9-11, 2009. Pages 445-450.
Abstract:	The purpose of this paper is to describe a dynamic fault tolerance scaling technique that is supported by the self-adaptive features of a hardware architecture developed within the framework of the AETHER project. The architecture is composed of an array of cells that support dynamic and distributed self-routing and self-placement of components in the system. The combination of a large array of cells together with component-level routing ultimately constitutes a SANE (self-adaptive networked entity). The dynamic fault tolerance scaling technique proposed in this paper permits a given subsystem to modify autonomously its structure in order to achieve fault detection and fault recovery. The decision to modify or not its organization is based on the actual power consumption of the system.
DOI	http://dx.doi.org/10.1109/ReConFig.2009.45
Print ISBN	978-1-4244-5293-4
E-ISBN	978-0-7695-3917-1

6.1.4 International Conference - DCIS 2008

Title	Design of a Configurable Multiprocessor for a Self-Adaptive Hardware Architecture
Authors	Javier Soto, Juan Manuel Moreno, Jordi Madrenas, Joan Cabestany.
Publication	XXIII Conference on Design of Circuits and Integrated Systems (DCIS 2008). ISBN: 978-2-84813-124-5. Grenoble, France. November 12-14, 2008.
Abstract:	The purpose of this paper is to describe the design of a configurable multiprocessor used as a functional unit of a cell that is able to perform self-placement and self-routing. An array of such cells ultimately constitutes a SANE (Self-Adaptive Networked Entity). The Functional Unit includes one to four processors working in parallel, with a programmable configuration mode that allows selecting the size of program and data memories. Data processing can be done in modes of 8, 16, 24 and 32 bits. The architecture includes special instructions and specific hardware designed to be compatible with a model of computation based on microthreads.

6.1.5 International Conference - JCRA 08

Title	Diseño de un Multiprocesador Configurable y de la Interfaz de Comunicaciones para una Arquitectura de Hardware Auto-Adaptable (Design of a Configurable Multiprocessor and the Communication Interface for a Self- Adaptive Hardware Architecture)
Authors	Javier Soto, Juan Manuel Moreno, Jordi Madrenas, Joan Cabestany.
Publication	VIII Jornadas de Computación Reconfigurables y aplicaciones (JCRA 08) (Universidad Rey Juan Carlos – URJC). ISBN: 978-84-612-5635-8. Pages 295-304. Madrid, Spain, September 18-19, 2008.
Abstract:	El propósito de este artículo es describir el diseño de un multiprocesador configurable usado como unidad funcional de una célula que es capaz de realizar procesos de auto-enrutamiento y auto-emplazamiento. La unidad funcional incluye de uno a cuatro procesadores trabajando en paralelo, cuyo modo de configuración programable permite seleccionar el tamaño de las memorias de datos (8, 16, 24 o 32 bits) y programa. Este procesador incluye hardware e instrucciones específicas para ser compatible con un modelo de computación basado en microthreads. Se describe también el diseño de la interfaz de comunicaciones necesaria para la ejecución de los procesos de auto-emplazamiento y auto-enrutamiento.

6.1.6 International Conference - ReCoSoC'08

Title	Communication Infrastructure for a Self-Adaptive Hardware Architecture
Authors	Javier Soto, Juan Manuel Moreno, Jordi Madrenas, Joan Cabestany.
Publication	Proceedings of the Reconfigurable Communication-centric Systems-on-Chip Workshop (ReCoSoC'08), ISBN: 978-84-691-3603-4, pp. 175-180, Barcelona, Spain, July 9-11, 2008.
Abstract:	The purpose of this paper is to describe the design of a communication interface between a cell array and a global configuration unit to support self-placement and self-routing capabilities. The interface is based on the I2C bus specification. The combination of a large array of such cells together with component-level routing ultimately constitutes a SANE (Self-Adaptive Networked Entity).

6.2 Code Generated

This section presents a relation of the code generated for the implementation of the self-adaptive architecture presented in this document. This code represents only the final prototype implemented. The system developed includes different types of technologies divided in three scenarios: hardware, firmware and software, which are detailed in following sections.

6.2.1 Hardware

The hardware section represents the self-adaptive hardware architecture with parallel processing capabilities presented along this document. This section was developed in two Virtex4 Xilinx FPGAs (XC4VLX60), each one includes the same configuration and hardware description written in VHDL code. Some differences has been implemented in the design for differentiating the master and slave chips in prototype. The FPGA pins configuration is different for these chips, therefore two projects were built for the implementation of the prototype. Table 6.1 presents a relation of files, code lines and a brief description of each file generated for prototype. Note that the hardware definition of the [Control Microprocessor \(CμP\)](#) is not included in the list, since it was generated with the Xilinx Platform Studio.

It is important to note that these files only represent the final prototype, which is a reduced approach of the architecture presented in this dissertation. This is due mainly to the physical limitations in the FPGAs used for the system implementation. It is worth noting the following consideration: in prototype the cell (without [CCU](#)) and the [SM](#) have 1558 and 1912 code lines respectively. A previous version of the prototype without [FU](#) and with two clusters (3x3 cell array each) was implemented for testing of self-routing and self-placement algorithms. For this case the cell (without [CCU](#)) and the [SM](#) have 2300 and 11900 code lines respectively. The comparison of the code lines of a cluster with 2x2 cell array (prototype) and the cluster with 3x3 cell array is a reference of the hardware complexity for these approaches, and the main reason for the implementation of the prototype described in section 2.14.

File Name	Lines	Description
CCU.vhd	1945	Cell Configuration Unit. Implements all self-adaptive algorithms for a cell, mainly for self-placement and self-routing processes.
cell_NE.vhd ¹	1558	Routing resources for cell North-East.
cell_NW.vhd ¹	1558	Routing resources for cell North-West.

Continued on next page

File Name	Lines	Description
cell_SE.vhd ¹	1558	Routing resources for cell South-East.
cell_SW.vhd ¹	1558	Routing resources for cell South-West.
Cluster_array.vhd	833	Instantiation of GCU , cells, SM and PIM .
Commands.vhd	207	Library for global definition of special addresses, commands for INET and ENET , and other definitions.
dcm1.vhd	107	Clock divider for obtaining 25 MHz clock.
GCU.vhd	1960	Global Configuration Unit. Interface between CpP and CUs inside chips. Controls the self-adaptive processes inside a chip.
Matrix.vhd ²	1912	Switch Matrix. It includes the routing resources of SM and the SMCU , which implements the self-adaptive processes inside the SM .
Matrix_border.vhd	1172	Pin Interconnection Matrix. It includes the routing resources of PIM and the PIMCU , which implements the self-adaptive processes inside the PIM .
System_chip.vhd	281	Top module. Instantiation of CpP , cluster_array and clock_divider (dcm1).
table.vhd	62	Input/output connection tables.
winning_column_box.vhd	50	Part of the circuit for cell selection process: leftmost up-permost cell.
Mux15x1.vhd	61	Multiplexer 15x1 for 9-bit data bus. FU inputs.
Mux19x1.vhd	66	Multiplexer 19x1 for 9-bit data bus. Connects the SM port with the FU inputs in cell.
Mux20x1.vhd	67	Multiplexer 20x1 for 9-bit data bus. SM ports
Mux4x1.vhd	47	Multiplexer 4x1 for 9-bit data bus. Chip ports (PIM ports).
Mux5x1.vhd	50	Multiplexer 5x1 for 9-bit data bus. Cell local ports.
Mux7x1.vhd	52	Multiplexer 7x1 for 9-bit data bus. PIM ports.
Mux8x1.vhd	52	Multiplexer 8x1 for 9-bit data bus. Cell remote ports.
alu0.vhd	390	ALU for CORE0.
alu1.vhd	391	ALU for CORE1.
alu2.vhd	391	ALU for CORE2.
alu3.vhd	385	ALU for CORE3.
CM.vhd	115	Control Memory. Same for all cores.
DM.vhd	102	General purpose registers. Same for all cores.
DM4.vhd	316	Configuration and status registers mapped in Data Memory: IN0...IN3, OUT0...OUT3.
DM5.vhd	385	Configuration and status registers mapped in Data Memory: MODE FAMILY, PORTS, SUBPCSR and FTCSR.
FTS.vhd	143	Description of Fault Tolerance System.
FU.vhd	1211	Functional Unit top module. Instantiation and logic for all modules that belongs to the FU .
PC0.vhd	70	Program Counter for CORE0.
PC1.vhd	67	Program Counter for CORE1.

Continued on next page

File Name	Lines	Description
PC2.vhd	70	Program Counter for CORE2.
PC3.vhd	67	Program Counter for CORE3.
PM.vhd	121	Program memory. Same for all cores.
sum_com.vhd	45	Full Adder for design of ALUs.
Total	19425	Total number of VHDL code lines for prototype.

¹ Cell with routing resources for two sides (1560 lines approximately). For comparative purposes, a generic cell with routing resources for four sides may have 2300 lines approximately.

² Switch Matrix with routing resources for two sides and four cells (1900 lines approximately). For comparative purposes, a **SM** with routing resources for eight sides and nine cells may have 11900 lines approximately.

Table 6.1: List of VHDL files for hardware implementation of prototype.

6.3 Firmware

The firmware section of the application is represented by the control program implemented in the **Control Microprocessor (C_μP)**, which was implemented in the same FPGAs used for the hardware prototype. This firmware was implemented using the microprocessor MicroBlaze, which was generated by Xilinx Platform Studio (XPS). It is programmed in C language by means of the Xilinx Software Development Kit.

Table 6.2 presents a relation of files, code lines and a brief description of the firmware developed for the system.

File name	Code Lines	Description
main.c	1898	Main program implemented in C_μP .
print.h	69	Functions for writing data in UART. This information is presented in the communication tab of SPD .
uart.h	602	Uart configuration and algorithms for communication with SPD by means of XMODEM-based protocol.
commands.h	217	Definitions of commands and generic values.
Total	2786	Total number of code lines implemented for C_μP in prototype.

Table 6.2: List of C files for firmware section of prototype (Control Microprocessor).

6.4 Software

The software section of the system represents the **SANE Project Developer (SPD)**, which is a software tool developed for the creation and edition of projects that can be downloaded to prototype (See appendix D for details). This software was developed in C Sharp (C#) using the Microsoft Visual C# 2008.

Table 6.3 presents the files, code lines and a brief description of the classes created for the implementation of the **SPD**. Note that the list only presents the code created for the application; it is not included the code generated by the developed tool, i.e., it is not included the code that contains the configuration of the forms, which is normally created in the files FormX.Designer.cs.

File Name	Lines	Description
AppData/ApplicationData.cs	586	Object for serialization of application data.
AppData/FormAppData.cs	736	Form events management for edition of application data.
AppData/FormSaneApps.cs	68	Form events management for configuration of default location of projects.
AppData/SerializableColor.cs	59	Color object with XML serialization.
AppData/SerializableFont.cs	77	Font object with XML serialization.
Compiler/AsmCodeLine.cs	138	Object used for discrimination of instructions, arguments and others when a ASM file is compiled.
Compiler/AsmInstructions.cs	84	Object used for definition of ASM instructions.
Compiler/Compile.cs	1493	Object used for compiling ASM files. Generation of HEX files.
Compiler/Output.cs	69	Object used for generation of output results for compiling and building processes.
Compiler/Build.cs	1717	Object used for building the project. Generation of SHEX and SXM files.
Compiler/SasmCodeLine.cs	162	Object used for discrimination of instructions, arguments and others when a SASM files is built.
Compiler/SasmInstructions.cs	74	Object used for definition of SASM instructions.
Figure/Figure.cs	1086	Object for generation of a Figure of prototype.
Form/Form1.cs	1213	Management of events for main Form.
Form/Form2.Tree.cs	435	Partial class Form1. Management of events left tree.
Form/Form3.ProjectTab.cs	1850	Partial class Form1. Management of events for Project Tab.
Form/MenuCommunication.cs	156	Partial class Form1. Management of events for menu communications.
Form/MenuFile.cs	1488	Partial class Form1. Managements of events for File menu.
Form/MenuProject.cs	394	Partial class Form1. Management of events for Project menu.
Form/MenuTools.cs	129	Partial class Form1. Management of events for Tools menu.
Form/Tab.cs	93	Object for management of Tab pages.
Other/FormAbout.cs	47	Management of About form for credits in SPD .
Project/Cell.cs	165	Object with the parameters of a cell.
Project/CellsArray.cs	1895	Object for management of the cell array.
Project/Project.cs	985	Object for management of the project.
Comm.cs	1372	Partial class Form1. Management of communications ports and threads.
Common.cs	231	Definition of constant values and static methods common for the application.
FindAndReplaceForm.cs	475	Management of events and methods for find and replace action in text editor.

Continued on next page

File Name	Lines	Description
FormNewFileTemplate.cs	530	Management of events and methods for creation of a new file with template wizard.
FormNewProject.cs	140	Management of events and methods for creation of new projects.
FormRenameCell.cs	48	Management of events for edition of cells.
FormSelFileProgFPGA.cs	137	Management of events for selection of file when Write process is executed.
Globals.cs	27	Static class with global values for text editor management.
Program.cs	29	Main program. Start the execution of SPD , call for main Form - Form1.cs.
SerialPortFixer	207	Solve compatibility problems for communication ports when used alternately with hyperterminal and others.
Total	18395	Total number of C# code lines for SANE Project Developer (SPD) . This number does not includes the code generated automatically for configuration of Forms.

Note: Automatic files created for configuration of Forms are not included in this table.

Table 6.3: List of C# files developed for implementation of SANE Project Developer.

6.5 Synthesis Process for Prototype

The results of the synthesis process that shows the usage rate for elements of the architecture are detailed in Table 6.4 (hardware section). The Xilinx Synthesis Technology (XST) was used for the system implementation in the device selected. This table shows the usage rate for the [FU](#), a cell, a cluster and a complete chip, this permits to have an idea of the system granularity. The program memory of the [FU](#) and the connection table have been implemented by means of the RAM blocks available in the FPGA used. After generation of bitstream the total utilization rate was 80%.

6.6 Conclusions

The publications developed during the elaboration of this thesis project have been presented. They encompass one article in the Journal *Neurocomputing* and five international conferences, two of which are referenced in electronic publications in *Springer Berlin Heidelberg* and *IEEE Xplore Digital Library*.

The code generated for the final prototype includes approximately 40.000 code lines distributed in hardware, firmware and software, this code has been developed respectively in the following languages: VHDL, C and C#.

The results of the synthesis processes are presented for the main components of the hardware architecture, this gives an idea of the granularity of the hardware prototype implemented.

Part (Description)	Slices	Slice Flip Flops	4 input LUTs	RAMB16
FPGA: chip resources, for comparison	26624 100%	53248 100%	53248 100%	160 100%
Functional Unit: Four-core configurable multicomputer	1927 7%	402 1%	3715 6%	4 2%
cell: the routing resources of two sides were eliminated	3537 13%	992 1%	6771 12%	6 3%
cluster: 2x2 cell array + switch matrix	15920 59%	4086 7%	30315 56%	24 15%
chip: cluster + GCU + μ P of control + pin interconnection matrix	19560 73%	9638 18%	36418 68%	56 35%

Note: the total utilization rate was 80% after generation of bitstream.

Table 6.4: Results of the synthesis process for the proposed prototype.

Chapter 7

Conclusions and Future Work

*Somewhere, something incredible is waiting
to be known.*

En algún sitio algo increíble espera ser descubierto.

Carl Sagan (1934 – 1996)

Abstract: This chapter presents general conclusions related with the architecture developed. Additionally, some research lines are suggested as future work in this research area.

7.1 Conclusions

A novel self-adaptive hardware architecture with parallel processing capability has been developed. Basically, this is an unconventional [MIMD](#) hardware architecture with self-adaptive capabilities including self-placement and self-routing, which due to its intrinsic design, enable the development of systems with runtime self-configuration, self-repair and/or fault tolerance capabilities.

The self-adaptive capabilities of the architecture are executed autonomously and in a distributed way by cells. One of the main features of this architecture is its high degree of parallelism. The major drawback is the configuration of complex applications, where many processors have to be programmed and synchronized in order to accomplish a specific task. A new high-level programming paradigm has to be implemented, with the purpose of obtaining the maximum performance of the architecture.

The architecture presented includes a dedicated or static Fault Tolerance mechanism. It provides redundant processing capabilities that are working continuously. When a failure in the execution of a program is detected, the processors of the cell are stopped and the self-elimination and self-replication processes starts for the cell (or cells) involved in the failure. This cell(s) will be self-discarded for future self-placement processes.

The runtime self-configuration capability of the system is possible with the execution of subprocesses, which can be started by any cell in the system. This dynamic reconfiguration capability permits the implementation of a Dynamic Fault Tolerance Scaling Technique, which permits a given subsystem to modify autonomously its structure in order to achieve fault detection and fault recovery. It has the ability to create and eliminate the redundant copies of the functional section of a specific application.

A software tool and a hardware prototype that checks the functionality of the system have been developed. The [SANE Project Developer \(SPD\)](#) is an Integrated Development Environment that permits in a friendly way the management of projects that will be implemented in the hardware

prototype. The applications developed provides parallel processing capabilities, and may include Fault Tolerance mechanisms and runtime self-configuration.

7.1.1 About System Architecture

The proposed architecture consists of four conceptual layers:

- ▶ **First Layer - Cells:** the cells implement the self-adaptive capabilities and provide the computing capacity of the system.
- ▶ **Second Layer - Components:** the components are composed of interconnected cells.
- ▶ **Third Layer - SANE:** The [Self-Adaptive Networked Entity \(SANE\)](#) layer consists of a group of interconnected components. The [SANE](#) is the basic self-adaptive computing system; it has the ability of monitoring its local environment and its internal computation process.
- ▶ **Fourth Layer - SANE-ASM:** The top layer, the [SANE ASSEMBLY \(SANE-ASM\)](#) is composed of a group of interconnected [SANEs](#).

The proposed architecture is composed of one or more chips and an [External Controller \(EC\)](#), which are interconnected by means of an [External Network \(ENET\)](#). Each chip includes a two-layers implementation with interconnected cells in the first level and interconnected [SMs](#) in the second level. The [SANE](#) and [SANE-ASM](#) are just conceptual and are implemented in the same layer of components. The chip includes a cluster array, a [Global Configuration Unit \(GCU\)](#) and Pin Interconnection Matrices ([PIMs](#)). The main features of these components are described bellow:

- ▶ **Cluster:** The cluster is composed of a 3x3 cell array and a [Switch Matrix \(SM\)](#).
 - **Cell:** The cell is the basic element of the proposed self-adaptive architecture. The cell consists of the [Functional Unit \(FU\)](#), the [Cell Configuration Unit \(CCU\)](#) and additional hardware that allows the interconnection between [FU](#) ports of two cells.
 - * **Functional Unit:** The [FU](#) is in charge of executing the processes scheduled to the cell, i.e, it includes the processing capabilities of the cell. The [FU](#) includes four cores. Each core contains the digital elements that are used for the construction of a processor. The processor is constituted by the elements of one or more cores. Therefore the [FU](#) can have between one to four processors working in parallel. There are twelve configuration modes, where the expansion of Data and Program Memory describes the specific configuration mode. Therefore, the data processing of [FU](#) could be configured for 8, 16, 24 or 32 bits and the Program Memories can be joined or not depending on the configuration mode, allowing Program Memory sizes of 64, 128, 192 or 256 instructions. The instruction set of processors is composed of 44 instructions, which includes arithmetic, logic, shift, branch, conditional branch and special instruction for the execution of microthreads.
 - * **Cell Configuration Unit:** the [CCUs](#) are responsible for the execution of the required algorithms for the implementation of the system self-adaptive capabilities, mainly the self-placement and self-routing algorithms.
 - **Switch Matrix:** The [SMs](#) permit to connect cells from two different components. The [SM](#) is connected to its eight adjacent neighbors; it is also connected to the nine cells belonging to the cluster. The [Switch Matrix Configuration Unit \(SMCU\)](#) participates in the component self-routing process. In this process, the [FU](#) output port of a cell in a given component is connected to the [FU](#) input port of a cell in a different component.

- ▶ **Global Configuration Unit:** The **GCU** is in charge of controlling the self-adaptive processes inside the chip. The **GCU** is interconnected with the **EC** through the **ENET** and with the internal components of the chip through the **INET**. The **GCU** is the interface between the **EC** and **CUs** inside the chip. The **GCU** receives and translates information related to self-adaptive processes or configuration data.
- ▶ **Pin Interconnection Matrix:** The **PIMs** are used exclusively for the port interconnection between cells of two components in different chips. The **PIM** is connected to its three adjacent clusters. The **Pin Interconnection Matrix Configuration Unit (PIMCU)** participates in the component self-routing process, to allow for the interconnection of the **FU** port of a cell with a pin of the chip. Previously to this configuration, the **GCU** undertook a negotiation process with other chips, with the aim of assigning a pin of the chip to connect these components.

The **INET**, **ENET** and Configuration Units (**CUs**) participate actively in all self-adaptive processes implemented in the architecture.

7.1.2 About the Self-Adaptive Processes

All self-adaptive processes described in this dissertation have been implemented and tested in the hardware prototype. The algorithms presented are the base for the implementation of the high-level instructions in the system. These algorithms are executed by the Configuration Units and are presented below:

- ▶ **The self-placement algorithm:** it is responsible for finding out the most suitable position to insert the new cell of a component. For the placement of the first cell of a component, a particular procedure is used, different from other cells. In this case, a good candidate position is defined as one where a free cell has low routing congestion and the largest number of free neighboring cells. After the insertion of the component first cell, the next cells to be inserted are placed as close as possible to the cell with the largest number of connections with the new cell.
- ▶ **The self-routing algorithm:** it permits to connect the Functional Unit ports of two cells. This process can be executed at cell or component level. The self-routing process at cell level is executed since the insertion of the second cell of a component, each time that the self-placement process ends. The algorithm allows interconnecting the ports of the functional unit of two cells, in the same component, through the local and remote cell ports. After the insertion of all components, the self-routing process at component level can be executed. This algorithm implements the interconnection of two cells belonging to different components through Switch and Pin Interconnection Matrices.
- ▶ **The self-derouting algorithm:** it permits to release all routing resources used to interconnect cells or components. This process can be executed for a single cell or a entire component. For this purpose, the Release Process is implemented. This process releases the routing resources (multiplexers) used for an interconnection between cells.
- ▶ **Self-configuration:** The elimination of a single cell and the deletion of a entire component are processes used by the runtime self-configuration capabilities included in the system: (1) the Static Fault Tolerance mechanism is able to execute the self-replication and self-elimination of cells, and, (2) the dynamic reconfiguration by means of subprocess can execute the creation, connection and deletion of components, among others.

7.1.3 About Integrated Development System

The proposed hardware architecture has been implemented and tested in a hardware prototype developed in VHDL for two chips (boards with Virtex 4 Xilinx FPGAs). Additionally, an Integrated Development Environment has been developed. This software tool called [SANE Project Developer \(SPD\)](#) permits the implementation of general purpose applications that include all capabilities presented along the document.

The hardware and software tools constitute the Integrated Development System, which permits to create projects that implement the self-adaptive and parallel processing capabilities presented in this dissertation. The following are some features supported by the system:

- ▶ The high-level configuration file for the description of a [SANE ASSEMBLY \(SANE-ASM\)](#) has been defined as the [SANE Assembler \(SASM\)](#) file.
- ▶ The [SASM](#) file is composed of a sequence of [SASM](#) instructions that describe the configuration of the [SANE-ASM](#). The syntax and instruction format for all [SASM](#) instructions have been presented. There are 25 instructions that permit the execution of the following processes:
 - Create, delete and interconnect components.
 - Write the [Functional Unit \(FU\)](#) memory of cells, including the Configuration registers.
 - Restart, disable or enable the processors in system.
 - Configuration of system in a special state called *wait*, which permits the execution of runtime self-configuration processes in system.
 - Execution of one to four subprocesses, which provides the system with dynamic reconfiguration capabilities.
 - Configuration of Static Fault Tolerance mechanism, which provides the system with self-healing capability.
 - Instruction to denote the end of the [SASM](#) configuration file.

Two application examples have been presented. These applications has been selected because they include all self-adaptive, parallel processing and fault tolerance capabilities developed for the architecture.

- ▶ The first is the Dynamic Fault Tolerance Scaling Technique, which permits to check the dynamic reconfiguration of the system by means of subprocesses. This application is able to improve autonomously its fault tolerance features based on its current workload. Therefore, depending on a specific condition in the functional section of an application, the system dynamically either creates or kills one or two copies of its functional section. The fault tolerance subsystem compares the redundant copies of the functional section, if they exist, so as to decide the continuity of the system depending on eventual failures in the comparison.
- ▶ The other mechanism of fault tolerance is a dedicated or Static Fault Tolerance mechanism. It provides redundant processing capabilities that are working continuously. In the application example, when a failure in the execution of a binary sequence in the Primary or Redundant processors is detected, the processors in Primary cell are stopped and the self-elimination and self-replication processes start for the cells involved in the failure. These cells will be self-discarded for future self-placement processes.

7.2 Future Work

Some research topics that can be studied in the future are discussed as follows:

- ▶ Integration or development of a new high-level programming paradigm that permits the development of complex application with the features of the architecture presented in this dissertation. The purpose of this is obtaining the maximum performance of the architecture. References [29] [30] [31] [32] present relevant information about this point.
- ▶ A software model for self-adaptive architectures has been developed for the AETHER project [30]. The SANE Virtual Processor (SVP) is a thread-based model of concurrent program composition as a basis for designing and programming many-core chips. The model is based in microthreads, which are small code fragments that can be run concurrently to gain increased performance in the proposed self-adaptive hardware architecture. As mentioned previously, the integration of a new high-level software model like this and the proposed hardware architecture constitutes an important advance for the development of complex applications.
- ▶ Depending of the programming paradigm exposed in the previous items, it must be considered the implementation of a C compiler, which involves the creation of a back-end for the Functional Units processors in the cell.
- ▶ Implementation of a larger array of elements in both scenarios: chips and cell. If a prototype with more cells is implemented inside a chip, the architecture and self-adaptive algorithm should not be modified unless new capabilities will be implemented. If more than two chips are included in a prototype, some negotiation processes must be redesigned to achieve the negotiation between chips, which is mainly used for interconnection of components in different chips.
- ▶ If a larger array of clusters inside a chip is achieved, the interface between chips currently implemented with Pin Interconnections Matrices must be redefined. Similarly, an external interface must be defined for chips, with the purpose of implementing general purpose applications that control external devices, or in general terms that permit to communicate the system with another digital device.

Appendix A

Instructions Set for Functional Unit Processors

The integrity of men is to be measured by their conduct, not by their professions.

La integridad del hombre se mide por su conducta, no por sus profesiones.

Décimo Junio Juvenal (60 – 128)

Abstract: This section shows all relevant information related with the instruction set for Functional Unit processor(s). The instructions are summarized in a table and described in alphabetical order for easy reference.

A.1 Instructions Format

Each instruction is a 25-bit word divided into an opcode and operands. The opcode represents the unique identifier of the instruction. The remaining bits of the instructions represents the operands that specifies the operation of the instruction. The instruction formats are presented in Figure A.1, while their fields are summarized in Table A.1.

The FU instruction formats are divided in the next categories:

- ▶ **Operations with literal and registers:** W and F represent data memory registers and 'k' represents a 8-bit literal or constant value. For processors with data length greater than 8 bits, the other bits of 'k' must be assumed as 0's. The destination selector 'd' is useful to assign a byte in a specific position of the entire word without modifying the other bytes, e.g., a 32-bit constant value could be assigned using four instructions MOVLF.
- ▶ **Operations with three registers:** W and Y represent data source registers, while F represents the operation destination register. It is important to note that there is not restriction in the use of source and destination registers i.e. the source and destination registers could be the same, any combination is possible.
- ▶ **Operations with two registers:** W and F represent source and destination register respectively. These registers could be the same, therefore the source register could be modified in the same operation. INP represents a register located between address 0x20 and 0x23, wich represents different combination of input ports which depends on configuration mode and processor used.

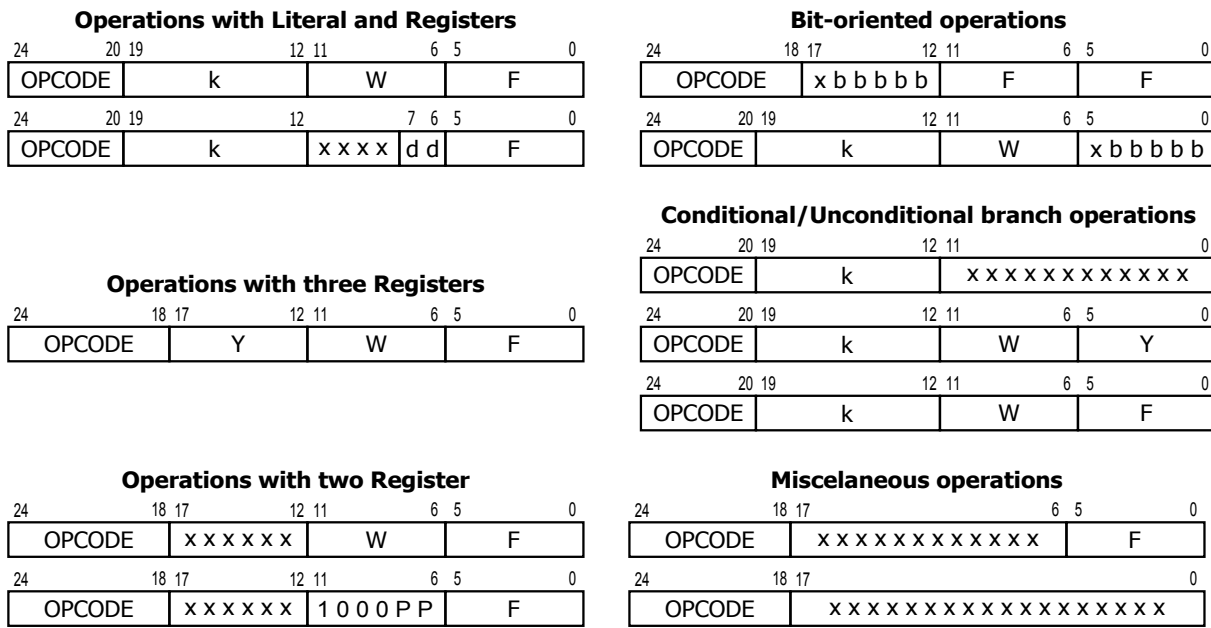


Figure A.1: Instructions format.

- ▶ **Bit-oriented operations:** F represents the register that will be affected in a set or clear bit operation, i.e., F is the source and destination register at the same time. W represents the source register used for a conditional branch to address k that depends on a bit value. 'b' represents a bit field designator which selects the bit affected by the operation. Some of these operations include conditional operations.
- ▶ **Operations with conditional and unconditional branches:** W and Y represent data source registers, these registers will not be affected during comparison operations. F represents the operation destination register. 'k' represents the absolute destination address for this operations.
- ▶ **Miscellaneous operations:** In these operations F represents the destination register.

A.2 Instructions Set

The nomenclature shown in Table A.2 is used in the instruction descriptions throughout this section. Table A.3 shows the assembler instructions for the FU processors. Thereafter, all instructions are organized alphabetically and detailed individually. Each instruction is executed in one single clock. The oscillator frequency for processors in the prototype is 25 MHz, therefore each instruction is executed in 40 ns.

Field	Description
OPCODE	Operation code (5 or 7 bits)
W	6-bit Source register address ($0 \leq W \leq 63$)
Y	6-bit Source register address ($0 \leq Y \leq 63$)
F	6-bit Destination register address ($0 \leq F \leq 63$)
(W) (Y) (F)	Contents of W, Y and F could be 8, 16, 24 or 32 bits width, depending of configuration mode and processor selected
k	8-bit Immediate value (operand or literal) or 8-bit Absolute address for branch (denoted as label in assembler code) ($0 \leq k \leq 255$)
b	5-bit Bit address ($0 \leq b \leq 31$). The two most significant bits could be omitted depending of the processor data width (8, 16, 24 or 32 file register).
d	2-bit Destination select ($0 \leq d \leq 3$). d=X for 8-bit processors. d=0: store result in first byte (LSB for 16, 24 or 32 bit processors) d=1: store result in second byte (MSB for 16 bit processor) d=2: store result in third byte (MSB for 24 bit processor) d=3: store result in fourth byte (MSB for 32 bit processor)
P - INP	2-bit Port(s) selection. Port(s) selected depends of the processor data width. ($0 \leq p \leq 3$) P=0: move input ports(s) of address 0x20 P=1: move input ports(s) of address 0x21 P=2: move input ports(s) of address 0x22 P=3: move input ports(s) of address 0x23

Table A.1: Instructions field description

Operators	Description
()	Content of register or memory location shown inside parentheses
\leftarrow	Is loaded with
\wedge	Boolean AND
\vee	Boolean OR
\oplus	Boolean exclusive-OR
\neg	One's complement or Boolean NOT
\Rightarrow	Then
$\&$	Concatenate
+	Add
-	Subtract (two's complement)
$\langle x \rangle$	Bit x (or set of bits x) of memory location used in operation
$\langle B_x \rangle$	Byte x of the memory location used in operation (B_0 is the least significant byte)
:	Denote a range of bits or bytes

Table A.2: Nomenclature for processor operations

A.2. INSTRUCTIONS SET

Mnemonic, Operands	Description	25-bit Instruction Code	CCR Affected
LITERAL AND REGISTERS ORIENTED OPERATIONS			
ADDLW	W,k,F	Add Literal and W	00000 kkkkkkkk wwwwww ffffff C,Z
SUBLW	W,k,F	Subtract Literal and W	00001 kkkkkkkk wwwwww ffffff C,Z
ANDLW	W,k,F	AND Literal with W	00010 kkkkkkkk wwwwww ffffff Z
IORLW	W,k,F	Inclusive OR Literal with W	00011 kkkkkkkk wwwwww ffffff Z
XORLW	W,k,F	Exclusive OR Literal with W	00100 kkkkkkkk wwwwww ffffff Z
MOVLW	k,F,d	Move Literal to F	00101 kkkkkkkk xxxxdd ffffff -
THREE REGISTERS ORIENTED OPERATIONS			
ADDWY	W,Y,F	Add W and Y	00110 00yyyyyy wwwwww ffffff C,Z
SUBWY	W,Y,F	Subtract W and Y	00110 01yyyyyy wwwwww ffffff C,Z
ANDWY	W,Y,F	AND W with Y	00110 10yyyyyy wwwwww ffffff Z
IORWY	W,Y,F	Inclusive OR W with Y	00110 11yyyyyy wwwwww ffffff Z
XORWY	W,Y,F	Exclusive OR W with Y	00111 00yyyyyy wwwwww ffffff Z
TWO REGISTER ORIENTED OPERATIONS			
MOVW	W,F	Move W to F	00111 01xxxxxx wwwwww ffffff Z
BLMOV	INP,F	Blocked Move of INP to F	00111 10xxxxxx 1000pp ffffff Z
COMW	W,F	One's complement of W	00111 11xxxxxx wwwwww ffffff Z
NEGW	W,F	Two's complement of W	01000 00xxxxxx wwwwww ffffff C,Z
INCW	W,F	Increment W	01000 01xxxxxx wwwwww ffffff Z
DECW	W,F	Decrement W	01000 10xxxxxx wwwwww ffffff Z
SWAPW	W,F	Swap halves in W	01000 11xxxxxx wwwwww ffffff -
RLW	W,F	Rotate left through Carry	01001 00xxxxxx wwwwww ffffff C,Z
RRW	W,F	Rotate right through Carry	01001 01xxxxxx wwwwww ffffff C,Z
LSL	W,F	Logical shift left (Same as ASL)	01001 10xxxxxx wwwwww ffffff C,Z
LSR	W,F	Logical shift right	01001 11xxxxxx wwwwww ffffff C,Z
ASL	W,F	Arithmetic shift left (Same as LSL)	01001 10xxxxxx wwwwww ffffff C,Z
ASR	W,F	Arithmetic shift right	01010 00xxxxxx wwwwww ffffff C,Z
MISCELANEOUS OPERATIONS			
CLRF	F	Clear F	01010 01xxxxxx xxxxxx ffffff Z
CLC		Clear carry bit	01010 10xxxxxx xxxxxx xxxxxx C
SEC		Set carry bit	01010 11xxxxxx xxxxxx xxxxxx C
END		End of execution	01011 00xxxxxx xxxxxx xxxxxx TA
NOP		No operation	01011 01xxxxxx xxxxxx xxxxxx -
BIT-ORIENTED (CONDITIONAL) OPERATIONS			
BCLR	F,b	Clear bit b in F	01011 10-bbbbb ffffff ffffff -
BSET	F,b	Set bit b in F	01011 11-bbbbb ffffff ffffff -
BRCLR	W,b,k	Branch if bit b in W clear	01100 kkkkkkkk wwwwww -bbbbbb -
BRSET	W,b,k	Branch if bit b in W set	01101 kkkkkkkk wwwwww -bbbbbb -
CONDITIONAL AND UNCONDITIONAL BRANCH OPERATIONS			
GOTO	k	Go to address	01110 kkkkkkkk xxxxxx xxxxxx -
BZ	k	Branch if Z bit set	01111 kkkkkkkk xxxxxx xxxxxx -
BNZ	k	Branch if Z bit clear	10000 kkkkkkkk xxxxxx xxxxxx -
BC	k	Branch if Carry bit set	10001 kkkkkkkk xxxxxx xxxxxx -
BNC	k	Branch if Carry bit clear	10010 kkkkkkkk xxxxxx xxxxxx -
CBEQ	W,Y,k	Compare and Branch if Equal	10011 kkkkkkkk wwwwww yyyyyy -
CBGE	W,Y,k	Compare and Branch if greater than or equal to	10100 kkkkkkkk wwwwww yyyyyy -
CBGT	W,Y,k	Compare and Branch if greater than	10101 kkkkkkkk wwwwww yyyyyy -
CBNE	W,Y,k	Compare and Branch if not Equal	10110 kkkkkkkk wwwwww yyyyyy -
DBNZ	W,F,k	Decrement and Branch if Not Zero	10111 kkkkkkkk wwwwww ffffff -
IBNZ	W,F,k	Increment and Branch if Not Zero	11000 kkkkkkkk wwwwww ffffff -

Table A.3: Instructions set summary

ADDLW Add Literal and register W

Syntax: ADDLW W,k,F

Operation: $(F) \leftarrow (W) + k$

Description: The contents of the register W are added to the eight-bit literal 'k' and the result is placed in the register F. For *modes* of 16, 24 and 32 bits, the most significant bits of 'k' must be assumed as 0's.

ADDWY Add registers W and Y

Syntax: ADDWY W,Y,F

Operation: $(F) \leftarrow (W) + (Y)$

Description: The contents of the register W are added to the contents of register Y and the result is placed in the register F.

ANDLW AND Literal with register W

Syntax: ANDLW W,k,F

Operation: $(F) \leftarrow (W) \wedge k$

Description: Performs the logical AND between the contents of register W and literal 'k' and places the result in register F. For *modes* of 16, 24 and 32 bits, the most significant bits of 'k' must be assumed as 0's.

ANDWY AND register W with register Y

Syntax: ANDWY W,Y,F

Operation: $(F) \leftarrow (W) \wedge (Y)$

Description: Performs the logical AND between the contents of register W and register Y and places the result in register F.

ASL Arithmetic shift left

Syntax: ASL W,F

Operation: 8-bit: $C \leftarrow (W)\langle 7 \rangle, (F) \leftarrow (W)\langle 6:0 \rangle \& 0$
 16-bit: $C \leftarrow (W)\langle 15 \rangle, (F) \leftarrow (W)\langle 14:0 \rangle \& 0$
 24-bit: $C \leftarrow (W)\langle 23 \rangle, (F) \leftarrow (W)\langle 22:0 \rangle \& 0$
 32-bit: $C \leftarrow (W)\langle 31 \rangle, (F) \leftarrow (W)\langle 30:0 \rangle \& 0$

Description: The contents of register W are shifted one bit to the left, bit 0 is loaded with a 0, the result is placed in register F. The C bit in the CCR is loaded from the most significant bit of W. This is mathematically equivalent to multiplication by two.

ASR Arithmetic shift right

Syntax: ASR W,F

Operation: 8-bit: $(F) \leftarrow (W)\langle 7 \rangle \& (W)\langle 7:1 \rangle, C \leftarrow (W)\langle 0 \rangle$
 16-bit: $(F) \leftarrow (W)\langle 15 \rangle \& (W)\langle 15:1 \rangle, C \leftarrow (W)\langle 0 \rangle$
 24-bit: $(F) \leftarrow (W)\langle 23 \rangle \& (W)\langle 23:1 \rangle, C \leftarrow (W)\langle 0 \rangle$
 32-bit: $(F) \leftarrow (W)\langle 31 \rangle \& (W)\langle 31:1 \rangle, C \leftarrow (W)\langle 0 \rangle$

Description: The contents of register W are shifted one bit to the right, most significant bit held constant, the result is placed in register F. The C bit in the CCR is loaded from bit 0 of W. This operation effectively divides a signed value by 2 without changing its sign. The carry bit can be used to round the result.

BC	Branch if Carry bit set
Syntax:	BC k
Operation:	if (C) = 1 \Rightarrow PC \leftarrow k
Description:	Tests the state of the C bit in the CCR and causes a branch if C is set. BC can be used after any instructions that affect the C bit in register CCR.
BCLR	Clear bit b in F
Syntax:	BCLR F,b
Operation:	(F) \leftarrow 0
Description:	Bit 'b' in register F is cleared. Bits b<2:0> are used for 8-bit processors. Bits b<3:0> are used for 16-bit processors. All bits of b are used for 24-bit and 32-bit processors. If the value used in 'b' is out of appropriate range of values for 8, 16 and 24 bit processors, the result might not be as expected.
BLMOV	Blocked Move of INP to F
Syntax:	BLMOV INP,F
Operation:	if (RE) = 1 \Rightarrow (F) \leftarrow (0x20 + INP), (PC)++ else \Rightarrow (PC) \leftarrow (PC)
Description:	Moves INP to register F when Read Enable pulse(s) is(are) active. INP=[0,1,2,3] represents any address between 0x20 and 0x23 respectively, each address can contain one or more input ports, depending on the data processing width. RE is set during a clock pulse when a processor writes any output port(s) (address 0x24 to 0x27). Examples: 8-bit: for INP=3, (F) \leftarrow (0x23) when RE pulse at IN3; for INP \in [0,1,2,3] 16-bit: for INP=1, (F) \leftarrow (0x21) when RE pulses at IN2_IN3; for INP \in [0,1] 24-bit: for INP=0, (F) \leftarrow (0x20) when RE pulses at IN0_IN1_IN2; INP \in [0] 32-bit: for INP=0, (F) \leftarrow (0x20) when RE pulses at IN0_IN1_IN2_IN3; INP \in [0]
BNC	Branch if Carry bit clear
Syntax:	BNC k
Operation:	if (C) = 0 \Rightarrow PC \leftarrow k
Description:	Tests the state of the C bit in the CCR and causes a branch if C is clear. BC can be used after any instructions that affects the C bit in register CCR.
BNZ	Branch if Z bit clear
Syntax:	BNZ k
Operation:	if (Z) = 0 \Rightarrow PC \leftarrow k
Description:	Tests the state of the Z bit in the CCR and causes a branch if Z is clear. BZ can be used after any instructions that affects the Z bit in register CCR.
BRCLR	Branch if bit b in W clear
Syntax:	BRCLR W,b,k
Operation:	if (W) = 0 \Rightarrow PC \leftarrow k
Description:	Test bit n of register W and branches if the bit is clear. Bits b<2:0> are used for 8-bit processors. Bits b<3:0> are used for 16-bit processors. All bits of b are used for 24-bit and 32-bit processors. If the value used in 'b' is out of appropriate range of values for 8, 16 and 24 bit processors, the result might not be as expected.

BRSET Branch if bit b in W set

Syntax: BRSET W,b,k

Operation: if (W) = 1 \Rightarrow PC \leftarrow k

Description: Test bit n of register W and branches if the bit is set. Bits b<2:0> are used for 8-bit processors. Bits b<3:0> are used for 16-bit processors. All bits of b are used for 24-bit and 32-bit processors. If the value used in 'b' is out of appropriate range of values for 8, 16 and 24 bit processors, the result might not be as expected.

BSET Set bit b in F

Syntax: BSET F,b

Operation: (F) \leftarrow 1

Description: Bit 'b' in register F is set. Bits b<2:0> are used for 8-bit processors. Bits b<3:0> are used for 16-bit processors. All bits of b are used for 24-bit and 32-bit processors. If the value used in 'b' is out of appropriate range of values for 8, 16 and 24 bit processors, the result might not be as expected.

BZ Branch if Z bit set

Syntax: BZ k

Operation: if (Z) = 1 \Rightarrow PC \leftarrow k

Description: Tests the state of the Z bit in the CCR and causes a branch if Z is set. BZ can be used after any instructions that affects the Z bit in register CCR.

CBEQ Compare and branch if equal

Syntax: CBEQ W,Y,k

Operation: if (W) = (Y) \Rightarrow PC \leftarrow k

Description: Compares the contents of register W against the contents of register Y and causes a branch if the contents are equal.

CBGE Compare and branch if greater than or equal to

Syntax: CBGE W,Y,k

Operation: if (W) \geq (Y) \Rightarrow PC \leftarrow k

Description: The instruction causes a branch if the contents of register W is greater than or equal to the contents of register Y. The instruction assumes unsigned values in the registers.

CBGT Compare and branch if greater than

Syntax: CBGT W,Y,k

Operation: if (W) > (Y) \Rightarrow PC \leftarrow k

Description: The instruction causes a branch if the contents of register W is greater than the contents of register Y. The instruction suppose unsigned values in the registers.

CBNE Compare and branch if not equal

Syntax: CBNE W,Y,k

Operation: if (W) \neq (Y) \Rightarrow PC \leftarrow k

Description: Compares the contents of register W against the contents of register Y and causes a branch if the contents are not equal..

CLC	Clear Carry bit
Syntax:	CLC
Operation:	$C \leftarrow 0$
Description:	Clears the C bit in the CCR. CLC may be used to set up the C bit prior to a shift or rotate instruction that involves the C bit. The C bit can also be used to pass status information between subroutines.
CLRF	Increment W
Syntax:	CLRF F
Operation:	$(F) \leftarrow 0$
Description:	The contents of register F is cleared, the Z bit in CCR is set.
COMW	One's complement of W
Syntax:	COMW W,F
Operation:	$(F) \leftarrow \neg(W)$
Description:	Performs the one's complement of the contents of register W and places the result in register F.
DBNZ	Decrement and branch if not Zero
Syntax:	DBNZ W,F,k
Operation:	$(F) \leftarrow (W) - 1$, if $(Z) = 0 \Rightarrow PC \leftarrow k$
Description:	The contents of register W is decremented, the result is placed in register F. The instruction causes a branch if the result is not 0.
DECW	Decrement W
Syntax:	DECW W,F
Operation:	$(F) \leftarrow (W) - 1$
Description:	The contents of register W is decremented, the result is placed in register F.
END	End of execution
Syntax:	END
Operation:	$PC \leftarrow PC$, $TA \leftarrow 0$
Description:	Ends the execution of instructions by the processor. Clears the TA bit in the CCR.
GOTO	Go to address
Syntax:	GOTO k
Operation:	$PC \leftarrow k$
Description:	GOTO is an unconditional branch. The 8-bit immediate value is loaded into PC bits.
IBNZ	Increment and branch if not Zero
Syntax:	IBNZ W,F,k
Operation:	$(F) \leftarrow (W) + 1$, if $(Z) = 0 \Rightarrow PC \leftarrow k$
Description:	The contents of register W is incremented, the result is placed in register F. The instruction causes a branch if the result is not 0.

INCW Increment W

Syntax: INCW W,F
 Operation: $(F) \leftarrow (W) + 1$
 Description: The contents of register W is incremented, the result in placed in register F.

IORLW Inclusive OR Literal with register W

Syntax: IORLW W,k,F
 Operation: $(F) \leftarrow (W) \vee k$
 Description: Performs the logical inclusive-OR between the contents of register W and literal 'k' and places the result in register F. For *modes* of 16, 24 and 32 bits, the most significant bits of 'k' must be assumed as 0's.

IORWY Inclusive OR register W with register Y

Syntax: IORWY W,Y,F
 Operation: $(F) \leftarrow (W) \vee (Y)$
 Description: Performs the logical inclusive-OR between the contents of register W and register Y and places the result in register F.

LSL Logical shift left

Syntax: LSL W,F
 Operation: 8-bit: $C \leftarrow (W)\langle 7 \rangle$, $(F) \leftarrow (W)\langle 6:0 \rangle \& 0$
 16-bit: $C \leftarrow (W)\langle 15 \rangle$, $(F) \leftarrow (W)\langle 14:0 \rangle \& 0$
 24-bit: $C \leftarrow (W)\langle 23 \rangle$, $(F) \leftarrow (W)\langle 22:0 \rangle \& 0$
 32-bit: $C \leftarrow (W)\langle 31 \rangle$, $(F) \leftarrow (W)\langle 30:0 \rangle \& 0$
 Description: The contents of register W are shifted one bit to the left, bit 0 is loaded with a 0, the result in placed in register F. The C bit in the CCR is loaded from the most significant bit of W.

LSR Logical shift right

Syntax: LSR W,F
 Operation: 8-bit: $(F) \leftarrow 0 \& (W)\langle 7:1 \rangle$, $C \leftarrow (W)\langle 0 \rangle$
 16-bit: $(F) \leftarrow 0 \& (W)\langle 15:1 \rangle$, $C \leftarrow (W)\langle 0 \rangle$
 24-bit: $(F) \leftarrow 0 \& (W)\langle 23:1 \rangle$, $C \leftarrow (W)\langle 0 \rangle$
 32-bit: $(F) \leftarrow 0 \& (W)\langle 31:1 \rangle$, $C \leftarrow (W)\langle 0 \rangle$
 Description: The contents of register W are shifted one bit to the right, most significant bit is loaded with a 0, the result in placed in register F. The C bit in the CCR is loaded from the bit 0 of W.

MOVLF Move Literal to F

Syntax: MOVLF k,F,d
 Operation: $(F)\langle d \rangle \leftarrow k$
 Description: Moves the literal 'k' to any byte of register F, depending of destination 'd'.
 8-bit: $(F)\leftarrow k$ for any value of 'd'.
 16-bit: for d=1, $(F)\langle B_1 \rangle \leftarrow k$, $(F)\langle B_0 \rangle \leftarrow (F)\langle B_0 \rangle$. If $d \neq [0,1]$, $(F)\leftarrow (F)$.
 24-bit: for d=2, $(F)\langle B_2 \rangle \leftarrow k$, $(F)\langle B_1:B_0 \rangle \leftarrow (F)\langle B_1:B_0 \rangle$. If $d \neq [0,1,2]$, $F \leftarrow F$.
 32-bit: for d=3, $(F)\langle B_3 \rangle \leftarrow k$, $(F)\langle B_2:B_0 \rangle \leftarrow (F)\langle B_2:B_0 \rangle$

MOVW	Move W to F
Syntax:	MOVW W,F
Operation:	$(F) \leftarrow (W)$
Description:	Moves the contents of register W to register F.
NEGW	Two's complement of W
Syntax:	NEGW W,F
Operation:	$(F) \leftarrow \neg(W) + 1$
Description:	Performs the two's complement of the contents of register W and places the result in register F.
NOP	No operation
Syntax:	NOP
Operation:	None ($PC \leftarrow PC + 1$)
Description:	This is an instruction that does nothing except to consume one CPU clock cycle while the program counter is advanced to the next instruction. No register or memory contents are affected by this instruction.
RLW	Rotate Left through Carry
Syntax:	RLW W,F
Operation:	8-bit: $C \leftarrow (W)\langle 7 \rangle$, $(F) \leftarrow (W)\langle 6:0 \rangle \& C$ 16-bit: $C \leftarrow (W)\langle 15 \rangle$, $(F) \leftarrow (W)\langle 14:0 \rangle \& C$ 24-bit: $C \leftarrow (W)\langle 23 \rangle$, $(F) \leftarrow (W)\langle 22:0 \rangle \& C$ 32-bit: $C \leftarrow (W)\langle 31 \rangle$, $(F) \leftarrow (W)\langle 30:0 \rangle \& C$
Description:	The contents of register W are rotated one bit to the left through the Carry, the result in placed in register F.
RRW	Rotate Right through Carry
Syntax:	RRW W,F
Operation:	8-bit: $(F) \leftarrow C \& (W)\langle 7:1 \rangle$, $C \leftarrow (W)\langle 0 \rangle$ 16-bit: $(F) \leftarrow C \& (W)\langle 15:1 \rangle$, $C \leftarrow (W)\langle 0 \rangle$ 24-bit: $(F) \leftarrow C \& (W)\langle 23:1 \rangle$, $C \leftarrow (W)\langle 0 \rangle$ 32-bit: $(F) \leftarrow C \& (W)\langle 31:1 \rangle$, $C \leftarrow (W)\langle 0 \rangle$
Description:	The contents of register W are rotated one bit to the right through the Carry, the result in placed in register F.
SEC	Set Carry bit
Syntax:	SEC
Operation:	$C \leftarrow 1$
Description:	Clears the C bit in the CCR. CLC may be used to set up the C bit prior to a shift or rotate instruction that involves the C bit. The C bit can also be used to pass status information between subroutines.
SUBLW	Subtract Literal from register W
Syntax:	SUBLW W,k,F
Operation:	$(F) \leftarrow (W) - k$
Description:	Subtracts the contents of literal 'k' from register W and places the result in register F (2's complement method). For <i>modes</i> of 16, 24 and 32 bits, the most significant bits of 'k' must be assumed as 0's.

SUBWY Subtracts registers W and Y

Syntax: SUBWY W,Y,F

Operation: $(F) \leftarrow (W) - (Y)$

Description: Subtracts the contents of register Y from register W and places the result in register F (2's complement method).

SWAPW Swap halves of W

Syntax: SWAPW W,F

Operation: 8-bit: $(F)\langle 7:4 \rangle \leftarrow (W)\langle 3:0 \rangle$, $(F)\langle 3:0 \rangle \leftarrow (W)\langle 7:4 \rangle$
16-bit: $(F)\langle 15:8 \rangle \leftarrow (W)\langle 7:0 \rangle$, $(F)\langle 7:0 \rangle \leftarrow (W)\langle 15:8 \rangle$
24-bit: $(F)\langle 23:12 \rangle \leftarrow (W)\langle 11:0 \rangle$, $(F)\langle 11:0 \rangle \leftarrow (W)\langle 23:12 \rangle$
32-bit: $(F)\langle 31:16 \rangle \leftarrow (W)\langle 15:0 \rangle$, $(F)\langle 15:0 \rangle \leftarrow (W)\langle 31:16 \rangle$

Description: Swaps upper and lower halves of the contents of register W, the result is placed in register F.

XORLW Exclusive OR Literal with register W

Syntax: XORLW W,k,F

Operation: $(F) \leftarrow (W) \oplus k$ Description: Performs the logical exclusive-OR between the contents of register W and literal 'k' and places the result in register F. For *modes* of 16, 24 and 32 bits, the most significant bits of 'k' must be assumed as 0's.**XORWY Exclusive OR register W with register Y**

Syntax: XORWY W,Y,F

Operation: $(F) \leftarrow (W) \oplus (Y)$

Description: Performs the logical exclusive-OR between the contents of register W and register Y and places the result in register F.

Appendix B

Data Memory Registers of Functional Unit Processors

*Don't walk in front of me; I may not follow.
Don't walk behind me; I may not lead.
Just walk beside me and be my friend.
No camines delante de mí, puede que no te siga.
No camines detrás de mí, puede que no te guíe.
Camina junto a mí y sé mi amigo.*
Albert Camus (1913 – 1960)

Abstract: This section presents a detailed description of Data Memory registers of FU processors for all configuration modes and data sizes. The registers are shown in order according to their address and separated by pages for easy reference.

B.1 Abbreviations

Table B.1 shows the abbreviations used for description of bit registers throughout this section.

Abbreviations			
r = Readable bit	w = Writable bit	u = Unimplemented bit, read as 0	
-n = Value at POR/R	1 = Bit is set	0 = Bit is cleared	x = Bit is unknown
R = Readable byte	W = Writable byte	U = Unimplemented byte, read as 00h	
-N=Value at POR/R	00-FFh = 8-bit value	X = Byte is unknown	

POR/R = Power-On Reset or manual reset with push-button.

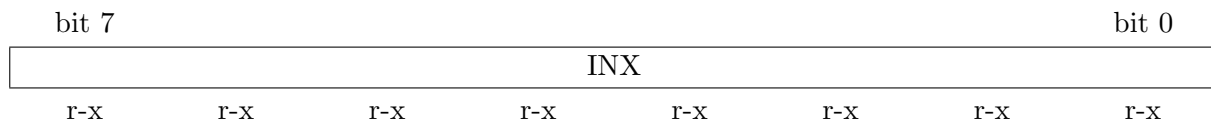
Table B.1: Abbreviations for bits of Data Memory registers

B.2 Input Ports Registers

The input ports registers are between addresses 20h and 23h. Its configuration is showed below. Note that input ports in a specific address depends of the processors data size.

8-bit Processors

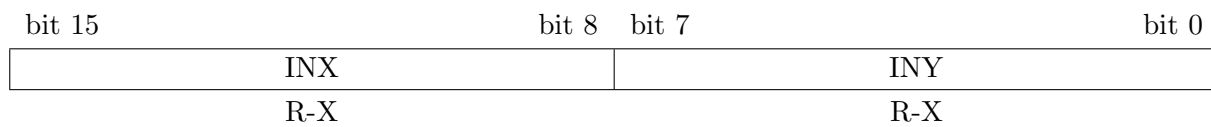
Input Ports - IN0, IN1, IN2 and IN3 (ADDRESS 20h, 21h, 22h and 23h)



bit 7:0 Value in the input port X (read only registers).
 IN0 when address is 20h
 IN1 when address is 21h
 IN2 when address is 22h
 IN3 when address is 23h

16-bit Processors

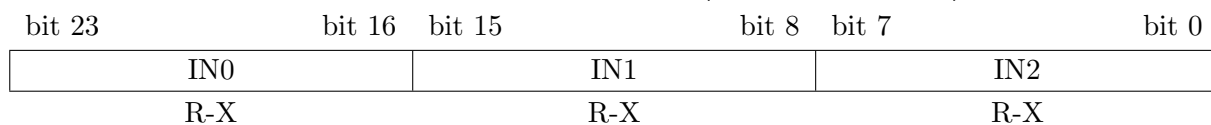
Input Ports - IN0_IN1, IN2_IN3 (ADDRESS 20h, 21h)



bit 15:0 Value in the concatenation of two 8-bits input ports INX_INY(read only registers).
 IN0_IN1 when address is 20h
 IN2_IN3 when address is 21h
 Read 0x0000 for address 22h and 23h

24-bit Processors

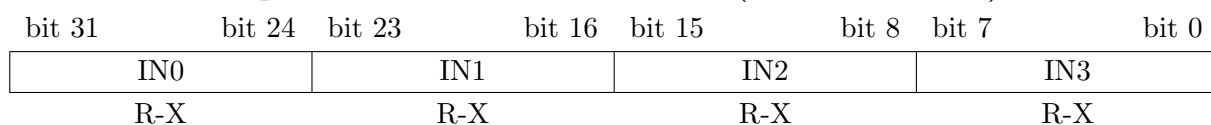
Input Ports - IN0_IN1_IN2 (ADDRESS 20h)



bit 23:0 Value in the concatenation of three 8-bits input ports IN0_IN1_IN2 (read only registers). Read 0x000000 for address 21h, 22h and 23h

32-bit Processors

Input Ports - IN0_IN1_IN2_IN3 (ADDRESS 20h)



bit 31:0 Value of the concatenation of four 8-bits input ports IN0_IN1_IN2_IN3 (read only registers). Read 0x00000000 for address 21h, 22h and 23h

B.3 Output Ports Registers

The output ports registers are between addresses 24h and 27h. Its configuration is shown below. Note that output ports in a specific address depend on the processors data size.

It is important to note that an output port can be written only by one CORE, which depends of the value of the PORTS register. Therefore if the PORTS register is not configured properly, a write operation over an address related with an output port might not affect the port. Any write operation in an output port generates a one-cycle pulse in the Read Enable (RE) bit of the corresponding port (RE is the ninth bit of the port.)

8-bit Processors - Output Ports

OUT0, OUT1, OUT2 and OUT3 (ADDRESS 24h, 25h, 26h and 27h)

bit 7	OUTX								bit 0
	w-0	w-0	w-0	w-0	w-0	w-0	w-0	w-0	
bit 7:0	Value in the output port X (write only register).								
	OUT0 when address is 24h								
	OUT1 when address is 25h								
	OUT2 when address is 26h								
	OUT3 when address is 27h								

16-bit Processors - Output Ports

OUT0_OUT1, OUT2_OUT3 (ADDRESS 24h, 25h)

bit 15	bit 8	bit 7	bit 0
OUTX		OUTY	
W-00h		W-00h	
bit 15:0	Value in the concatenation of two 8-bits output ports OUTX_OUTY.		
	OUT0_OUT1 when address is 24h		
	OUT2_OUT3 when address is 25h		
	No output is modified for addresses 26h and 27h		

24-bit Processors - Output Ports

OUT0_OUT1_OUT2 (ADDRESS 24h)

bit 23	bit 16	bit 15	bit 8	bit 7	bit 0
OUT0		OUT1		OUT2	
W-00h		W-00h		W-00h	
bit 23:0	Value in the concatenation of three 8-bits output ports OUT0_OUT1_OUT2 (write only registers). No output is modified for addresses 25h, 26h and 27h.				

32-bit Processors - Output Ports
OUT0_OUT1_OUT2_OUT3 (ADDRESS 24h)

bit 31	bit 24	bit 23	bit 16	bit 15	bit 8	bit 7	bit 0
OUT0	OUT1	OUT2	OUT3				
W-00h	W-00h	W-00h	W-00h				

bit 31:0 Value in the concatenation of four 8-bits output ports OUT0_OUT1_OUT2_OUT3 (write only registers). No output is modified for addresses 25h, 26h and 27h. PORTS register must be set to E4h.

B.4 Code Condition Register

The **Code Condition Register (CCR)** contains the arithmetic status of the ALU and the status of the thread executed. The **CCR** register can be read by any instruction, as with any other register.

The Z and C elements correspond to the flags that indicate when an operation is zero and when the operation has a carry respectively. These bits indicate the results of the instruction just executed. The Carry bit can be modified using the instructions CLC and SEC.

The bit TA (Thread Active) indicates if the execution thread has finished or not. The instruction END is the only one able to stop the execution of the thread ($TA \leftarrow 0$).

For 16, 24 and 32 bit processors, the most significant bits of **CCR** (from the bit 8) must be assumed as unimplemented, a read operation will return 0's.

Condition Code Register - CCR (ADDRESS 28h)

bit 7	-	-	-	-	-	TA	Z	bit 0 C
	u-0	u-0	u-0	u-0	u-0	r-0	r-0	r-0

bit 7:3 Unimplemented.

bit 2 **TA - Thread Active**

1 = Thread is active.

0 = Thread not active. The END instruction is the only that can stop a thread ($TA \leftarrow 0$).

bit 1 **Z - Zero bit**

1 = The result of a logic or arithmetic operation is zero.

0 = The result of a logic or arithmetic operation is not zero.

bit 0 **C - Carry bit**

1 = The result of a shift, logic or arithmetic operation generates a carry bit.

0 = No carry.

B.5 Mode Register

The Mode register configures the operation mode of the **FU**. In other words, it configures the number of processors in the cell and specifies the configuration of the Data and Program Memories.

The **FU** may have 1 to 4 processors. The **FU** can be configured for data processing of 8, 16, 24 and 32 bits, and the thread capacity can be for 64, 128, 192 or 256 instructions.

This register is loaded for the **C_μP** in prototype when a new cell is inserted. For 16, 24 and 32 bit processors, the most significant bits of MODE (from the bit 8) must be assumed as unimplemented, a read operation will return 0's.

Mode Register - MODE (ADDRESS 29h)

bit 7	-	-	-	-	mode			bit 0
	u-0	u-0	u-0	u-0	r-0	r-0	r-0	r-0

bit 7:4 Unimplemented.

bit 3:0 **mode**: Specifies the Configuration Mode (CM) of cores in Functional Unit.

0000 = CM 0: four processors [P0: 8x8, 64] [P1: 8x8, 64] [P2: 8x8, 64] [P3: 8x8, 64]

0001 = CM 1: three processors [P0: 16x8, 128] [P2: 8x8, 64] [P3: 8x8, 64]

0010 = CM 2: two processors [P0: 16x8, 128] [P2: 16x8, 128]

0011 = CM 3: two processors [P0: 24x8, 192] [P3: 8x8, 64]

0100 = CM 4: one processors [P0: 32x8, 256]

0101 = CM 5: three processors [P0: 8x16, 128] [P2: 8x8, 64] [P3: 8x8, 64]

0110 = CM 6: two processors [P0: 8x16, 128] [P2: 16x8, 128]

0111 = CM 7: two processors [P0: 8x16, 128] [P2: 8x16, 128]

1000 = CM 8: two processors [P0: 8x16, 192] [P2: 16x8, 64]

1001 = CM 9: one processors [P0: 16x16, 256]

1010 = CM 10: two processors [P0: 8x24, 192] [P3: 8x8, 64]

1011 = CM 11: one processors [P0: 8x32, 256]

others = Configuration mode not implemented

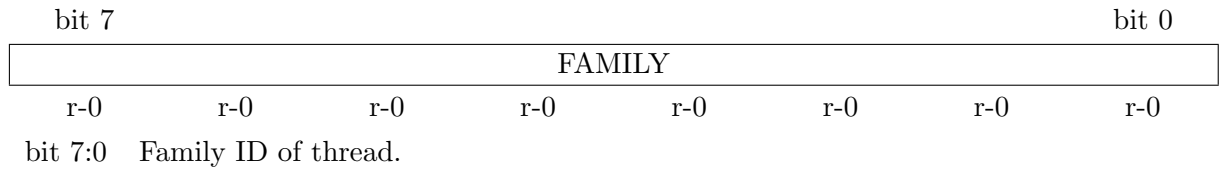
Note: [P0: 16x8, 64] = [Processor 0: General Purpose Registers with 16 words of 8 bits each mapped in Data Memory, Program Memory with capacity for 64 instructions]

B.6 Family Register

The Family register is reserved for future implementations. This register has been reserved for supporting the implementation of microthreads.

This register is loaded for the C μ P in prototype when a new cell is inserted.

Family Register- FAMILY (ADDRESS 2Ah)



B.7 Output Ports Configuration Register (PORTS)

This register configures the CORE that may perform a write operation over any output port of the FU i.e. select the ALU of a CORE that writes the result of any operation to the OUTX register.

For 16, 24 and 32 bit processors, the most significant bits of PORTS (from the bit 8) must be assumed as unimplemented, a read operation will return 0's.

The value of some PORTX field could be disabled when the FTS is enabled in the redundant cell (see FTCSR in section B.9).

This register is loaded for the C_μP in prototype when a new cell is inserted.

Output Ports Configuration Register - PORTS (ADDRESS 2Bh)

bit 7 bit 0

PORT3	PORT2	PORT1	PORT0
r-1 r-1	r-1 r-0	r-0 r-1	r-0 r-0

bit 7:6 **PORT3:** Sets the core that can performs write operations in the OUT3.

- 00 = OUT3 can be written from CORE0
- 01 = OUT3 can be written from CORE1
- 10 = OUT3 can be written from CORE2
- 11 = OUT3 can be written from CORE3

bit 5:4 **PORT2:** Sets the core that can performs write operations in the OUT2.

- 00 = OUT2 can be written from CORE0
- 01 = OUT2 can be written from CORE1
- 10 = OUT2 can be written from CORE2
- 11 = OUT2 can be written from CORE3

bit 3:2 **PORT1:** Sets the core that can performs write operations in the OUT1.

- 00 = OUT1 can be written from CORE0
- 01 = OUT1 can be written from CORE1
- 10 = OUT1 can be written from CORE2
- 11 = OUT1 can be written from CORE3

bit 1:0 **PORT0:** Sets the core that can performs write operations in the OUT0.

- 00 = OUT0 can be written from CORE0
- 01 = OUT0 can be written from CORE1
- 10 = OUT0 can be written from CORE2
- 11 = OUT0 can be written from CORE3

The next are sample values for PORTS register, each value depends of configuration mode, e.g., if MODE=00h and PORTS=E4h, the processor 0 (P0) can write any value to OUT0, P1 to OUT1, P2 to OUT2 and P3 to OUT3. In this case, if P0 performs a write operation over OUT1, OUT2 or OUT3, these registers will not be affected.

MODE	PORTS	P0	P1	P2	P3
00h	E4h	OUT0	OUT1	OUT2	OUT3
01h	E0h	OUT0, OUT1	-	OUT2	OUT3
02h	A0h	OUT0, OUT1	-	OUT2, OUT3	-
03h	C0h	OUT0, OUT1, OUT2	-	-	OUT3
04h	00h	OUT0, OUT1, OUT2, OUT4	-	-	-
05h	E4h	OUT0_OUT1	-	OUT2	OUT3
06h	A4h	OUT0_OUT1	-	OUT2, OUT3	-
07h	E4h	OUT0_OUT1	-	OUT2_OUT3	-
08h	F4h	OUT0_OUT1	-	-	OUT2, OUT3
09h	44h	OUT0_OUT1, OUT2_OUT3	-	-	-
0Ah	E4h	OUT0_OUT1_OUT2	-	-	OUT3
0Bh	E4h	OUT0_OUT1_OUT2_OUT3	-	-	-

- Denotes that the processor is unimplemented.

, Denotes output registers in different addresses.

_ Denotes concatenation of two or more output registers.

B.8 Subprocess Configuration and Status Register (SUBPCSR)

This register controls the execution of subprocesses in the system.

For 16, 24 and 32 bit processors, the most significant bits of SUBPCSR (from the bit 8) must be assumed as unimplemented, a read operation will return 0's.

Subprocess Configuration and Status Register SUBPCSR (ADDRESS 2Ch)

bit 7	SWS	ESP3	ESP2	ESP1	ESP0	SUBPID	bit 0
	r-0	w/r-0	w/r-0	w/r-0	w/r-0	w/r-0	w/r-0
bit 7	SWS - SYSTEM WAIT STATE: The SYSTEM is in wait state. The GCU of the master chip could receive subprocess instructions. This bit is controlled by CCU. 1 = SYSTEM in wait state. This bit is set when the CCU receives a frame that contains a command related to the state <i>wait</i> . 0 = SYSTEM is not in wait state. When a processor sets EXSP bit to high level or when a cell receives any data from INET, this bit is set to zero automatically.						
bit 6	ESP3 - ENDS SUBPROCESS 3: The execution of the subprocess 3 has ended. The CCU sets this bit, but must be cleared by software. 1 = Creation of subprocess 3 end. 0 = No creation.						
bit 5	ESP2 - ENDS SUBPROCESS 2: The execution of the subprocess 2 has ended. The CCU sets this bit, but must be cleared by software. 1 = Creation of subprocess 2 end. CCU sets this bit. It must be cleared by software. 0 = No creation.						
bit 4	ESP1 - ENDS SUBPROCESS 1: The execution of the subprocess 1 has ended. The CCU sets this bit, but must be cleared by software. 1 = Creation of subprocess 1 end. 0 = No creation.						
bit 3	ESP0 - ENDS SUBPROCESS 0: The execution of the subprocess 0 has ended. The CCU sets this bit, but must be cleared by software. 1 = Creation of subprocess 0 end. 0 = No creation.						
bit 2:1	SUBPID - SUBPROCESS ID: ID of the subprocess to execute. 00 = Subprocess 0. 01 = Subprocess 1. 10 = Subprocess 2. 11 = Subprocess 3.						
bit 0	EXSP - EXECUTE SUBPROCESS: Executes a subprocess for a specific component. 1 = The FU sends a command indicating to execute a subprocess of the component to which the cell belongs. 0 = No execute.						

Note: when using the instruction MOVLf for writing this register, be sure to configure appropriately the destination (d=0), otherwise you may modify the register value.

B.9 Fault Tolerance Configuration and Status Register (FTCSR)

This register configures the [Fault Tolerance System \(FTS\)](#).

For 16, 24 and 32 bit processors, the most significant bits of FTCSR (from the bit 8) must be assumed as unimplemented, a read operation will return 0's.

This register is loaded for the [C_μP](#) in prototype when a new cell is inserted.

Fault Tolerance Configuration and Status Register FTCSR (ADDRESS 2Dh)

bit 7	bit 0						
FTEF	FTE	-	FTRC	ft_mode			
r-0	r-0	u-0	r-0	r-0	r-0	r-0	r-0
bit 7	FTEF - FAULT TOLERANCE ERROR FLAG: The FT error flag indicates when the FTS found an error while performing the comparison between two processors. 1 = A FT error was detected, self-elimination and self-replication processes start. 0 = no FT error.						
bit 6	FTE - FAULT TOLERANCE ENABLE: Enables or disables the FTS. 1 = FTS enabled. 0 = FTS disabled.						
bit 5	Unimplemented.						
bit 4	FTRC - FAULT TOLERANCE REDUNDANT CELL: Indicates if the cell is the redundant cell, this bit should be set in ft_modes = 5, 6, 7 and 8. The data bus of a core is connected to output ports directly i.e. some bits of PORTS register are disabled, RE is set to '1'. 1 = Redundant cell. It automatically disables the comparators of FTS for this cell. FT_mode 5: The CORE0 writes permanently the OUT0 (C0⇒OUT0). PORT0 disabled (P0-D). FT_mode 6: C0⇒OUT0, C1⇒OUT1. [P0,P1]-D. FT_mode 7: C0⇒OUT0, C1⇒OUT1, C2⇒OUT2. [P0,P1,P2]-D. FT_mode 8: C0⇒OUT0, C1⇒OUT1, C2⇒OUT2, C3⇒OUT3. [P0,P1,P2,P3]-D. 0 = Primary cell.						
bit 3:0	FT_MODE: Specifies the fault tolerance configuration mode. 0000 = FT_mode 0: [C0 ⇔ C1] 0001 = FT_mode 1: [C0 ⇔ C1] & [C2 ⇔ C3] 0010 = FT_mode 2: [C2 ⇔ C3] 0011 = FT_mode 3: [C0 ⇔ C2] 0100 = FT_mode 4: [C0 ⇔ C2] & [C1 ⇔ C3] 0101 = FT_mode 5: [C0 ⇔ C0*] 0110 = FT_mode 6: [C0 ⇔ C0*] & [C1 ⇔ C1*] 0111 = FT_mode 7: [C0 ⇔ C0*] & [C1 ⇔ C1*] & [C2 ⇔ C2*] 1000 = FT_mode 8: [C0 ⇔ C0*] & [C1 ⇔ C1*] & [C2 ⇔ C2*] & [C3 ⇔ C3*] others = FT configuration mode not implemented						

Note: Symbol ⇔ indicates comparison between CORES (C). *Denote a CORE in the redundant cell. The connections must be implemented by user.

Appendix C

Flow Diagrams for Self-adaptive Processes in System

*Sports do not build character. They reveal it.
El deporte no construye el carácter. Lo revela.*
Haywood Hale Broun (1918 – 2001)

Abstract: This chapter presents the flow diagrams of self-adaptive algorithms included in the system. These algorithms are implemented in the Configuration Units of Cell and Switch Matrix. The flow diagrams presented include the algorithms for self-placement, self-routing and self-derouting processes.

Along this chapter, the labels “_inet” and “_enet” will be added to differentiate frames that includes commands related with the [Internal Network \(INET\)](#) and [External Network \(ENET\)](#) respectively.

C.1 Transmission and Reception in Cell

The transmission and reception processes used for the [Cell Configuration Unit \(CCU\)](#) are shown in [Figure C.1](#). The [CCU](#) implements these algorithms for the communication with the [Global Configuration Unit \(GCU\)](#) through [INET](#). The communication protocol and interface communication are explained in detail in sections [2.11](#) and [2.12](#). These processes participate actively in the self-routing and self-placement algorithms.

The data in frames is divided in four groups. The first group (`tx_control = 00`) sends between 1 and 256 bytes of information, using the `nBytes` field for specifying the number of bytes. The second group (`tx_control = 01`) only sends the command, it does not send arguments. The third group are the commands that use the acknowledge bit (`tx_control = 10`) and the last group (`tx_control = 11`) use the transmission and reception to perform a comparison process of data (8-bits).

When the [CCU](#) requires the acknowledge bit, the transmission process always sends a logic ‘1’ in the time space of the acknowledge bit, and the reception process performs simultaneously the read and write of the acknowledge bit. It is important to note that all the cells in the array participate in this process, but only one can write the acknowledge bit with a logic ‘0’, the cell which *address* match with the *address* field of the frame.

It is possible that several [CCUs](#) require the comparison of a special number to take any action, in this case the [CCUs](#) send the control bits (11), the associated command (`scan...`) and

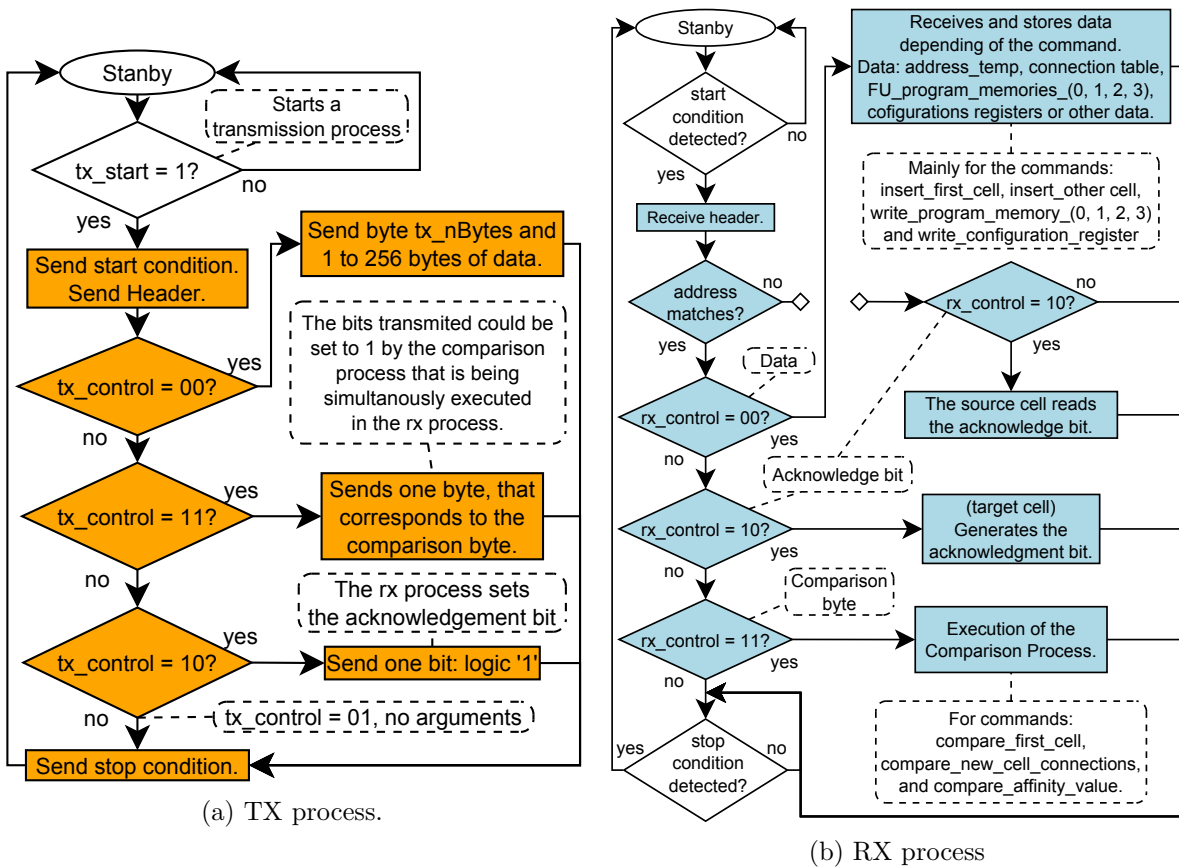


Figure C.1: Transmission and reception processes in Cell Configuration Unit.

the comparison byte. The reception process performs the simultaneous comparison of the data. The winner is the cell that has the lowest comparison value, in case of a tie, the winner will be the leftmost uppermost cell in the array.

C.2 Self-Placement Processes in CCU

C.2.1 Flow Diagram for Insertion of First Cell of a Component

Figure C.2 shows a detailed description of the algorithm implemented by cells for the insertion process of the first cell of a component. The process is started by GCU who sends the command *insert_first_cell_inet* with the *address* and connection tables of the new cell as arguments. The process ends when the GCU receives the command *end_first_cell_inet*.

C.2.2 Flow Diagram for Insertion of Other Cells of a Component

The process is started by GCU who sends the command *insert_other_cell_inet* with the *address* and connection tables of the new cell as arguments. The flow diagram of the algorithm that performs the self-placement of the other cells of the component (from the second) is shown in Figure C.3.

It is important to note, that after the placement process, the self-routing process at cell level starts. The self-placement and self-routing processes ends when the GCU receives the command *end_other_cell_inet* (Figure C.4).

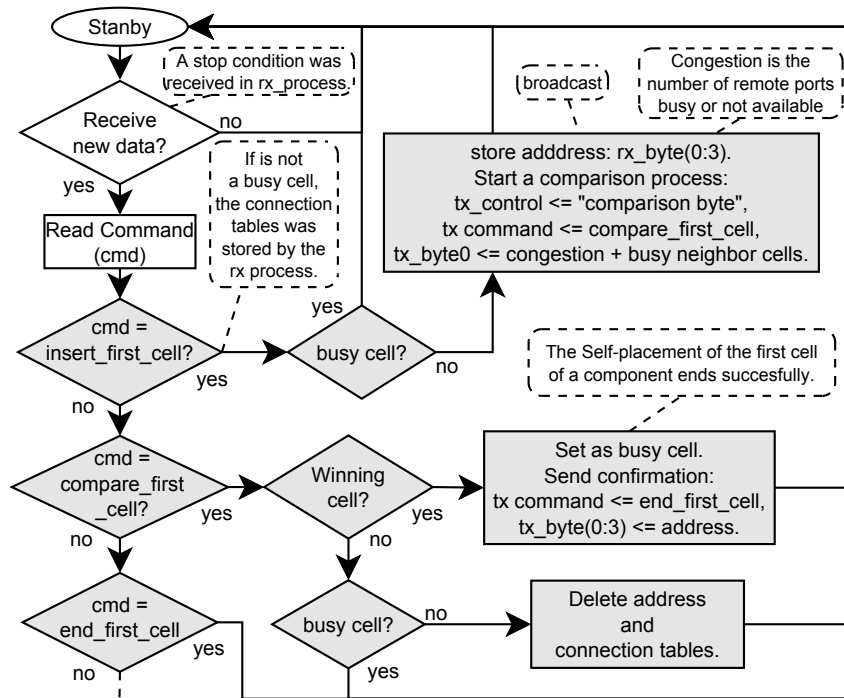


Figure C.2: Self-placement algorithm for the insertion of the first cell of a component.

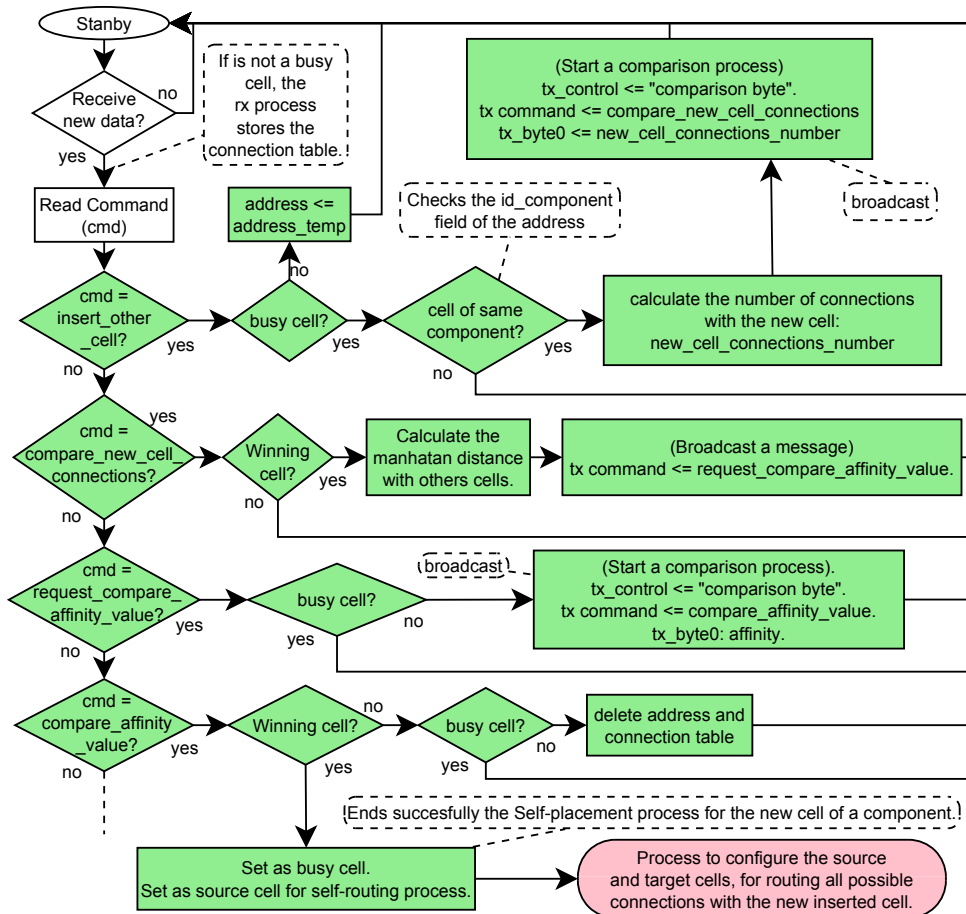


Figure C.3: Self-placement algorithm for other cells of a component (from the second).

C.3 Self-Routing Processes in CCU

C.3.1 Flow Diagram to select the Source and Target cells before the Expansion Process at Cell Level

The algorithm presented in Figure C.4 is executed after the insertion of the remaining cells of a component (from the second). Note that the process starts when the self-placement algorithm presented in Figure C.3 ends.

When the *source_cell* and *target_cell* are ready to configure a connection, the *source_cell* starts the “Expansion Process at Cell Level”. For this purpose the flag *Starts Cell Propagation* is used.

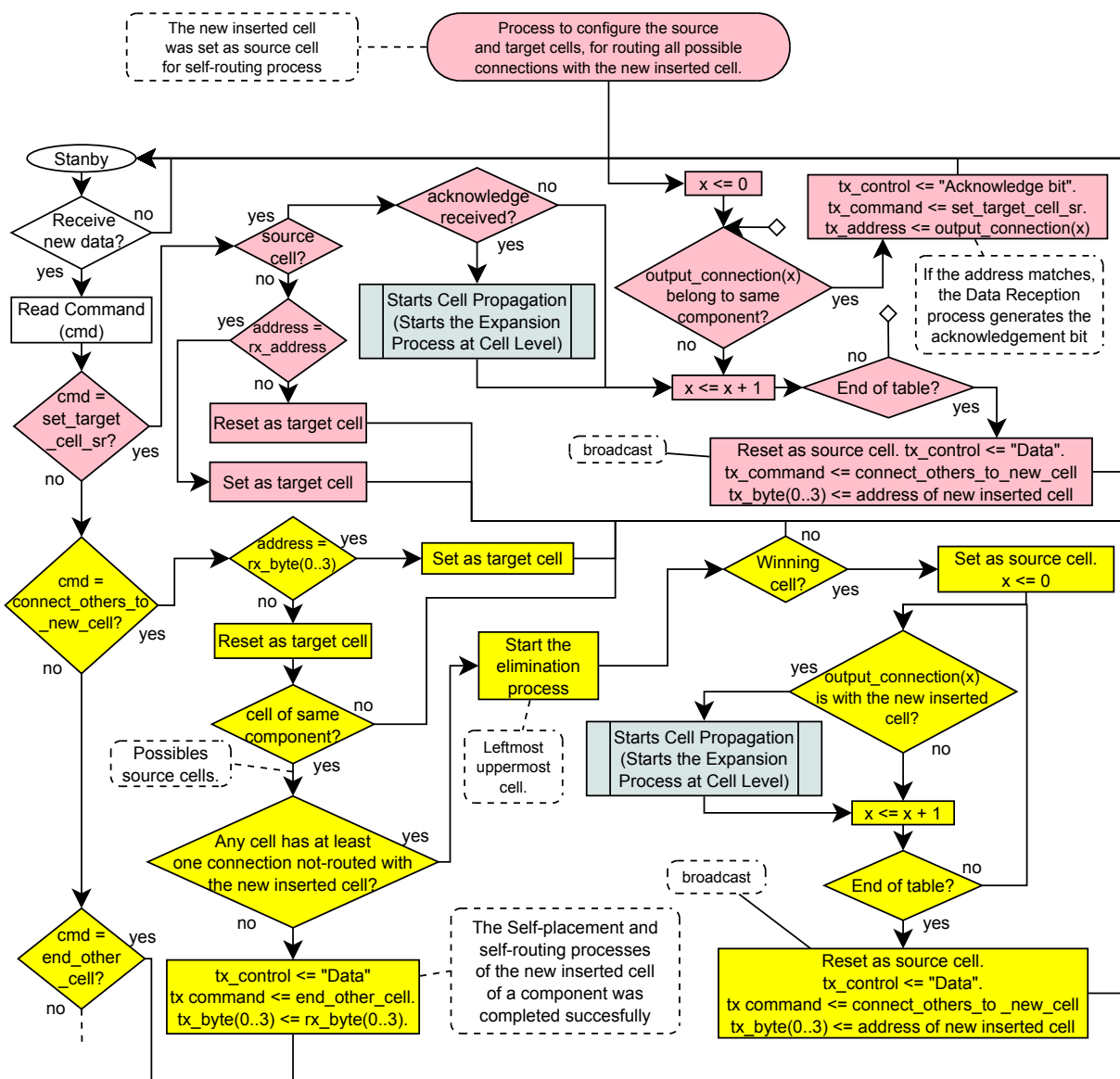


Figure C.4: Configuration of source and target cell for execution of Expansion Process at Cell Level.

C.3.2 Main Flow Diagram in CCU

Figure C.5 shows the flow diagram for the Expansion and Release processes in Cell Configuration Unit (CCU). This is the start point for the execution of any process in system that requires the propagation of signals using the expansion ports of cells, SMs and PIMs. It includes the Expansion at Cell or Component level and the Release processes.

The flow diagram remains in *standby* state until the CCU of a cell in the array starts one of the following process:

1. Expansion Process at Cell Level (Search Phase): this process is started by the *source_cell* when the signal *start_cell_propagation* is set.
2. Expansion Process at Component Level (Search Phase): this process is started by the *source_cell* when the signal *start_component_propagation* is set.
3. Expansion Process at Component Level (Search Phase): this process is started by the *source_cell* when the signal *start_component_propagation_pin* is set.
4. Release Process: this process is started by the *target_cell* when the signal *start_delete_cell_connection* is set.

The cells on the array that receive any propagation signals can execute any of the process denoted with a box in the figure, as follows:

1. Neighbor [NORTH, EAST, SOUTH or WEST]: The process is executed when a *neighbor_in_X* signal is received. These boxes represent the transition between the Search and Configuration Phases of the Expansion Process at Cell Level when the *target_cell* is reached in a neighbor cell.
2. Propagate [NORTH, EAST, SOUTH or WEST]: The process is executed when a *propagate_in_X* signal is received. These boxes represent the transition between the Search and Configuration Phases of the Expansion Process at Cell Level when the *target_cell* is reached.
3. Propagate Matrix: The process is executed when a *propagate_in_matrix* signal is received. This box represents the transition between the Search and Configuration Phases of the Expansion Process at Component Level when the *target_cell* is reached.
4. Delete [NORTH, EAST, SOUTH or WEST]: The process is executed when a *del_connection_in_X* signal is received. These boxes represent a step in the Release Process at Cell Level.
5. Delete Matrix: The process is executed when a *del_connection_in_matrix* signal is received. This box represents the end of the Release Process at Component Level.
6. Expansion Process at Cell Level - Configuration Phase [NORTH, EAST, SOUTH or WEST]: The process is executed when the cell is in *lock_cell* state and a *lock_in_X* signal is received. These boxes represent the Configuration Phase of the Expansion Process at Cell Level.

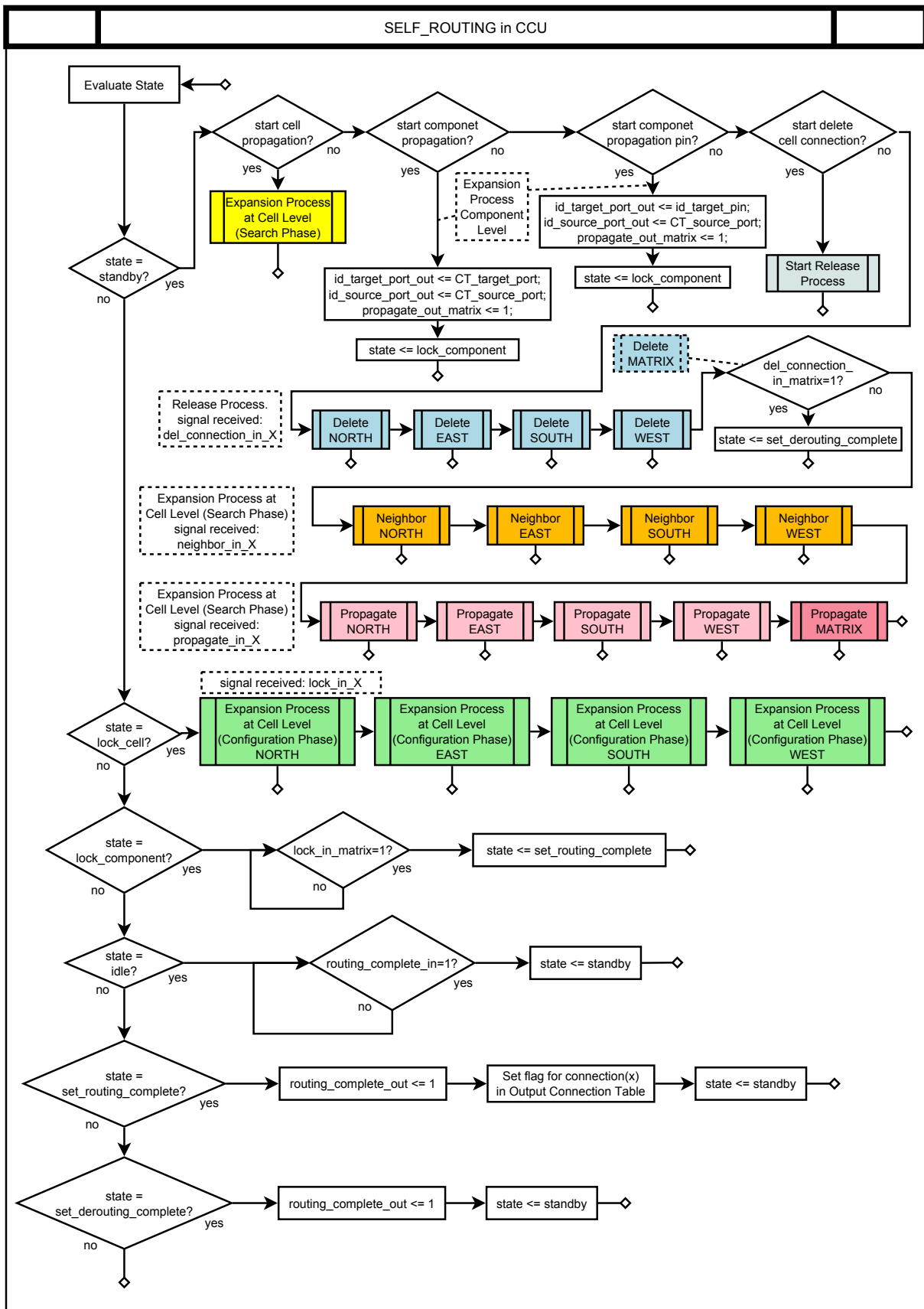


Figure C.5: Main flow diagram for Expansion and Release processes in Cell Configuration Unit.

C.3.3 Expansion Process at Cell Level - Search Phase

The search phase is started by the *source_cell*. This is an expansion process that propagates signals in the sides of the cell that have available routing resources, like local and/or remote free ports. The propagation process includes the configuration of signals for each side (north, east, south and west) of the cell as shown in Figure C.6.

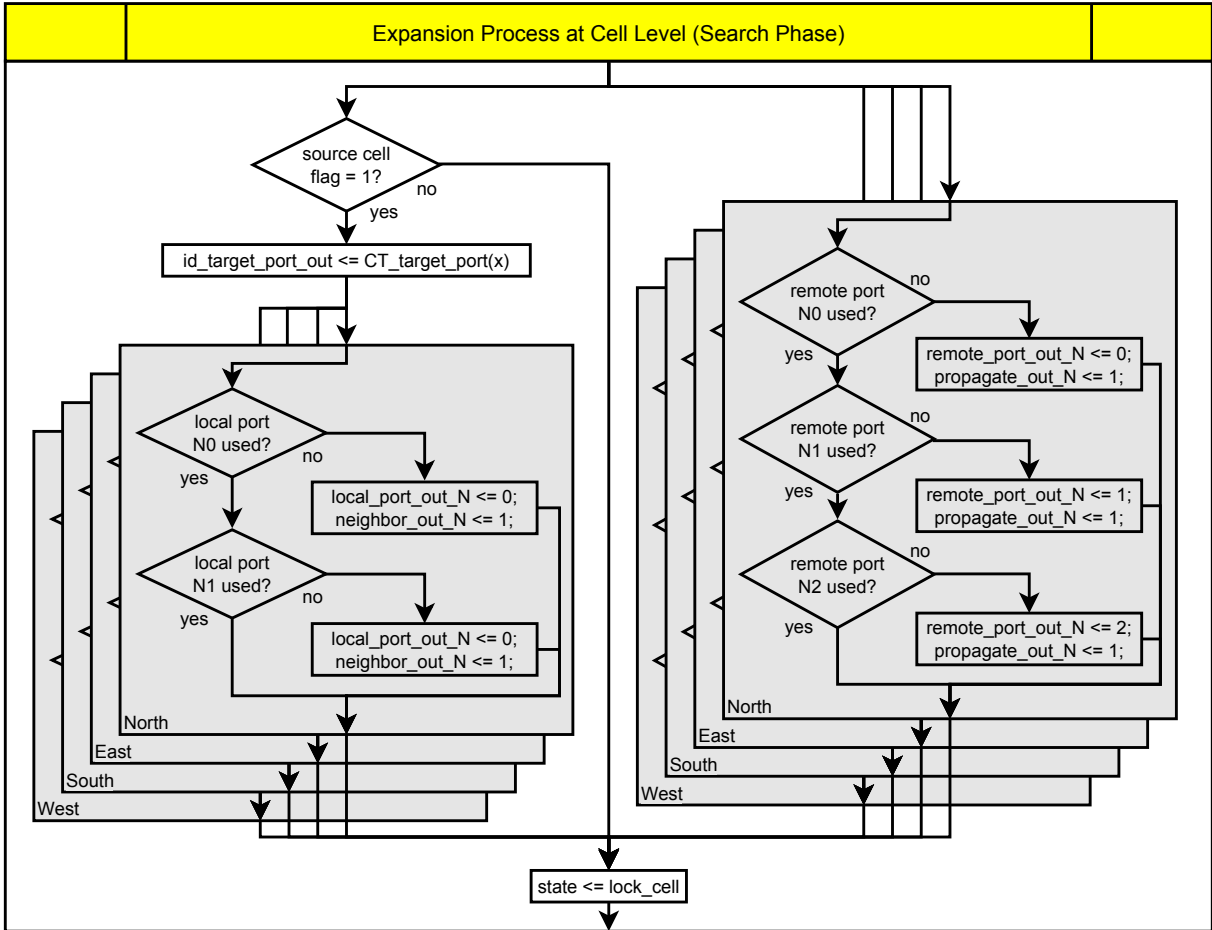
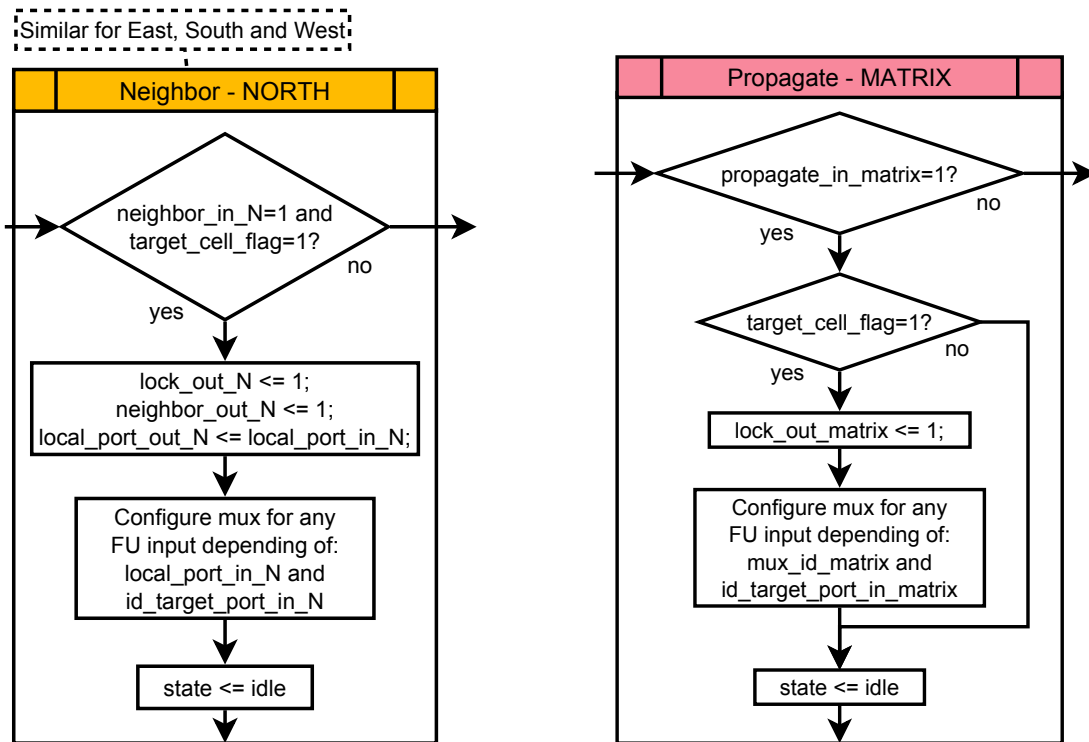


Figure C.6: Flow diagram for the propagation of Signals in the Search Phase of the Expansion Process at Cell Level.

Note that propagation of *neighbor_out_X* signal is only available for *source_cell* when local ports are available. The *source_cell* and the other cells that participate in the Search Phase use the *propagate_out_X* signal when remote ports are available.

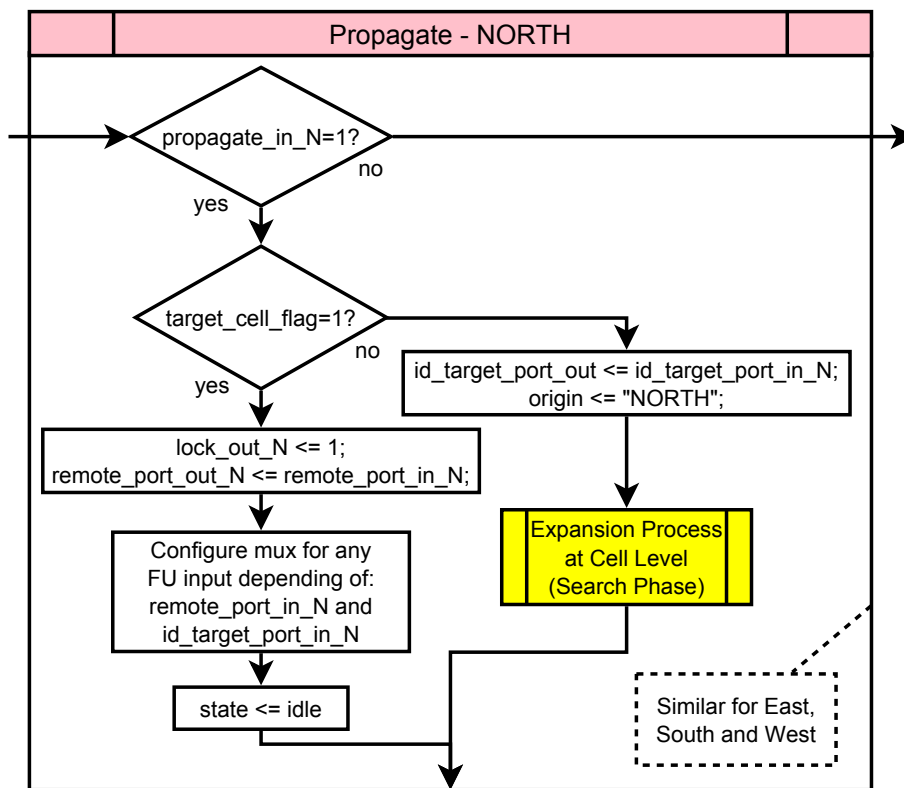
When the *target_cell* is a neighbor cell, the Search Phase ends and the Configuration Phase starts as shown in Figures C.7a and C.7c. Note that these figures show the case for a propagation signal received from NORTH. Similar functionality must be assumed for EAST, SOUTH and WEST.

When the *target_cell* is not a neighbor cell, the propagation (C.6) is executed by each cell that reads the *propagate_in_X* signal as shown in Figure C.7c. The priority order for propagation signals is NORTH, EAST, SOUTH and WEST. The *origin* register stores the side from which the propagation signal was received. The propagation process explores the entire cell array until finding the *target_cell*, if possible. The Configuration Phase starts when the Search Phase finds the *target_cell*.



(a) Propagation signal at cell level for a neighbor cell.

(b) Propagation signal at component level.



(c) Propagation signal at cell level.

Figure C.7: Flow diagrams for Expansion Process when propagation input signals is received in Cell Configuration Unit.

C.3.4 Expansion Process at Cell Level - Configuration Phase

The Configuration Phase at Cell Level starts when the Search Phase finds the *target_cell* (Figures C.7a and C.7c).

The Configuration Phase that was started by the *target_cell* goes backward over the path previously configured in the Search Phase until it arrives to the *source_cell*. This process configures the multiplexers of the corresponding cells to fix the path. The cells that participate in this process are in the state *lock_cell* and perform the actions described in Figure C.8 when the signal *lock_in_X* in the corresponding side is activated. Similar functionality must be assumed for EAST, SOUTH and WEST.

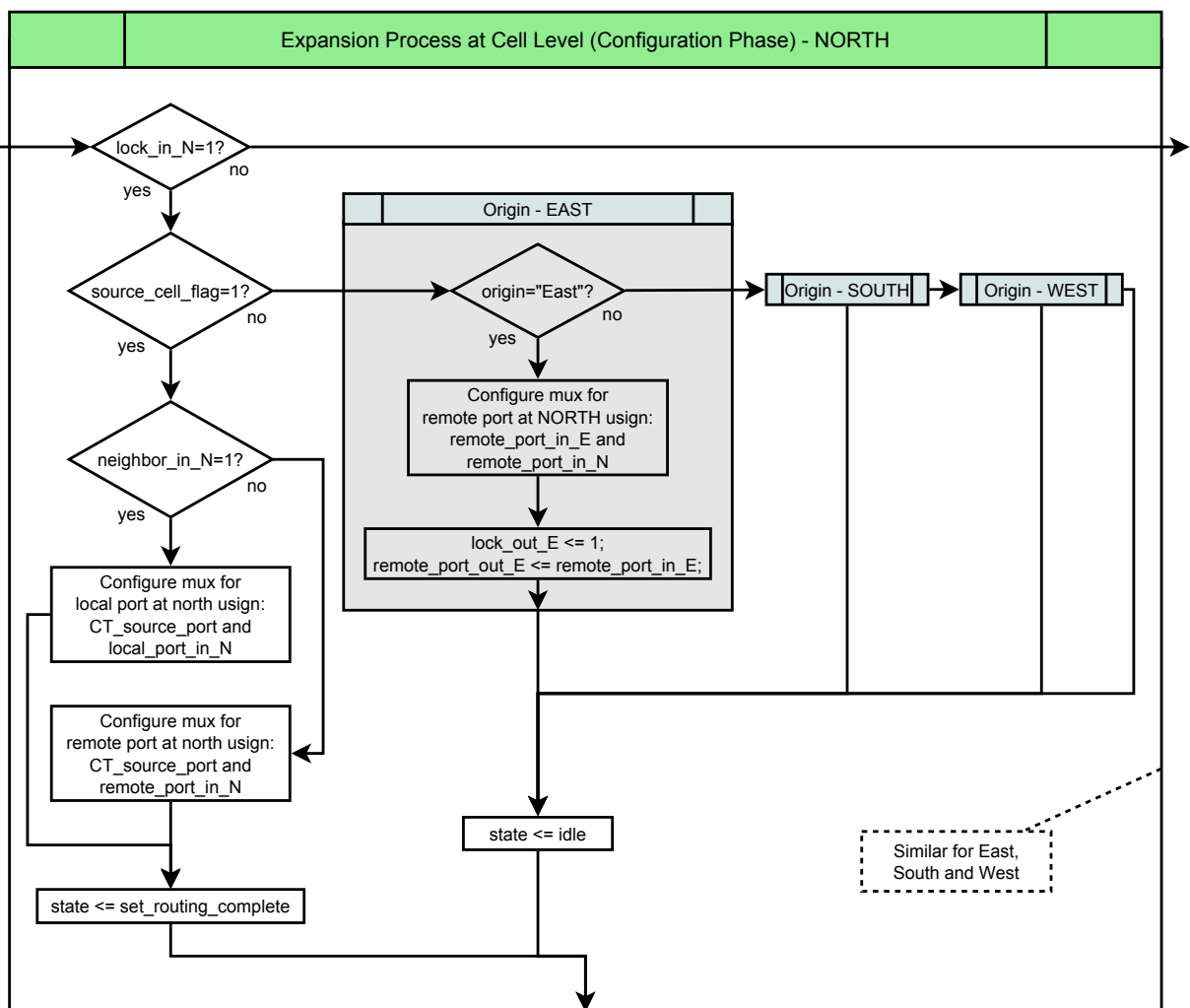


Figure C.8: Flow diagram for Configuration Phase of the Expansion Process at Cell Level.

C.3.5 Release Process at Cell Level

This process releases the routing resources used for a interconnection between cells. The Release Process goes from the *target* to the *source* of a connection.

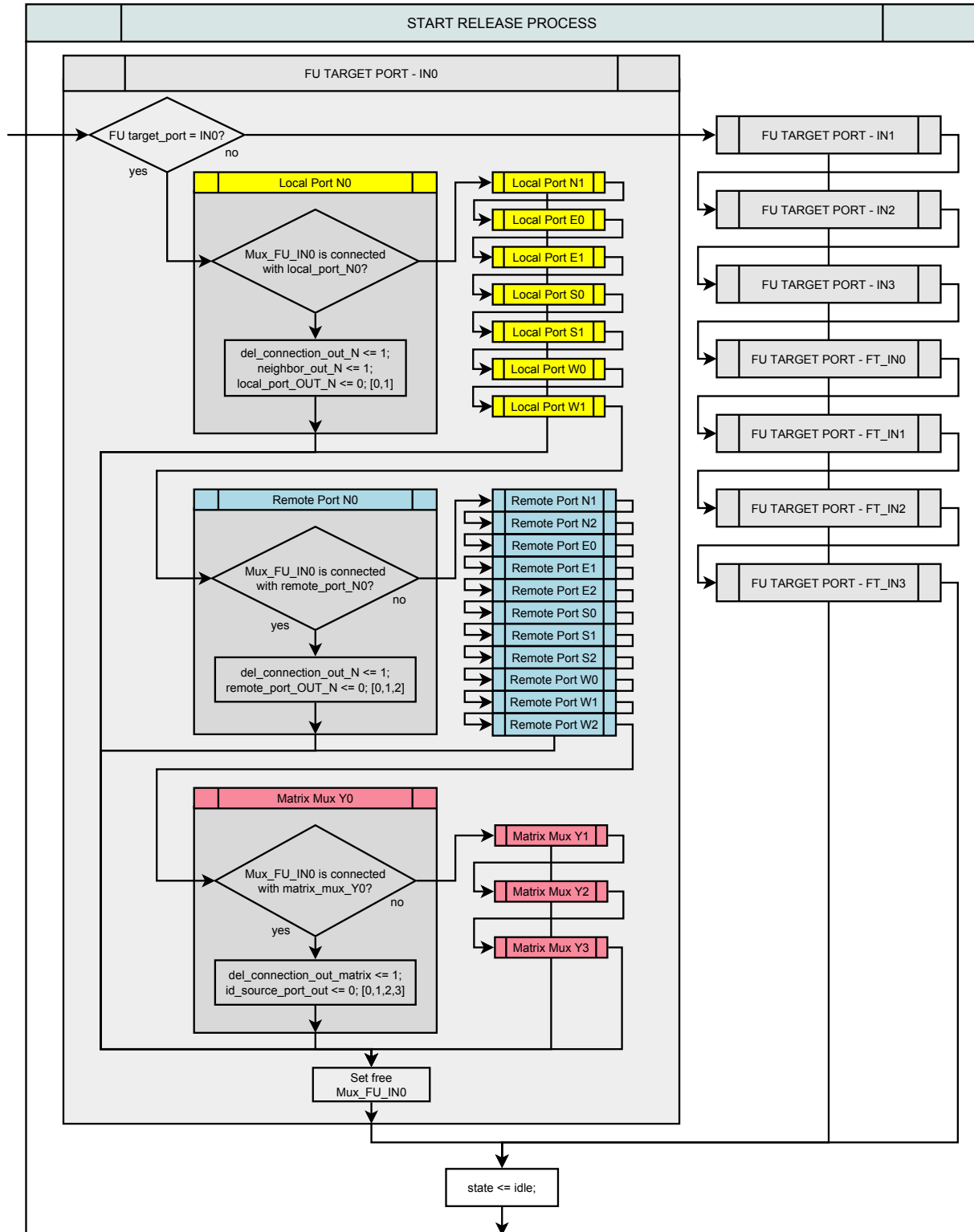


Figure C.9: Flow diagram of the start point of Release Process at Cell and Component Level.

If the connection is at cell level, the multiplexers of FU inputs, local and remote cell ports are released. In this case, the Release Process starts from the FU input port of the *target_cell* and go backwards to the FU output port of the *source_cell*. This process reads the multiplexers configuration and propagate the signal *del_connection_out_X* in the direction where the connection was previously established by the self-routing process.

The *target_cell* starts the process presented in Figure C.5 when the flag *start_delete_cell_connection* is set. Then, the *target_cell* executes the algorithm presented in Figure C.9. Thereafter, each cell that receives the signal *del_connection_in_X* executes the algorithm presented in Figure C.10 until it finds the *source_cell*, which goes to the state *set_derouting_complete* and the process ends.

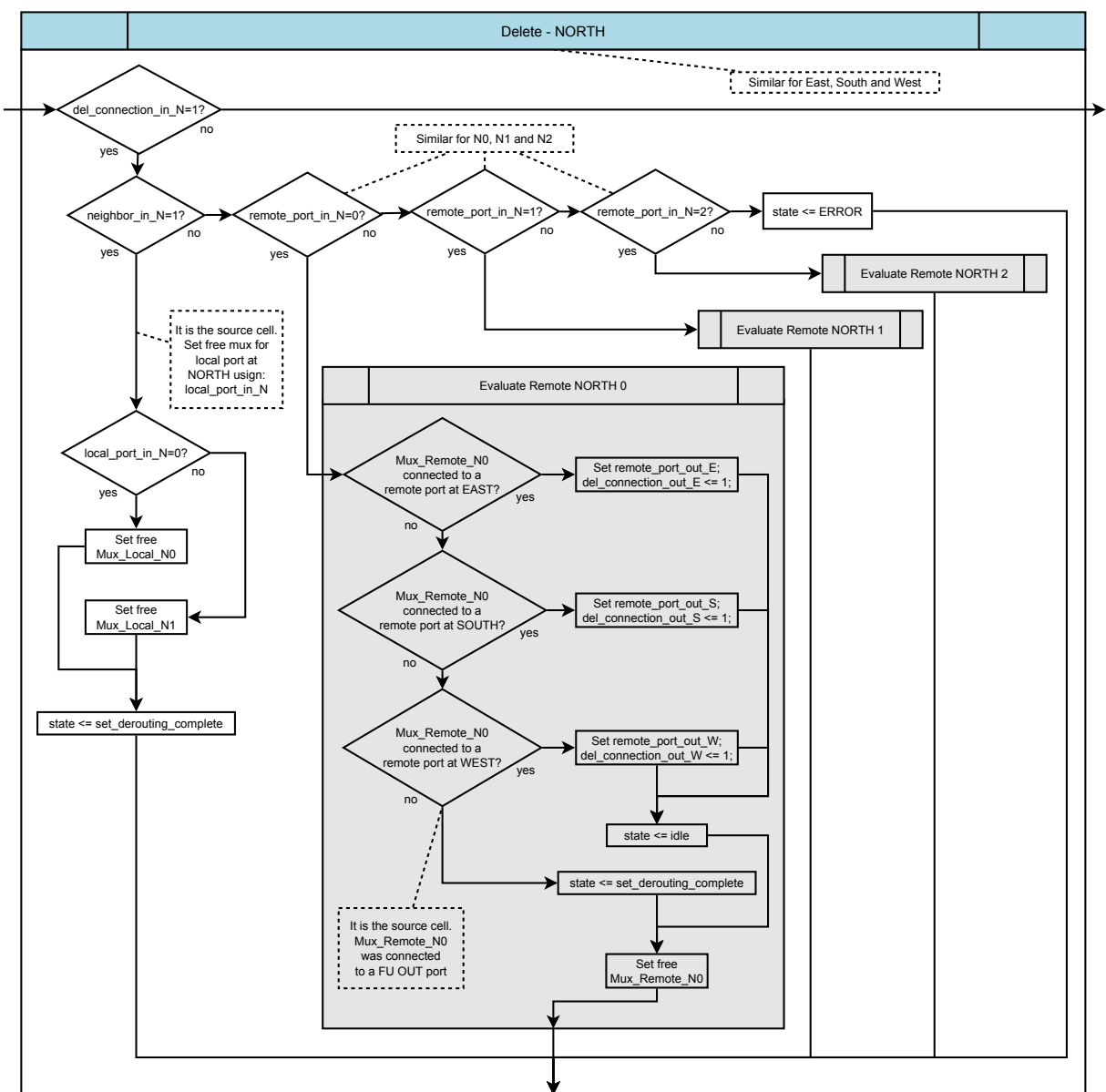


Figure C.10: Flow diagram of Release Process at Cell Level.

C.4 Self-Routing Processes in SMCU

When the Expansion or Release processes are at component level, the propagation of signals is made between cells and SMs. Note that the process must be started and finalized by cells (Figure C.5) that propagate signals to the SM that belongs to the cluster, which in turn propagates signals to the SMs of neighboring clusters until it finds the destination cell of a process.

Figure C.11 shows the flow diagram for the Expansion and Release processes in Switch Matrix Configuration Unit (SMCU). It includes the Expansion at Cell or Component level and the Release processes.

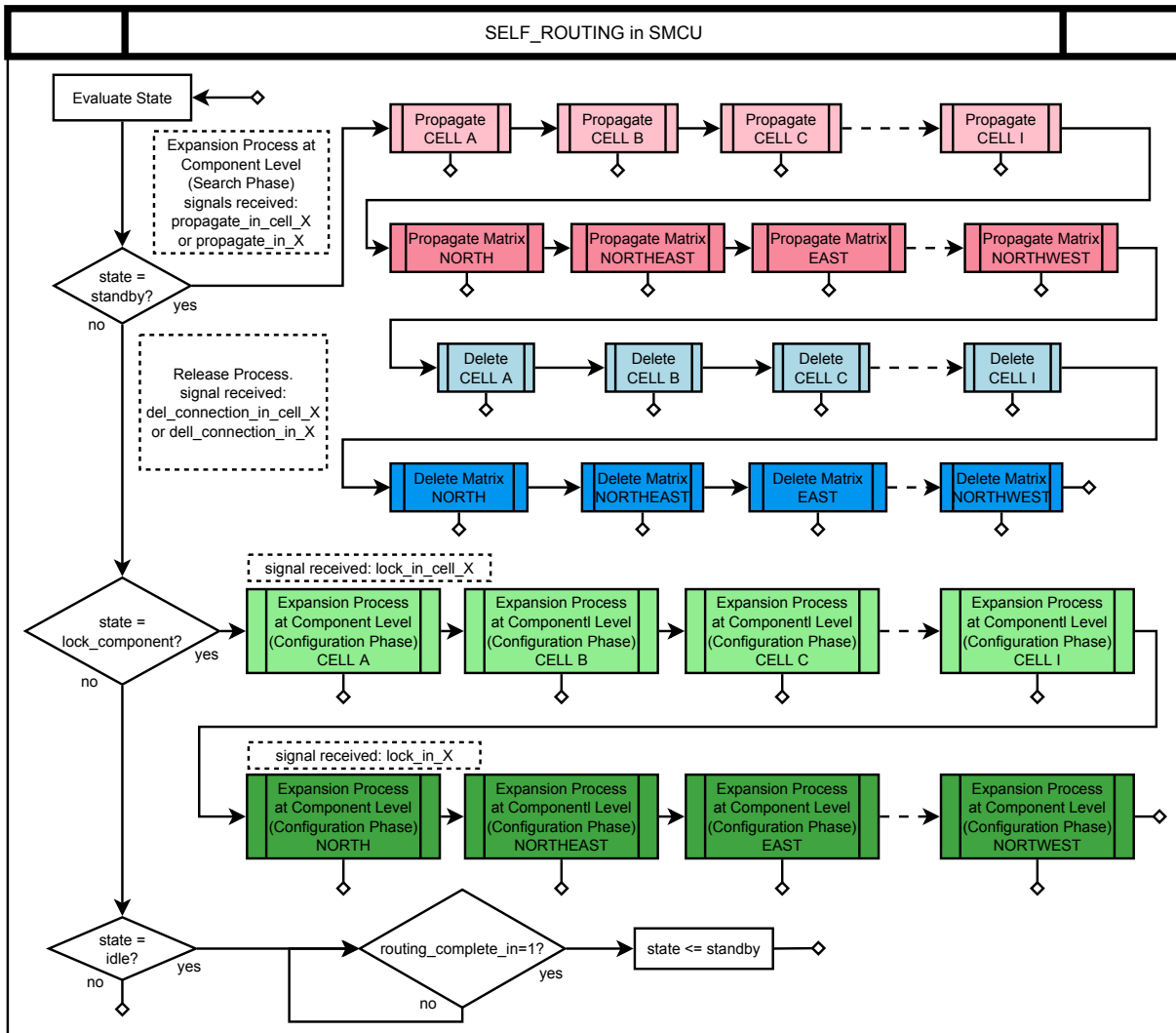


Figure C.11: Main flow diagram for Expansion and Release processes in Switch Matrix Configuration Unit.

The SMCU remains in *standby* state until the CCU of a cell in the array starts one of the following process:

1. Expansion Process at Component Level: this process is started by the *source_cell* when the signal *start_component_propagation* is set.
2. Expansion Process at Component Level: this process is started by the *source_cell* when the signal *start_component_propagation_pin* is set.

3. Release Process at Component Level: this process is started by the *target_cell* when the signal *start_delete_cell_connection* is set.

The **SM** that receives any propagation signals can execute any of the process denoted with a box in the figure, as follows:

1. Propagate CELL [A, B, C, D, E, F, G, H or I]: The process is executed when a *propagate_in_cell_X* signal is received. These processes correspond with the Search Phase of the Expansion Process at Component Level.
2. Propagate Matrix [NORTH, NORTHEAST, EAST, SOUTHEAST, SOUTH, SOUTHWEST, WEST or NORTHWEST]: The process is executed when a *propagate_in_X* signal is received. These processes correspond with the Search Phase of the Expansion Process at Component Level.
3. Delete Cell [A, B, C, D, E, F, G, H or I]: The process is executed when a *del_connection_in_cell_X* signal is received. These boxes correspond with the Release Process at component level.
4. Delete Matrix [NORTH, NORTHEAST, EAST, SOUTHEAST, SOUTH, SOUTHWEST, WEST or NORTHWEST]: The process is executed when a *del_connection_in_X* signal is received. These boxes correspond with the Release Process at component level.
5. Expansion Process at Component Level - Configuration Phase [A, B, C, D, E, F, G, H or I]: The process is executed when the **SM** is in *lock_component* state and a *lock_in_cell_X* signal is received.
6. Expansion Process at Component Level - Configuration Phase [NORTH, NORTHEAST, EAST, SOUTHEAST, SOUTH, SOUTHWEST, WEST or NORTHWEST]: The process is executed when the **SM** is in *lock_component* state and a *lock_in_X* signal is received.

C.4.1 Expansion Process at Component Level - Search Phase

The search phase is started by the *source_cell* (Figure C.5) with the signal *propagate_out_matrix*. The *source_cell* goes to the *lock_component* state waiting for the Configuration Phase. The process continues at component level when the **SM** reads the signal *propagate_in_cell_X* as shown in Figure C.12a, then the **SM** propagate signals until it finds the *target_cell*. If the *target_cell* is not in the same cluster, the **SM** continues the Search Phase when it receives the propagation signal *propagate_in_X* as shown in Figure C.12b. Note that these figures show the case for a propagation signal received from Cell A and **SM** at NORTH. Similar functionality must be assumed for other cells and other sides of **SM**.

The expansion process propagates signals in the sides of the **SM** that has available routing resources. The propagation process includes the configuration of signals for each side (north, northeast, east, southeast, south, southwest, west and northwest) of the **SM** and for each cell of the cluster (Cell A, Cell B, ... Cell I) as shown in Figure C.13.

The priority order for propagation signals is NORTH, NORTHEAST, EAST, SOUTHEAST, SOUTH, SOUTHWEST, WEST and NORTHWEST. The *origin_cell* and *origin_matrix* register stores the cell or the side from which the propagation signal was received. The propagation process explores the entire cell array until finding the *target_cell*, if possible. The Configuration Phase starts when the Search Phase finds the *target_cell*.

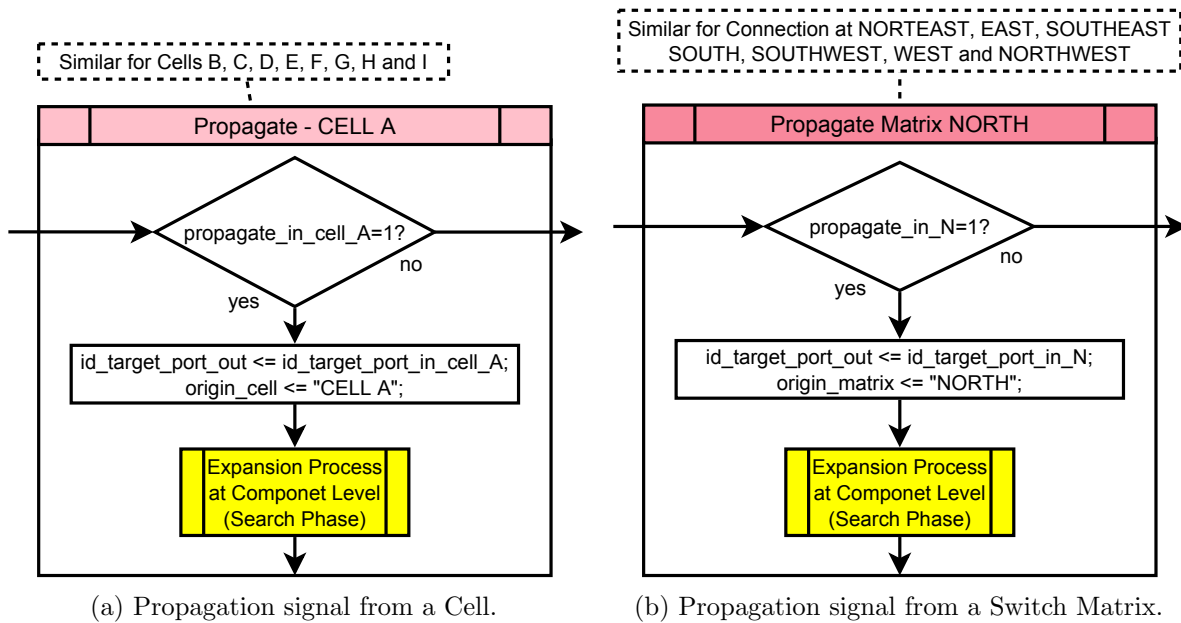


Figure C.12: Flow diagrams for propagation input signals at component level in Switch Matrix Configuration Unit.

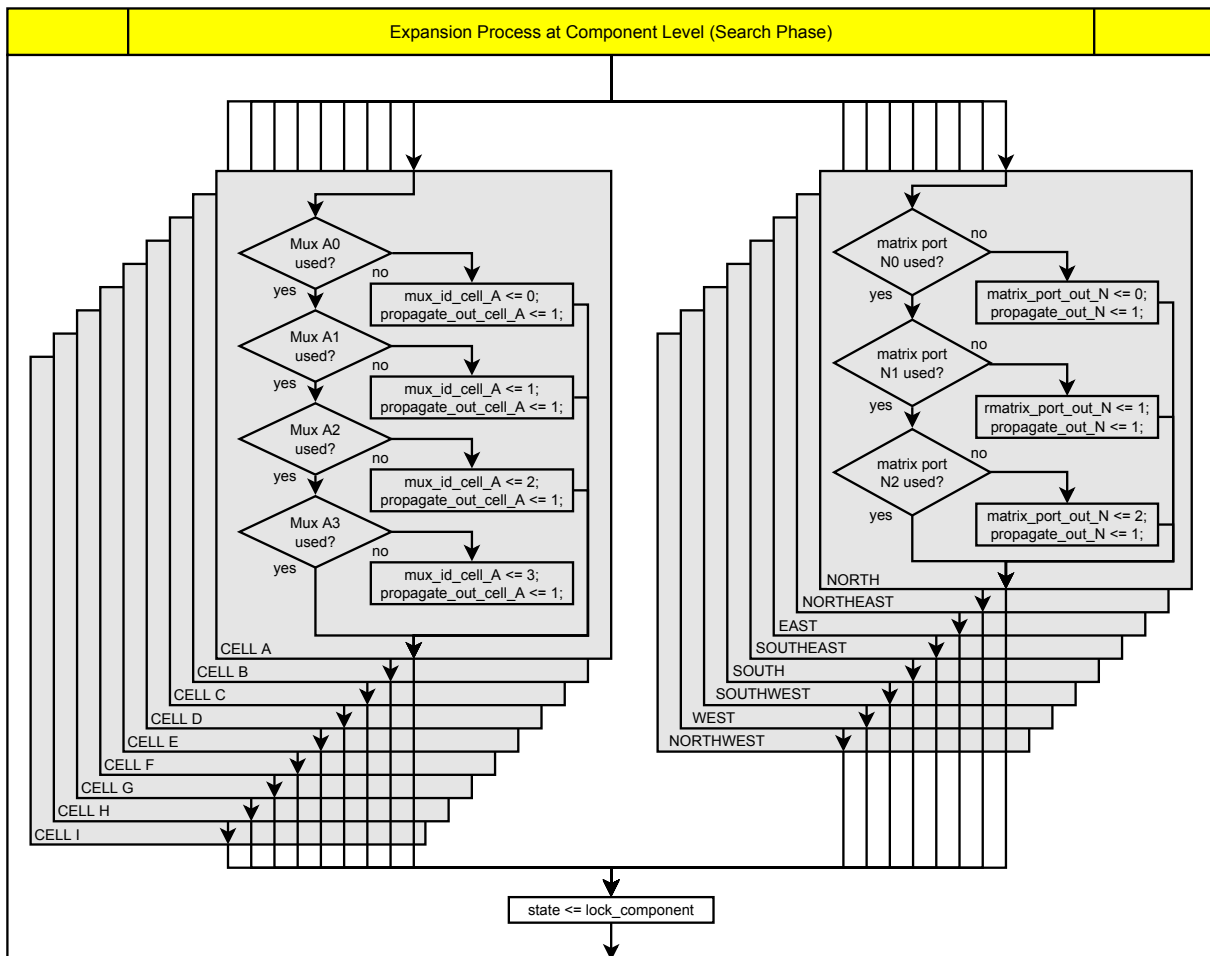


Figure C.13: Flow diagram for the propagation of Signals in the Search Phase of the Expansion Process at Component Level.

C.4.2 Expansion Process at Component Level - Configuration Phase

The Configuration Phase at Component Level starts when the Search Phase finds the *target_cell* (Figure C.5), in the process denoted as Propagate Matrix (Figure C.7b), then the multiplexer of the appropriate FU input port is configured (FU *target_port*).

The Configuration Phase that was started by the *target_cell* goes backward over the path previously configured in the Search Phase until it arrives to the *source_cell*. This process configures the multiplexers of the corresponding SMs to fix the path.

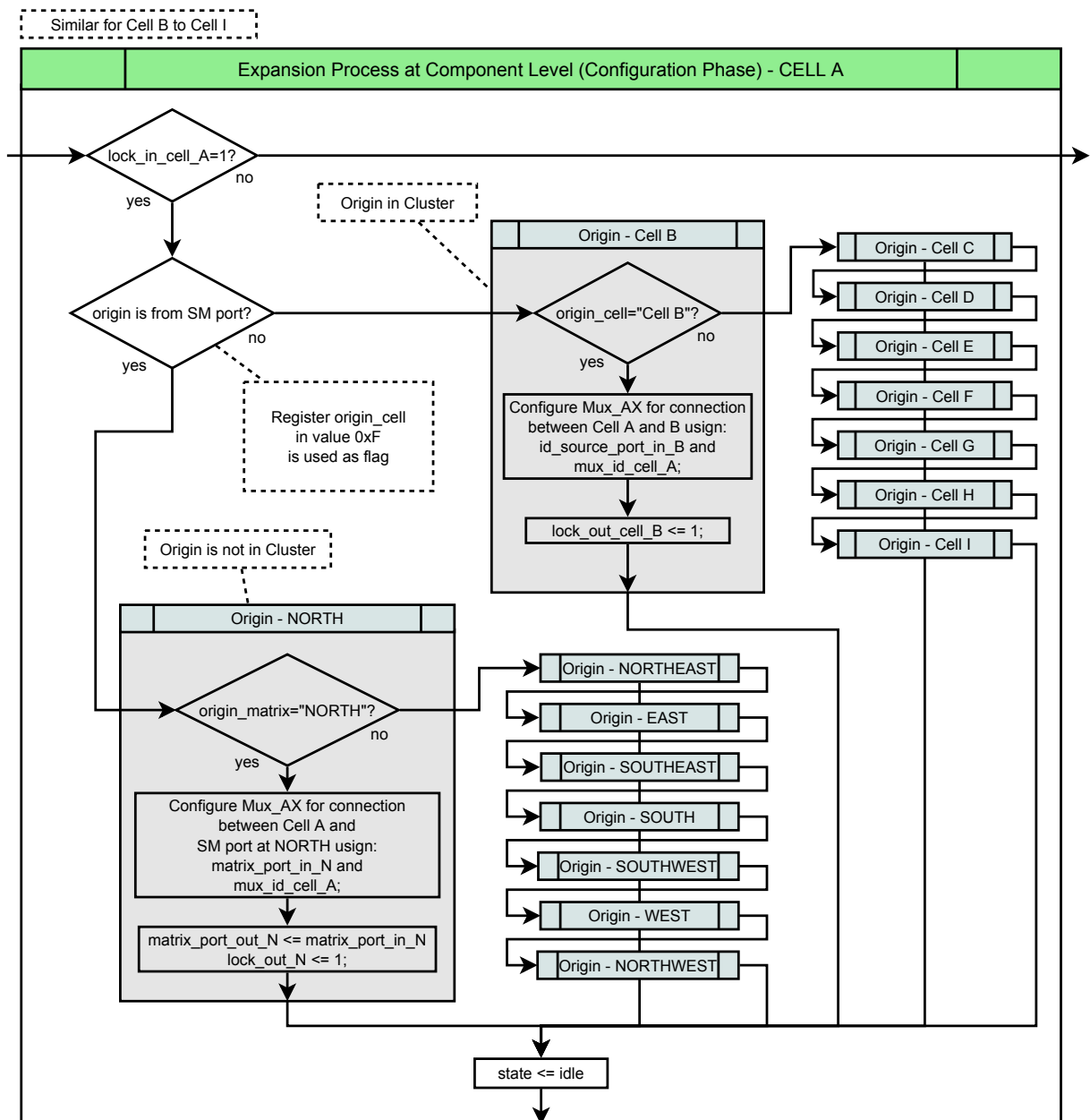


Figure C.14: Flow diagram for Configuration Phase of the Expansion Process at Component Level when the *lock_in* signal comes from a Cell.

The process continues as follows:

1. The *target_cell* sets the signal *lock_out_matrix*. Therefore, the SM that receives the signal *lock_in_cell_X* performs the action described in Figure C.14. Similar functionality must be assumed for other cells in cluster. If the *source_cell* belongs to the same cluster the process ends, otherwise the process continues in step 2.
2. The SMs that participate in this process are in the state *lock_component*. The SMs in this state perform the actions described in Figure C.15 when the signal *lock_in_X* in the corresponding side is activated. Similar functionality must be assumed for other sides of SM. This process is repeated until it finds the *source_cell*, which ends the process by setting the global signal *routing_complete*.

Similar for SM ports NORTHEAST, EAST, SOUTHEAST, SOUTH, SOUTHWEST, WEST, NORTHWEST

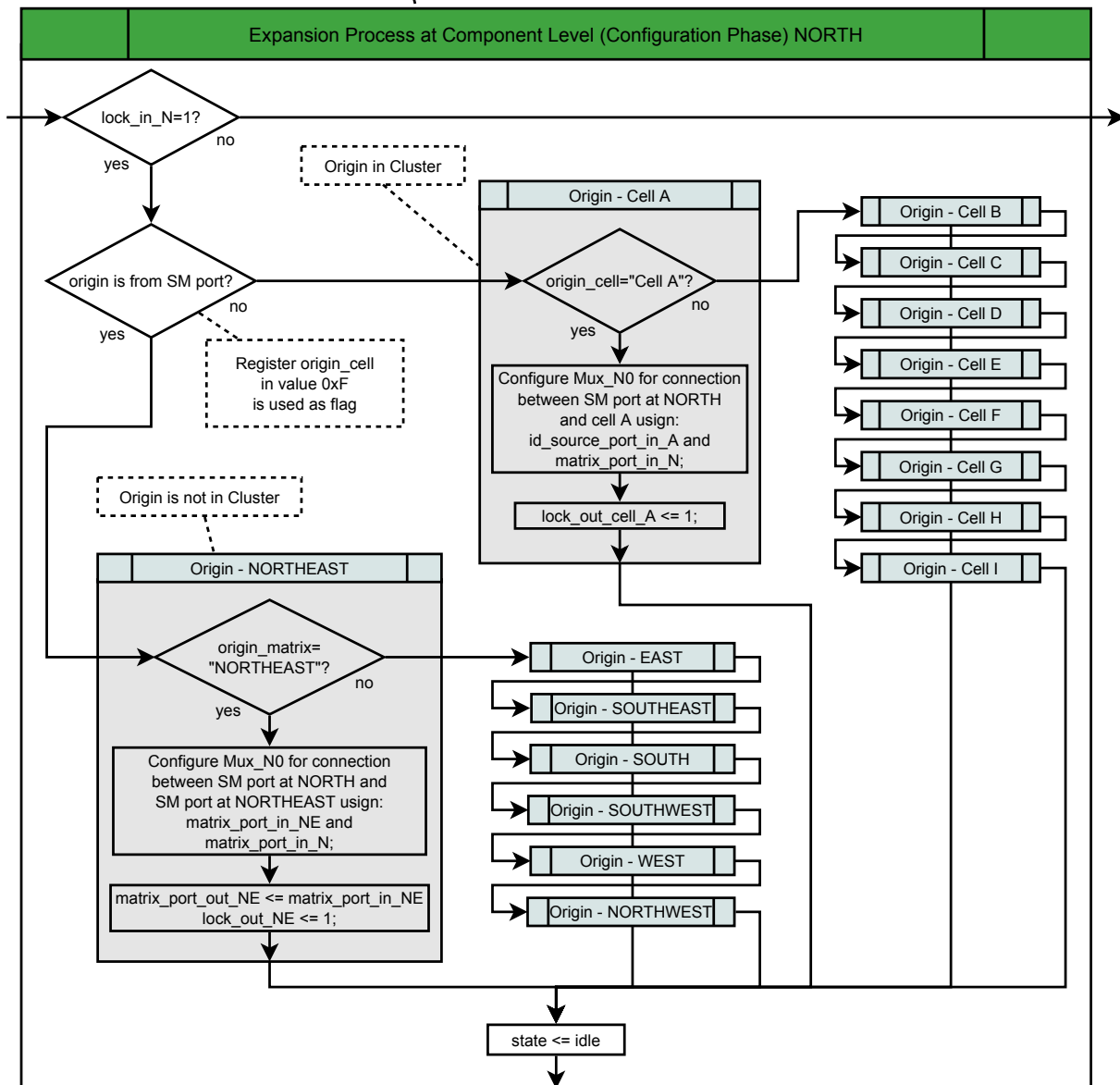


Figure C.15: Flow diagram for Configuration Phase of the Expansion Process at Component Level when the *lock_in* signal comes from a Switch Matrix.

C.4.3 Release Process at Component Level

This process releases the routing resources used for an interconnection between cells, or between a cell and a PIM. The Release Process goes from the *target* to the *source* of a connection.

If the connection is at component level, the multiplexers of FU inputs and SM ports are released. In this case, the Release Process starts from the FU input port of the *target_cell* and go backwards at component level to the FU output port of the *source_cell*. This process reads the multiplexers configuration and propagate the signals *del_connection_out_cell_X* and *del_connection_out_X* in the direction where the connection was previously established by self-routing process.

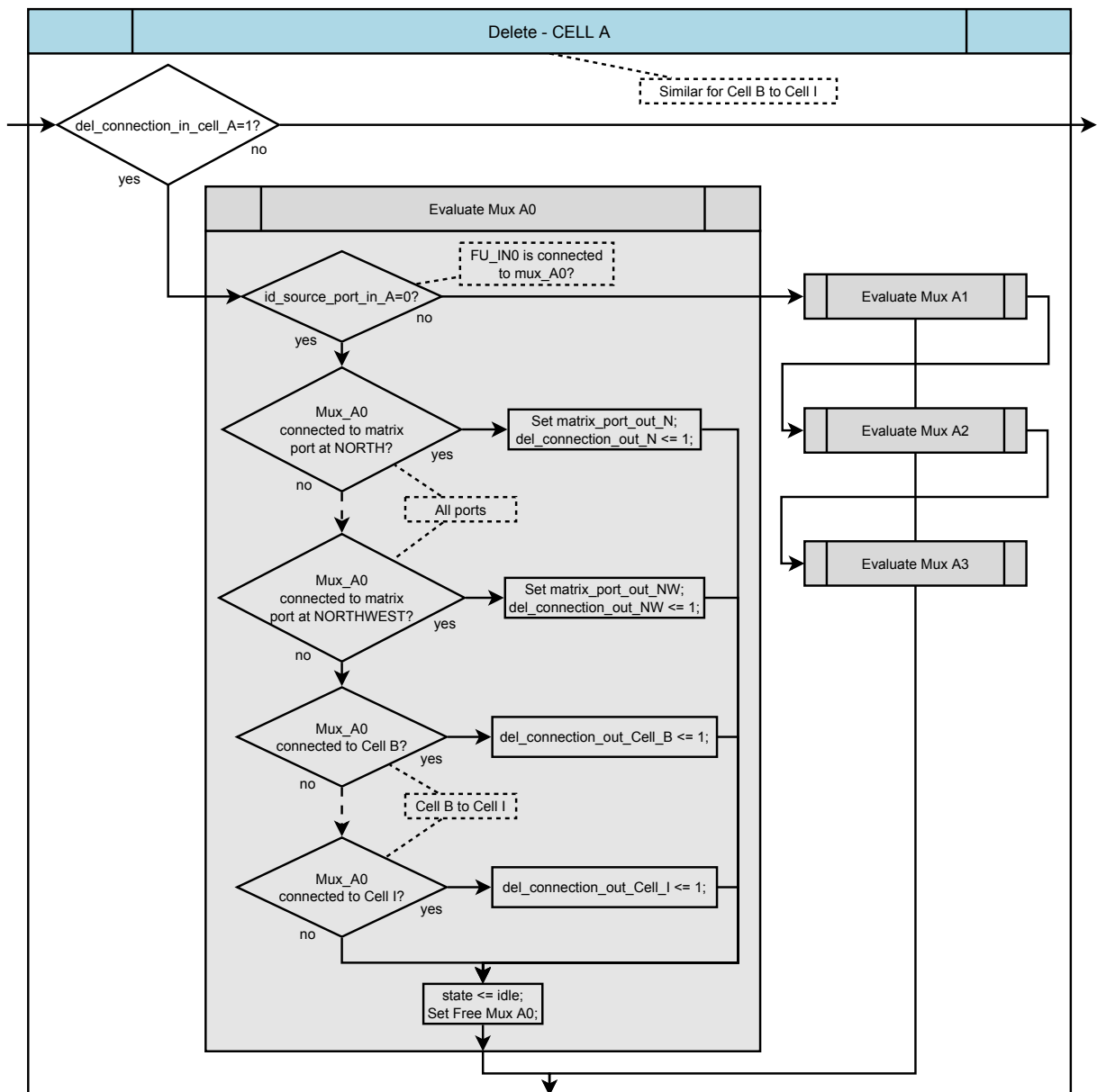


Figure C.16: Flow diagram of Release Process at Component Level when *del_connection* signal comes from a cell.

The *target_cell* starts the process presented in Figure C.5 when the flag *start_delete_cell_connection* is set. Then, the *target_cell* executes the flow diagram presented in Figure C.9. Thereafter, the SM that receives the signal *del_connection_in_cell_X* executes the algorithm presented in Figure C.16.

The process continues at component level. The SMs propagate the appropriate *del_connection* signal. If the *source_cell* does not belong to the cluster, the SM propagates the signal *del_connection_out_X* and the process continues in other cluster as shown in Figure C.17.

The process continues until it reaches the *source_cell*, which ends the process setting the global signal *routing_complete* as shown in Figure C.5 in the box denoted as “Delete Matrix”.

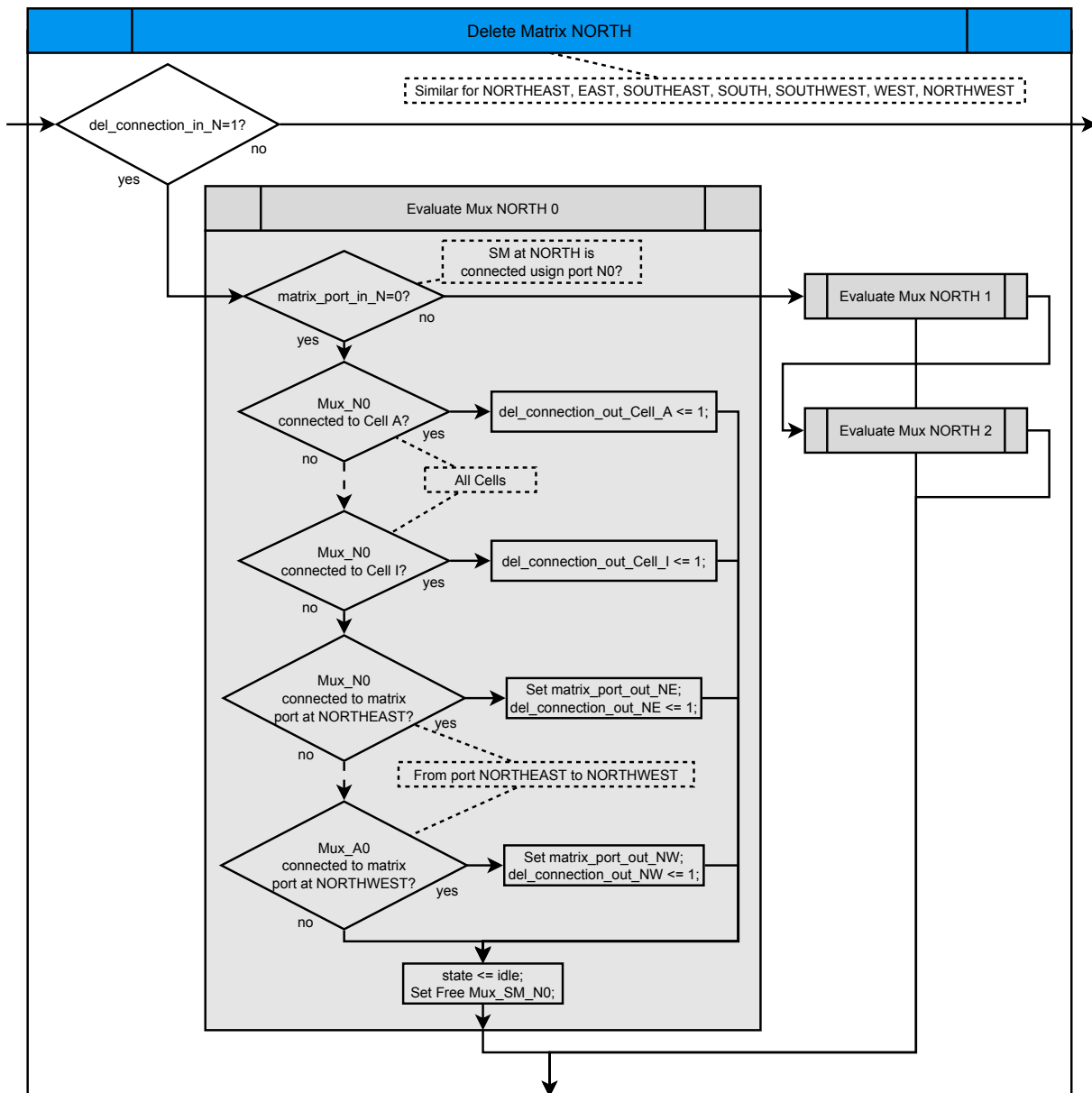


Figure C.17: Flow digram of Release Process at Component Level when *del_connection* signal comes from a Switch Matrix.

C.5 Conclusions

This section presents the flow diagrams of self-adaptive algorithms implemented in the Configuration Units of Cells and Switch Matrices.

The **Cell Configuration Unit (CCU)** is the start point for the execution of any process in system that requires the propagation of signals using the expansion ports of cells, **SMs** and **PIMs**. The **CCU** includes the following algorithms:

- ▶ The self-placement algorithm is divided in two. The first is the algorithm for the insertion of the first cell of a component, and the second is the algorithm for the insertion of other cells of a component (from the second).
- ▶ Since the insertion of the second cell of a component the self-routing at cell level algorithm is executed. This is implemented with the following process: first, the selection of source and target cells for the connections to be routed, and later the Expansion Process at Cell Level, which is divided in Search and Configuration Phases. This process is repeated for all connections that can be routed for the new inserted cell.
- ▶ The flow diagrams for the Release Process at Cell Level are presented. These algorithms permits to release the routing resources at cell level used for the interconnection of the **FU** ports of two cells. These algorithms are used for self-derouting process, before eliminating a single cell or deleting an entire component.

The **Switch Matrix Configuration Unit (SMCU)** includes the following algorithms:

- ▶ The Expansion Process at Component Level, which is divided in Search and Configuration Phases. This process is repeated for all connections that can be routed for the components.
- ▶ The flow diagrams for the Release Process at Component Level are presented. These algorithms permit to release the routing resources at component level used for the interconnection of the **FU** ports of two cells belonging to different components. These algorithms are used for self-derouting process, before eliminating a single cell or deleting an entire component.

Appendix D

SANE Project Developer (SPD)

*You only live once, but if you do it right,
once is enough.*

*Sólo se vive una vez, pero si lo haces bien,
una vez puede ser suficiente*

Mae West (1893 – 1980)

Abstract: This section describes the main features of the software tool [SANE Project Developer \(SPD\)](#). It presents all functions included in the software. Additionally, it is presented the basic syntax consideration for most common files that will be edited in [SPD](#). The protocol for downloading files to prototype is shown at the end of this chapter.

D.1 Description

In the design phase of the architecture, one of the the main inconveniences was the creation of applications that permit to test the system. This process consisted in the creation of a [SANE ASSEMBLY \(SANE-ASM\)](#), that includes a specific number of interconnected components, and interconnected cells inside each component. Additionally, multiple processors had to be manually programmed and compiled. Any modification in the application implies a lot of time rewriting the data for its configuration. Similar to any commercial general purpose device a software tool is fundamental for improving the capacity of a designer when developing applications.

The [SANE Project Developer \(SPD\)](#) is an Integrated Development Environment (IDE) developed in C Sharp with Microsoft Visual C# 2008. The [SPD](#) permits the user –in a friendly way– the creation and edition of projects that describe any [SANE-ASM](#) application designed. The [SPD](#) includes an adaptation of the project `ICSharpCode.TextEditor`[37], which is a feature-rich text editor control that provides the [SPD](#) with a powerful tool for edition of files in a project¹. The text editor for [SPD](#) includes a specific configuration for syntax highlight of files related with the project, as well as other basic features for an advanced edition of files.

The [SPD](#) allows generating and downloading the memory initialization data for the control microprocessor inside the prototype. The [SPD](#) allows the creation of files that describe the configuration of a [SANE-ASM](#). This files are called [SASM](#) files, which includes the high-level (or [SASM](#)) instructions described in Chapter 5. For writing the Program Memories of the processors,

¹`ICSharpCode.TextEditor` is licensed under The MIT License.

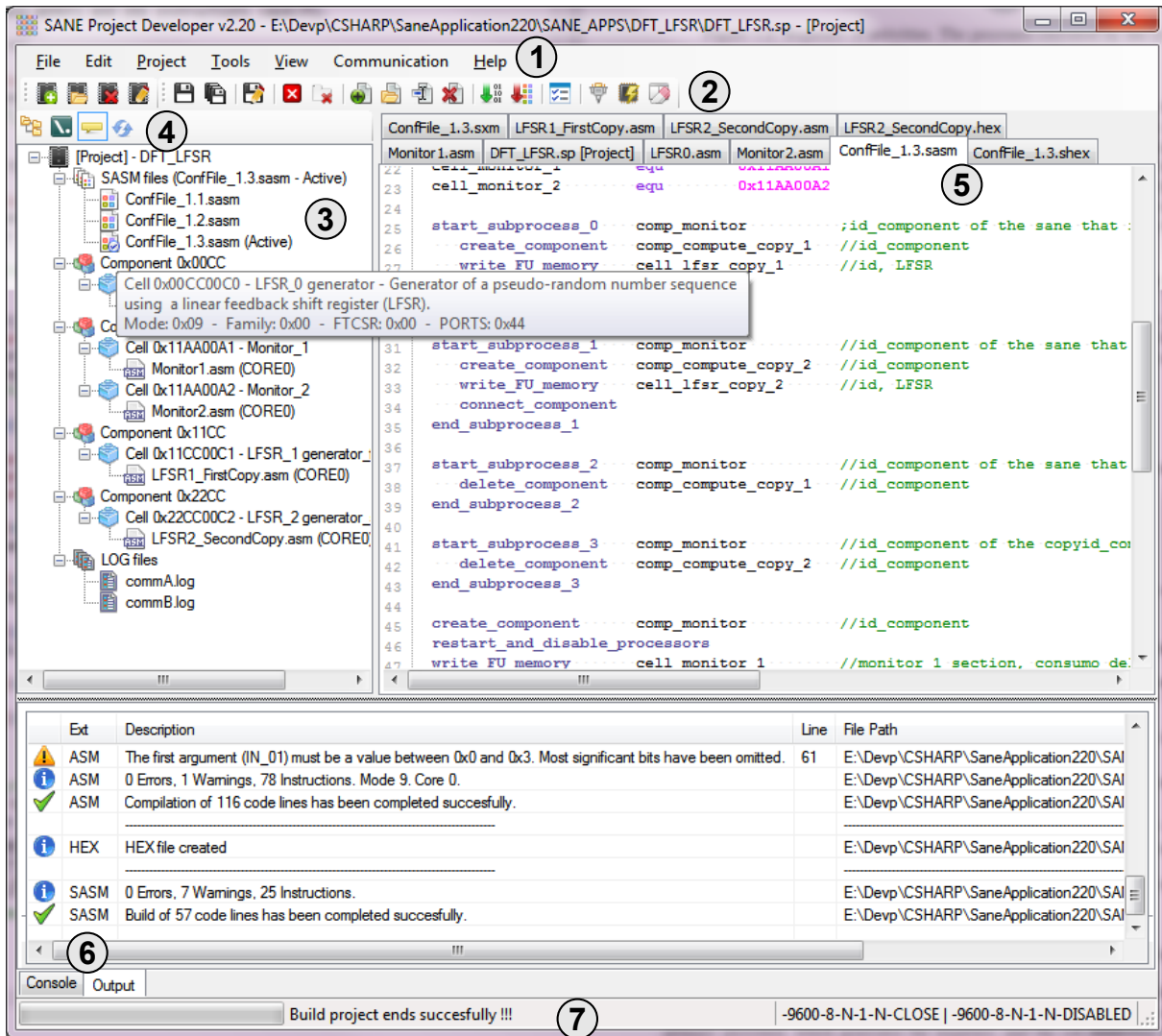


Figure D.1: Screen capture of SANE Project Developer.

Assembler (ASM) files will be created, this permits to execute the functionality of a processor in the cell (between 1 and 4 per cell depending of operation mode).

The SPD supports building of the final hexadecimal file with the configuration of the SANE-ASM that will be implemented in the FPGA. This process includes the compilation of the files involved in the process according to the SASM file. The SPD generates a list of errors, warnings and infos for all files involved in the building process and guides the user to make the appropriate corrections if required. The SPD also supports the compilation of individual ASM files.

Figure D.1 shows a screen capture of the SPD, which shows the SASM file for the Dynamic Fault Tolerance Application presented in Section 5.5. It is also shown the structure of the solution in the left tree and the output of the result of building process in the bottom section. Below are the features of the main form presented in the figure by means of numeric labels:

- 1 **Menu Strip:** it includes the following menus: File, Edit, Project, Tools, View, Communication, Help and Admin (only available for developer). All actions that SPD is able to execute are included in these menus, which will be detailed later in this chapter.
- 2 **Top Tool Strip:** it includes buttons for easy access to most common functions in SPD. All

this functions are included in the Menu Strip.

- ③ **Left panel:** it includes a Tree View object that contains the hierarchical organization of the project. This tree could be shown in Cell View or Folders View. The figure shows the tree for a Cell View, which shows the project organized in components and cells. Cell View includes all files associated with the project, whilst Folders View includes all files in project folder.
- ④ **Buttons for Left Panel:** these buttons permit the configuration the Tree View object in Left Panel. It includes the option to alternate between Cell View and Folder View, visualization of full path of files, visualization of tooltip text and option to force a Refresh over the tree.
- ⑤ **Main Tab Control:** it includes the Tab Pages that could be edited by SPD. These tabs are divided in three categories:
 - (a) **Project Tab:** This tab permits to configure specific options for a project created by SPD. The configuration of components and cells in a project will be detailed later in this chapter.
 - (b) **Communication Tab:** This tab represents the data that is sent and received from prototype by means of serial port connections (RS-232). The SPD permits to configure between one and two communication panels. This tab is used for two purposes: the visualization of data downloaded to prototype using an adaptation of XMODEM protocol, and the visualization of the execution of a SANE-ASM in the prototype for debugging purposes (for two chips in prototype).
 - (c) **Text Editor.** The tabs that includes any file could be edited using the text editor adapted for the application. This editor includes a specific configuration for syntax highlight of files with the following extensions: *.ASM, *.HEX, *.INC, *.SASM and *.SHEX.
- ⑥ **Output Tab Control:** it includes two tab pages:
 - (a) **Console Tab:** this tab shows information of all functions that are being executed in the SPD. This tab s mainly used for debugging purposes.
 - (b) **Output Tab:** this tab is updated each time that a ASM file is compiled or the project is built. This tab shows Warnings, Informations, Errors and the result of the process executed. It permits to navigate in a friendly way to the file associated with the message, and presents the appropriate information related with the message.
- ⑦ **Status Bar:** This bar shows the status of some features of SPD as follows:
 - (a) Status and configuration of communication ports.
 - (b) Result of a single file compilation, or built of a project.
 - (c) Progress of a process that spends time, like downloading of data to the prototype and others.

D.2 Files Edition

Table D.1 shows a description of files that SPD is able to edit. The ASM and SASM files are the most frequent files that will be edited in a project using the text editor. The SPD is not case sensitive for reserved words.

File Extension	Description
*.SP	SANE Assembly Project. This file is automatic configured for the SPD . It is advisable does not edit manually this file because the project might be corrupted.
*.SASM ✓	SANE Assembler file. It corresponds to the high-level configuration file, which includes the SASM instructions.
*.SHEX ✓	SANE Hexadecimal File. This file is generated when the project is built. The file is generated taking into account the active *.sasm file.
*.SXM	SANE XMODEM File. This file is generated when the project is built. The file is generated taking into account the active *.sasm file. It is used for downloading the project to prototype memory.
*.ASM ✓	Assembler file. It corresponds to the code implemented in processors of cells.
*.INC ✓	Include file. It corresponds to libraries for *.asm files.
*.HEX ✓	Hexadecimal File. This file is generated when an individual *.asm file is compiled.
*.LOG	Communication LOG Files. It corresponds to the communication activities related with the RS-232 ports.
*.TXT	Text Files. It corresponds to plain text for general purpose.
.	Any Files. The SPD allows the creation of any editable file in plain text.

✓ The files with this extension includes syntax highlight.

Table D.1: Relation of files for SANE Project Developer.

D.2.1 Assembler Files

The [Assembler \(ASM\)](#) files correspond to the code implemented in the processors of cells. Depending on configuration mode, it is possible to have between one to four [ASM](#) files per cell. The [SPD](#) includes the following features for [ASM](#) files:

► **Reserved words for instructions:**

```
ADDLW, SUBLW, ANDLW, IORLW, XORLW, MOVLW, ADDW, SUBW,
ANDW, IORW, XORW, MOVW, BLMOV, COMW, NEGW, INCW, DECW,
SWAPW, RLW, RRW, LSL, LSR, ASL, ASR, CLRF, CLC, SEC, END,
NOP, BCLR, BSET, BRCLR, BRSET, GOTO, BZ, BNZ, BC, BNC,
CBEQ, CBGE, CBGT, CBNE, DBNZ, IBNZ.
```

► **Reserved words for directives:**

```
EQU, ORG, MODE_CORE, #INCLUDE
```

► **Numbers format:**

- Hexadecimal (default): 0xe9, 0XE9, e9, h'E9', H'e9'
- Decimal: d'233', D'233', .233
- Octal: o'351', O'351'
- Binary: b'11101001', B'11101001'

- ASCII: a'G', A'k' (one alphanumeric character, from ASCII 20h to 7Eh).
- **Comments and labels:** The labels must start with a letter or underscore (a-z,A-Z,_), later may include any other alphanumeric character. The comments can be included with any sequence of text after semicolon or double-slash:

```

label1                ;This is a label
    movlf      .255,bin8,0    ;Example 1 of a comment
cycle_38              //This is another label
    BLMOV      BL_IN0,0x3F    //Example 2 of a comment

```

D.2.2 SANE Assembler Files

The [SANE Assembler \(SASM\)](#) files corresponds to the high-level configuration file for the implementation of a [SANE-ASM](#) in the system. The [SPD](#) includes the following features for [SASM](#) files:

- **Reserved words for instructions:**

```

CREATE_COMPONENT , CONNECT_COMPONENT , DELETE_COMPONENT ,
WRITE_FU_MEMORY , WRITE_FU_MEMORY_CR , WRITE_FU_MEMORY_PMO ,
WRITE_FU_MEMORY_PM1 , WRITE_FU_MEMORY_PM2 ,
WRITE_FU_MEMORY_PM3 , RESTART_PROCESSORS ,
DISABLE_PROCESSORS , RESTART_AND_DISABLE_PROCESSORS ,
ENABLE_PROCESSORS , WAIT , RESTART_PROCESSORS_WAIT ,
ENABLE_PROCESSORS_WAIT , END , START_SUBPROCESS_0 ,
END_SUBPROCESS_0 , START_SUBPROCESS_1 , END_SUBPROCESS_1 ,
START_SUBPROCESS_2 , END_SUBPROCESS_2 , START_SUBPROCESS_3 ,
END_SUBPROCESS_3 , FT_CONFIGURATION .

```

- **Reserved words for directives:**

```

EQU

```

- **Numbers format:**

- Hexadecimal (default): 0xe9, 0XE9, e9, h'E9', H'e9'
 - Decimal: d'233', D'233', .233
 - Octal: o'351', O'351'
 - Binary: b'11101001', B'11101001'
 - ASCII: a'G', A'k' (one alphanumeric character, form ASCII 20h to 7Eh).
- **Comments:** The comments can be included with any sequence of text after semicolon or double-slash:

```

primary_cell      equ  0xAAAA0001    ;cell definition - hexa
redundant_cell    equ  d'8613'        //cell definition - decimal
comp_A            equ  0xAAAA        //component definition hexa

ft_configuration  primary_cell,redundant_cell ;Comment style 1
create_component  comp_A                //Comment style 2

```

D.3 Functions

The **SPD** includes all necessary tools for developing and executing applications in the prototype. Any **SANE-ASM** application is implemented by means of a Project, which includes all files related with the application. The main characteristics of the **SPD** are included in the Main Menu, which permits the user to execute the corresponding action as shown bellow. In many cases the name of the option selected denotes the action that will be executed and does not require additional explanation.

D.3.1 File Menu

It includes tools for management of projects and files. The options included in this menu are presented bellow:

1. **New Project.** Starts a template for creation of a new project.
2. **Open Project.**
3. **Close Project.**
4. **Save Project As...**
5. **Save File As...**
6. **Save ‘*.*’.** Save current file or tab selected in Main Panel (Ctrl+S).
7. **Save All.** Save all files (Ctrl+Shift+S).
8. **Close ‘*.*’.** Close current file or tab selected in Main Panel.
9. **Close all except selected tab.** Close all files except the selected tab in Main Panel.
10. **New File.** Start a template wizard for creation of a new file. The new file could be created with a basic configuration template for files `*.asm`, `*.sasm` and `*.txt`.
11. **Open File.**
12. **Rename File.**
13. **Delete File.**
14. **Recent Projects.** List of recent projects for quick access.
15. **Recent Files.** List of recent files for quick access.
16. **Exit.**

D.3.2 Edit Menu

This menu includes basic and advanced tools for edition of files. The options included in this menu are presented bellow:

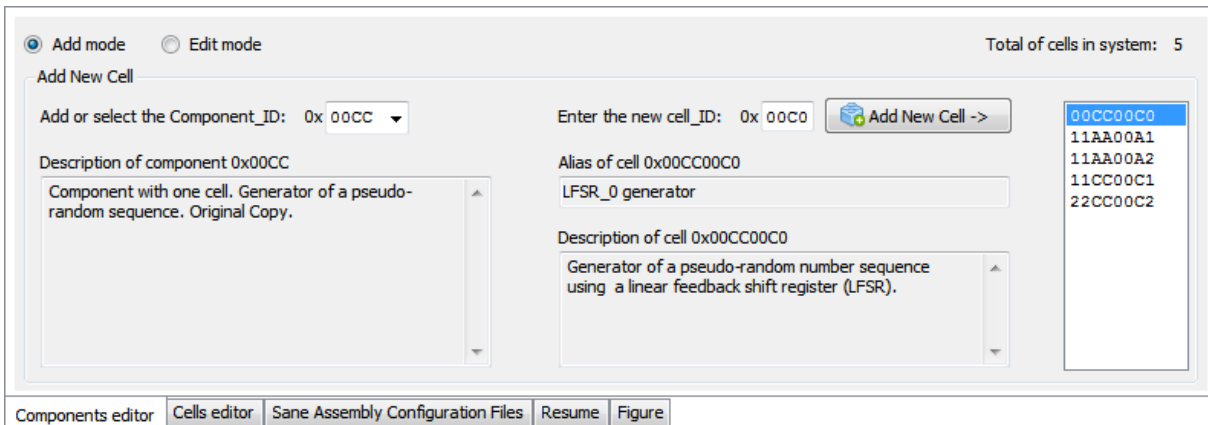
1. **Split text area.** This options permits visualization of a file in two different segments of code.
2. **Cut** (Ctrl+X).
3. **Copy** (Ctrl+C).
4. **Paste** (Ctrl+V).
5. **Delete.**
6. **Select All** (Ctrl+A).
7. **Find ...** (Ctrl+F).
8. **Find and replace ...** (Ctrl+H).
9. **Find again** (F3).
10. **Find again reverse** (May+F3)
11. **Display.** This is a sub-menu that permits the following actions over text editor:
 - ▶ **Show line numbers.**
 - ▶ **Show end of line markers.**
 - ▶ **Highlight current line.**

- ▶ **Show spaces and tabs.**
 - ▶ **Highlight matching brackets when cursor is after.**
 - ▶ **Allow cursor past end of line.**
12. **Bookmark.** This is a sub-menu that permits the following action over text editor:
 - ▶ **Toogle bookmark.** (Ctrl+F2).
 - ▶ **Goto next bookmark.** (F2).
 - ▶ **Go to previous bookmark.** (May+F2).
 - ▶ **Clear all bookmark.**
 13. **Uppercase/Lowercase.** This is a sub-menu that permits the following actions over text editor:
 - ▶ **Convert to uppercase.** (Ctrl+Shift+U).
 - ▶ **Convert to lowercase.** (Ctrl+U).
 14. **Advanced.** This is a sub-menu that permits the following actions over text editor:
 - ▶ **Toggle line comments.** (Alt+Q).
 - ▶ **Convert spaces to tabs.**
 - ▶ **Convert tabs to spaces.**

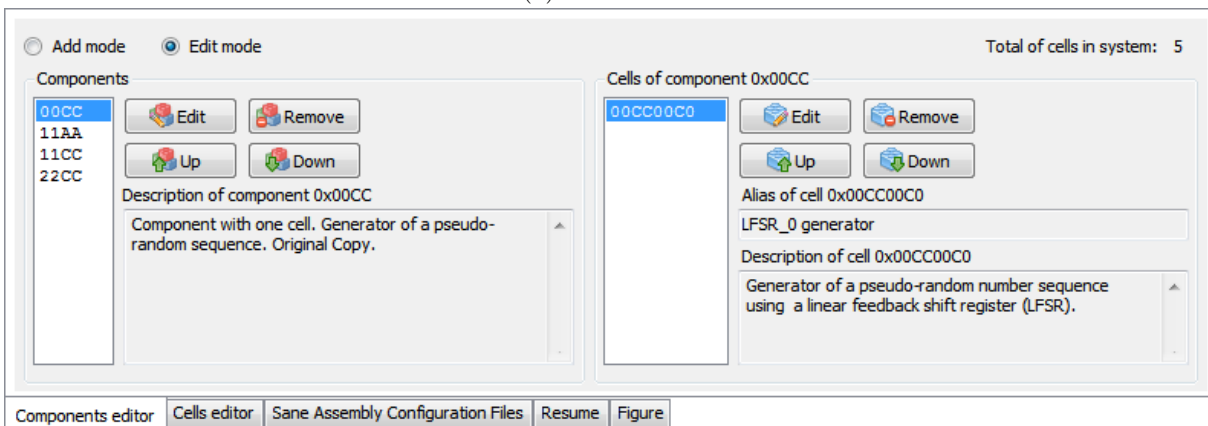
D.3.3 Project Menu

This menu includes tools for the current project opened as follows:

1. **Component Editor (F5).** Tool that permits to edit the components configuration in project. Figure D.2 shows the tool implemented for this purpose. Note that there are two different views, one for addition and the other for edition. This tool permits the user configure the components and cells for a specific project.
2. **Cell Editor (F6).** Tool that permits to edit the cells configuration in project. Figure D.3 shows the tool implemented for this purpose. This tool permits the user to configure the cells previously included in the project. Thus, the user is able to edit the Configuration Registers, Connection Tables and the [ASM](#) files associated to each CORE.
3. **SASM Configuration Files (F7).** Tool that permits to add and select the [SASM](#) files to project. Figure D.4 shows the tool implemented for this purpose. This tool permits to add and/or activate the [SASM](#) file that will be used when “Built Project” tool is executed. Note that [SPD](#) permits to have many different [SASM](#) files, but only one can be activated.
4. **Compile File (F9).** Compile the selected [ASM](#) file. This tool generates a *.HEX file with the same name of the correspondent *.ASM file. This function could be executed previously to built the project for detecting error or warnings in [ASM](#) files. In this case, the software guides the user to find the source of the correspondent message.
5. **Built Project (F10).** BUILT the project taking into account the active [SASM](#) file. This tool generate the files *.SASM and *.SXM with the same name of the active *.SASM file. This is the last function that must be executed before downloading the configuration file ([SXM](#)) to [CpP](#) memory in prototype. If there are errors or warnings in this process, the software guides the user to find the source of the correspondent message.
6. **Add copy of source.** This tool permits to make a copy of any file to the project folder.



(a) Add mode.



(b) Edit mode.

Figure D.2: Component editor tool.

D.3.4 Tool Menu

This menu includes the following options:

1. **Export.** This is a sub-menu that permits the user perform the following actions:
 - ▶ **Figure.** Exports a figure that represents the architecture implemented in the prototype.
 - ▶ **Screen Capture.** Exports a screen capture of the current view of **SPD** (formats *.png, *.jpg, *.gif or *.bmp).
 - ▶ **Console.** Exports the console as a *.txt file.
2. **Clear Console.**
3. **Options.** This is a form that permits the user to configure several option for **SPD**. This form includes five tabs as follows:
 - (a) **General:** configuration of general options for **SPD**.
 - (b) **Text Editor:** configuration of text editor.
 - (c) **Compiler:** configuration for compilation tools.
 - (d) **Tree:** configuration of project visualization tree in Left Panel.
 - (e) **Communications:** configuration of serial ports (RS-232) connected with prototype.
 - (f) **Figure:** configuration of figure that represents the system architecture.

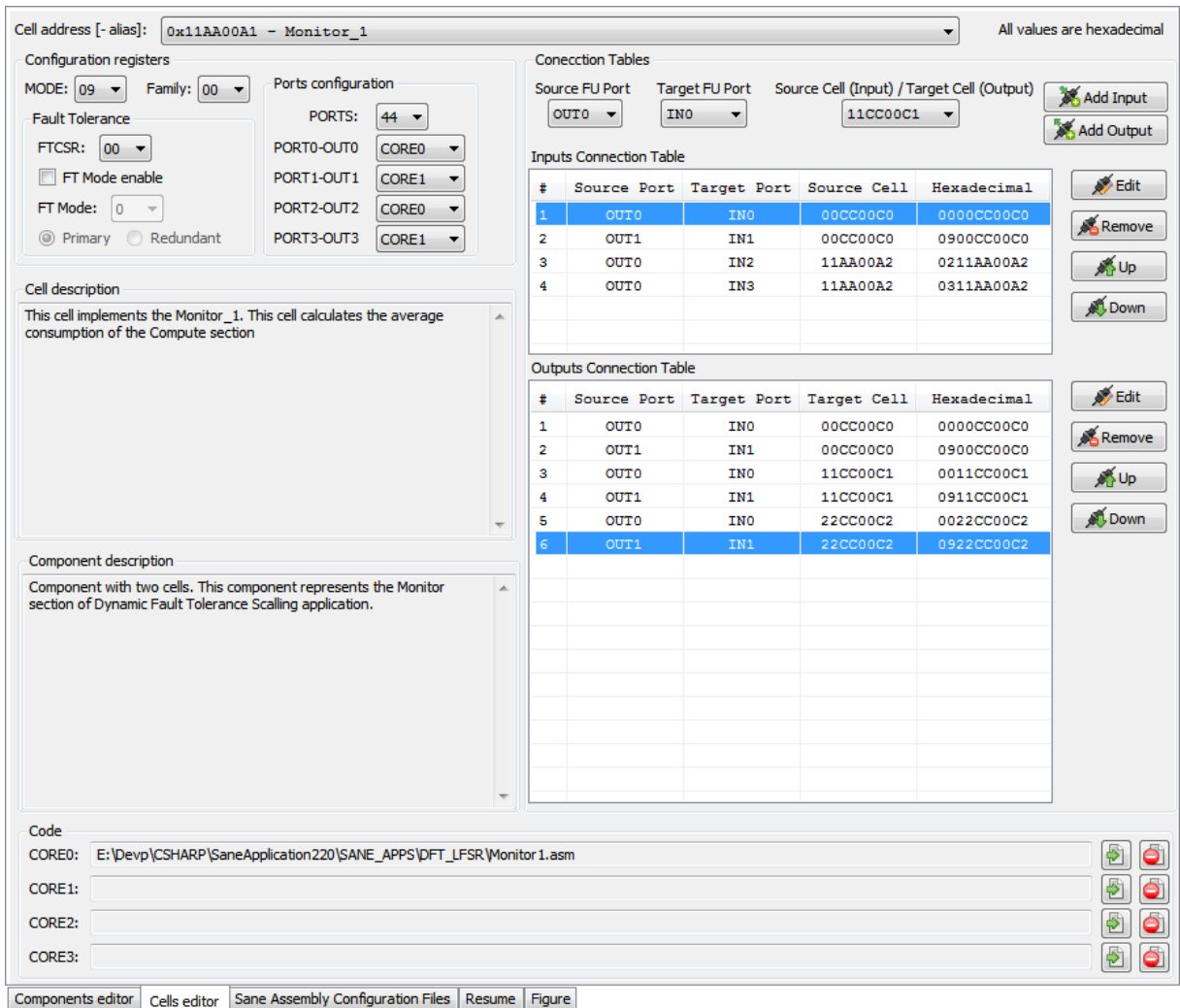


Figure D.3: Cell editor tool.

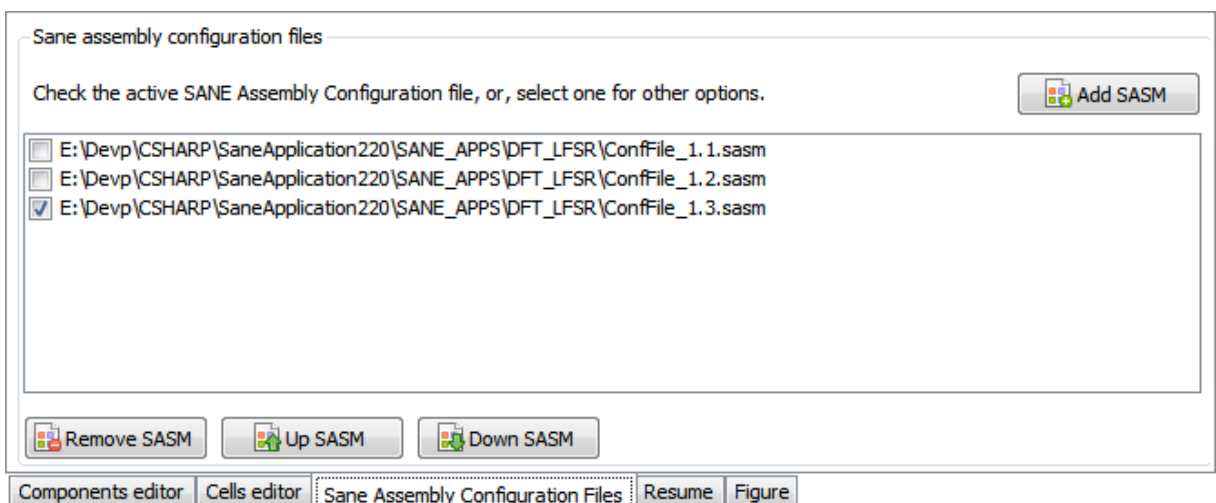


Figure D.4: Tool for addition/activation of SANE assembler files.

D.3.5 View Menu

This menu is used for accessing some special Page Tabs object. Note that project and communication tabs could be closed in the same way of a text editor tab. It includes the following options:

1. **Project Tab.** Permits to open the project tab for edition of components, cells and addition/activation of [SASM](#) files.
2. **Communication Tab.** Permits to open the communication tab for visualization of processes executed in serial ports.
3. **Console Tab.** Permits to open the console tab for debugging purposes.

D.3.6 Communication Menu

This menu includes the tools related with the serial port communication, which are used to send/receive information to FPGAs in prototype. Some of the functions listed bellow are detailed in section [D.4](#). This menu includes the following options:

1. **Open/close Communication Ports.** This tool opens or closes the serial ports configured for communication with FPGAs in prototype. Additionally, this tool starts or stops threads that permits the correct management and visualization of data in communication panels.
2. **Clear Communication Panles.**
3. **Save copy of communication logs.**
4. **Communication Test.** Execute a communication test between the [SPD](#) and the [CμP](#) in the prototype. It permits to check the correct configuration of serial ports for the execution of other functions over [CμP](#) memory.
5. **Clear Memory.** Execute a process to clear all section of memory in [CμP](#) dedicated for the [SASM](#) configuration file.
6. **Write Memory.** Execute a process to write the [SXM](#) file that was previously generated with the “Built Project” function. This file is written in section of memory dedicated for the high-level configuration file.
7. **Read Memory.** Execute a process to read the entire section of memory dedicated for the high-level configuration file.
8. **Cancel FPGA communication process.** This function permits to cancel in a safe way any process that has been started for a communication between the [SPD](#) and the [CμP](#).

D.3.7 Help and Admin Menus

The Help menu presents the credits of the [SPD](#) (About). Note that this chapter can be used as a User Manual for the software implemented. The Admin menu is only available for debugging or developer options. It is activated executing the [SPD](#) with the argument: `/admin`.

Field	Name	Description
<CB>	Control Byte	Define the process that will be executed: <CB> = 0x01: Communication test. <CB> = 0x02: Clear Memory. <CB> = 0x03: Write Memory. <CB> = 0x04: Read Memory.
<DB>	Data Bytes	Denote the zero-based number of bytes send or received in the frame (0x00 to 0xFF represents 1 to 256 bytes)
<AAA1>	Address 1	Initial address for write/read operations (2 bytes).
<AAA2>	Address 2	Final address for read operations (2 bytes).
<D0 D1 . . . D255>	Data Bytes	Bytes sent or received in frame. The amount of data bytes depends on the Data Bytes field.
<CKS>	Checksum	Two's complement of the arithmetic sum of the bytes in frame except the <SOH> and <CRC>. Final carry is discarded.

Table D.2: Description of fields for XMODEM based protocol.

D.4 Downloading Project to Prototype

The [SPD](#) and the [CμP](#) implements an adaptation of the XMODEM protocol for downloading projects to prototype. XMODEM, like most file transfer protocols, breaks up the original data into a series of “packet” or “frames“ that are sent to the receiver, along with additional information allowing the receiver to determine whether that packet was correctly received. Xmodem is a half-duplex communication protocol. The following bytes are defined for the protocol implemented:

- ▶ <SOH> = 0x01: Start of Heading.
- ▶ <EOT> = 0x04: End of Transmission.
- ▶ <ACK> = 0x06: Acknowledge.
- ▶ <NACK>= 0x15: Negative Acknowledge.
- ▶ <CAN> = 0x18: Cancel.

The frames sent or received have the structure presented below. Note that additional fields are only used when the frame starts with the byte <SOH>. The description of additional fields is shown in [Table D.2](#).

<SOH> [[<CB>](#)] [[<DB>](#)] [[<AAA1>](#)] [[<AAA2>](#)] [[<D0 D1 . . . D255>](#)] [<CKS>](#)

There are four basic functions implemented in [SPD](#), which corresponds to the four values of the field “Control Byte”. These functions are described in [Sections D.4.1 to D.4.4](#). Note that the receiver, after receiving a packet, will either acknowledge (ACK) or not acknowledge (NACK) the packet. If a NACK is received five times, the sender cancel the process sending the correspondent byte (CAN). These sections present data flow examples including error recovery, which in normal conditions is not present in frames. The normal data flow is interrupted when an unexpected event is produced as follows:

1. A <NACK> is sent when there is a checksum error. On any <NACK>, the sender will re-transmit the last packet.
2. A <CAN< is sent when there is a format error or five <NACK> has been received.
3. When a <CAN> is received, the process is finalized and no more bytes are sent.

D.4.1 Communication Test

This function permits the user to ensure that communication with the prototype is configured properly. Table D.3 shows the data flow executed for communication test (<CB>=0x01).

SANE Project Developer	↔	Prototype
<SOH><01><CKS>	→	
	←	<NACK> ¹
<SOH><01><CKS>	→	
	←	<ACK>
<EOT>	→	
	←	<ACK>

¹ Framing error on any byte.

Table D.3: Example of data flow for Communication Test with prototype.

D.4.2 Clear Memory

This function permits to clear the entire section of memory dedicated to the configuration file in the prototype. Table D.4 shows the data flow executed for clear memory (<CB>=0x02).

SANE Project Developer	↔	Prototype
<SOH><02><CKS>	→	
	←	<NACK> ¹
<SOH><02><CKS>	→	
	←	<ACK>
<EOT>	→	
	←	<ACK>

¹ Framing error on any byte.

Table D.4: Example of data flow for Clear Memory in prototype.

D.4.3 Write Memory

This function permits to write a portion of the memory in prototype, which corresponds to the high-level configuration file (SASM file). The format of the first frame sent by SPD is shown bellow:

<SOH> <CB=0x03> <DB> <AAA1> <D0 D1 ... D255> <CKS>

Table D.5 shows an example of the data flow executed for write five 32-bit words in memory, i.e., from address 0x0000 to 0x0004 (<CB>=0x03).

Note that words in prototype memory are 32-bit width. Therefore, the Data Bytes must be a multiple of 4 in zero-based range, e.g., 0x03, 0x07, 0x0B. This implies that address is incremented each four data bytes as shown in the example. If the SPD receives NACK five times, the SPD sends the byte <CAN> and the process ends.

SANE Project Developer	↔	Prototype
<SOH><03><07><0000><00 01 02 03 04 05 06 07><CKS>	→	
	←	<ACK>
<SOH><03><07><0002><08 09 0A 0B 0C 0D 0E 0F><CKS>	→	
	←	<NACK> ¹
<SOH><03><07><0002><08 09 0A 0B 0C 0D 0E 0F><CKS>	→	
	←	<ACK>
<SOH><03><03><0004><10 11 12 13><CKS>	→	
	←	<ACK>
	→	<EOT>
	←	<ACK>

¹ Framing error on any byte.

Table D.5: Example of data flow for Write Memory in prototype.

D.4.4 Read Memory

This function permits to read a portion of the memory in prototype, which corresponds to the high-level configuration file ([SASM](#) file). The format of the first frame sent by [SPD](#) is shown below:

```
<SOH> <CB=0x04> <DB> <AAA1> <AAA2> <CKS>
```

The format of the frame with data bytes sent by [CμP](#) is shown below:

```
<SOH> <DB> <AAA1> <D0 D1 ... D255> <CKS>
```

Table [D.6](#) shows an example of the data flow executed for read five 32-bit words in memory, i.e., from address 0x0000 to 0x0004 (<CB>=0x04).

Note that words in prototype memory are 32-bit width. Therefore, the Data Bytes must be a multiple of 4 in zero-based range, e.g., 0x03, 0x07, 0x0B. This implies that address is incremented each four data bytes as shown in the example. If the [SPD](#) receives NACK five times, the [SPD](#) sends the byte <CAN> and the process ends.

The size of the data sent by [CμP](#) depends on the Data Bytes argument received the first time. Only the last Data Bytes field is modified by [CμP](#), when the number of bytes does not correspond with the remaining bytes that will be sent.

SANE Project Developer	↔	Prototype
<SOH><04><07><0000><0004><CKS>	→	
	←	<ACK>
<ACK>	→	
	←	<SOH><07><0000><00 01 02 03 04 05 06 07><CKS>
<NACK> ¹	→	
	←	<SOH><07><0000><00 01 02 03 04 05 06 07><CKS>
<ACK>	→	
	←	<SOH><07><0002><08 09 0A 0B 0C 0D 0E 0F><CKS>
<ACK>	→	
	←	<SOH><03><0004><10 11 12 13><CKS>
<ACK>	→	
	←	<EOT>
<ACK>	→	

¹ Framing error on any byte.

Table D.6: Example of data flow for Read Memory from prototype.

D.5 Conclusions

The software tool [SANE Project Developer](#) (SPD) has been developed as an integrated development environment for creation and edition of projects that will be downloaded to prototype. The SPD permits the creation and edition in a friendly way of all relevant files for the generation of [SANE-ASM](#) based applications. It includes tools for edition of components and cells belonging to a [SANE-ASM](#). The SPD includes an adaptation of the `ICSharpCode.TextEditor`, which is a text editor control with syntax-highlighting and other functionalities, which permits the appropriate edition of files related with an application project.

The SPD provide tools to compile individual assembler files, or for building a entire [SANE-ASM](#) project, which is closely tied with a [SANE Assembler](#) (SASM) file. In case of errors (or warnings) in the execution of any of these functions, the software provides the appropriate information for helping the user to solve theses issues.

The SPD provides all necessary tool for configuring a communications system based in serial ports (RS-232), which is used for interaction with prototype. This system implements a XMODEM-based protocol that permits the user to perform basic functions over the section of memory dedicated to the execution of the [SANE-ASM](#) application. Therefore, the SPD together with the [Control Microprocessor](#) (CμP) are able to execute the following functions: Communication Test, Clear Memory, Write Memory and Read Memory. After downloading an application to prototype, the communication system permits to read the debugging frames in both cards of prototype, which shows step by step the execution of an application.

Appendix E

Listings of Example Applications

*Just as iron rusts from disuse,
even so does inaction spoil the intellect.
Así como el hierro se oxida por falta de uso,
también la inactividad destruye el intelecto.*

Leonardo Da Vinci (1452 – 1519)

Abstract: This chapter presents a set of listings related with application examples developed for testing the self-adaptive hardware architecture described in this document. These listings include *.SASM and *.ASM files, which represents the high-level configuration file for the configuration of an application, and the threads scheduled for processors in cells.

The listings shown in this chapter are related with two projects with example applications:

- ▶ The first is a Dynamic Fault Tolerance Scaling application, which demonstrates the correct execution of runtime self-configuration by means of subprocesses (Section 5.5).
- ▶ The second is related with the Static Fault Tolerance mechanism, which demonstrates the self-repair ability of the system by means of self-elimination and self-replications of damaged cells when a hardware failure is detected (Section 5.6).

Tables E.1 and E.2 show a relation of listings presented in this section. Each listing is explained by means comments in code, therefore no additional explanation will be added along this chapter.

References	Listing	Description
Application description in Section 5.5.	E.1	SASM file with high-level configuration of application.
	E.2	ASM file with code for Monitor_1 Section.
Listings in Section E.1	E.3	ASM file with code for Monitor_2 Section.
	E.4	ASM file with code for original copy of Compute Section (copy0). The code for first copy (copy1) and second copy (copy2) of Compute Section is the same.
	E.5	SHEX file generated after building project. This listing shows the instructions code implemented in section of memory of CpP dedicated to SANE-ASM configuration.
	E.6	SXM file generated after building project. For visualization purposes, the SXM file was generated with eight 32-bit word per line. However, the SPD could be configured to write between 1 to 32 words per line (default value is 16).

Table E.1: Listings for Dynamic Fault Tolerance Scaling application example.

References	Listing	Description
Application description in Section 5.6.	E.7	SASM file with high-level configuration of application.
	E.8	ASM file with code for <i>Working Processor</i> in <i>Primary cell</i> . The code for <i>Redundant Processor</i> in <i>Redunadnt Cell</i> is the same. A modification in the sequence must be performed manually in one of this files to test the Static Fault Tolerance mechanism as shown in listing.
Listings in Section E.2	E.9	ASM file with delay function for visualization of sequence in leds.
	E.10	SHEX file generated after building project. This listing shows the instructions code implemented in section of memory of CpP dedicated to SANE-ASM configuration.
	E.11	SXM file generated after building project. For visualization purposes, the SXM file was generated with eight 32-bit word per line. However, the SPD could be configured to write between 1 to 32 words per line (default value is 16).

Table E.2: Listings for Static Fault Tolerance application example.

E.1 Listings for Dynamic Fault Tolerance Scaling Application Example

Listing E.1: SASM file for configuration of Dynamic Fault Tolerance Scaling application.

```

1  ;-----
2  ;-- SANE assembly file template for Project DFT_APP_TESIS
3  ;-- Created by: SANE Project Developer - v 2.20 - Javier Soto Vargas
4  ;-- Engineer: JSV
5  ;--
6  ;-- Create Date: 22/02/2013 17:12:19
7  ;-- Project Name: DFT_APP_TESIS
8  ;-- Filename: ConfFile_1.3.sasm
9  ;-- Description: SASM file for Dynamic Fault Tolerance example application.
10 ;--
11 ;-- Revision 0.01 - File created.
12 ;-- Additional Comments:
13 ;--
14 ;-----
15 ;*****
16 ;Final configuration after execution
17 ;*****
18 ;CHIP0 |----| |----| CHIP1 |----| |----|
19 ;      | C00 | | C10 |      | C00 | | C10 |
20 ;      |----| |----|      |----| |----|
21 ;
22 ;      |----| |----|      |----| |----|
23 ;      | C01 | | C11 |      | C01 | | C11 |
24 ;      |----| |----|      |----| |----|
25 ;
26 ;c00_CHIPO: address=0x00CC00C0, MODE=0x09, PORTS=0x44, FTCSR=0x00.
27 ;           Pseudo-random number generator (PRNG) using a linear
28 ;           feedback shift register (LFSR). Compute Section (PRNG_0).
29 ;c01_CHIPO: address=0x11AA00A1, MODE=0x09, PORTS=0x44, FTCSR=0x00.
30 ;           Monitor_1: monitor.
31 ;c10_CHIPO: address=0x11AA00A2, MODE=0x04, PORTS=0x00, FTCSR=0x00.
32 ;           Monitor_2: comparator.
33 ;c11_CHIPO: address=0x11CC00C1, MODE=0x09, PORTS=0x44, FTCSR=0x00.
34 ;           First copy of Compute section (PRNG_1).
35 ;           This component (1 cell) is dinamically created and deleted.
36 ;c00_CHIP1: address=0x22CC00C2, MODE=0x09, PORTS=0x44, FTCSR=0x00.
37 ;           Second copy of Compute section (PRNG_2).
38 ;           This component (1 cell) is dinamically created and deleted.
39 ;others   : empty.
40 ;
41 ;*****
42 ;Difinitions
43 ;*****
44 comp_compute      equ 0x00CC
45 comp_compute_copy_1 equ 0x11CC
46 comp_compute_copy_2 equ 0x22CC
47 comp_monitor      equ 0x11AA
48 cell_lfsr         equ 0x00CC00C0
49 cell_lfsr_copy_1  equ 0x11CC00C1
50 cell_lfsr_copy_2  equ 0x22CC00C2
51 cell_monitor_1    equ 0x11AA00A1
52 cell_monitor_2    equ 0x11AA00A2
53 ;*****
54 ;subprocess 0 for Monitor component
55 ;*****
56 start_subprocess_0 comp_monitor
57   create_component comp_compute_copy_1 ;Create Compute section, copy 1
58   write_FU_memory  cell_lfsr_copy_1   ;Write FU memories for cell
59   connect_component
60 end_subprocess_0
61 ;*****
62 ;subprocess 1 for Monitor component
63 ;*****

```

E.1. LISTINGS FOR DYNAMIC FAULT TOLERANCE SCALING APPLICATION EXAMPLE

```

64 start_subprocess_1  comp_monitor
65   create_component  comp_compute_copy_2 ;Create Compute section, copy 2
66   write_FU_memory   cell_lfsr_copy_2   ;Write FU memories for cell
67   connect_component ;connect component
68 end_subprocess_1
69 ;*****
70 ;subprocess 2 for Monitor component
71 ;*****
72 start_subprocess_2  comp_monitor
73   delete_component  comp_compute_copy_1 ;delete copy 1 of Compute section
74 end_subprocess_2
75 ;*****
76 ;subprocess 3 for Monitor component
77 ;*****
78 start_subprocess_3  comp_monitor
79   delete_component  comp_compute_copy_2 ;delete copy 2 of Compute section
80 end_subprocess_3
81
82 ;*****
83 ;* Initial Configurtion *
84 ;*****
85 create_component  comp_monitor      ;Create Monitor component
86 restart_and_disable_processors
87 write_FU_memory   cell_monitor_1    ;write FU program memories for Monitor_1
88 write_FU_memory   cell_monitor_2    ;write FU program memories for Monitor_2
89 create_component  comp_compute      ;Create Compute component
90 write_FU_memory   cell_lfsr         ;Write FU program memories for cell
91 connect_component ;Connect component
92 enable_processors_wait ;Enable processors and wait for
93                               ;an event to start a subprocess.
94 end                               ;End of SASM configuration file

```

Listing E.2: ASM code for Monitor_1 section.

```

1  ;-----
2  ;-- Assembler template for Processor Core 0 in Mode 9
3  ;-- Created by: SANE Project Developer - v 2.20 - Javier Soto Vargas
4  ;-- Engineer: Javier Soto
5  ;--
6  ;-- Date Created: 22/02/2013 17:12:03
7  ;-- Project Name: DFT_APP_TESIS
8  ;-- Filename:      Monitor_1.asm
9  ;-- Description: One 16-bit processor (P0) with 16x16 data memory and 256
10 ;--                instructions. Monitor_1 section, measure the power
11 ;--                consumption of PRNGs, and start the creation/killing of
12 ;--                copies of compute sections.
13 ;-- Revision 0.01 - File created.
14 ;-- Additional Comments: Cell address: 0x11AA00A1. MODE = 0x09
15 ;-----
16 #include <pMode9Core0.inc> ;Definition of Configuration and Status
17                               ;Registers including inputs and outputs.
18 ;16-bit General purpose Registers
19 ;Definitions for measuring the compute section.
20 new_data      equ    0x0
21 old_data      equ    0x1
22 threshold     equ    0x2
23 average       equ    0x3
24 m1_status     equ    0x4
25 cont_changes  equ    0x5
26 comparison    equ    0x6
27 ;FIFO for average of last eigth values
28 FIFO_0        equ    0x8
29 FIFO_1        equ    0x9
30 FIFO_2        equ    0xA
31 FIFO_3        equ    0xB
32 FIFO_4        equ    0xC
33 FIFO_5        equ    0xD
34 FIFO_6        equ    0xE
35 FIFO_7        equ    0xF
36 ;*****

```

```

37 ;* Description of register with status of MONITOR_1: m1_status
38 ;*****
39 ;m1_status<0> : 1 -> first copy active, 0-> no active
40 ;m1_status<1> : 1 -> second copy active, 0-> no active
41 ;m1_status<2> : 1 -> creation first copy in progress, 0-> no started
42 ;m1_status<3> : 1 -> creation second copy in progress, 0-> no started
43 ;m1_status<4> : 1 -> killing first copy in progress, 0-> no started
44 ;m1_status<5> : 1 -> killing second copy in progress, 0-> no started
45 ;*****
46 ;Description of register: comparison
47 ;*****
48 ;comparison<0> : 1 -> PRNG_copy_0_original == PRNG_copy1
49 ;                0 -> PRNG_copy_0_original /= PRNG_copy1
50 ;comparison<1> : 1 -> PRNG_copy_1 == PRNG_copy2
51 ;                0 -> PRNG_copy_1 /= PRNG_copy2
52 ;*****
53 ;Directives
54 ;*****
55 MODE_CORE    0x9,0 ;Directive for MODE and CORE
56 ORG          0x0 ;Origin of first instruction
57 ;*****
58 ;Start of program - initialization
59 ;*****
60 start
61  MOVLW 0x05,old_data,1 ;Seed for LFSR 0x05F3
62  MOVLW 0xF3,old_data,0
63  MOVLW 0x00,FIFO_0,1 ;Set FIFO registers to 0x000F
64  MOVLW 0x0F,FIFO_0,0 ;initial value for high consumption regime,
65  MOVW FIFO_0,FIFO_1 ;there are not COMPUTE sections copies
66  MOVW FIFO_0,FIFO_2
67  MOVW FIFO_0,FIFO_3
68  MOVW FIFO_0,FIFO_4
69  MOVW FIFO_0,FIFO_5
70  MOVW FIFO_0,FIFO_6
71  MOVW FIFO_0,FIFO_7
72  CLRF threshold ;Set threshold to 0x0000
73  CLRF m1_status ;Set m1_status to 0x0000
74 cycle
75  MOVW old_data,OUT_01 ;Move old_data to OUT_01 Port two times
76  MOVW old_data,OUT_01 ;for metaestability issues with two chips.
77  BLMOV IN_01,new_data ;Wait pseudo-random data from COMPUTE section
78  BLMOV IN_23,comparison ;Wait comparison value from MONITOR_2 section
79  GOTO calculate_average ;Calculate average
80 ret_calc_average
81  MOVW new_data,old_data ;old_data <= new_data
82  MOVW average,OUT_23 ;Move average to OUT_23 Port - average in leds
83 review_progress
84  BRCLR m1_status,2,next1 ;next1 if creation copy_1 is not in progress
85  BRCLR SUBPCSR,3,nextLast ;nextLast if ends creation of copy_1
86 ;(nextlast if ends execution of subprocess0)
87  BCLR m1_status,2 ;clear flag creation_first_copy_in_progress
88  BCLR SUBPCSR,3 ;clear subprocess0 ends flag
89  BSET m1_status,0 ;set flag copy_1 of COMPUTE section active
90  GOTO nextLast
91 next1
92  BRCLR m1_status,3,nextLast ;nextLast if create copy_2 is not in progress
93  BRCLR SUBPCSR,4,nextLast ;nextLast if ends creation of copy_2
94 ;(nextlast if ends execution of subprocess1)
95  BCLR m1_status,3 ;clear flag creation_second_copy_in_progress
96  BCLR SUBPCSR,4 ;clear subprocess1 ends flag
97  BSET m1_status,1 ;set flag copy_2 of COMPUTE section active
98  GOTO nextLast
99 next2
100 BRCLR m1_status,4,next3 ;next3 if killing copy_1 is not in progress
101 BRCLR SUBPCSR,5,nextLast ;nextLast if ends killing of copy_1
102 ;(nextlast if ends execution of subprocess2)
103 BCLR m1_status,4 ;clear flag kill_first_copy_in_progress
104 BCLR SUBPCSR,5 ;clear subprocess2 ends flag
105 GOTO nextLast
106 next3

```

E.1. LISTINGS FOR DYNAMIC FAULT TOLERANCE SCALING APPLICATION EXAMPLE

```

107 BRCLR m1_status,5,nextLast ;nextLast if killing copy_2 is not in progress
108 BRCLR SUBPCSR,6,nextLast ;nextLast if ends killing of copy_2
109 ;(nextlast if ends execution of subprocess3)
110 BCLR m1_status,5 ;clear flag kill_second_copy_in_progress
111 BCLR SUBPCSR,6 ;clear subprocess3 ends flag
112 nextLast
113 BRSET m1_status,1,second_copy_active ;process when copy_2 is active
114 BRSET m1_status,0,first_copy_active ;process when copy_1 is active
115 none_copy_active ;process when none copy is active
116 MOVLF 0x0B,threshold,0 ;for high consumption regime
117 CBGE average,threshold,cycle ;goto cycle if average >= 11
118 MOVLF 0x01,threshold,0 ;for low consumption regime (copy_1)
119 CBGE average,threshold,pre_create_first_copy ;jump if average >= 1
120 MOVLF 0xF1,OUT_23,1 ;set error code 1 (leds)
121 END ;End with error
122 pre_create_first_copy
123 BRCLR SUBPCSR,7,cycle ;goto cycle if system is not in wait state
124 create_first_copy
125 BSET m1_status,2 ;set flag creation_first_copy_in_progress
126 BCLR SUBPCSR,2 ;configure creation of first copy
127 BCLR SUBPCSR,1 ;subprocess0, SUBPCSR<2:1> <= 00
128 BSET SUBPCSR,0 ;start creation of first copy
129 BCLR SUBPCSR,0 ;(start execution of subprocess_0)
130 GOTO cycle
131
132 org 0x40 ;Optional, for locating code in PM1
133 ;*****
134 ;Process when first copy is active
135 ;*****
136 first_copy_active
137 BRSET comparison,0,$+3 ;jump 3 positions if copy_original == copy_1
138 MOVLF 0xF2,OUT_23,1 ;set error code 2 (leds)
139 END ;End with error
140 MOVLF 0x0B,threshold,0 ;for high consumption regime
141 CBGE average,threshold,pre_delete_first_copy ;jump if average >= 11
142 MOVLF 0x06,threshold,0 ;for medium consumption regime
143 CBGE average,threshold,cycle ;jump if average >= 6
144 MOVLF 0x01,threshold,0 ;for low consumption regime
145 CBGE average,threshold,pre_create_second_copy ;jump if average >= 1
146 MOVLF 0xF3,OUT_23,1 ;set error code 3 (leds)
147 END ;End with error
148 pre_delete_first_copy
149 BRCLR SUBPCSR,7,cycle ;goto cycle if system is not in wait state
150 delete_first_copy
151 BCLR m1_status,0 ;clear flag first_copy_active
152 BSET m1_status,4 ;set flag kill_first_copy_in_progress
153 BSET SUBPCSR,2 ;configure subprocess for killing first copy
154 BCLR SUBPCSR,1 ;subprocess2, SUBPCSR<2:1> <= 10
155 BSET SUBPCSR,0 ;start killing of copy_1
156 BCLR SUBPCSR,0 ;(start execution of subprocess_2)
157 GOTO cycle
158 pre_create_second_copy
159 BRCLR SUBPCSR,7,cycle ;goto cycle if system is not in wait state
160 create_second_copy
161 BSET m1_status,3 ;set flag creation_second_copy_in_progress
162 BCLR SUBPCSR,2 ;configure subprocess for create second copy
163 BSET SUBPCSR,1 ;subprocess_1, SUBPCSR<2:1> <= 01
164 BSET SUBPCSR,0 ;start creation of copy_2
165 BCLR SUBPCSR,0 ;(start execution of subprocess_1)
166 GOTO cycle
167 ;*****
168 ;Process when second copy is active
169 ;*****
170 second_copy_active
171 BRSET comparison,1,$+3 ;jump 3 positions if copy_1 == copy_2
172 MOVLF 0xF4,OUT_23,1 ;set error code 4 (leds)
173 END ;End with error
174 MOVLF 0x06,threshold,0 ;for medium consumption regime
175 CBGE average,threshold,pre_delete_second_copy ;jump if average >= 6
176 MOVLF 0x01,threshold,0 ;for low consumption regime

```

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```

177  CBGE    average,threshold,cycle    ;jump if average >= 1
178  MOVL   0xF5,OUT_23,1              ;set error code 5 (leds)
179  END                                          ;End with error
180 pre_delete_second_copy
181  BRCLR  SUBPCSR,7,cycle    ;goto cycle if system is not in wait state
182 delete_second_copy
183  BCLR   m1_status,1          ;clear flag second_copy_active
184  BSET   m1_status,5          ;set flag kill_second_copy_in_progress
185  BSET   SUBPCSR,2            ;configure subprocess for killing second copy
186  BSET   SUBPCSR,1            ;subprocess_3, SUBPCSR<2:1> <= 11
187  BSET   SUBPCSR,0            ;start killing of copy_2
188  BCLR   SUBPCSR,0            ;(start execution of subprocess_3)
189  GOTO   cycle
190
191  org 0x80
192  ;*****
193  ;Calculate average of changes
194  ;*****
195 calculate_average
196  CLRF   cont_changes          ;counter of changes between old_data
197 bit0                                         ;and new_data
198  XORWY  new_data,old_data,old_data ;comparison of old_data and new_data
199  BRCLR  old_data,0,$+2        ;Increment counter when a transition
200  INCW   cont_changes,cont_changes ;occurs
201  BRCLR  old_data,.1,$+2      ;Same for all bits
202  INCW   cont_changes,cont_changes
203  BRCLR  old_data,.2,$+2
204  INCW   cont_changes,cont_changes
205  BRCLR  old_data,.3,$+2
206  INCW   cont_changes,cont_changes
207  BRCLR  old_data,.4,$+2
208  INCW   cont_changes,cont_changes
209  BRCLR  old_data,.5,$+2
210  INCW   cont_changes,cont_changes
211  BRCLR  old_data,.6,$+2
212  INCW   cont_changes,cont_changes
213  BRCLR  old_data,.7,$+2
214  INCW   cont_changes,cont_changes
215  BRCLR  old_data,.8,$+2
216  INCW   cont_changes,cont_changes
217  BRCLR  old_data,.9,$+2
218  INCW   cont_changes,cont_changes
219  BRCLR  old_data,.10,$+2
220  INCW   cont_changes,cont_changes
221  BRCLR  old_data,.11,$+2
222  INCW   cont_changes,cont_changes
223  BRCLR  old_data,.12,$+2
224  INCW   cont_changes,cont_changes
225  BRCLR  old_data,.13,$+2
226  INCW   cont_changes,cont_changes
227  BRCLR  old_data,.14,$+2
228  INCW   cont_changes,cont_changes
229  BRCLR  old_data,.15,$+2
230  INCW   cont_changes,cont_changes
231  MOVW   FIFO_6,FIFO_7        ;Shift FIFO registers one position
232  MOVW   FIFO_5,FIFO_6
233  MOVW   FIFO_4,FIFO_5
234  MOVW   FIFO_3,FIFO_4
235  MOVW   FIFO_2,FIFO_3
236  MOVW   FIFO_1,FIFO_2
237  MOVW   FIFO_0,FIFO_1
238  MOVW   cont_changes,FIFO_0   ;Set new value of changes
239  MOVW   FIFO_0,average        ;to FIFO_0 register and
240  ADDWY  FIFO_1,average,average ;calculate average
241  ADDWY  FIFO_2,average,average
242  ADDWY  FIFO_3,average,average
243  ADDWY  FIFO_4,average,average
244  ADDWY  FIFO_5,average,average
245  ADDWY  FIFO_6,average,average
246  ADDWY  FIFO_7,average,average

```

```

247 LSR    average,average
248 LSR    average,average
249 LSR    average,average
250 GOTO   ret_calc_average

```

Listing E.3: ASM code for Monitor_2 section.

```

1  ;-----
2  ;-- Assembler template for Processor Core 0 in Mode 4
3  ;-- Created by: SANE Project Developer - v 2.20 - Javier Soto Vargas
4  ;-- Engineer: JSV
5  ;--
6  ;-- Date Created: 22/02/2013 17:12:47
7  ;-- Project Name: DFT_APP_TESIS
8  ;-- Filename: Monitor_2.asm
9  ;-- Description: Monitor_2 section: comparison of PRNGs
10 ;--
11 ;-- Revision 0.01 - File created.
12 ;-- Additional Comments: address: 11AA00A2
13 ;--
14 ;-----
15 #include <pMode4Core0.inc>
16
17 ;8-Bit General Purpose Registers
18 data0_L equ 0x0 ;LSB read from original COMPUTE section (copy0)
19 data0_H equ 0x1 ;MSB read from original COMPUTE section (copy0)
20 data1_L equ 0x2 ;LSB read from COMPUTE section (copy1)
21 data1_H equ 0x3 ;MSB read from COMPUTE section (copy1)
22 data2_L equ 0x4 ;LSB read from COMPUTE section (copy2)
23 data2_H equ 0x5 ;MSB read from COMPUTE section (copy2)
24 comparison equ 0x6
25 ;comparison<0> : 1 -> PRNG_copy_0_original == PRNG_copy1
26 ;                0 -> PRNG_copy_0_original != PRNG_copy1
27 ;comparison<1> : 1 -> PRNG_copy_1 == PRNG_copy2
28 ;                0 -> PRNG_copy_1 != PRNG_copy2
29 ;*****
30 ;*Directives
31 ;*****
32 MODE_CORE 0x4,0
33 ORG 0x0
34 ;*****
35 ;*Start of program
36 ;*****
37 start
38 BLMOV IN0,data0_L ;Wait for a new pseudo-random number from
39 NOP ;COMPUTE section (original or copy_0).
40 NOP ;Read low byte first.
41 NOP ;Delay due metaestability between chips
42 NOP
43 NOP
44 MOVW IN1,data1_L ;Read low byte from COMPUTE section(copy_1)
45 MOVW IN2,data2_L ;Read low byte from COMPUTE section(copy_2)
46 BLMOV IN0,data0_H ;Read high byte from COMPUTE section
47 NOP ;Delay because metaestability between chips
48 NOP
49 NOP
50 NOP
51 NOP
52 MOVW IN1,data1_H ;Read high byte from COMPUTE section(copy_1)
53 MOVW IN2,data2_H ;Read high byte from COMPUTE section(copy_2)
54 CLRF comparison ;Clear comparison register
55 compare_1_2
56 CBNE data0_L,data1_L,write_port ;Jump if copy_0 != copy_1 (low bytes)
57 CBNE data0_H,data1_H,write_port ;Jump if copy_0 != copy_1 (high bytes)
58 BSET comparison,0 ;Set flag copy_0 == copy_1
59 compare_2_3
60 CBNE data1_L,data2_L,write_port ;Jump if copy_1 != copy_2 (low bytes)
61 CBNE data1_H,data2_H,write_port ;Jump if copy_1 != copy_2 (high bytes)
62 BSET comparison,1 ;Set flag copy_1 == copy_2
63 write_port

```

```

64 MOVW  comparison,OUT0          ;Write comparison register to port OUT0
65 GOTO  start

```

Listing E.4: ASM code for Compute sections (original, first and second copy).

```

1  ;-----
2  ;-- Assembler template for Processor Core 0 in Mode 9
3  ;-- Created by: SANE Project Developer - v 2.20 - Javier Soto Vargas
4  ;-- Engineer: JSV
5  ;--
6  ;-- Date Created: 22/02/2013 17:12:55
7  ;-- Project Name: DFT_APP_TESIS
8  ;-- Filename: PRNG0_OriginalCompute.asm
9  ;-- Description: Pseudo-random number generator, 16-bits,
10 ;--                output port OUT0_OUT01 (original compute section)
11 ;--
12 ;-- Revision 0.01 - File created.
13 ;-- Additional Comments: Mode 9, address: 00CC00C0, 16-bit processor
14 ;--                with 16x16 bits in memory data, 256 instructions
15 ;--                (Linear feedback shift register) PRNG_0 generator
16 ;-----
17 #include <pMode9Core0.inc>
18 ;*****
19 ;Polynomial for LFSR 16-bit:  $x^{11} + x^{13} + x^{14} + x^{16} + 1$ 
20 ;
21 ; -> x1 x1 x2 x3 x4 x5 x6 x7 x8 x9 x10 x11 x12 x13 x14 x15 x16 ->
22 ; |
23 ; | | | XOR<-----
24 ; | | |
25 ; | | XOR<-
26 ; | | |
27 ; |<-----XOR<-----
28
29 ;16-Bit General Purpose Registers
30 data equ 0x0 ;pseudo-random data generated
31 seed equ 0x1 ;seed for calculate data
32 cont_taps equ 0x2 ;counter of taps
33 none equ 0x3F ;empty address
34 ;*****
35 ;* Directives
36 ;*****
37 MODE_CORE 0x9,0
38 ORG 0x0
39 ;*****
40 ;* Start of program
41 ;*****
42 start
43 BLMOV IN_01,seed ;read 16-bit seed from Monitor_1
44 NOP
45 MOVW IN_01,seed ;read again for LFSR_2 (metaestability)
46 GOTO next_data ;calculate next data
47 ret_next_data
48 MOVW seed,OUT_23 ;move seed to output ports OUT2 and OUT3 (leds)
49 MOVW data,OUT_01 ;move 16-bit pseudo-random data to Monitor_1
50 NOP ;Monitor_2 read low byte.
51 NOP ;Delay implemented to Monitor_2, which needs time
52 NOP ;to read data from Compute sections:
53 NOP ;PRNG_0, PRNG_1 (if exist) and PRNG_2 (if exist)
54 NOP
55 NOP
56 NOP
57 NOP
58 NOP
59 NOP
60 NOP
61 NOP
62 NOP
63 NOP
64 NOP
65 NOP

```


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```

66  NOP
67  NOP
68  SWAPW  data,OUT_01  ;SWAP and write data to port OUT0-OUT1,
69  GOTO   start      ;Monitor_2 read high byte.
70  ;*****
71  ;* Calculation of pseudo-random data
72  ;*****
73  org 0x40 ;used for allocate code in Program memory 1 (optional).
74 next_data
75  CLRFB  cont_taps          ;clear taps counter
76  BRCLR  seed,0,jump1      ;evaluate x16
77  INCW   cont_taps,cont_taps ;increment taps counter
78 jump1
79  BRCLR  seed,2,jump2      ;evaluate x14
80  INCW   cont_taps,cont_taps ;increment taps counter
81 jump2
82  BRCLR  seed,3,jump3      ;evaluate x13
83  INCW   cont_taps,cont_taps ;increment taps counter
84 jump3
85  BRCLR  seed,5,jump4      ;evaluate x11
86  INCW   cont_taps,cont_taps ;increment taps counter
87 jump4
88  SEC    ;Set carry
89  BRSET  cont_taps,0,$+2    ;Jump 2 positions if cont_taps is odd (XOR=1)
90  CLC    ;Clear carry
91  RRW   seed,data          ;Rotate right through carry for
92  GOTO  ret_next_data      ;generation of new pseudo-random data.

```

Listing E.5: SHEX file generated by SANE Project developer after execute Build Project option.

```

1  unsigned int memoria[] =
2  {
3  start_subprocess0_IC, //0x10
4  0x11AA, //id_comp
5  create_component_IC, //0x00
6  0x11CC, //id_comp
7  0, //Zero-based num cells in component
8  1, //num of outputs
9  0x11CC00C1, //address
10 0x00,
11 0x11AA00A1, //Input 0
12 0x09,
13 0x11AA00A1, //Input 1
14 0x00,
15 0x00000000, //Input 2
16 0x00,
17 0x00000000, //Input 3
18 0x00,
19 0x00000000, //FT Input 0
20 0x00,
21 0x00000000, //FT Input 1
22 0x00,
23 0x00000000, //FT Input 2
24 0x00,
25 0x00000000, //FT Input 3
26 0x01,
27 0x11AA00A2, //Output 0
28 write_FU_memory_CR_IC, //0x03
29 0x11CC00C1, //address
30 4, //register number
31 0x09, //MODE
32 0x00, //FAMILY
33 0x44, //PORTS
34 0x00, //FTCSR
35 write_FU_memory_PMO_IC, //0x04
36 0x11CC00C1, //address
37 26, //register number
38 0x0780801, //0 BLMOV IN_01,seed,
39 0x0B40000, //1 NOP ,,
40 0x0740801, //2 MOVW IN_01,seed,

```


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```

41 0x0E40000, //3 GOTO next_data,,
42 0x0740065, //4 MOVW seed,OUT_23,
43 0x0740024, //5 MOVW data,OUT_01,
44 0x0B40000, //6 NOP ,,
45 0x0B40000, //7 NOP ,,
46 0x0B40000, //8 NOP ,,
47 0x0B40000, //9 NOP ,,
48 0x0B40000, //10 NOP ,,
49 0x0B40000, //11 NOP ,,
50 0x0B40000, //12 NOP ,,
51 0x0B40000, //13 NOP ,,
52 0x0B40000, //14 NOP ,,
53 0x0B40000, //15 NOP ,,
54 0x0B40000, //16 NOP ,,
55 0x0B40000, //17 NOP ,,
56 0x0B40000, //18 NOP ,,
57 0x0B40000, //19 NOP ,,
58 0x0B40000, //20 NOP ,,
59 0x0B40000, //21 NOP ,,
60 0x0B40000, //22 NOP ,,
61 0x0B40000, //23 NOP ,,
62 0x08C0024, //24 SWAPW data,OUT_01,
63 0x0E00000, //25 GOTO start,,
64 write_FU_memory_PM1_IC, //0x05
65 0x11CC00C1, //address
66 14, //register number
67 0x0A40002, //64 CLRf cont_taps,,
68 0x0C43040, //65 BRCLR seed,0,jump1
69 0x0840082, //66 INCW cont_taps,cont_taps,
70 0x0C45042, //67 BRCLR seed,2,jump2
71 0x0840082, //68 INCW cont_taps,cont_taps,
72 0x0C47043, //69 BRCLR seed,3,jump3
73 0x0840082, //70 INCW cont_taps,cont_taps,
74 0x0C49045, //71 BRCLR seed,5,jump4
75 0x0840082, //72 INCW cont_taps,cont_taps,
76 0x0AC0000, //73 SEC ,,
77 0x0D4C080, //74 BRSET cont_taps,0,$+2
78 0x0A80000, //75 CLC ,,
79 0x0940040, //76 RRW seed,data,
80 0x0E04000, //77 GOTO ret_next_data,,
81 connect_component_IC, //0x01
82 end_subprocess0_IC, //0x11
83 start_subprocess1_IC, //0x12
84 0x11AA, //id_comp
85 create_component_IC, //0x00
86 0x22CC, //id_comp
87 0, //Zero-based num cells in component
88 1, //num of outputs
89 0x22CC00C2, //address
90 0x00,
91 0x11AA00A1, //Input 0
92 0x09,
93 0x11AA00A1, //Input 1
94 0x00,
95 0x00000000, //Input 2
96 0x00,
97 0x00000000, //Input 3
98 0x00,
99 0x00000000, //FT Input 0
100 0x00,
101 0x00000000, //FT Input 1
102 0x00,
103 0x00000000, //FT Input 2
104 0x00,
105 0x00000000, //FT Input 3
106 0x02,
107 0x11AA00A2, //Output 0
108 write_FU_memory_CR_IC, //0x03
109 0x22CC00C2, //address
110 4, //register number

```

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```

111 0x09 ,                //MODE
112 0x00 ,                //FAMILY
113 0x44 ,                //PORTS
114 0x00 ,                //FTCSR
115 write_FU_memory_PMO_IC , //0x04
116 0x22CC00C2 ,        //address
117 26 ,                 //register number
118 0x0780801 ,         //0    BLMOV  IN_01,seed,
119 0x0B40000 ,         //1    NOP    ,,
120 0x0740801 ,         //2    MOVW  IN_01,seed,
121 0x0E40000 ,         //3    GOTO  next_data,,
122 0x0740065 ,         //4    MOVW  seed,OUT_23,
123 0x0740024 ,         //5    MOVW  data,OUT_01,
124 0x0B40000 ,         //6    NOP    ,,
125 0x0B40000 ,         //7    NOP    ,,
126 0x0B40000 ,         //8    NOP    ,,
127 0x0B40000 ,         //9    NOP    ,,
128 0x0B40000 ,         //10   NOP    ,,
129 0x0B40000 ,         //11   NOP    ,,
130 0x0B40000 ,         //12   NOP    ,,
131 0x0B40000 ,         //13   NOP    ,,
132 0x0B40000 ,         //14   NOP    ,,
133 0x0B40000 ,         //15   NOP    ,,
134 0x0B40000 ,         //16   NOP    ,,
135 0x0B40000 ,         //17   NOP    ,,
136 0x0B40000 ,         //18   NOP    ,,
137 0x0B40000 ,         //19   NOP    ,,
138 0x0B40000 ,         //20   NOP    ,,
139 0x0B40000 ,         //21   NOP    ,,
140 0x0B40000 ,         //22   NOP    ,,
141 0x0B40000 ,         //23   NOP    ,,
142 0x08C0024 ,         //24   SWAPW data,OUT_01,
143 0x0E00000 ,         //25   GOTO  start,,
144 write_FU_memory_PM1_IC , //0x05
145 0x22CC00C2 ,        //address
146 14 ,                 //register number
147 0x0A40002 ,         //64   CLRF  cont_taps,,
148 0x0C43040 ,         //65   BRCLR seed,0,jump1
149 0x0840082 ,         //66   INCW  cont_taps,cont_taps,
150 0x0C45042 ,         //67   BRCLR seed,2,jump2
151 0x0840082 ,         //68   INCW  cont_taps,cont_taps,
152 0x0C47043 ,         //69   BRCLR seed,3,jump3
153 0x0840082 ,         //70   INCW  cont_taps,cont_taps,
154 0x0C49045 ,         //71   BRCLR seed,5,jump4
155 0x0840082 ,         //72   INCW  cont_taps,cont_taps,
156 0x0AC0000 ,         //73   SEC   ,,
157 0x0D4C080 ,         //74   BRSET cont_taps,0,$+2
158 0x0A80000 ,         //75   CLC   ,,
159 0x0940040 ,         //76   RRW  seed,data,
160 0x0E04000 ,         //77   GOTO  ret_next_data,,
161 connect_component_IC , //0x01
162 end_subprocess1_IC ,  //0x13
163 start_subprocess2_IC , //0x14
164 0x11AA ,             //id_comp
165 delete_component_IC , //0x02
166 0x11CC ,             //id_comp
167 end_subprocess2_IC ,  //0x15
168 start_subprocess3_IC , //0x16
169 0x11AA ,             //id_comp
170 delete_component_IC , //0x02
171 0x22CC ,             //id_comp
172 end_subprocess3_IC ,  //0x17
173 create_component_IC , //0x00
174 0x11AA ,             //id_comp
175 1 ,                   //Zero-based num cells in component
176 6 ,                   //num of outputs
177 0x11AA00A1 ,         //address
178 0x00 ,
179 0x00CC00C0 ,         //Input 0
180 0x09 ,

```

```

181 0x00CC00C0 ,           //Input 1
182 0x02 ,
183 0x11AA00A2 ,         //Input 2
184 0x03 ,
185 0x11AA00A2 ,         //Input 3
186 0x00 ,
187 0x00000000 ,         //FT Input 0
188 0x00 ,
189 0x00000000 ,         //FT Input 1
190 0x00 ,
191 0x00000000 ,         //FT Input 2
192 0x00 ,
193 0x00000000 ,         //FT Input 3
194 0x00 ,
195 0x00CC00C0 ,         //Output 0
196 0x09 ,
197 0x00CC00C0 ,         //Output 1
198 0x00 ,
199 0x11CC00C1 ,         //Output 2
200 0x09 ,
201 0x11CC00C1 ,         //Output 3
202 0x00 ,
203 0x22CC00C2 ,         //Output 4
204 0x09 ,
205 0x22CC00C2 ,         //Output 5
206 2 ,                   //num of outputs
207 0x11AA00A2 ,         //address
208 0x00 ,
209 0x00CC00C0 ,         //Input 0
210 0x01 ,
211 0x11CC00C1 ,         //Input 1
212 0x02 ,
213 0x22CC00C2 ,         //Input 2
214 0x00 ,
215 0x00000000 ,         //Input 3
216 0x00 ,
217 0x00000000 ,         //FT Input 0
218 0x00 ,
219 0x00000000 ,         //FT Input 1
220 0x00 ,
221 0x00000000 ,         //FT Input 2
222 0x00 ,
223 0x00000000 ,         //FT Input 3
224 0x02 ,
225 0x11AA00A1 ,         //Output 0
226 0x03 ,
227 0x11AA00A1 ,         //Output 1
228 restart_and_disable_processors_IC , //0x0A
229 write_FU_memory_CR_IC , //0x03
230 0x11AA00A1 ,         //address
231 4 ,                   //register number
232 0x09 ,               //MODE
233 0x00 ,               //FAMILY
234 0x44 ,               //PORTS
235 0x00 ,               //FTCSR
236 write_FU_memory_PM0_IC , //0x04
237 0x11AA00A1 ,         //address
238 56 ,                 //register number
239 0x0505041 ,         //0    MOVLF    0x05,old_data,1
240 0x05F3001 ,         //1    MOVLF    0xF3,old_data,0
241 0x0500048 ,         //2    MOVLF    0x00,FIFO_0,1
242 0x050F008 ,         //3    MOVLF    0x0F,FIFO_0,0
243 0x0740209 ,         //4    MOVW    FIFO_0,FIFO_1,
244 0x074020A ,         //5    MOVW    FIFO_0,FIFO_2,
245 0x074020B ,         //6    MOVW    FIFO_0,FIFO_3,
246 0x074020C ,         //7    MOVW    FIFO_0,FIFO_4,
247 0x074020D ,         //8    MOVW    FIFO_0,FIFO_5,
248 0x074020E ,         //9    MOVW    FIFO_0,FIFO_6,
249 0x074020F ,         //10   MOVW    FIFO_0,FIFO_7,
250 0x0A40002 ,         //11   CLR    threshold,,

```

E.1. LISTINGS FOR DYNAMIC FAULT TOLERANCE SCALING APPLICATION EXAMPLE

```

251 0x0A40004, //12 CLRFB m1_status,,
252 0x0740064, //13 MOVW old_data,OUT_01,
253 0x0740064, //14 MOVW old_data,OUT_01,
254 0x0780800, //15 BLMOV IN_01,new_data,
255 0x0780846, //16 BLMOV IN_23,comparison,
256 0x0E80000, //17 GOTO calculate_average,,
257 0x0740001, //18 MOVW new_data,old_data,
258 0x07400E5, //19 MOVW average,OUT_23,
259 0x0C1A102, //20 BRCLR m1_status,2,next1
260 0x0C29B03, //21 BRCLR SUBPCSR,3,nextLast
261 0x0B82104, //22 BCLR m1_status,2,
262 0x0B83B2C, //23 BCLR SUBPCSR,3,
263 0x0BC0104, //24 BSET m1_status,0,
264 0x0E29000, //25 GOTO nextLast,,
265 0x0C29103, //26 BRCLR m1_status,3,nextLast
266 0x0C29B04, //27 BRCLR SUBPCSR,4,nextLast
267 0x0B83104, //28 BCLR m1_status,3,
268 0x0B84B2C, //29 BCLR SUBPCSR,4,
269 0x0BC1104, //30 BSET m1_status,1,
270 0x0E29000, //31 GOTO nextLast,,
271 0x0C25104, //32 BRCLR m1_status,4,next3
272 0x0C29B05, //33 BRCLR SUBPCSR,5,nextLast
273 0x0B84104, //34 BCLR m1_status,4,
274 0x0B85B2C, //35 BCLR SUBPCSR,5,
275 0x0E29000, //36 GOTO nextLast,,
276 0x0C29105, //37 BRCLR m1_status,5,nextLast
277 0x0C29B06, //38 BRCLR SUBPCSR,6,nextLast
278 0x0B85104, //39 BCLR m1_status,5,
279 0x0B86B2C, //40 BCLR SUBPCSR,6,
280 0x0D5A101, //41 BRSET m1_status,1,second_copy_active
281 0x0D40100, //42 BRSET m1_status,0,first_copy_active
282 0x050B002, //43 MOVLF 0x0B,threshold,0
283 0x140D0C2, //44 CBGE average,threshold,cycle
284 0x0501002, //45 MOVLF 0x01,threshold,0
285 0x14310C2, //46 CBGE average,threshold,pre_create_first_copy
286 0x05F1065, //47 MOVLF 0xF1,OUT_23,1
287 0x0B00000, //48 END ,,
288 0x0C0DB07, //49 BRCLR SUBPCSR,7,cycle
289 0x0BC2104, //50 BSET m1_status,2,
290 0x0B82B2C, //51 BCLR SUBPCSR,2,
291 0x0B81B2C, //52 BCLR SUBPCSR,1,
292 0x0BC0B2C, //53 BSET SUBPCSR,0,
293 0x0B80B2C, //54 BCLR SUBPCSR,0,
294 0x0E0D000, //55 GOTO cycle,,
295 write_FU_memory_PM1_IC, //0x05
296 0x11AA00A1, //address
297 43, //register number
298 0x0D43180, //64 BRSET comparison,0,$+3
299 0x05F2065, //65 MOVLF 0xF2,OUT_23,1
300 0x0B00000, //66 END ,,
301 0x050B002, //67 MOVLF 0x0B,threshold,0
302 0x144B0C2, //68 CBGE average,threshold,pre_delete_first_copy
303 0x0506002, //69 MOVLF 0x06,threshold,0
304 0x140D0C2, //70 CBGE average,threshold,cycle
305 0x0501002, //71 MOVLF 0x01,threshold,0
306 0x14530C2, //72 CBGE average,threshold,pre_create_second_copy
307 0x05F3065, //73 MOVLF 0xF3,OUT_23,1
308 0x0B00000, //74 END ,,
309 0x0C0DB07, //75 BRCLR SUBPCSR,7,cycle
310 0x0B80104, //76 BCLR m1_status,0,
311 0x0BC4104, //77 BSET m1_status,4,
312 0x0BC2B2C, //78 BSET SUBPCSR,2,
313 0x0B81B2C, //79 BCLR SUBPCSR,1,
314 0x0BC0B2C, //80 BSET SUBPCSR,0,
315 0x0B80B2C, //81 BCLR SUBPCSR,0,
316 0x0E0D000, //82 GOTO cycle,,
317 0x0C0DB07, //83 BRCLR SUBPCSR,7,cycle
318 0x0BC3104, //84 BSET m1_status,3,
319 0x0B82B2C, //85 BCLR SUBPCSR,2,
320 0x0BC1B2C, //86 BSET SUBPCSR,1,

```

APPENDIX E. LISTINGS OF EXAMPLE APPLICATIONS

```

321 0x0BC0B2C , //87 BSET SUBPCSR,0,
322 0x0B80B2C , //88 BCLR SUBPCSR,0,
323 0x0E0D000 , //89 GOTO cycle,,
324 0x0D5D181 , //90 BRSET comparison,1,$+3
325 0x05F4065 , //91 MOVLF 0xF4,OUT_23,1
326 0x0B00000 , //92 END ,,
327 0x0506002 , //93 MOVLF 0x06,threshold,0
328 0x14630C2 , //94 CBGE average,threshold,pre_delete_second_copy
329 0x0501002 , //95 MOVLF 0x01,threshold,0
330 0x140D0C2 , //96 CBGE average,threshold,cycle
331 0x05F5065 , //97 MOVLF 0xF5,OUT_23,1
332 0x0B00000 , //98 END ,,
333 0x0C0DB07 , //99 BRCLR SUBPCSR,7,cycle
334 0x0B81104 , //100 BCLR m1_status,1,
335 0x0BC5104 , //101 BSET m1_status,5,
336 0x0BC2B2C , //102 BSET SUBPCSR,2,
337 0x0BC1B2C , //103 BSET SUBPCSR,1,
338 0x0BC0B2C , //104 BSET SUBPCSR,0,
339 0x0B80B2C , //105 BCLR SUBPCSR,0,
340 0x0E0D000 , //106 GOTO cycle,,
341 write_FU_memory_PM2_IC , //0x06
342 0x11AA00A1 , //address
343 54 , //register number
344 0x0A40005 , //128 CLRF cont_changes,,
345 0x0701001 , //129 XORWY new_data,old_data,old_data
346 0x0C84040 , //130 BRCLR old_data,0,$+2
347 0x0840145 , //131 INCW cont_changes,cont_changes,
348 0x0C86041 , //132 BRCLR old_data,.1,$+2
349 0x0840145 , //133 INCW cont_changes,cont_changes,
350 0x0C88042 , //134 BRCLR old_data,.2,$+2
351 0x0840145 , //135 INCW cont_changes,cont_changes,
352 0x0C8A043 , //136 BRCLR old_data,.3,$+2
353 0x0840145 , //137 INCW cont_changes,cont_changes,
354 0x0C8C044 , //138 BRCLR old_data,.4,$+2
355 0x0840145 , //139 INCW cont_changes,cont_changes,
356 0x0C8E045 , //140 BRCLR old_data,.5,$+2
357 0x0840145 , //141 INCW cont_changes,cont_changes,
358 0x0C90046 , //142 BRCLR old_data,.6,$+2
359 0x0840145 , //143 INCW cont_changes,cont_changes,
360 0x0C92047 , //144 BRCLR old_data,.7,$+2
361 0x0840145 , //145 INCW cont_changes,cont_changes,
362 0x0C94048 , //146 BRCLR old_data,.8,$+2
363 0x0840145 , //147 INCW cont_changes,cont_changes,
364 0x0C96049 , //148 BRCLR old_data,.9,$+2
365 0x0840145 , //149 INCW cont_changes,cont_changes,
366 0x0C9804A , //150 BRCLR old_data,.10,$+2
367 0x0840145 , //151 INCW cont_changes,cont_changes,
368 0x0C9A04B , //152 BRCLR old_data,.11,$+2
369 0x0840145 , //153 INCW cont_changes,cont_changes,
370 0x0C9C04C , //154 BRCLR old_data,.12,$+2
371 0x0840145 , //155 INCW cont_changes,cont_changes,
372 0x0C9E04D , //156 BRCLR old_data,.13,$+2
373 0x0840145 , //157 INCW cont_changes,cont_changes,
374 0x0CA004E , //158 BRCLR old_data,.14,$+2
375 0x0840145 , //159 INCW cont_changes,cont_changes,
376 0x0CA204F , //160 BRCLR old_data,.15,$+2
377 0x0840145 , //161 INCW cont_changes,cont_changes,
378 0x074038F , //162 MOVW FIFO_6,FIFO_7,
379 0x074034E , //163 MOVW FIFO_5,FIFO_6,
380 0x074030D , //164 MOVW FIFO_4,FIFO_5,
381 0x07402CC , //165 MOVW FIFO_3,FIFO_4,
382 0x074028B , //166 MOVW FIFO_2,FIFO_3,
383 0x074024A , //167 MOVW FIFO_1,FIFO_2,
384 0x0740209 , //168 MOVW FIFO_0,FIFO_1,
385 0x0740148 , //169 MOVW cont_changes,FIFO_0,
386 0x0740203 , //170 MOVW FIFO_0,average,
387 0x0603243 , //171 ADDWY FIFO_1,average,average
388 0x0603283 , //172 ADDWY FIFO_2,average,average
389 0x06032C3 , //173 ADDWY FIFO_3,average,average
390 0x0603303 , //174 ADDWY FIFO_4,average,average

```

E.1. LISTINGS FOR DYNAMIC FAULT TOLERANCE SCALING APPLICATION EXAMPLE

```

391 0x0603343,          //175  ADDWY  FIFO_5, average, average
392 0x0603383,          //176  ADDWY  FIFO_6, average, average
393 0x06033C3,          //177  ADDWY  FIFO_7, average, average
394 0x09C00C3,          //178  LSR    average, average,
395 0x09C00C3,          //179  LSR    average, average,
396 0x09C00C3,          //180  LSR    average, average,
397 0x0E12000,          //181  GOTO   ret_calc_average,,
398 write_FU_memory_CR_IC, //0x03
399 0x11AA00A2,          //address
400 4,                   //register number
401 0x04,               //MODE
402 0x00,               //FAMILY
403 0x00,               //PORTS
404 0x00,               //FTCSR
405 write_FU_memory_PMO_IC, //0x04
406 0x11AA00A2,          //address
407 25,                 //register number
408 0x0780800,          //0    BLMOV  IN0, data0_L,
409 0x0B40000,          //1    NOP    ,,
410 0x0B40000,          //2    NOP    ,,
411 0x0B40000,          //3    NOP    ,,
412 0x0B40000,          //4    NOP    ,,
413 0x0B40000,          //5    NOP    ,,
414 0x0740842,          //6    MOVW  IN1, data1_L,
415 0x0740884,          //7    MOVW  IN2, data2_L,
416 0x0780801,          //8    BLMOV  IN0, data0_H,
417 0x0B40000,          //9    NOP    ,,
418 0x0B40000,          //10   NOP    ,,
419 0x0B40000,          //11   NOP    ,,
420 0x0B40000,          //12   NOP    ,,
421 0x0B40000,          //13   NOP    ,,
422 0x0740843,          //14   MOVW  IN1, data1_H,
423 0x0740885,          //15   MOVW  IN2, data2_H,
424 0x0A40006,          //16   CLRF  comparison,,
425 0x1617002,          //17   CBNE  data0_L, data1_L, write_port
426 0x1617043,          //18   CBNE  data0_H, data1_H, write_port
427 0x0BC0186,          //19   BSET  comparison, 0,
428 0x1617084,          //20   CBNE  data1_L, data2_L, write_port
429 0x16170C5,          //21   CBNE  data1_H, data2_H, write_port
430 0x0BC1186,          //22   BSET  comparison, 1,
431 0x07401A4,          //23   MOVW  comparison, OUT0,
432 0x0E00000,          //24   GOTO   start,,
433 create_component_IC, //0x00
434 0x00CC,             //id_comp
435 0,                   //Zero-based num cells in component
436 3,                   //num of outputs
437 0x00CC00C0,         //address
438 0x00,
439 0x11AA00A1,          //Input 0
440 0x09,
441 0x11AA00A1,          //Input 1
442 0x00,
443 0x00000000,         //Input 2
444 0x00,
445 0x00000000,         //Input 3
446 0x00,
447 0x00000000,         //FT Input 0
448 0x00,
449 0x00000000,         //FT Input 1
450 0x00,
451 0x00000000,         //FT Input 2
452 0x00,
453 0x00000000,         //FT Input 3
454 0x00,
455 0x11AA00A1,          //Output 0
456 0x09,
457 0x11AA00A1,          //Output 1
458 0x00,
459 0x11AA00A2,          //Output 2
460 write_FU_memory_CR_IC, //0x03

```

```

461 0x00CC00C0 ,           //address
462 4,                     //register number
463 0x09,                  //MODE
464 0x00,                  //FAMILY
465 0x44,                  //PORTS
466 0x00,                  //FTCSR
467 write_FU_memory_PM0_IC, //0x04
468 0x00CC00C0 ,           //address
469 26,                     //register number
470 0x0780801,             //0    BLMOV  IN_01,seed,
471 0x0B40000,             //1    NOP    ,,
472 0x0740801,             //2    MOVW  IN_01,seed,
473 0x0E40000,             //3    GOTO  next_data,,
474 0x0740065,             //4    MOVW  seed,OUT_23,
475 0x0740024,             //5    MOVW  data,OUT_01,
476 0x0B40000,             //6    NOP    ,,
477 0x0B40000,             //7    NOP    ,,
478 0x0B40000,             //8    NOP    ,,
479 0x0B40000,             //9    NOP    ,,
480 0x0B40000,             //10   NOP    ,,
481 0x0B40000,             //11   NOP    ,,
482 0x0B40000,             //12   NOP    ,,
483 0x0B40000,             //13   NOP    ,,
484 0x0B40000,             //14   NOP    ,,
485 0x0B40000,             //15   NOP    ,,
486 0x0B40000,             //16   NOP    ,,
487 0x0B40000,             //17   NOP    ,,
488 0x0B40000,             //18   NOP    ,,
489 0x0B40000,             //19   NOP    ,,
490 0x0B40000,             //20   NOP    ,,
491 0x0B40000,             //21   NOP    ,,
492 0x0B40000,             //22   NOP    ,,
493 0x0B40000,             //23   NOP    ,,
494 0x08C0024,             //24   SWAPW data,OUT_01,
495 0x0E00000,             //25   GOTO  start,,
496 write_FU_memory_PM1_IC, //0x05
497 0x00CC00C0 ,           //address
498 14,                     //register number
499 0x0A40002,             //64   CLRf  cont_taps,,
500 0x0C43040,             //65   BRCLR seed,0,jump1
501 0x0840082,             //66   INCW  cont_taps,cont_taps,
502 0x0C45042,             //67   BRCLR seed,2,jump2
503 0x0840082,             //68   INCW  cont_taps,cont_taps,
504 0x0C47043,             //69   BRCLR seed,3,jump3
505 0x0840082,             //70   INCW  cont_taps,cont_taps,
506 0x0C49045,             //71   BRCLR seed,5,jump4
507 0x0840082,             //72   INCW  cont_taps,cont_taps,
508 0x0AC0000,             //73   SEC    ,,
509 0x0D4C080,             //74   BRSET cont_taps,0,$+2
510 0x0A80000,             //75   CLC    ,,
511 0x0940040,             //76   RRW  seed,data,
512 0x0E04000,             //77   GOTO  ret_next_data,,
513 connect_component_IC,  //0x01
514 enable_processors_wait_IC, //0x0E
515 end_IC                  //0x0F
516 };

```

Listing E.6: SXM file generated by SANE Project developer after execute Build Project option.

```

1 01031F000000000010000011AA0000000000011CC0000000000000011CC00C10000000097
2 01031F000811AA00A10000000911AA00A10000000000000000000000000000000000000000000015
3 01031F00100000000000000000000000000000000000000000000000000000000000000000000001CD
4 01031F001811AA00A20000000311CC00C10000000400000009000000000000000000000000000077
5 01031F00200000000411CC00C10000001A0078080100B400000074080100E400000074006593
6 01031F00280074002400B4000000B4000000B4000000B4000000B4000000B4000000B4000000B4000000B4000032
7 01031F003000B4000000B4000000B4000000B4000000B4000000B4000000B4000000B4000000B4000000B400000E
8 01031F003800B4000000B4000000B40000008C002400E000000000000511CC00C10000000E49
9 01031F004000A4000200C430400084008200C450420084008200C470430084008200C490454C
10 01031F00480084008200AC000000D4C08000A800000094004000E04000000000010000001122
11 01031F005000000012000011AA00000000000022CC00000000000000122CC00C20000000022

```


E.2 Listings for Static Fault Tolerance Application Example

Listing E.7: SASM file for Static Fault Tolerance example application.

```

1 ;-----
2 ;-- SANE assembly file template for Project ftMode5_8BitsSequence_3Components
3 ;-- Created by: SANE Project Developer - v 2.20 - Javier Soto Vargas
4 ;-- Engineer: JSV
5 ;--
6 ;-- Date Created: 07/04/2014 6:40:09
7 ;-- Project Name: ftMode5_8BitsSequence_3Components
8 ;-- Filename: Program3.sasm
9 ;-- Description: SASM file for Static Fault Tolerance example application.
10 ;--
11 ;-- Revision 0.01 - File created.
12 ;-- Additional Comments:
13 ;--
14 ;-----
15 ;*****
16 ;Initial configuration after execution
17 ;*****
18 ;CHIP0 |-----| |-----| CHIP1 |-----| |-----|
19 ;      | C00 | | C10 |          | C00 | | C10 |
20 ;      |-----| |-----|          |-----| |-----|
21 ;
22 ;      |-----| |-----|          |-----| |-----|
23 ;      | C01 | | C11 |          | C01 | | C11 |
24 ;      |-----| |-----|          |-----| |-----|
25 ;
26 ;c00_CHIPO: address=0xAAAA0001, MODE=0x04, PORTS=0x00, FTCSR=0x45.
27 ;           Primary_Cell with one 8-bit Working_processor.
28 ;           Generator of a 8-bit binary sequence as follows:
29 ;           00000000
30 ;           00000001
31 ;           00000011
32 ;           00000111
33 ;           00001111
34 ;           00011111
35 ;           00111111
36 ;           01111111
37 ;           11111111
38 ;c01_CHIPO: address=0xBBBB0002, MODE=0x04, PORTS=0x00, FTCSR=0x55.
39 ;           Redundant_Cell with one 8-bit Redundant_processor.
40 ;           Same sequence of Working_Processor.
41 ;c10_CHIPO: address=0xCCCC0003, MODE=0x00, PORTS=0x00, FTCSR=0x00.
42 ;           Delay for Working and Redundant Processors.
43 ;others   : Empty in the initial configuration, when the FTS detect the
44 ;           failure, thprimary and redundant will be located in this cells.
45 ;note: Normally the Working_processor and the redundant_processor
46 ;       must execute the same thread (or sequence for the current example).
47 ;       For testing purposes, one of the sequences must be altered to
48 ;       check the Fault Tolerance functionality presented here.
49 ;*****
50 ;* Declarations
51 ;*****
52 cont_primary    equ    0xAAAA0001
53 cont_redundant  equ    0xBBBB0002
54 retardo        equ    0xCCCC0003
55 ;*****
56 ;* Main configuration program
57 ;*****
58 ft_configuration  cont_primary,cont_redundant ;original and redundant cells
59 create_component  0xAAAA                    ;create component with primary cell
60 create_component  0xBBBB                    ;create component with redundant cell
61 create_component  0xCCCC                    ;create component with delay process
62 restart_and_disable_processors              ;
63 write_FU_memory  cont_primary              ;write FU memories for primary cell
64 write_FU_memory  cont_redundant           ;write FU memories for redundant cell
65 write_FU_memory  retardo                   ;write FU memories for delay cell

```

E.2. LISTINGS FOR STATIC FAULT TOLERANCE APPLICATION EXAMPLE

```

66 connect_component          ;Connect components
67 enable_processors_wait    ;Start execution and wait for an event.
68                            ;When a hardware failure is detected the
69                            ;instruction ft_configuration is executed
70 end                        ;End of SASM configuration file

```

Listing E.8: ASM code for Working and Redundant Processors in Primary and Redundant Cells.

```

1  ;-----
2  ;-- Assembler template for Processor Core 0 in Mode 4
3  ;-- Created by: SANE Project Developer - v 2.20 - Javier Soto Vargas
4  ;-- Engineer: JSV
5  ;--
6  ;-- Date Created: 07/04/2014 6:45:03
7  ;-- Project Name: ftMode5_8BitsSequence_3Components
8  ;-- Filename: Primary_3bitsBinaryCounter.asm
9  ;-- Description: Primary_Cell with the Working_processor. 8-bits Binary sequence,
10 ;--                for test Fault Tolerance System in ft_mode=5
11 ;--                Sequence; 0x00, 0x01, 0x03, 0x07, 0x0F, 0x1F, 0x3F, 0x7F, 0xFF, ...
12 ;-- Revision 0.01 - File created.
13 ;-- Additional Comments: address AAAA0001 - one 8-bit processor. Mode 4.
14 ;--
15 ;-----
16 #include <pMode4Core0.inc>
17
18 ;8-Bit General Purpose Registers
19 bin0 equ 0x0 ;Constant definitions for binary sequence
20 bin1 equ 0x1
21 bin2 equ 0x2
22 bin3 equ 0x3
23 bin4 equ 0x4
24 bin5 equ 0x5
25 bin6 equ 0x6
26 bin7 equ 0x7
27 bin8 equ 0x8
28 H3F equ 0x3F
29 BL_IN0 equ 0x0 ;input port definition for BLMOV instruction
30 ;*****
31 ;* Directives
32 ;*****
33 MODE_CORE 0x4,0
34 ORG 0x0
35 ;*****
36 ;* Start of programm
37 ;*****
38 start
39 movlf 0x00, bin0, 0 ;move constants values to binX registers
40 movlf 0x01, bin1, 0 ;for sequence generation
41 movlf 0x03, bin2, 0
42 movlf 0x07, bin3, 0
43 movlf 0x0F, bin4, 0
44 movlf 0x1F, bin5, 0
45 movlf 0x3F, bin6, 0
46 movlf 0x7F, bin7, 0
47 movlf 0xFF, bin8, 0
48 cycle
49 movw bin0, OUT0 ;move binX data to output port
50 blmov BL_IN0, H3F ;wait for an input data from Working_processor
51 movw bin1, OUT0 ;Continue with the sequence ...
52 blmov BL_IN0, H3F
53 movw bin2, OUT0
54 blmov BL_IN0, H3F
55 movw bin3, OUT0
56 blmov BL_IN0, H3F
57 movw bin4, OUT0
58 blmov BL_IN0, H3F
59 movw bin5, OUT0
60 blmov BL_IN0, H3F
61 movw bin7, OUT0 ;THIS LINE INCLUDE THE INDUCED SOFTWARE ERROR
62 ;movw bin6, OUT0 ;THE CORRECT SEQUENCE MUST INCLUDE THIS LINE

```

```

63  blmov  BL_IN0, H3F
64  movw  bin7, OUT0
65  blmov  BL_IN0, H3F
66  movw  bin8, OUT0
67  blmov  BL_IN0, H3F
68  goto  cycle

```

Listing E.9: ASM code for delay of binary sequence.

```

1  ;-----
2  ;-- Assembler template for Processor Core 0 in Mode 0
3  ;-- Created by: SANE Project Developer - v 2.20 - Javier Soto Vargas
4  ;-- Engineer: JSV
5  ;--
6  ;-- Date Created:      07/04/2014 6:51:35
7  ;-- Project Name:     ftMode5_8BitsSequence_3Components
8  ;-- Filename:         retardo.asm
9  ;-- Description:      Delay for sequence
10 ;--
11 ;-- Revision 0.01 - File created.
12 ;-- Additional Comments:
13 ;--
14 ;-----
15 #include      <pMode0Core0.inc>
16
17 ;8-Bit General Purpose Registers
18 cont1      equ      0x1
19 cont2      equ      0x2
20 cont3      equ      0x3
21 BL_IN0     equ      0x0
22 ;*****
23 ;* Directives
24 ;*****
25  MODE_CORE 0x0,0 ;mode core directive
26  ORG      0x0 ;origin of first instruction
27 ;*****
28 ;* Start of programm
29 ;*****
30 start
31  BLMOV  BL_IN0,0x3F ;Read an indicator from Working_processor
32 delay ;to start the delay process
33  MOVL  .127,cont3,0 ;constant cont3 to generate delay
34 del3
35  MOVL  0,cont2,0 ;constant cont2 to generate delay
36 del2
37  MOVL  0,cont1,0 ;constant cont1 to generate delay
38 del1
39  nop
40  DBNZ  cont1,cont1,del1 ;loop using cont1
41  DBNZ  cont2,cont2,del2 ;loop using cont2
42  DBNZ  cont3,cont3,del3 ;loop using cont3
43  MOVL  0x55,OUT0,0 ;move any data to OUT0 for comunicate the end
44  GOTO  start ;of the process to other cells

```

Listing E.10: SHEX file generated by SANE Project developer after execute Build Project option.

```

1  unsigned int memoria[] =
2  {
3  ft_configuration_IC, //0x18
4  0xAAAA0001, //id_primary
5  0BBBB0002, //id_redundant
6  create_component_IC, //0x00
7  0xAAAA, //id_comp
8  0, //Zero-based num cells in component
9  1, //num of outputs
10 0xAAAA0001, //address
11 0x00,
12 0xCCCC0003, //Input 0
13 0x00,

```

E.2. LISTINGS FOR STATIC FAULT TOLERANCE APPLICATION EXAMPLE

```

14 0x00000000, //Input 1
15 0x00,
16 0x00000000, //Input 2
17 0x00,
18 0x00000000, //Input 3
19 0x04,
20 0xBBBB0002, //FT Input 0
21 0x00,
22 0x00000000, //FT Input 1
23 0x00,
24 0x00000000, //FT Input 2
25 0x00,
26 0x00000000, //FT Input 3
27 0x00,
28 0xCCCC0003, //Output 0
29 create_component_IC, //0x00
30 0BBBB, //id_comp
31 0, //Zero-based num cells in component
32 1, //num of outputs
33 0BBBBB0002, //address
34 0x00,
35 0xCCCC0003, //Input 0
36 0x00,
37 0x00000000, //Input 1
38 0x00,
39 0x00000000, //Input 2
40 0x00,
41 0x00000000, //Input 3
42 0x00,
43 0x00000000, //FT Input 0
44 0x00,
45 0x00000000, //FT Input 1
46 0x00,
47 0x00000000, //FT Input 2
48 0x00,
49 0x00000000, //FT Input 3
50 0x04,
51 0xAAAA0001, //Output 0
52 create_component_IC, //0x00
53 0xCCCC, //id_comp
54 0, //Zero-based num cells in component
55 2, //num of outputs
56 0xCCCC0003, //address
57 0x00,
58 0xAAAA0001, //Input 0
59 0x00,
60 0x00000000, //Input 1
61 0x00,
62 0x00000000, //Input 2
63 0x00,
64 0x00000000, //Input 3
65 0x00,
66 0x00000000, //FT Input 0
67 0x00,
68 0x00000000, //FT Input 1
69 0x00,
70 0x00000000, //FT Input 2
71 0x00,
72 0x00000000, //FT Input 3
73 0x00,
74 0xAAAA0001, //Output 0
75 0x00,
76 0BBBBB0002, //Output 1
77 restart_and_disable_processors_IC, //0x0A
78 write_FU_memory_CR_IC, //0x03
79 0xAAAA0001, //address
80 4, //register number
81 0x04, //MODE
82 0x00, //FAMILY
83 0x00, //PORTS

```

```

84 0x45,                //FTCSR
85 write_FU_memory_PM0_IC, //0x04
86 0xAAAA0001,         //address
87 28,                 //register number
88 0x0500000,          //0    movlf  0x00, bin0, 0
89 0x0501001,          //1    movlf  0x01, bin1, 0
90 0x0503002,          //2    movlf  0x03, bin2, 0
91 0x0507003,          //3    movlf  0x07, bin3, 0
92 0x050F004,          //4    movlf  0x0F, bin4, 0
93 0x051F005,          //5    movlf  0x1F, bin5, 0
94 0x053F006,          //6    movlf  0x3F, bin6, 0
95 0x057F007,          //7    movlf  0x7F, bin7, 0
96 0x05FF008,          //8    movlf  0xFF, bin8, 0
97 0x0740024,          //9    movw   bin0, OUT0,
98 0x078083F,          //10   blmov   BL_IN0, H3F,
99 0x0740064,          //11   movw   bin1, OUT0,
100 0x078083F,         //12   blmov   BL_IN0, H3F,
101 0x07400A4,         //13   movw   bin2, OUT0,
102 0x078083F,         //14   blmov   BL_IN0, H3F,
103 0x07400E4,         //15   movw   bin3, OUT0,
104 0x078083F,         //16   blmov   BL_IN0, H3F,
105 0x0740124,         //17   movw   bin4, OUT0,
106 0x078083F,         //18   blmov   BL_IN0, H3F,
107 0x0740164,         //19   movw   bin5, OUT0,
108 0x078083F,         //20   blmov   BL_IN0, H3F,
109 0x07401E4,         //21   movw   bin7, OUT0,
110 0x078083F,         //22   blmov   BL_IN0, H3F,
111 0x07401E4,         //23   movw   bin7, OUT0,
112 0x078083F,         //24   blmov   BL_IN0, H3F,
113 0x0740224,         //25   movw   bin8, OUT0,
114 0x078083F,         //26   blmov   BL_IN0, H3F,
115 0x0E09000,         //27   goto   cycle,,
116 write_FU_memory_CR_IC, //0x03
117 0xBBBB0002,        //address
118 4,                 //register number
119 0x04,              //MODE
120 0x00,              //FAMILY
121 0x00,              //PORTS
122 0x55,              //FTCSR
123 write_FU_memory_PM0_IC, //0x04
124 0xBBBB0002,        //address
125 28,                 //register number
126 0x0500000,          //0    movlf  0x00, bin0, 0
127 0x0501001,          //1    movlf  0x01, bin1, 0
128 0x0503002,          //2    movlf  0x03, bin2, 0
129 0x0507003,          //3    movlf  0x07, bin3, 0
130 0x050F004,          //4    movlf  0x0F, bin4, 0
131 0x051F005,          //5    movlf  0x1F, bin5, 0
132 0x053F006,          //6    movlf  0x3F, bin6, 0
133 0x057F007,          //7    movlf  0x7F, bin7, 0
134 0x05FF008,          //8    movlf  0xFF, bin8, 0
135 0x0740024,          //9    movw   bin0, OUT0,
136 0x078083F,          //10   blmov   BL_IN0, H3F,
137 0x0740064,          //11   movw   bin1, OUT0,
138 0x078083F,          //12   blmov   BL_IN0, H3F,
139 0x07400A4,          //13   movw   bin2, OUT0,
140 0x078083F,          //14   blmov   BL_IN0, H3F,
141 0x07400E4,          //15   movw   bin3, OUT0,
142 0x078083F,          //16   blmov   BL_IN0, H3F,
143 0x0740124,          //17   movw   bin4, OUT0,
144 0x078083F,          //18   blmov   BL_IN0, H3F,
145 0x0740164,          //19   movw   bin5, OUT0,
146 0x078083F,          //20   blmov   BL_IN0, H3F,
147 0x07401A4,          //21   movw   bin6, OUT0,
148 0x078083F,          //22   blmov   BL_IN0, H3F,
149 0x07401E4,          //23   movw   bin7, OUT0,
150 0x078083F,          //24   blmov   BL_IN0, H3F,
151 0x0740224,          //25   movw   bin8, OUT0,
152 0x078083F,          //26   blmov   BL_IN0, H3F,
153 0x0E09000,         //27   goto   cycle,,

```

E.3. CONCLUSIONS

```

154 write_FU_memory_CR_IC, //0x03
155 0xCCCC0003, //address
156 4, //register number
157 0x00, //MODE
158 0x00, //FAMILY
159 0x00, //PORTS
160 0x00, //FTCSR
161 write_FU_memory_PMO_IC, //0x04
162 0xCCCC0003, //address
163 10, //register number
164 0x078083F, //0 BLMOV BL_IN0,0x3F,
165 0x057F003, //1 MOVLF .127,cont3,0
166 0x0500002, //2 MOVLF 0,cont2,0
167 0x0500001, //3 MOVLF 0,cont1,0
168 0x0B40000, //4 nop ,,
169 0x1704041, //5 DBNZ cont1,cont1,del1
170 0x1703082, //6 DBNZ cont2,cont2,del2
171 0x17020C3, //7 DBNZ cont3,cont3,del3
172 0x0555024, //8 MOVLF 0x55,OUT0,0
173 0x0E00000, //9 GOTO start,,
174 connect_component_IC, //0x01
175 enable_processors_wait_IC, //0x0E
176 end_IC //0x0F
177 };

```

Listing E.11: SXM file generated by SANE Project developer after execute Build Project option.

```

1 01031F000000000018AAAA0001BBBB0002000000000000AAAA00000000000000001AAAA00014F
2 01031F000800000000CCCC000300000000000000000000000000000000000000000000000000000003B
3 01031F0010000000004BBBB000200000000000000000000000000000000000000000000000000000052
4 01031F001800000000CCCC0003000000000000BBBB0000000000000000000000000000000000000000003C
5 01031F0020CCCC00030000000000000000000000000000000000000000000000000000000000000023
6 01031F00280000000000000000000000000000000000000000000000000000000000000000000000004B2
7 01031F0030AAAA0001000000000000CCCC0000000000000002CCCC000300000000AAAA0001CF
8 01031F0038000000000000000000000000000000000000000000000000000000000000000000000000A6
9 01031F0040000000000000000000000000000000000000000000000000000000000000000000000000AAAA000149
10 01031F004800000000BBBB000200000000A00000003AAAA000100000004000000040000000000000000B4
11 01031F0050000000000000000450000004AAAA00010000001C005000000050100100503002A1
12 01031F0058005070030050F0040051F0050053F0060057F007005FF008007400240078083FF4
13 01031F0060007400640078083F007400A40078083F007400E40078083F007401240078083FA1
14 01031F0068007401640078083F007401E40078083F007401E40078083F007402240078083F55
15 01031F007000E0900000000003BBBB000200000004000000040000000000000000000000000000005526
16 01031F007800000004BBBB00020000001C005000000050100100503002005070030050F00494
17 01031F00800051F0050053F0060057F007005FF008007400240078083F007400640078083F3C
18 01031F0088007400A40078083F007400E40078083F007401240078083F007401640078083F78
19 01031F0090007401A40078083F007401E40078083F007402240078083F00E09000000000000000392
20 01031F0098CCCC00030000000400000000000000000000000000000000000000000000000000004CCCC000308
21 01031F00A00000000A0078083F0057F003005000020050000100B400000170404101703082BF
22 01031700A8017020C30055502400E0000000000010000000E000000F23

```

E.3 Conclusions

The listings for the Dynamic Fault Tolerance Scaling application and for the Static Fault Tolerance mechanism has been presented. These applications has been described in section 5.5 and 5.6 respectively.

The listing presented includes [SANE Assembler \(SASM\)](#) and [Assembler \(ASM\)](#) files. The listings of [SASM](#) files presents the syntax and structure of the high-level configuration file, which represents the sequence of instructions that the [Control Microprocessor \(C_μP\)](#) executes for the configuration of a [SANE ASSEMBLY \(SANE-ASM\)](#). The listings of [ASM](#) files represents the tasks scheduled to cell processors.

The [SASM](#) and [ASM](#) listings presented in this chapter shows the syntax and structure of their correspondent languages. These listings has been created and edited using the [SANE Project](#)

Developer (SPD). The listings for SHEX and SXM files has been generated automatically by SPD after execution of the “Build Project” process.

The SHEX files represents the byte-code of the SASM instructions that C μ P read when execute the configuration of a SANE-ASM. This information is stored in C μ P memory and includes the Instruction Code and their correspondent arguments of SASM instructions.

The SXM files presents the frames that will be downloaded to C μ P memory when the option “Write Memory” is executed in the SPD. The format of this file is an adaptation of the XMODEM protocol, which includes the same data generated for SHEX files when the project was built.

Glossary

A

ASM (Assembler) Assembly language instructions that are executed by processors. This term can be also associated with the file that includes the ASM instructions, p. 66.

C

CCR (Code Condition Register) Contains the status of bits: Carry, Zero-bit and Thread Active, p. 33.

CCU (Cell Configuration Unit) Part of the cell that executes the self-adaptive algorithms and configure the internal multiplexers, p. xi.

CSR (Configuration and Status Register) Register mapped in Data Memory used for system configuration, p. 34.

C μ P (Control Microprocessor) It is responsible for implementing the main program for the configuration and execution of system functionality. In the prototype, the C μ P is implemented inside the chip and replaces the External Controller, p. xii.

CU (Configuration Unit) It refers to any configuration unit in a chip, i.e., GCU, CCUs, SMCUs or PIMCUs, p. 20.

E

EC (External Controller) Connected to the External Network, it controls the execution of all processes in the system. In the prototype, the External Controller was replaced by the Control Microprocessor (C μ P) inside the chip, p. 13.

ENET (External Network) Network based in the I2C protocol that allows interconnect several chips, p. 13.

F

FTS (Fault Tolerance System) Enables the system to continue operating properly in the event of the failure of some of its processors, p. 17.

FU (Functional Unit) Part of the cell with processing capabilities, p. xi.

G

GCU (Global Configuration Unit) Part of the chip that controls the execution of all self-adaptive processes, p. 14.

GPR (General Purpose Register) Register mapped in Data Memory used for data processing, p. 33.

H

HEX (Hexadecimal File) Hexadecimal file with the compilation result of ASM files.

I

INET (Internal Network) Network based in the I2C protocol that allows interconnect several configuration units inside the chip, p. 14.

M

MIMD (Multiple Instruction Multiple Data) Technique employed to achieve parallelism. Different processors may be executing different instructions on different pieces of data.

MISD (Multiple Instruction Single Data) Many functional units perform different operations on the same data.

O

OMS (Output Multiplexing System) Configures a path between CORES and output registers. It allows write operations over FU output ports., p. 31.

P

PIM (Pin Interconnection Matrix) Part of the chip that allows the interconnection between two chips, p. 14.

PIMCU (Pin Interconnection Matrix Configuration Unit) Part of the pin interconnection matrix that executes the self-adaptive algorithms and configures the internal multiplexers, p. 18.

R

RE (Read Enable) Ninth bit of any FU port. Pulse of one clock-cycle when an FU output port is written, p. 17.

S

SANE (Self-Adaptive Networked Entity) The SANE is the basic self-adaptive computing system; it has the ability of monitoring its local environment and its internal computation process, p. xi.

SANE-ASM (SANE ASSEMBLY) Composed of a group of interconnected SANEs, p. xi.

- SASM (SANE Assembler)** High-level instructions that are executed by the Control Micro-processor for the implementation of a SANE ASSEMBLY. This term can be also associated with the file that includes the SASM instructions, p. 44.
- SCL (Serial Clock Line)** Bus line for Internal and External Netorks, p. 20.
- SDA (Serial Data Line)** Bus line for Internal and External Netorks, p. 20.
- SHEX (SANE Hexadecimal File)** Hexadecimal file with the configuration of the [SANE-ASM](#) that will be implemented in the FPGA prototype, p. 66.
- SIMD (Single Instruction Multiple Data)** Multiple processing elements that perform the same operation on multiple data points simultaneously.
- SISD (Single Instruction Single Data)** A single processor executes a single instruction stream, to operate on data stored in a single memory.
- SM (Switch Matrix)** Part of the cluster that allows the interconnection of components, p. 11.
- SMCU (Switch Matrix Configuration Unit)** Part of the Swicth Matrix that executes the self-adaptive algortihms and configures the internal multiplexers, p. 18.
- SPD (SANE Project Developer)** Integrated development environment (IDE) used to develop complete SANE applications, p. xii.
- SXM (SANE X-Modem File)** Hexadecimal file with the final configuration of the [SANE-ASM](#) that will be downloaded in the FPGA prototype, p. 66.

V

- VLIW (Very Long Instruction Word)** , p. 5.

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